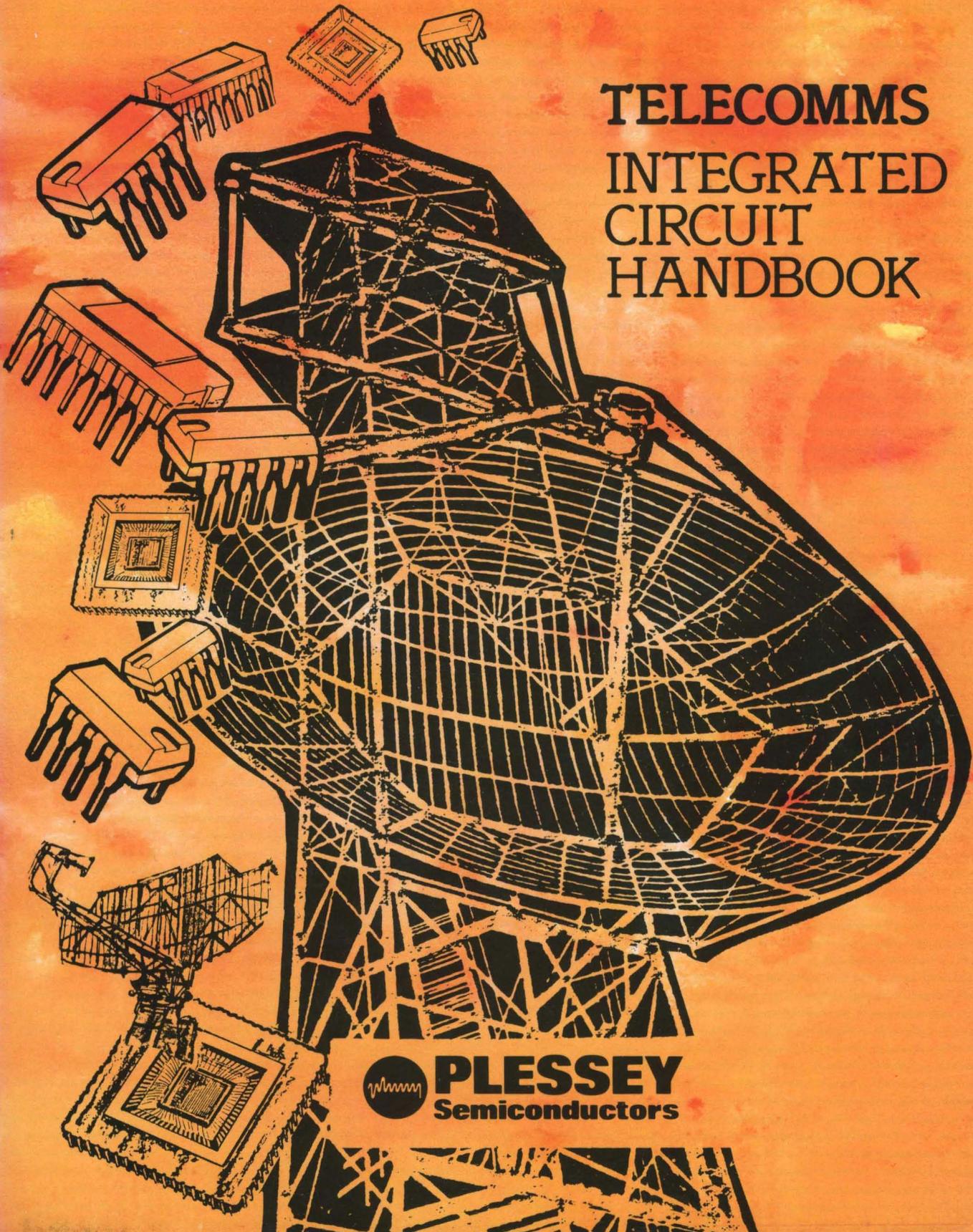


# TELECOMMS INTEGRATED CIRCUIT HANDBOOK



**PLESSEY**  
Semiconductors

# TELECOMS INTEGRATED CIRCUIT HANDBOOK



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Publication No. P.S. 1913 December 1985

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# Contents

	Page
Product index	5
Selection guide	6
The quality concept	7
Screening to BS9400	8
Plessey Hi-Rel screening	9
Semi-custom design	10
Plessey Megacell	11
Thermal design	12
Technical data	15
Package outlines	181
Ordering information	188
Plessey Semiconductors World-Wide	189



# Product index

TYPE NO.	DESCRIPTION	PAGE
<b>N-channel MOS</b>		
<b>MJ1410</b>	8-bit format converter	17
<b>MJ1440</b>	HDB3 encoder/decoder	23
<b>MJ1444</b>	Time slot zero transmitter	29
<b>MJ1445</b>	Time slot zero receiver	33
<b>MJ1446</b>	Time slot access	37
<b>MJ1471</b>	AM1/HDB3 encoder/decoder	41
<b>MJ1472</b>	PCM receiving circuit	47
<b>MJ1473</b>	PCM transmitter circuit	51
<b>MJ1474</b>	PCM elastic store	55
<b>N-channel silicon gate</b>		
<b>MS2002EXP</b>	Digital switch module (DSM) for CCITT 32-channel PCM	59
<b>MS2014</b>	Digital filter and detector (FAD)	67
<b>CMOS</b>		
<b>MV1441</b>	HDB3 encoder/decoder/clock regenerator	75
<b>MV1448</b>	HDB3 encoder/decoder	81
<b>MV3506</b>	A-law codec with filter	87
<b>MV3507</b>	$\mu$ -law codec with filter	87
<b>MV3507A</b>	$\mu$ -law codec with filter and A/B signalling	87
<b>MV4320</b>	Keypad pulse dialler with M1 masking	99
<b>MV4325</b>	Programmable keypad pulse dialler with M1 masking	103
<b>MV4330</b>	30-bit static shift register/LCD driver	109
<b>MV4332</b>	32-bit static shift register/LCD driver	109
<b>MV5087</b>	DTMF generator	113
<b>MV5089</b>	DTMF generator	119
<b>MV8804</b>	8 x 4 analog switch array	125
<b>MV8860</b>	DTMF decoder with 4-bit binary output	131
<b>MV8865</b>	DTMF filter	139
<b>MV8870EXP</b>	DTMF receiver	145
<b>MV9009EXP</b>	V21 modem TX/RX	153
<b>Bipolar</b>		
<b>SL650B,C</b>	Modulator/phase lock loop circuits for modems	159
<b>SL651B,C</b>	Modulator/phase lock loop circuits for modems	159
<b>SL652C</b>	Modulator/phase lock loop	163
<b>SL8204</b>	Telephone tone ringer	167
<b>SL9009EXP</b>	Adaptive cancellation filter	171
<b>SP1404BW</b>	High voltage interface circuit	175
<b>D3702</b>	High voltage interface circuit to BT Spec.	175
<b>SP1450B</b>	34Mbit/s PCM signal monitor	177
<b>SP1450B(B)</b>	As SP1450B but screened to MIL-STD-883, Method 5004, Class B	177
<b>SP1455B</b>	140Mbit/s PCM signal monitor	177
<b>SP1455B(B)</b>	As SP1455B but screened to MIL-STD-883, Method 5004, Class B	177

*EXP products are new designs designated 'Experimental' but which are, nevertheless, serious development projects. Details given may, therefore, change without notice and no undertaking is given or implied as to future availability. Please consult your local Plessey sales office for details of the current status*

# Selection guide

TYPE NO.	DESCRIPTION	PAGE
<b>NMOS PCM circuits</b>		
<b>MJ1410</b>	8-bit format converter	17
<b>MJ1440</b>	HDB3 encoder/decoder	23
<b>MJ1444</b>	Time slot zero transmitter	29
<b>MJ1445</b>	Time slot zero receiver	33
<b>MJ1446</b>	Time slot access	37
<b>MJ1471</b>	AM1/HDB3 encoder/decoder	41
<b>MJ1472</b>	PCM receiving circuit	47
<b>MJ1473</b>	PCM transmitter circuit	51
<b>MJ1474</b>	PCM elastic store	55
<b>CMOS PCM circuits</b>		
<b>MV1441</b>	HDB3 encoder/decoder/clock regenerator	75
<b>MV1448</b>	HDB3 encoder/decoder	81
<b>MV3506</b>	A-law codec with filter	87
<b>MV3507</b>	$\mu$ -law codec with filter	87
<b>MV3507A</b>	$\mu$ -law codec with filter and A/B signalling	87
<b>Telephone communications circuits</b>		
<b>SL8204</b>	Tone ringer	167
<b>SP1450B</b>	34Mbit/s PCM signal monitor	177
<b>SP1450B(B)</b>	As SP1450B but screened to MIL-STD-883, Method 5004, Class B	177
<b>SP1455B</b>	140Mbit/s PCM signal monitor	177
<b>SP1455B(B)</b>	As SP1455B but screened to MIL-STD-883, Method 5004, Class B	177
<b>Interface circuits</b>		
<b>SP1404BW</b>	High voltage interface	175
<b>D3702</b>	High voltage interface (BT Spec.)	175
<b>CMOS telephone dialling circuits - loop disconnect</b>		
<b>MV4320</b>	Keypad pulse dialler with M1 masking	99
<b>MV4325</b>	Programmable keypad pulse dialler with M1 masking	103
<b>CMOS telephone dialling circuits - DTMF/MF4</b>		
<b>MV5087</b>	DTMF generator (Form A keypad)	113
<b>MV5089</b>	DTMF generator (active keypad)	119
<b>MV8860</b>	DTMF decoder with 4-bit binary output	131
<b>MV8865</b>	DTMF filter	139
<b>MV8870EXP</b>	DTMF receiver (combined filter and decoder)	145
<b>Signal processing and switching</b>		
<b>MS2002EXP</b>	256 x 256 digital switch module for CCITT 32-channel PCM	59
<b>MS2014</b>	Digital filter and detector (FAD)	67
<b>MV8804</b>	Bi-directional 8 x 4 analog switch array	124
<b>Data transmission modems</b>		
<b>MV9009EXP</b>	V21 modem RX/TX	153
<b>SL9009EXP</b>	Adaptive cancellation filter	171
<b>SL650B,C</b>	Modulator/PLL	159
<b>SL651B,C</b>	Modulator/PLL	159
<b>SL652C</b>	Modulator/PLL	163
<b>CMOS interface circuits</b>		
<b>MV4330</b>	30-bit static shift register/LCD driver	109
<b>MV4332</b>	32-bit static shift register/LCD driver	109

# The quality concept

In common with most semiconductor manufacturers, Plessey Semiconductors perform incoming piece parts check, in-line inspections and final electrical tests. However, quality cannot be inspected into a product; it is only by careful design and evaluation of materials, parts and processes - followed by strict control and ongoing assessment to ensure that design requirements are still being met - that quality products will be produced.

In line with this philosophy, all designs conform to standard layout rules (evolved with performance and reliability in mind), all processes are thoroughly evaluated before introduction and all new piece part designs and suppliers are investigated before authorisation for production use.

The same basic system of evaluation, appraisals and checks is used on all products up to and including device packing for shipment. It is only at this stage that extra operations are performed for certain customers in terms of lot qualification or release procedure.

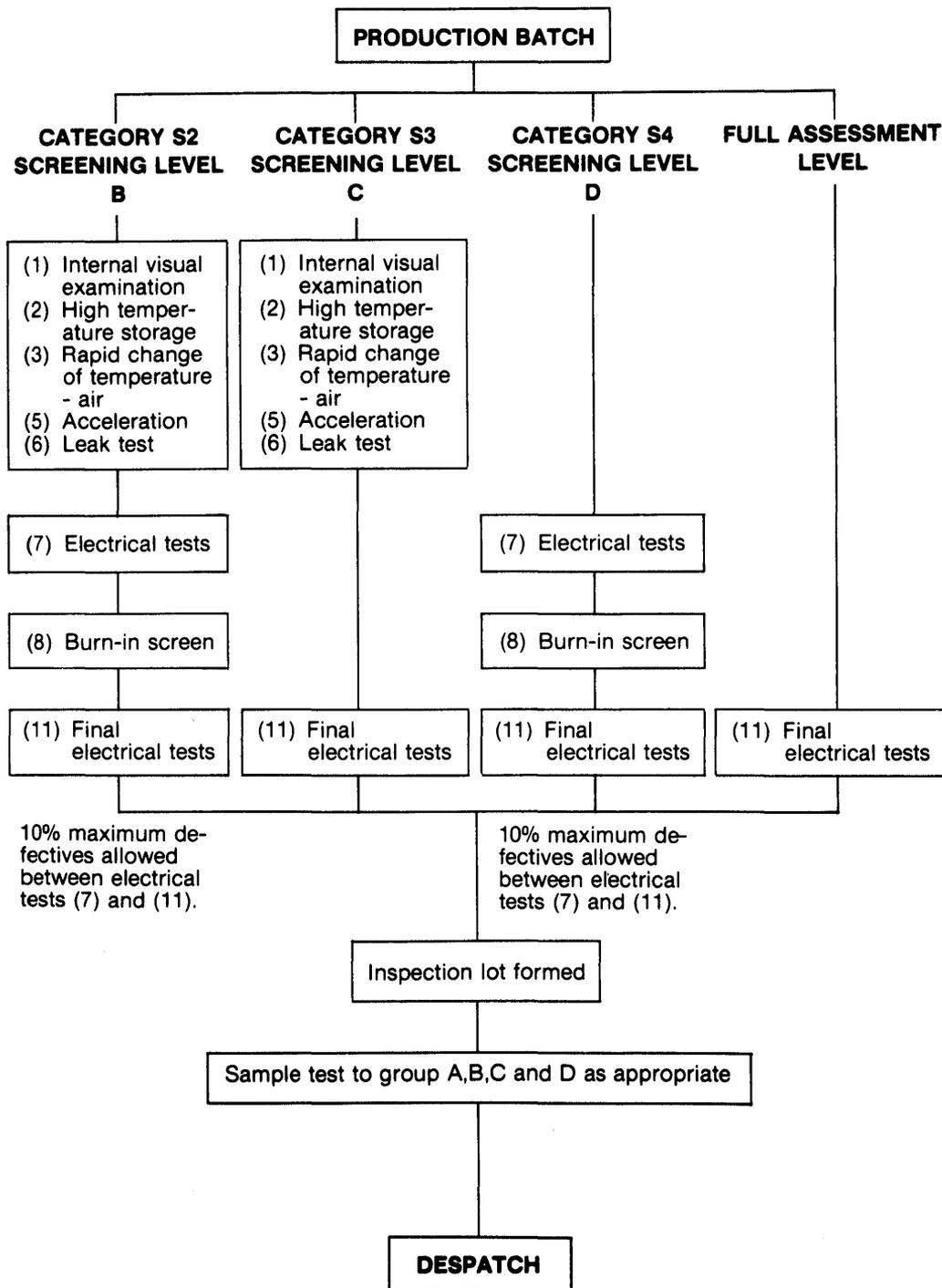
By working to common procedures for materials and processes for all types of customers advantages accrue to all users - the high reliability user gains the advantage of scale hence improving the confidence factor in the quality achieved whilst the large scale user gains the benefits associated with basic high reliability design concepts.

Plessey Semiconductors have the following factory approvals. **BS9300** and **BS9400** (BSI Approval No. 1053/M).

**DEF-STAN 05-21** (Reg. No. 23H POD).

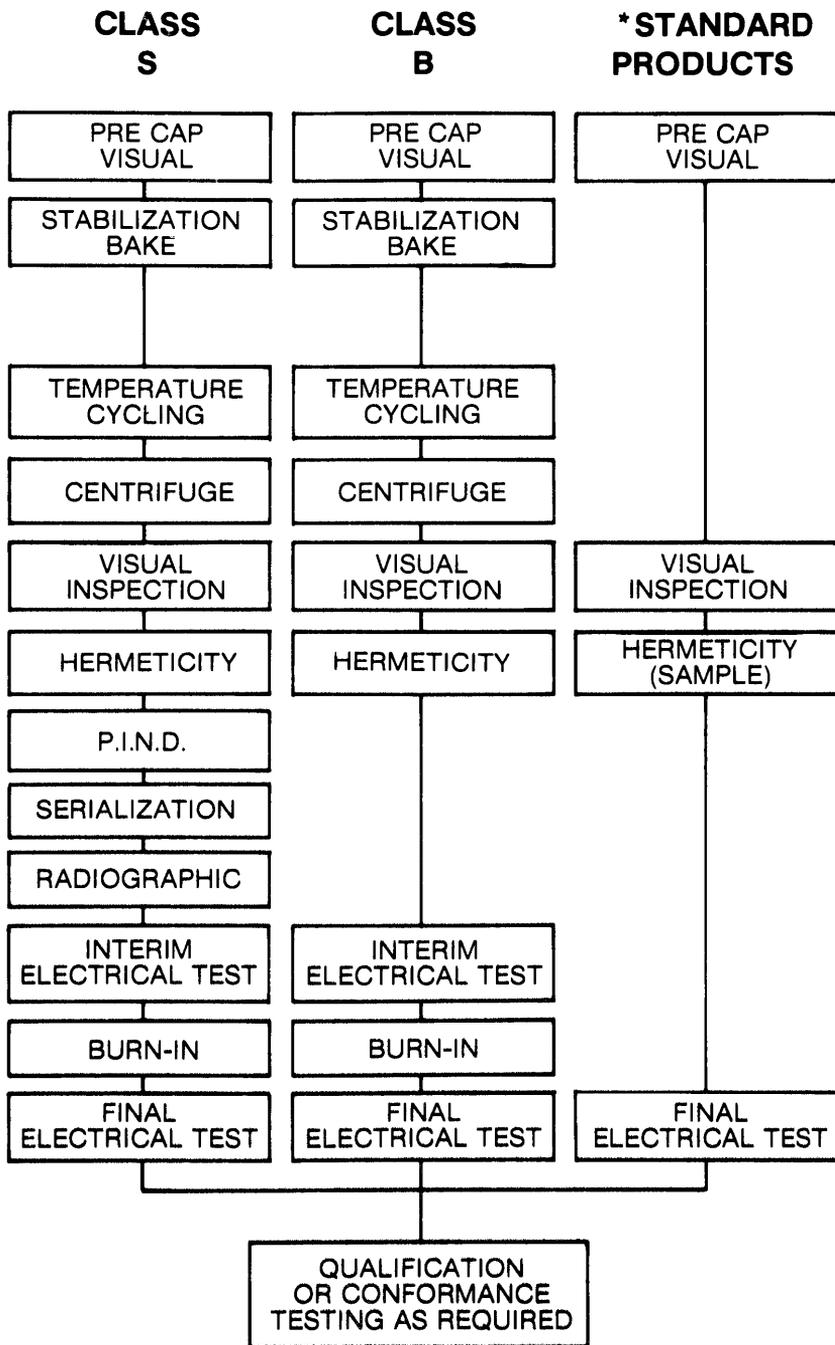
In addition a number of U.S., European and British customers manufacturing electronics for space have approved our facilities.

# Screening to BS9400



# Plessey Hi-Rel screening

The following Screening Procedures are available from Plessey Semiconductors.

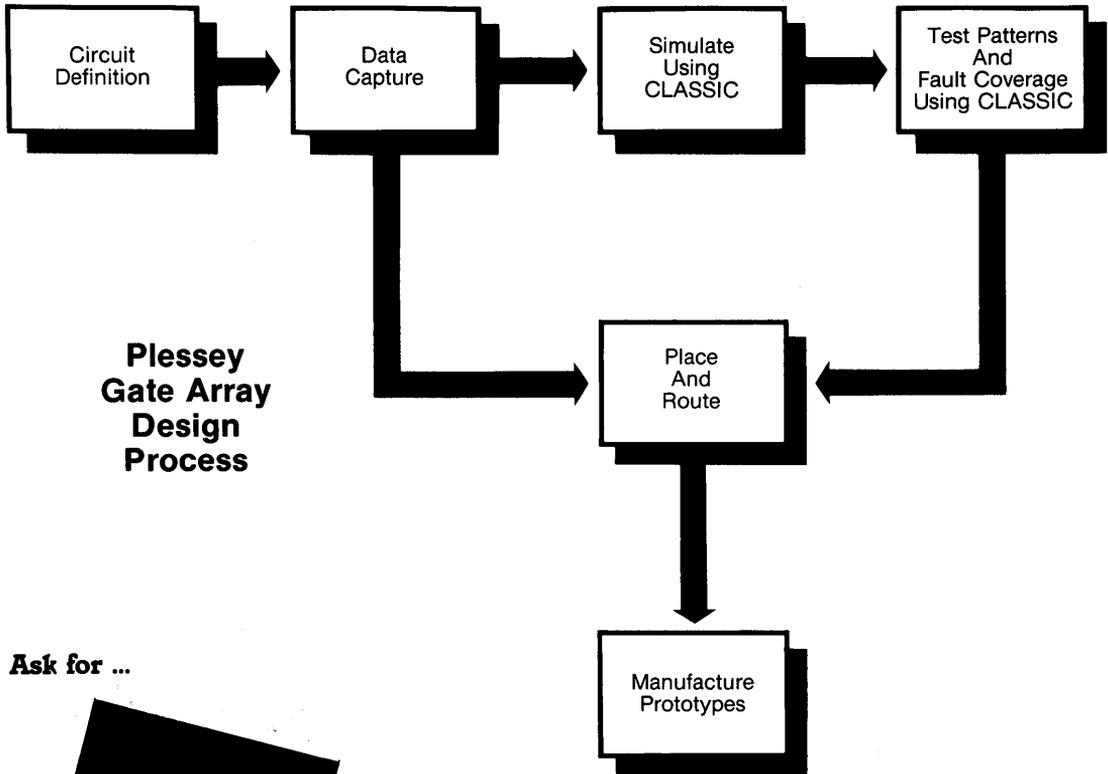


\* Plessey Semiconductors reserve the right to change the Screening Procedure for Standard Products.

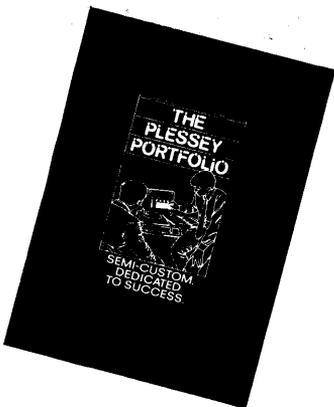
# Semi-custom design

Plessey Semiconductors' advanced work in the Semi-Custom field enables us to offer our customers the opportunity to develop their own high performance circuits using our CLASSIC software. Among the many advantages are:

- CLASSIC is cost effective and user friendly
- Prototypes in 6 weeks
- Close coordination with customer throughout design and production process
- State-of-the-art high performance produces
- Up to 10044 gates available



Ask for ...



# Microgate-C (Si-Gate CMOS)

## CLA 2000 SERIES

- Double layer metallisation
- 5 micron channel length
- Product family:
  - CLA 21XX 840 Gates
  - CLA 23XX 1400 Gates
  - CLA 25XX 2400 Gates
- 7ns max. prop delay (2 input NAND fanout of 2 with 2mm track 0-70°C 4.5-5.5V)
- 14MHz system clock rate
- 30MHz toggle rate
- Fully auto-routed

## CLA 3000 SERIES

- Double layer metallisation
- 4 micron channel length
- Product family:
  - CLA 31XX 840 Gates
  - CLA 33XX 1440 Gates
  - CLA35XX 2400 Gates
  - CLA 37XX 4200 Gates
  - CLA 39XX 6000 Gates
- 5ns max. prop delay
- 20MHz system clock rate
- 50MHz toggle rate
- Fully auto-routed

## CLA 5000 SERIES

- Double layer metallisation
- 2 micron channel length
- Product family:
  - CLA 51XX 640 Gates
  - CLA 52XX 1232 Gates
  - CLA 53XX 2016 Gates
  - CLA 54XX 3060 Gates
  - CLA 55XX 4408 Gates
  - CLA 56XX 5984 Gates
  - CLA 58XX 8064 Gates
  - CLA 59XX 10044 Gates
- 2.5ns max. prop delay
- 40MHz system clock rate
- 100MHz toggle rate
- Fully auto-routed

# Plessey Megacell™

Now there's a VLSI design system available that's perfect for solving your Application Specific Integrated Circuit (ASIC) problems. It's **PLESSEY MEGACELL** - a complete set of advanced computer-aided engineering and design tools coupled with an advanced CMOS process for implementing VLSI integrated circuits in the system design environment.

**PLESSEY MEGACELL** redefines semicustom integrated circuit design. It allows system engineers to design complex circuits with a high level of confidence of first time success in silicon - thanks to one of the best simulation facilities available in the world. This greatly reduces time to market, eliminating the many prototyping iterations that are all too common now in VLSI design.

**PLESSEY MEGACELL** is just about as close as you can get to achieving hand-crafted results short of full custom itself. System engineers can directly create their designs using the advanced layout and routing tools provided - without the aid of integrated circuit designers. So none of the system designers' application expertise is ever lost in transition, while chips of the smallest size and lowest production cost are regularly achieved.

Supporting the **PLESSEY MEGACELL** design capability is one of the most advanced CMOS processes available. It uses a 2-micron geometry capable of providing performance comparable with advanced Schottky TTL, with clock speeds to 40MHz and toggle rates of 100MHz achievable. And Plessey has established a 200,000 square foot dedicated processing facility to guarantee the manufacturing capacity required by even the most aggressive volume considerations.

**PLESSEY MEGACELL** is truly the gateway to the future - custom VLSI performance, with confidence of first time success and fast time to market. And it's going to stay that way - with Plessey's commitment to add future capabilities for high-speed ECL processes, 1 micron and submicron CMOS processes, and advanced analog capabilities.

# Thermal design

The temperature of any semiconductor device has an important effect upon its long term reliability. For this reason, it is important to minimise the chip temperature; and in any case, the maximum junction temperature should not be exceeded.

Electrical power dissipated in any device is a source of heat. How quickly this heat can be dissipated is directly related to the rise in chip temperature: if the heat can only escape slowly, then the chip temperature will rise further than if the heat can escape quickly. To use an electrical analogy: energy from a constant voltage source can be drawn much faster by using a low resistance load than by using a high resistance load.

The thermal resistance to the flow of heat from the semiconductor junction to the ambient temperature air surrounding the package is made up of several elements. These are the thermal resistance of the junction-to-case, case-to-heatsink and heatsink-to-ambient interfaces. Of course, where no heatsink is used, the case-to-ambient thermal resistance is used.

These thermal resistances may be represented as

$$\theta_{ja} = \theta_{jc} + \theta_{ch} + \theta_{ha}$$

where  $\theta_{ja}$  is thermal resistance junction-to-ambient °C/W

$\theta_{jc}$  is thermal resistance junction-to-case °C/W

$\theta_{ch}$  is thermal resistance case-to-heatsink °C/W

$\theta_{ha}$  is thermal resistance heatsink-to-ambient °C/W

The temperature of the junction is also dependent upon the amount of power dissipated in the device — so the greater the power, the greater the temperature.

Just as Ohm's Law is applied in an electrical circuit, a similar relationship is applicable to heatsinks.

$$T_j = T_{amb} + P_D (\theta_{ja})$$

$T_j$  = junction temperature

$T_{amb}$  = ambient temperature

$P_D$  = dissipated power

From this equation, junction temperature may be calculated, as in the following examples.

## Example 1

A device is to be used at an ambient temperature of +50° C.  $\theta_{ja}$  for the DG14 package with a chip of approximately 1mm sq is 107° C/W. Assuming the datasheet for the device gives  $P_D = 330\text{mW}$  and  $T_j \text{ max} = 175^\circ\text{C}$ .

$$\begin{aligned} T_j &= T_{amb} + P_D \theta_{ja} \\ &= 50 + (0.33 \times 107) \\ &= 85.31^\circ\text{C (typ.)} \end{aligned}$$

Where operation in a higher ambient temperature is necessary, the maximum junction temperature can easily be exceeded unless suitable measures are taken:

## Thermal design (cont'd)

### Example 2

A device with  $T_{\text{amb max.}} = +175^{\circ}\text{C}$  is to be used at an ambient temperature of  $+150^{\circ}\text{C}$ . Again,  $\theta_{\text{ja}} = 107^{\circ}\text{C/W}$ ,  $P_{\text{D}} = 330\text{mW}$  and  $T_{\text{j max.}} = +175^{\circ}\text{C}$ .

$$\begin{aligned}T_{\text{j}} &= 150 + (0.33 \times 107) \\ &= +185.3^{\circ}\text{C (typ.)}\end{aligned}$$

This clearly exceeds the maximum permissible junction temperature and therefore some means of decreasing the junction-to-ambient thermal resistance is required.

As stated earlier,  $\theta_{\text{ja}}$  is the sum of the individual thermal resistances; of these,  $\theta_{\text{jc}}$  is fixed by the design of device and package and so only the case-to-ambient thermal resistance,  $\theta_{\text{ca}}$ , can be reduced.

If  $\theta_{\text{ca}}$ , and therefore  $\theta_{\text{ja}}$ , is reduced by the use of a suitable heatsink, then the maximum  $T_{\text{amb}}$  can be increased:

### Example 3

Assume that an IERC LIC14A2U dissipator and DC000080B retainer are used. This device is rated as providing a  $\theta_{\text{ja}}$  of  $55^{\circ}\text{C/W}$  for the DG14 package. Using this heatsink with the device operated as in Example 2 would result in a junction temperature given by:

$$\begin{aligned}T_{\text{j}} &= 150 + (0.33 \times 55) \\ &= 168^{\circ}\text{C}\end{aligned}$$

Nevertheless, it should be noted that these calculations are not necessarily exact. This is because factors such as  $\theta_{\text{jc}}$  may vary from device type to device type, and the efficacy of the heatsink may vary according to the air movement in the equipment.

In addition, the assumption has been made that chip temperature and junction temperature are the same thing. This is not strictly so, as not only can hot spots occur on the chip, but the thermal conductivity of silicon is a variable with temperature, and thus the  $\theta_{\text{jc}}$  is in fact a function of chip temperature. Nevertheless, the method outlined above is a practical method which will give adequate answers for the design of equipment.

It is possible to improve the dissipating capability of the package by the use of heat dissipating bars under the package, and various proprietary items exist for this purpose.

Under certain circumstances, forced air cooling can become necessary, and although the simple approach outlined above is useful, more factors must be taken into account.



# Technical data



# MJ1410

## 8 BIT FORMAT CONVERTER

The MJ1410 is realised in N-channel MOS technology and operates from a single 5V supply. The circuit can be clocked from d.c. up to 2.5MHz and has 3-state output buffers capable of driving two LSTTL loads. All inputs are TTL compatible.

The MJ1410 performs the complementary functions of serial-to-parallel and parallel-to-serial data conversion on 8 bits of data. Both these conversions are achieved using the same time-position matrix, which has eight inputs and eight outputs.

An 8-bit parallel word clocked into the eight inputs appears as a serial 8-bit data stream on one of the eight outputs. Successive parallel words at the inputs appear as serial data streams on each of the eight outputs in turn.

Conversely, a serial 8-bit data stream on one of the eight inputs appears as an 8-bit parallel word on the eight outputs. Successive parallel words appearing at the eight outputs correspond to the serial data on each of the eight inputs in rotation.

The conversion can be 'programmed' to start in any register by setting the appropriate binary value on the counter pre-load inputs and applying a pulse to the Sync input. If the loading sequence produced by the counter is not required it can be disabled by connecting 'clock' to 'sync'. At each positive clock edge the register loaded will depend on the data on the counter inputs on the previous positive clock edge.

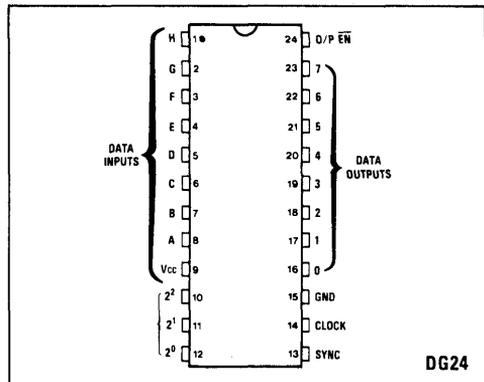


Fig.1 Pin connections

### FEATURES

- Single 5V supply.
- Three-state outputs.
- All inputs TTL compatible.

### FUNCTIONAL DESCRIPTION

Pin No.	Title	Function
1	H	Data i/p H
2	G	Data i/p G
3	F	Data i/p F
4	E	Data i/p E
5	D	Data i/p D
6	C	Data i/p C
7	B	Data i/p B
8	A	Data i/p A
9	Vcc	Positive supply, 5V ± 5%
10	2 <sup>2</sup>	Counter preset i/p bit 2
11	2 <sup>1</sup>	Counter preset i/p bit 1
12	2 <sup>0</sup>	Counter preset i/p bit 0
13	SYNC	A negative edge on this i/p initiates the counter preset sequence which causes the conversion cycle to start in the register which corresponds to the binary value of the counter preset i/ps.
14	CLOCK	System clock
15	GND	Zero volts
16	0	Three state data o/p '0'
17	1	Three state data o/p '1'
18	2	Three state data o/p '2'
19	3	Three state data o/p '3'
20	4	Three state data o/p '4'
21	5	Three state data o/p '5'
22	6	Three state data o/p '6'
23	7	Three state data o/p '7'
24	O/P EN	A logic '1' on this i/p forces all the data outputs to a high impedance state.

# MJ1410

## ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):  $V_{CC} = 5V$ ,  $T_{amb} = 22^{\circ}C \pm 2^{\circ}C$ , Test circuit: Fig. 6.  
 Supply voltage  $V_{CC} 5V \pm 10\%$   
 Ambient operating temperature  $T_{amb} -10^{\circ}C$  to  $+70^{\circ}C$

## STATIC CHARACTERISTICS

Characteristic	Symbol	Pins	Value			Units	Conditions
			Min.	Typ.	Max.		
Low level I/P voltage	$V_{IL}$	1,2,3,4, 5,6,7,8, 10,11,12, 13,14,24	-0.3		0.8	Volts	
High level I/P voltage	$V_{IH}$	1,2,3,4, 5,6,7,8, 10,11,12, 13,14,24	2.5		$V_{CC}$	Volts	
Low level I/P current/high level I/P current	$I_{IN}$	1,2,3,4, 5,6,7,8, 10,11,12, 13,14,24		1	50	$\mu A$	
Low level O/P voltage	$V_{OL}$	16,17,18, 19,20,21, 22,23			0.5	Volts	$I_{SYNC} = 1.6mA$
High level O/P voltage	$V_{OH}$	16,17,18, 19,20,21, 22,23	2.5			Volts	$I_{SOURCE} = 100\mu A$
Low level O/P current sink capability	$I_{OL}$	16,17,18, 19,20,21, 22,23	-1.6			mA	
High level O/P current source capability	$I_{OH}$	16,17,18, 19,20,21, 22,23	100			$\mu A$	
OFF state O/P current	$I_{OFF L}$	16,17,18, 19,20,21, 22,23			40	$\mu A$	$V_{OUT} = GND$
	$I_{OFF H}$	16,17,18, 19,20,21, 22,23			-40	$\mu A$	$V_{OUT} = V_{CC}$
Power dissipation	$P_{DISS}$		90		500	mW	$V_{CC} = 5.5V$

## DYNAMIC CHARACTERISTICS

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Max.clock frequency	$F_{max}$	2.4		10	MHz	
Min. clock frequency	$F_{min}$	0			MHz	
Sync. pulse width (positive)	$t_{SPP}$	60			ns	Fig. 6
Sync. pulse width (negative)	$t_{SPN}$	100			ns	Fig. 6
Lead of sync. clocking edge on positive clock edge	$t_{SL}$	130			ns	Fig. 6
Set up time of counter inputs ( $2^0, 2^1, 2^2$ )	$t_{SC}$	70			ns	Fig. 6
Hold time of counter inputs	$t_{HC}$	60			ns	Fig. 6
Set up time of data inputs (A-H)	$t_{SD}$	80			ns	Fig. 6

**DYNAMIC CHARACTERISTICS**

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Hold time of data inputs	t <sub>HD</sub>	85			ns	Fig. 6
Propagation delay, data out valid from output ENABLE low	tp <sub>DE</sub>			100	ns	Fig. 6
Propagation delay, data out disabled from output ENABLE high	tp <sub>DD</sub>			100	ns	Fig. 6
Propagation delay, clock to data out valid	tp <sub>CD</sub>			200	ns	Fig. 6

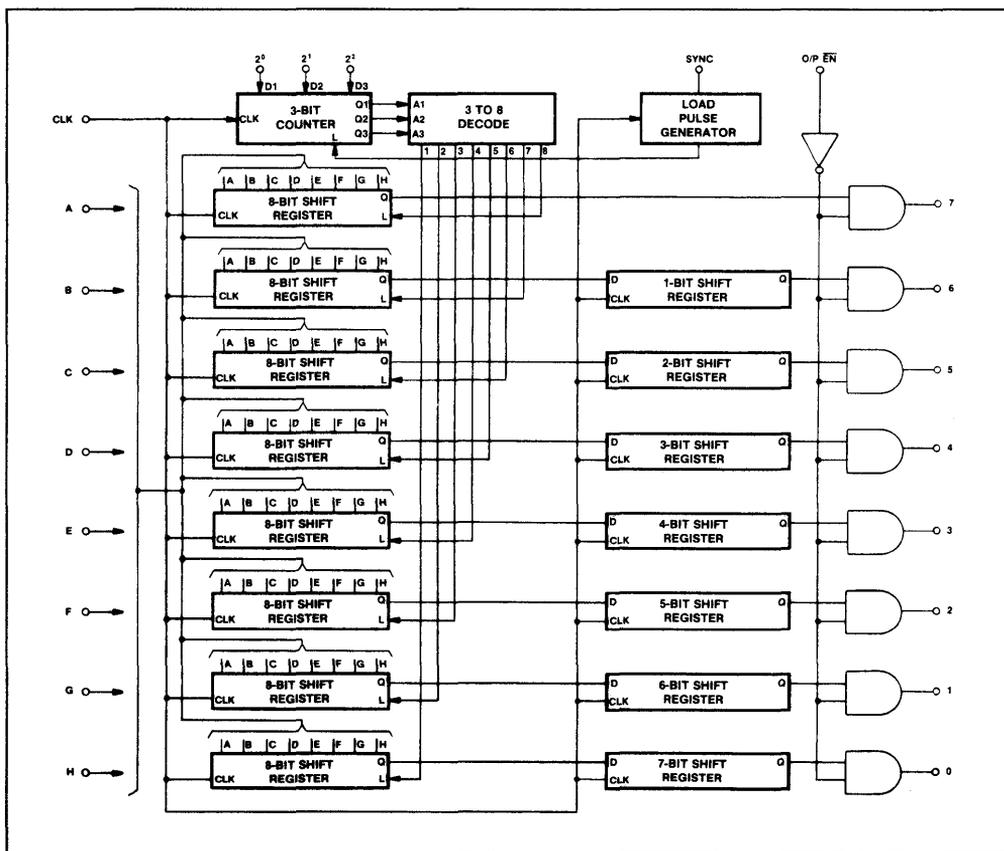


Fig.2 Block diagram

**ABSOLUTE MAXIMUM RATINGS**

Voltage on any pin w.r.t. ground = 7V max.  
 Storage temperature = -55°C to +125°C



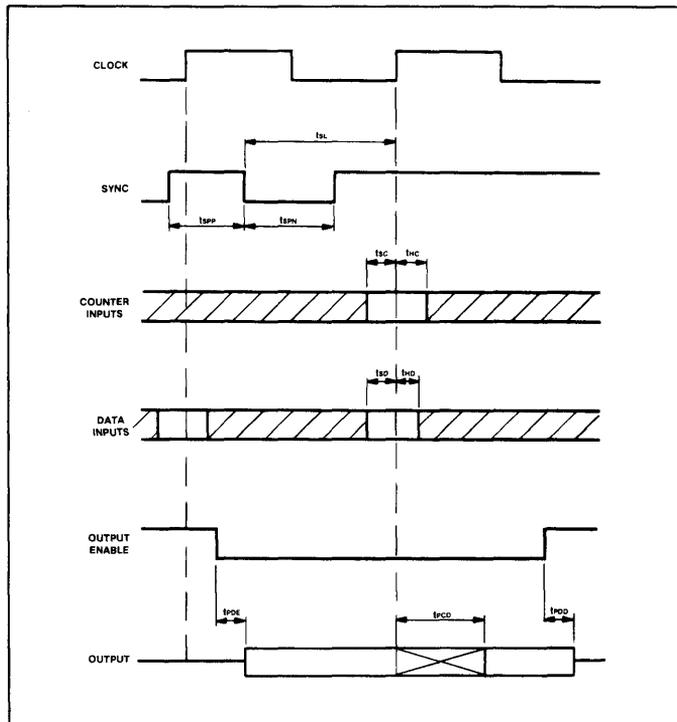


Fig.5 Timing details

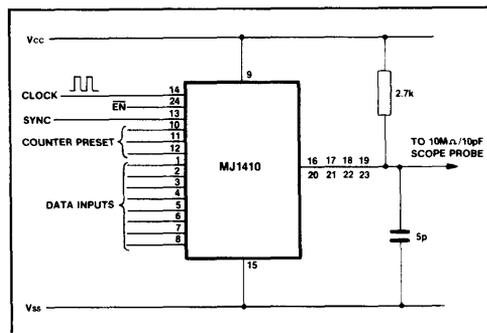


Fig.6 Test conditions



## 2 MBIT PCM SIGNALLING CIRCUIT

# MJ1440

### HDB3 ENCODER/DECODER

The 2.048 MBit PCM Signalling Circuits comprise a group of circuits which will perform the common signalling and error detection functions for a 2.048 MBit PCM transmission link operating to the appropriate CCITT recommendations. The circuits are fabricated in N-channel metal gate MOS and operate from a single 5 volt supply, relevant inputs and outputs are TTL compatible.

The MJ1440 is an encoder/decoder for the pseudoternary transmission code, HDB3 (CCITT Orange Book Vol III.2 Annex to Rec. G703). The device encodes and decodes simultaneously and asynchronously. Error monitoring functions are provided to detect violations of HDB3 coding, all ones detection and loss of input (all zeroes detection). In addition a loop back function is provided for terminal testing.

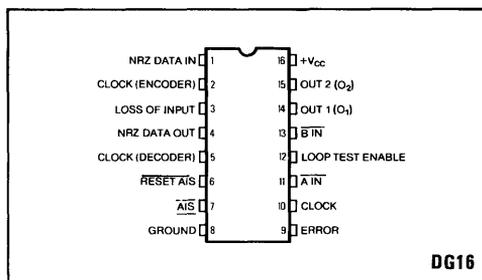


Fig. 1 Pin connections

#### FEATURES

- 5v  $\pm$  5% Supply – 50mA Max
- HDB3 Encoding and Decoding to CCITT rec. G703.
- Asynchronous Operation.
- Simultaneous Encoding and Decoding.
- Clock Recovery Signal Generated from Incoming HDB3 Data.
- Loop Back Control.
- HDB3 Error Monitor
- 'All Ones' Error Monitor
- Loss of Input Alarm (All Zeros Detector).
- Decode Data in NRZ Form.

#### ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

##### Electrical Ratings

+Vcc	7V
Inputs	Vcc + 0.5V Gnd – 0.3V
Outputs	Vcc, Gnd – 0.3V

##### Thermal Ratings

Max Junction Temperature	175°C	Chip to Amb.
Thermal Resistance: Chip to Case	40°C/Watt	120°C/Watt

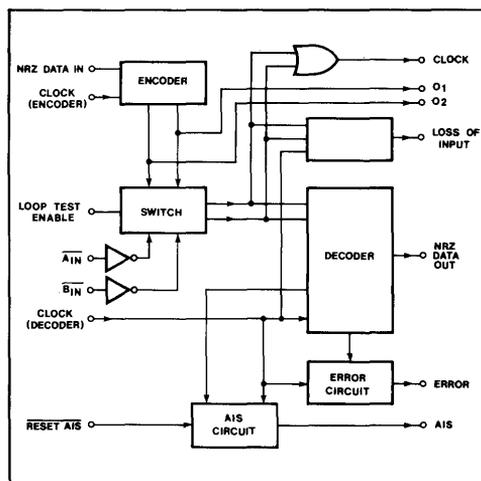


Fig. 2 Block diagram

# MJ1440

## ELECTRICAL CHARACTERISTICS

**Test conditions (unless otherwise stated):**

Supply voltage,  $V_{CC} = 5V \pm 0.25V$

Ambient temperature,  $T_{amb} = 0^{\circ}C$  to  $+70^{\circ}C$

### Static characteristics

Characteristic	Symbol	Pins	Value			Units	Conditions	
			Min	Typ	Max			
Low level input voltage	$V_{IL}$	1,2,5,6 10,11,12,13	-0.3		0.8	V	$V_{IL} = 0V$	
Low level input current	$I_{IL}$				50	$\mu A$		
High level input voltage	$V_{IH}$		2.5		$V_{CC}$	V		
High level input current	$I_{IH}$				50	$\mu A$		$V_{IH} = 5V$
Low level output voltage	$V_{OL}$		10,14,15		0.5	V		$I_{sink} = 80\mu A$
High level output voltage	$V_{OH}$	3,4,7,9	2.7	0.4	V	$I_{sink} = 1.6mA$		
		14,15				2.8	V	$I_{source} = 60\mu A$
Supply current	$I_{CC}$	10	2.8		V	$I_{source} = 2mA$		
				20	50	mA	$I_{source} = 1mA$ All inputs to 0V All outputs open circuit	

### Dynamic Characteristics

Characteristic	Symbol	Value			Units	Conditions
		Min	Typ	Max		
Max. Clock (Encoder) frequency	$f_{max_{enc}}$	4.0			MHz	Figs.10, 15
Max. Clock (Decoder) frequency	$f_{max_{dec}}$	2.2			MHz	Figs.11, 15
Propagation delay Clock (Encoder) to $O_1, O_2$	$tpd1A/B$			100	ns	Figs.10, 15. See Note 1
Rise and Fall times $O_1, O_2$				20	ns	Figs.10, 15
$tpd1A-tpd1B$				20	ns	Figs.10, 15
Propagation delay Clock (Encoder) to Clock	$tpd3$			150	ns	Loop test enable = Figs.13, 15
Setup time of NRZ data in to Clock (Encoder)	$ts3$	30			ns	Figs.8, 10, 15
Hold time of NRZ data in	$th3$	55			ns	Figs.10, 15
Propagation delay $A_{in}, B_{in}$ to Clock	$tpd2$			150	ns	Loop test enable = '0' Figs.9, 13, 15
Propagation delay Clock (Decoder) to loss of input				150	ns	
Propagation delay Clock (Decoder) to error	$tpd4$			200	ns	Figs.12, 15
Propagation delay $\overline{Reset AIS}$ to AIS	$tpd5$			200	ns	Loop test enable = '0' Figs.14, 15
Propagation delay Clock (Decoder) to NRZ data out	$tpd6$			150	ns	Figs.9, 11, 15. See Note 2
Setup time of $A_{in}, B_{in}$ to Clock (Decoder)	$ts1$	75			ns	Figs.9, 11, 15
Hold time of $A_{in}, B_{in}$ to Clock (Decoder)	$th1$	5			ns	Figs.9, 11, 15
Hold time of $\overline{Reset AIS} = '0'$	$th2$	100			ns	Figs.9, 14, 15
Setup time Clock (Decoder) to $\overline{Reset AIS}$	$ts2$	200			ns	Figs.9, 14, 15
Setup time $\overline{Reset AIS} = 1$ to Clock (Decoder)	$ts2$	0			ns	Figs.14, 15

### NOTES

1. Encoded HDB3 outputs ( $O_1, O_2$ ) are delayed by  $3\frac{1}{2}$  clock periods from NRZ data in (Fig.3).
2. The decoded NRZ output is delayed by 3 clock periods from the HDB3 inputs ( $A_{in}, B_{in}$ ) (Fig.4).

**FUNCTIONAL DESCRIPTION**

**Functions Listed by pin number**

**1. NRZ Data in**

Input data for encoding into ternary HDB3 form. The NRZ data is clocked by the negative edge of the Clock (Encoder).

**2. Clock (Encoder)**

Clock for encoding data on pin 1

**3. Loss of input alarm**

This output goes to logic '1' if eleven consecutive zeroes are detected in the incoming HDB3 data. The output is set to logic '0' on receipt of a '1'.

**4. NRZ data out**

Decoded data in NRZ form from ternary HDB3 input data ( $A_{in}, B_{in}$ ), data is clocked out by positive going edge of clock (Decoder).

**5. Clock (Decoder)**

Clock for decoding ternary data  $A_{in}, B_{in}$ .

**6, 7. Reset AIS, AIS**

Logic '0' on Reset AIS resets a decoded zero counter and either resets AIS outputs to zero provided 3 or more zeroes have been decoded in the preceding Reset AIS = 1 period or sets AIS to '1' if less than 3 zeroes have been decoded in the preceding two Reset AIS = 1 periods.

Logic '1' on Reset AIS enables the internal decoded zero counter.

**8. Ground**

Zero volts

**9. Error**

A logic '1' indicates that a violation of the HDB3 coding has been received i.e. 3 '1's of the same polarity.

**10. Clock**

'OR' function of  $\overline{A_{in}}, \overline{B_{in}}$  for clock regeneration when pin 12 = '0'. 'OR' function of  $O_1, O_2$  when pin 12 = '1'.

**11, 13.  $\overline{A_{in}}, \overline{B_{in}}$**

Inputs representing the received ternary HDB3 PCM signal.  $\overline{A_{in}}$  = '0' represents a positive going '1',  $\overline{B_{in}}$  = '0' represents a negative going '1'.  $\overline{A_{in}}$  and  $\overline{B_{in}}$  are sampled by the positive going edge of the Clock (Decoder).  $\overline{A_{in}}$  and  $\overline{B_{in}}$  may be interchanged.

**12. Loop test enable**

Input to select normal or loop back operation. Pin 12 = '0' selects normal operation, encode and decode are independent and asynchronous. When pin 12 = '1'  $O_1$  is connected internally to  $A_{in}$ ,  $O_2$  is connected internally to  $B_{in}$ . Clock becomes the OR function  $O_1 + O_2$ . The delay from NRZ in to NRZ out is 6½ clock periods in the loop back condition.

**14, 15.  $O_1, O_2$**

Outputs representing the ternary encoded data for line transmission  $O_1$  = '1' representing a positive going '1',  $O_2$  = '1' represents a negative going '1'.  $O_1$  and  $O_2$  may be interchanged.

**16.  $V_{cc}$**

Positive supply, 5V ± 5%

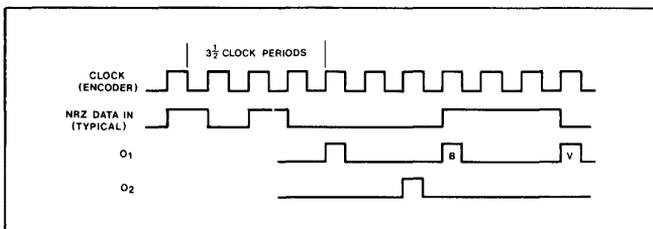


Fig. 3 Encode waveforms

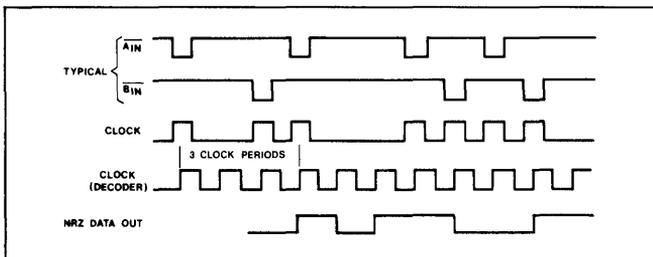


Fig. 4 Decode waveforms

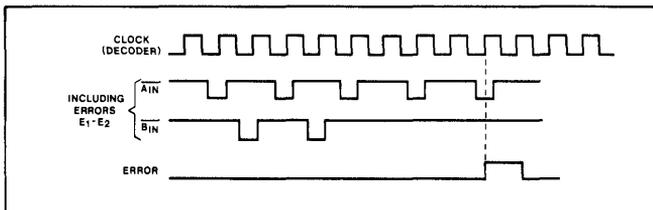


Fig. 5 HDB3 error output waveforms

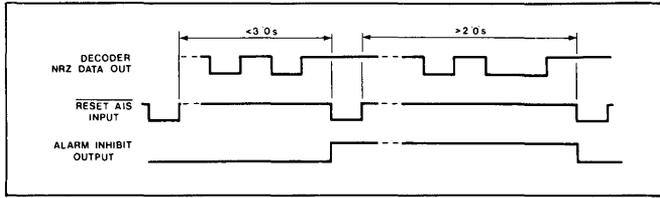


Fig. 6 AIS error and reset waveforms

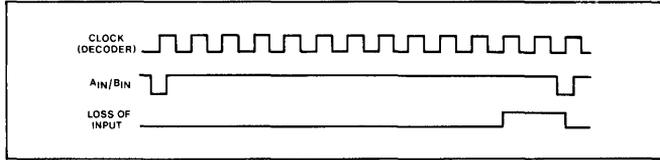


Fig. 7 Loss of input waveforms

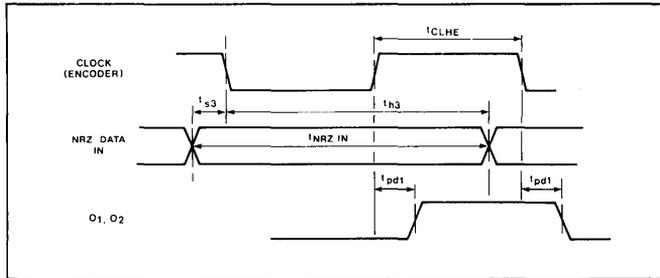


Fig. 8 Encoder timing relationship

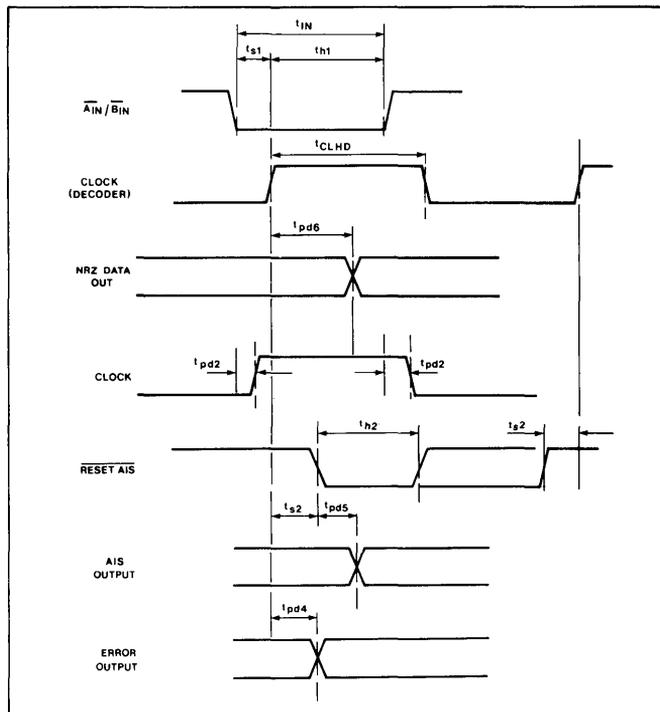


Fig. 9 Decoder timing relationship

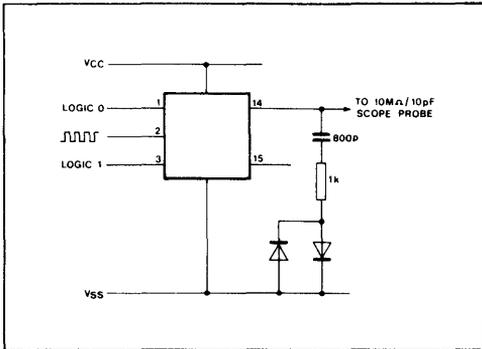


Fig. 10

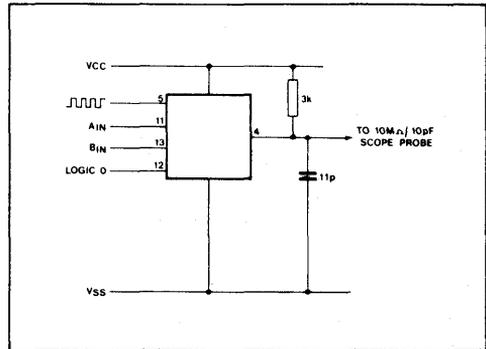


Fig. 11

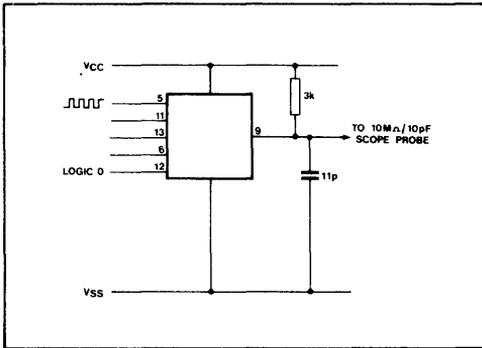


Fig. 12

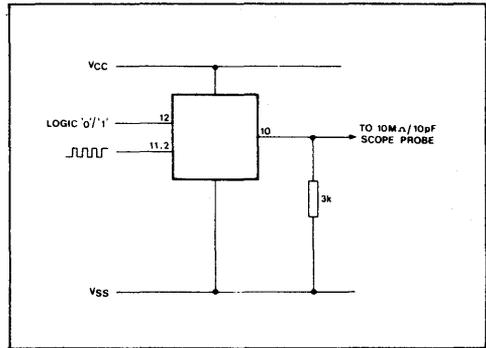


Fig. 13

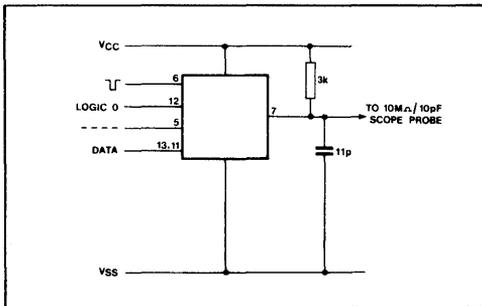


Fig. 14

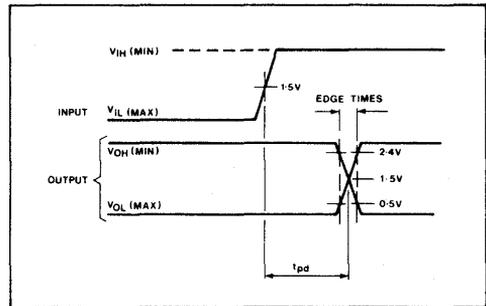


Fig. 15 Test timing definitions

**DEFINITION OF THE HDB3 CODE**

Coding of a binary signal into an HDB3 signal is done according to the following rules:

1. The HDB3 signal is pseudo-ternary; the three states are denoted B<sub>+</sub>, B<sub>-</sub> and O.
2. Spaces in the binary signal are coded as spaces in the HDB3 signal. For strings of four spaces however, special rules apply (see 4. below).
3. Marks in the binary signal are coded alternately as B<sub>+</sub> and B<sub>-</sub> in the HDB3 signal (alternate mark inversion). Violations of the rule of alternate mark inversion are introduced when coding strings of four spaces (see 4. below).
4. Strings of four spaces in the binary signal are coded according to the following rules:
  - a The first space of a string is coded as a space if the

preceding mark of the HDB3 signal has a polarity opposite to the polarity of the preceding violation and is not a violation by itself; it is coded as a mark, i.e. not a violation (i.e. B<sub>+</sub>, B<sub>-</sub>), if the preceding mark of the HDB3 signal has the same polarity as that of the preceding violation or is by itself a violation.

This rule ensures that successive violations are of alternative polarity so that no DC component is introduced.

b The second and third spaces of a string are always coded as spaces.

c The last space of a string of four is always coded as a mark, the polarity of which is such that it violates the rule of alternate mark inversion. Such violations are denoted V<sub>+</sub> or V<sub>-</sub> according to their polarity.





## 2 MBIT PCM SIGNALLING CIRCUIT

# MJ 1444

### PCM SYNCHRONISING WORD GENERATOR

The 2.048 Mbit PCM signalling circuits comprise a group of circuits which will perform the common signalling and error detection functions for a 2.048 Mbit 30 channel PCM transmission link operating to the appropriate CCITT recommendations. The circuits are fabricated in N-channel metal gate MOS and operate from a single 5 volt supply. Relevant inputs and outputs are TTL compatible.

The MJ1444 generates the synchronising word in accordance with CCITT recommendations G732. The MJ1445 has been designed to detect this synchronising word when received at the remote end of the transmission system.

The synchronising word is injected onto the PCM data highway during time slot 0 in alternate frames. The spare time slot 0 data bits, bit 1 in every frame and bits 3 to 8 inclusive in alternate frames (i.e. those not containing the synchronising word) are available as parallel inputs and are output onto the PCM data highway.

The data output of the MJ1444 is 'open collector' and can be wire-OR'd directly onto the highway.

The device also provides a time slot 0 channel pulse 'TS0', time slot 0 non-sync. frame 'TS0 SF', and time slot 16 'TS16' outputs.

#### FEATURES

- 5V ±5% Supply — 20mA Typical
- Fully Conforms to CCITT Recommendation G732
- Outputs Directly Onto PCM Data Highway
- Provides Both Time Slot 0 and Time Slot 16 Channel Pulses
- All Inputs and Outputs are TTL Compatible

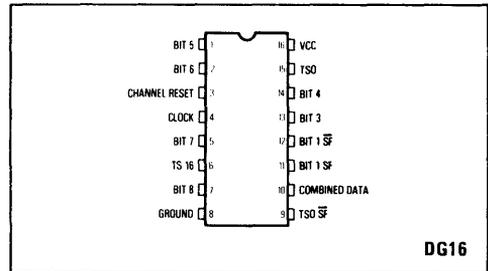


Fig.1 Pin connections

#### ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

#### Electrical Ratings

+Vcc	7V
Inputs	Vcc + 0.5V Gnd - 0.3V
Outputs	Vcc, Gnd - 0.3V

#### Thermal Ratings

Max Junction Temperature	175°C	
Thermal Resistance: Chip to Case	35°C/Watt	Chip to Amb.
		120°C/Watt

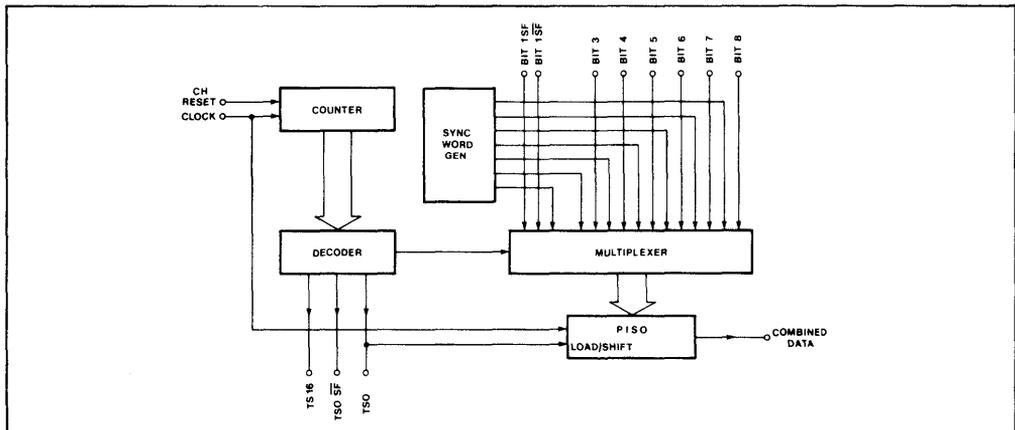


Fig.2 MJ1444 block diagram

**ELECTRICAL CHARACTERISTICS**

**Test conditions (unless otherwise stated):**  
 Supply voltage,  $V_{CC} = 5V \pm 0.25V$   
 Ambient operating temperature  $-10^{\circ}C$  to  $+70^{\circ}C$

**Static Characteristics**

Characteristic	Symbol	Pins	Value			Units	Conditions
			Min.	Typ.	Max.		
Low level input voltage	$V_{IL}$	1, 2, 3, 4, 5, 7, 11, 12, 13, 14.	-0.3		0.8	V	
Low level input current } High level input current }	$I_{IN}$	11		1	50	$\mu A$	
High level input voltage	$V_{IH}$	11	2.4		$V_{CC}$	V	
Low level output voltage	$V_{OL}$	6, 9, 15 10			0.5 0.7	V	$I_{sink} = 2mA$ $I_{sink} = 5mA$
High level output voltage	$V_{OH}$	6, 9, 15	2.8			V	$I_{source} = 200\mu A$
High level output leakage current	$I_{OH}$	10			20	$\mu A$	$V_{OUT} = V_{CC}$
Supply current	$I_{CC}$			20	40	mA	$V_{CC} = 5.25V$

**Dynamic Characteristics**

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Max clock frequency	$F_{max}$	3			MHz	
Propagation delay, clock to $TS0$ , $TS0 \overline{SF}$ , $TS16$ and combined data outputs.	$t_p$	80		200	ns	See Figs.5 and 6
Set up time channel reset to clock	$T_{S1}$	100		450	ns	$f_{clock} = 2.048MHz$
Hold time of channel reset input	$t_{H1}$	20		400	ns	
Set up time of bit 1 (SF) to datum B	$t_{S2}$	100			ns	
Hold time of bit 1 (SF) wrt datum B	$t_{H2}$	300			ns	
Set up time of bit 1 ( $\overline{SF}$ ) and data bits 3—8 to datum B	$t_{S2}$	100			ns	
Hold time of bit 1 ( $\overline{SF}$ ) and data bits 3—8 wrt datum B	$t_{H2}$	300			ns	

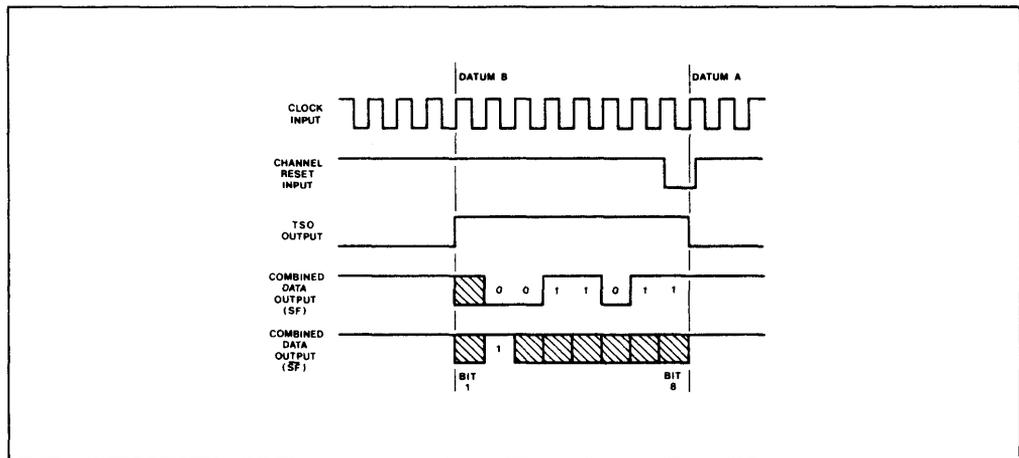


Fig.3 Data timing

**FUNCTIONAL DESCRIPTION**

**Functions Listed by pin number**

**1, 2, 5, 7, 13, 14. Bits 3 to 8**

Parallel data on these inputs is asynchronously loaded into bits 3 to 8 of the PISO shift register for transmission during Time slot 0 of non-sync. frames.

**3. Channel Reset**

A low going pulse at this input synchronises the MJ1444 with the other devices at the transmit end of the PCM link. It may be applied as a start pulse or repeated at the same instant in successive frames.

**4. Clock**

System clock input (2.048MHz for a 2 Mbit PCM system).

**6. TS16**

This output provides a positive pulse equivalent to 8 clock periods during time slot 16 of every 30 + 2 channel PCM frame.

**8. GND**

Zero volts.

**9. TS0 SF**

This output provides a positive pulse equivalent to 8 clock periods during time slot 0 of non-sync. frames.

**10. Combined data**

This 'open collector' output injects the contents of the PISO shift register onto the PCM data highway during time slot 0 in successive frames. The contents of the PISO shift register are defined as follows:

	Bit 1	2	3	4	5	6	7	8
Sync. Frame	X	0	0	1	1	0	1	1
Non-sync. frame	X	1	X	X	X	X	X	X

X — indicates that these bits may be set according to the parallel data inputs.

**11. Bit 1 SF**

Data on this input is asynchronously loaded into bit 1 of the PISO shift register for transmission during time slot 0 of sync. frames.

**12. Bit 1 SF**

Data on this input is asynchronously loaded into bit 1 of the PISO shift register for transmission during time slot 0 of non-sync. frames.

**15. TS0**

This output provides a positive pulse equivalent to 8 clock period during time slot 0 of every 30 channel PCM frame.

**16. V<sub>cc</sub>**

Positive supply, 5V ± 5%.

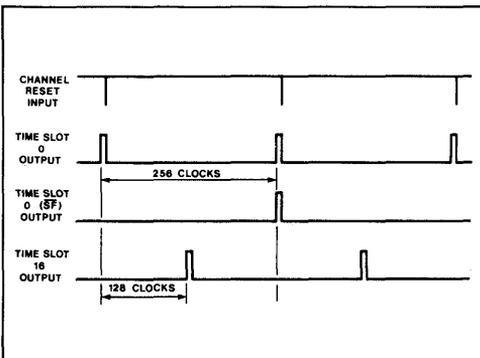


Fig.4 Sync. timing

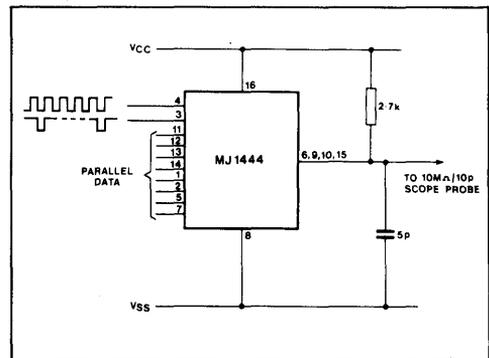


Fig.5 Test conditions (all outputs)

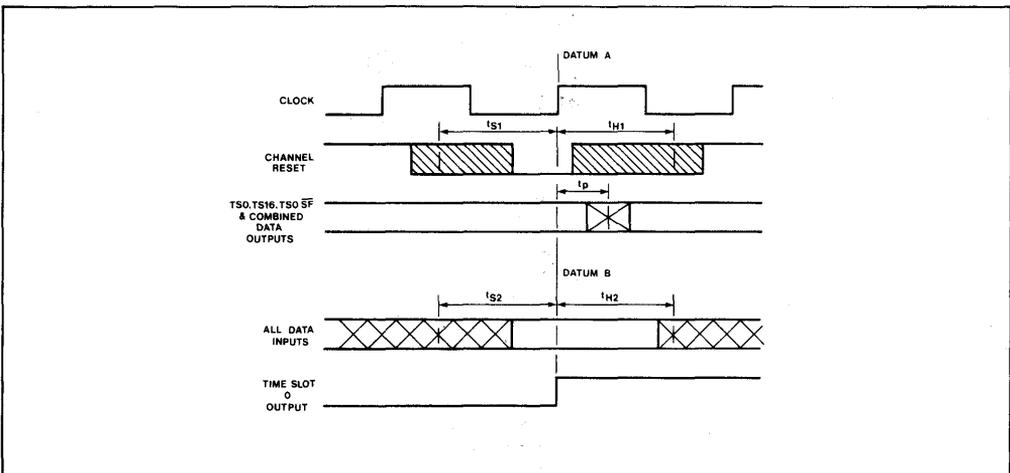


Fig.6 Timing definitions

**MJ1444**

PCM SYNCHRONISING WORD RECEIVER

# MJ1445

2 MBIT PCM SIGNALLING CIRCUIT

The 2.048 Mbit PCM signalling circuits comprise a group of circuits which will perform the common signalling and error detection functions for a 2.048 MBit 30 channel PCM transmission link operating to the appropriate CCITT recommendations. The circuits are fabricated in N-channel metal gate MOS and operate from a single 5volt supply. Relevant inputs and outputs are TTL compatible.

The MJ1445 establishes synchronisation by detecting the synchronising word when it is received at the remote end of the transmission system. The MJ1444 has been designed to generate this synchronisation word at the sending end of the system in accordance with CCITT recommendation G732.

Corruption of individual synchronisation words is signified by an 'Error' output, loss of synchronisation is indicated by a 'Sync Alarm' output and follows CCITT G732 in that loss of synchronism is assumed when 3 consecutive synchronisation words have been received with errors.

The 'Channel Reset' output goes low for the first period of the clock after time slot 0 in sync frames whenever the MJ1445 has established that the receiver terminal is in synchronisation in order that the rest of the receiver terminal may be reset.

The 'TSO' output is high for a period of 8 bits starting from the end of the first bit of the synchronising word. The spare data bits from the synchronising word are provided as parallel outputs.

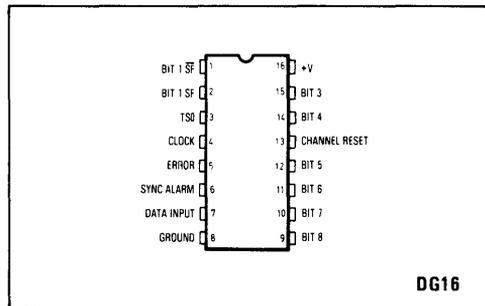


Fig.1 Pin connections

FEATURES

- 5V ± 5% Supply – 20mA Typical.
- Conforms to CCITT Recommendation G732
- Synchronising Word Error Monitor
- Out of Sync. Alarm
- All Inputs and Outputs are TTL Compatible

ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

Electrical Ratings

+Vcc	7V
Inputs	Vcc + 0.5V Gnd – 0.3V
Outputs	Vcc, Gnd – 0.3V

Thermal Ratings

Max Junction Temperature	175°C
Thermal Resistance: Chip to Case	35°C/Watt
Chip to Amb.	120°C/Watt

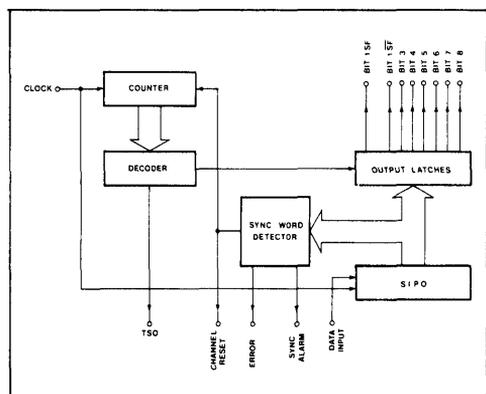


Fig.2 Block diagram MJ1445

# MJ1445

## ELECTRICAL CHARACTERISTICS

**Test conditions (unless otherwise stated):**  
 Supply voltage,  $V_{CC} = 5V \pm 0.25V$   
 Ambient temperature,  $T_{amb} = -10^{\circ}C$  to  $+70^{\circ}C$

### Static Characteristics

Characteristic	Symbol	Pins	Value			Units	Conditions
			Min.	Typ.	Max.		
Low level input voltage	$V_{IL}$	4, 7	-0.3		0.8	V	
Low level input current	$I_{IN}$	4, 7		1	50	$\mu A$	
High level input current							
High level input voltage	$V_{IH}$	4, 7	2.4		$V_{CC}$	V	
Low level output voltage	$V_{OL}$	1, 2, 3, 5, 6 9, 10, 11, 12 13, 14, 15			0.5	V	$I_{sink} = 2mA$
High level output voltage	$V_{OH}$		2.8			mA	$I_{source} = 200\mu A$
Supply current	$I_{CC}$			20	40	mA	$V_{CC} = 5.25V$

### Dynamic Characteristics

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Max. clock frequency	$f_{max}$	2.2			MHz	
Input delay of data input	$t_{d\ data}$	20		200	ns	$f_{clock} = 2.048MHz$
Propagation delay, clock to TS0 output	$t_{d\ TS0}$	40		200	ns	Fig.3
Propagation delay clock to error output, sync alarm and CH. Reset output high	$t_d$	50		400	ns	Fig.3
Propagation delay, clock to CH. Reset output low ( $T - t_p$ )	$t_p$	100		450	ns	Fig.3
Propagation delay clock to spare bits	$t_{d\ SB}$	50		300	ns	Fig.3

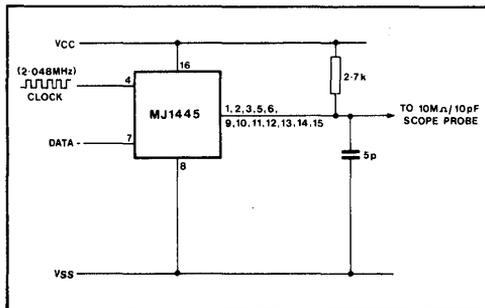


Fig.3 Test conditions, all outputs

## FUNCTIONAL DESCRIPTION

### Functions listed by pin number

#### 1. Bit 1 SF

This output is set to the level of data bit 1 during time slot 0 of non sync frames. The data becomes true on the first falling edge of the clock during TS1.

#### 2. Bit 1 SF

This output is set to the level of data bit 1 during time slot 0 of sync frames. The data becomes true on the first falling edge of the clock during TS1.

#### 3. TS0

This output provides a positive pulse of 8 clock periods in every frame starting from the end of the first bit of the synchronising word of the received data.

#### 4. Clock

System clock input (2.048MHz for a 2MBit PCM system).

#### 5. Error

This output goes high at the end of time slot 0 in the 2nd sync frame following the frame with sync word errors. If consecutive sync words occur with errors this output will remain high. If a sync alarm is generated this output will remain high until sync is regained.

#### 6. Sync Alarm

This output goes high at the end of time slot 0 output in the 3rd consecutive sync frame containing sync word errors. It returns low at the end of TS0 output in the 3rd consecutive frame received correctly (sync and non sync).

#### 7. Data Input

Serial data (2MBit/s) at this input is clocked through the SIPO shift register and examined by the sync word detector.

#### 8. GND

Zero volts

#### 9, 10, 11, 12, 14, 15. Bits 3 to 8

These parallel outputs are set to the level of the spare data bits (3 to 8) of time slot 0 of non sync frames. The data becomes true on the first falling edge of the clock during TS1.

#### 13. Channel reset

This output goes low for the first period of the clock after time slot 0 of the received data as long as synchronisation has been established. This pulse can be used to reset the rest of the receiver terminal.

#### 16. $V_{CC}$

Positive supply  $5V \pm 5\%$ .

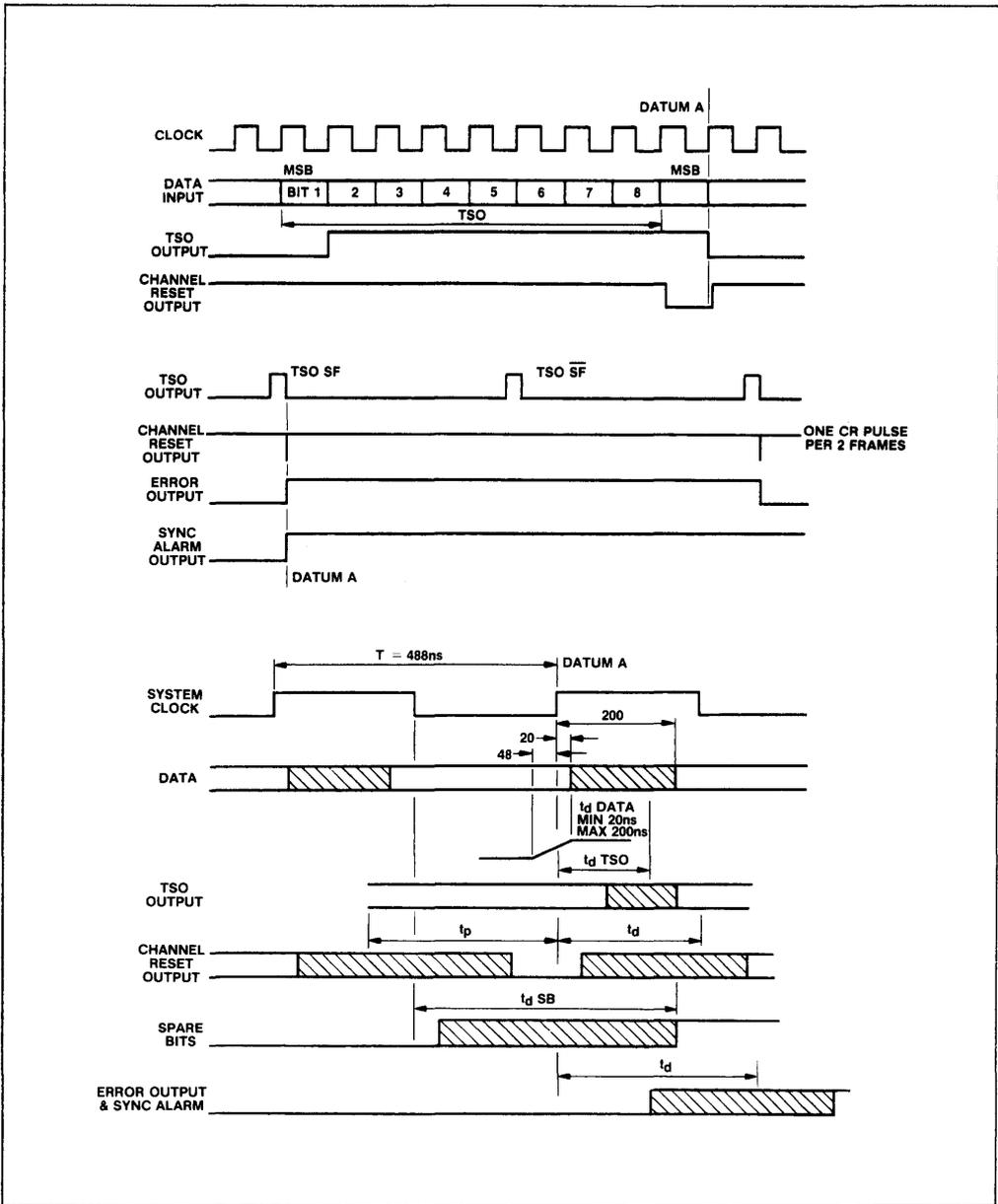


Fig.4 Timing diagram and output waveforms





## 2 MBIT PCM SIGNALLING CIRCUIT MJ1446 TIME SLOT 16 RECEIVER AND TRANSMITTER

The 2.048 Mbit PCM signalling circuits comprise a group of circuits which will perform the common signalling and error detection functions for a 2.048 Mbit 30 channel PCM transmission link operating to the appropriate CCITT recommendations. The circuits are fabricated in N-channel metal gate MOS and operate from a single 5volt supply. Relevant inputs and outputs are TTL compatible.

The MJ1446 has two modes of operation dependent on the state of the mode control input. With the mode control high the device is in the transmit mode and with the mode control low the device is in the receive mode.

In the transmit mode the device accepts 64kbits/sec signalling information in either binary or AMI format and outputs it at 2Mbits/sec on to the digital highway during time slot 16.

In the receive mode the device accepts 2Mbit/sec information from the digital highway, during time slot 16 and output is at 64kbits/sec in both binary and AMI format.

In both receive and transmit mode there is an AMI coded clock output, AMI output and  $\overline{\text{AMI}}$  output which conforms to CCITT recommendation no G372 for a 64kbits/sec contradirectional interface. The alarm inhibit input causes the 8kHz timing signal to be removed from the AMI clock output.

The device is reset in both modes by a time slot 16 channel pulse and the alarm output provides an indication that the internal counter is operating correctly.

Also provided are 64kHz, 16kHz and 8kHz clock outputs.

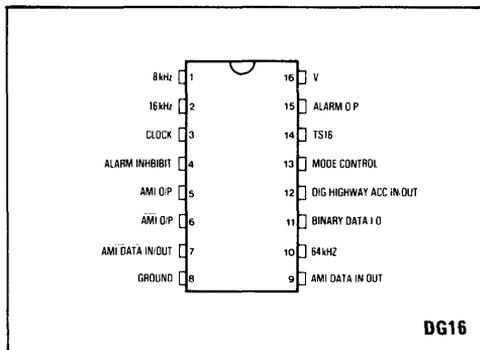


Fig.1 Pin connections

### FEATURES

- 5V ± 5% Supply — 20mA Typical
- Conforms to CCITT Recommendations
- Provides Both AMI and Binary Format Data Outputs
- Single Chip Receive or Transmit
- All Inputs and Outputs are TTL Compatible.

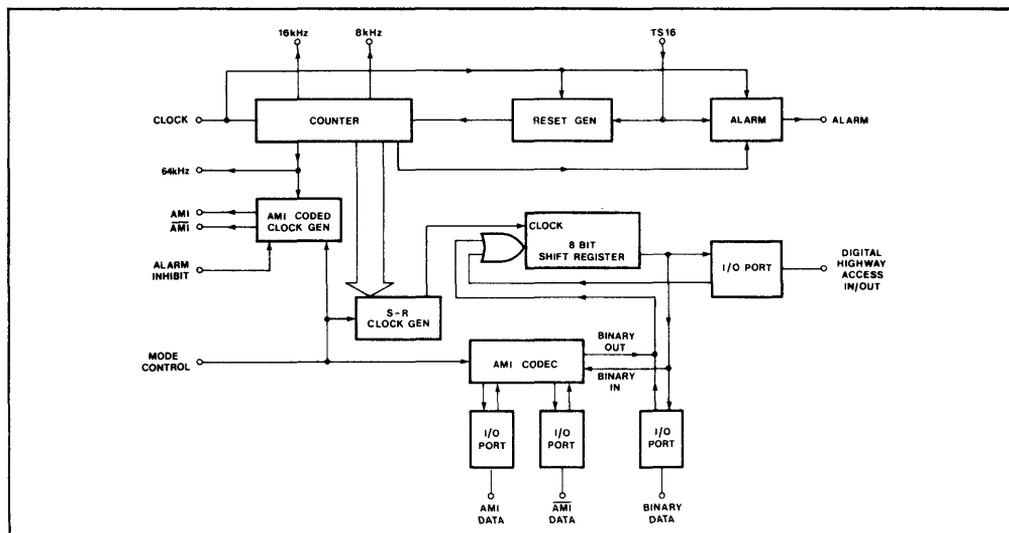


Fig.2 Block diagram

# MJ1446

## ELECTRICAL CHARACTERISTICS

### Test conditions (unless otherwise stated):

Supply voltage  $V_{CC} = 5V \pm 0.25V$

Ambient temperature  $T_{amb} = -10^{\circ}C$  to  $+70^{\circ}C$

### Static Characteristics

Characteristic	Symbol	Pins	Value			Units	Conditions
			Min.	Typ.	Max.		
Low level input voltage	$V_{IL}$	3, 4, 7, 9, 11, 12, 13, 14	-0.3		0.8	V	
Low level input current	$I_{IN}$	11		1	50	$\mu A$	
High level input current							
High level input voltage	$V_{IH}$	11	2.4		$V_{CC}$	V	
Low level output	$V_{OL}$	1, 2, 5, 6, 7, 9, 10, 11, 15			0.5	V	$I_{sink} = 2mA$
		12			0.5	V	$I_{sink} = 5mA$
High level output voltage	$V_{OH}$	1, 2, 10, 5, 6, 15	2.8			V	$I_{source} = 200\mu A$
High level output leakage current	$I_{CH}$	7, 9, 11, 12			20	$\mu A$	$V_{OUT} = V_{CC}$
Supply current	$I_{CC}$			20		mA	$V_{CC} = 5.25V$

### Dynamic Characteristics ( $f_{clock} = 2.048 MHz$ )

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Propagation delay clock to data out to digital highway	$t_p$	20		200	ns	Fig.7
Propagation delay clock to 64 kHz out	$t_p$	20		200	ns	Fig.7
Input delay, clock to digital highway access	$t_d DATA$	20		200	ns	
Input delay, clock to time slot 16	$t_d TS16$	80		200	ns	
Output delay 64 kHz to 16 kHz output	$t_p 16$			70	ns	Fig.7
Output delay, 64 kHz to 8 kHz output	$t_p 8$			170	ns	Fig.7
Output delay, 64 kHz to binary data output (64 kHz)	$t_p BIN$	20		450	ns	Fig.8
Output delay 64 kHz to AMI, $\overline{AMI}$ , AMI data & $\overline{AMI}$ data o/p's	$t_p AMI$	20		400	ns	Fig.8
Input delay, 64 kHz to binary data in (64 kHz)	$t_d BIN$			100	ns	

## FUNCTIONAL DESCRIPTION

### Functions listed by pin number

- 1. 8 kHz**  
8 kHz square wave output.
- 2. 16 kHz**  
16 kHz square wave output.
- 3. Clock**  
System clock input (2.048 MHz for a 2 Mbit PCM system)
- 4. Alarm inhibit**  
A high level on this input inhibits the 8 kHz timing signal on the AMI clock outputs.
- 5. AMI output**  
Alternative Mark Inversion coded 64 kHz.
- 6.  $\overline{AMI}$  output**
- 7. AMI Data in/out**  
In the transmit mode 64 kHz signalling data in AMI format is accepted at these inputs for output to PCM highway during time slot 16.
- 8. GND**  
Zero volts.
- 9. AMI Data in/out**  
In the receive mode data accepted from the PCM highway during time slot 16 appears on these outputs at 64 kbits/sec in AMI format.
- 10. 64 kHz**  
64 kHz square wave output.

### 11. Binary data in/out

In the transmit mode 64 k bit/sec signalling data in binary form is accepted at this input for output to the PCM data highway during time slot 16. In the receive mode data is accepted from the PCM highway during TS16 and appears at this output at 64 k bits/sec in binary format.

### 12. Digital Highway access in/out

In the receive mode 2 Mbit/sec signalling data is accepted at this input during time slot 16 from the PCM digital highway. In the transmit mode signalling data is output to the PCM digital highway during time slot 16 at 2 Mbits/sec.

### 13. Mode control

A high level on this input causes the MJ1446 to operate in the transmit mode while a low level causes it to operate in the receive mode.

### 14. TS16

This input should be connected to time slot 16 channel pulse of the PCM system to synchronise the MJ1446 with the rest of the system.

### 15. Alarm output

A high level on this output indicates that the internal counter has stopped or is out of synchronisation with the time slot 16 channel pulse.

### 16 $V_{CC}$

Positive supply  $5V \pm 5\%$ .

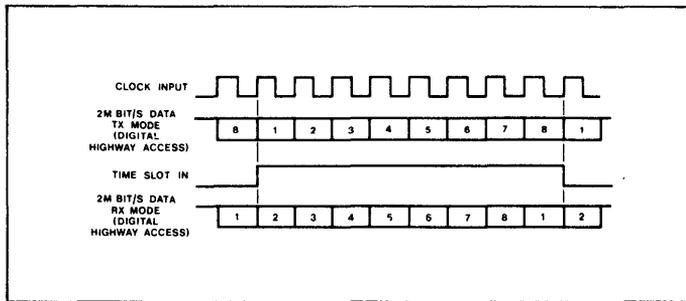


Fig.3 2MBit/s operation

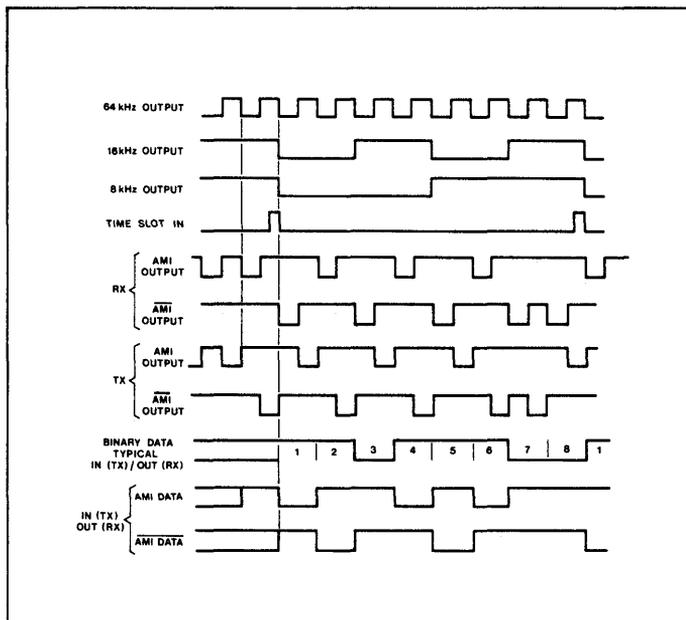


Fig.4 64kBit/s operation

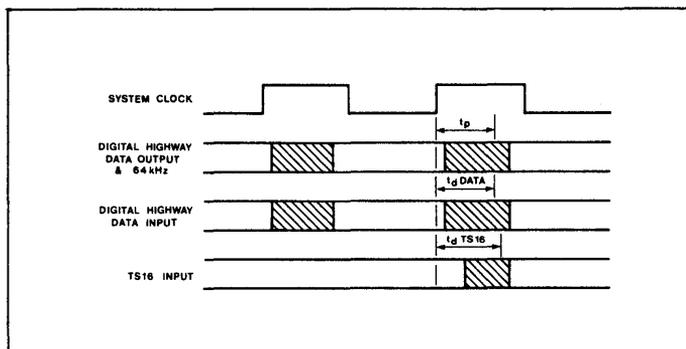


Fig.5 Timing diagram

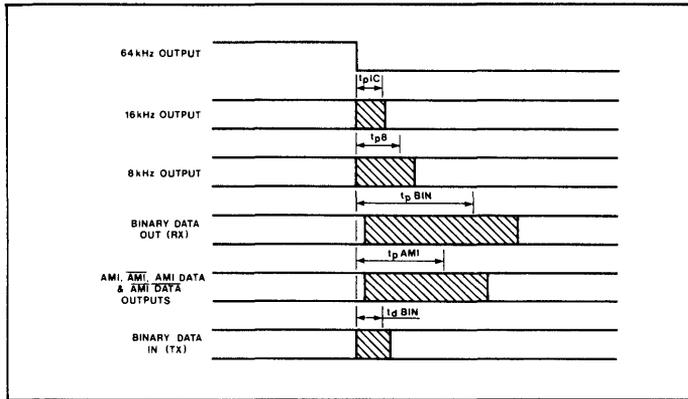


Fig.6 Timing diagram

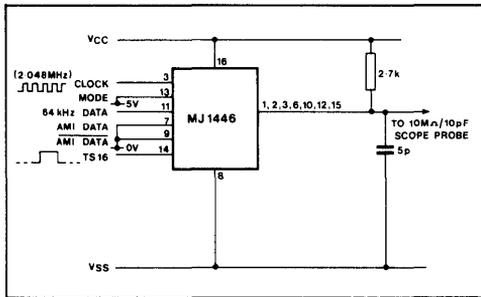


Fig.7 Test conditions (transmit mode)

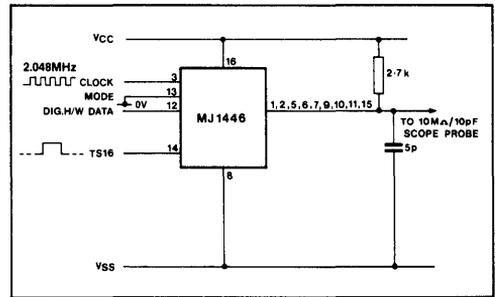


Fig.8 Test conditions (receive mode)

## 2 MBIT PCM SIGNALLING CIRCUIT

# MJ1471

### HDB3 OR AMI ENCODER/DECODER

The MJ1471 is an encoder/decoder for pseudo-ternary transmission codes. The codes are true Alternate Mark Inversion (AMI) or AMI modified according to HDB3 rules (CCITT Orange Book Vol 111-2, Annex to Rec.G703). The device encodes and decodes simultaneously and asynchronously. Error monitoring functions are provided to detect violations of HDB3 coding and all ones detection (AIS). In addition a loop test function is provided for terminal testing.

#### FUNCTIONS

- 5V  $\pm$  5% Supply — 40mA Max.
- AMI or HDB3 Operation — TTL Selectable
- Loop Back Facility
- 'All Ones' Error Monitor to Detect Loss of Synchronising Word (Time Slot Zero)
- Error Monitor of HDB3 Incoming Code
- Decoded Data in NRZ Form

#### FUNCTIONAL DESCRIPTION

##### Functions listed by pin number

##### 1. NRZ data in

Input data for encoding into ternary form. The data is clocked by the negative-going edge of the Clock (Encoder).

##### 2. Clock (Encoder)

Clock for encoding data on pin 1.

##### 3. AMI/HDB3

MJ1471 operates in HDB3 if pin 3 is at logic '1'. AMI if pin 3 is at logic '0'.

##### 4. NRZ Data out

Decoded data from ternary inputs  $A_{in}$ ,  $B_{in}$ .

##### 5. Clock (Decoder)

Clock for decoding ternary data  $A_{in}$ ,  $B_{in}$ .

##### 6, 7. Reset AIS, AIS

Logic '0' on Reset AIS resets a decoded zero counter and either resets AIS outputs to zero provided 3 or more zeroes have been decoded in the preceding Reset AIS = 1 period or sets AIS to '1' if less than 3 zeroes have been decoded in the preceding two Reset AIS = 1 periods.

Logic '1' on Reset AIS enables the internal decoded zero counter.

##### 8. Ground

Zero volts.

##### 9. Error

A logic '1' indicates that a violation of the HDB3 encoding law has been decoded i.e. 3 '1's of the same polarity.

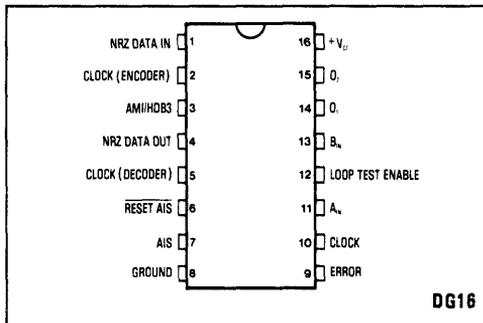


Fig.1 Pin connections

##### 10. Clock

OR function of  $A_{in}$ ,  $B_{in}$  for clock regeneration when pin 12 = '0', OR function of  $O_1$ ,  $O_2$  when pin 12 = '1'.

##### 11, 13. $A_{in}$ , $B_{in}$

Inputs representing the received ternary PCM signal.  $A_{in}$  = '1' represents a positive going '1',  $B_{in}$  = '1' represents a negative going '1'.  $A_{in}$  and  $B_{in}$  are sampled by the positive going edge of the clock decoder.  $A_{in}$  and  $B_{in}$  may be interchanged.

##### 12. Loop test enable

TTL input to select normal or loop back operation. Pin 12 = '0' selects normal operation, encode and decode are independent and asynchronous.

When pin 12 = '1'  $O_1$  is connected internally to  $A_{in}$  and  $O_2$  to  $B_{in}$ . Clock becomes the OR function of  $O_1$ ,  $O_2$ . N.B. a decode clock has to be supplied. The delay from NRZ in to NRZ out is  $7\frac{1}{2}$  clock periods in loop back.

##### 14, 15, $O_1$ , $O_2$

Outputs representing the ternary encoded PCM AMI/HDB3 signal for line transmission.  $O_1$  and  $O_2$  are in Return to zero form and are clocked out on the positive going edge of the encode clock. The length of  $O_1$  and  $O_2$  pulses is set by the positive clock pulse length.

##### 16. +Vcc

Positive 5V  $\pm$  5% supply.

**ELECTRICAL CHARACTERISTICS**

**Test conditions (unless otherwise stated):**

Supply voltage  $V_{CC} = 5V \pm 0.25V$

Ambient temperature  $T_{amb} = 0^{\circ}C$  to  $+70^{\circ}C$

**Static Characteristics**

Characteristic	Symbol	Pins	Value			Units	Conditions
			Min	Typ	Max		
Low level input voltage	$V_{IL}$	1,2,3,5,6 10,11,12,13	-0.3		0.8	volts	$V_{IL} = 0V$
Low level input current	$I_{IL}$				50	$\mu A$	
High level input voltage	$V_{IH}$		2.5		$V_{CC}$	V	
High level input current	$I_{IH}$			50	$\mu A$	$V_{IH} = 5V$	
Low level output voltage	$V_{OL}$	10,14,15 4,7,9			0.5	V	$I_{sink} = 800\mu A$ $I_{sink} = 1.6mA$
					0.4	V	
High level output voltage	$V_{OH}$	4,7,9 14,15 10	2.7			V	$I_{source} = 60\mu A$ $I_{source} = 2mA$ $I_{source} = 1mA$
			2.8			V	
			2.8			V	
Supply current	$I_{CC}$			20	40	mA	All inputs to 0v All outputs open circuit

**Dynamic Characteristics**

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Max. Clock (Encoder) frequency	$f_{max_{enc}}$	4.0			MHz	Figs.9, 14
Max. Clock (Decoder) frequency	$f_{max_{dec}}$	2.2			MHz	Figs.10, 14
Propagation delay Clock (Encoder) to $O_1, O_2$	$tpd1A/B$			100	ns	Figs.8, 9, 14. See Note 1
Rise and Fall times $O_1, O_2$				20	ns	Figs.9, 14
$tpd1A-tpd1B$				20	ns	Figs.9, 14
Propagation delay Clock (Encoder) to Clock	$tpd3$			150	ns	Loop test enable = 1, Figs.9, 14
Setup time of NRZ data in to Clock (Encoder)	$ts3$	30			ns	Figs.7, 9, 14
Hold time of NRZ data in	$th3$	55			ns	Figs.7, 9, 14
Propagation delay $A_{in}, B_{in}$ to Clock	$tpd2$			150	ns	Loop test enable = '0' Figs.12, 14
Propagation delay Clock (Decoder) to error	$tpd4$			200	ns	Figs.11, 14
Propagation delay $\overline{Reset AIS}$ to AIS	$tpd5$			200	ns	Loop test enable = '0' Figs.13, 14
Propagation delay Clock (Decoder) to NRZ data out	$tpd6$			150	ns	Figs.7, 10, 14. See Note 2
Setup time of $A_{in}, B_{in}$ to Clock (Decoder)	$ts1$	75			ns	Figs.7, 10, 14
Hold time of $A_{in}, B_{in}$ to Clock (Decoder)	$th1$	5			ns	Figs.7, 10, 14
Hold time of $\overline{Reset AIS} = '0'$	$th2$	100			ns	Figs.7, 13, 14
Setup time Clock (Decoder) to $\overline{Reset AIS}$	$ts2$	200			ns	Figs.7, 13, 14
Setup time $\overline{Reset AIS} = 1$ to Clock (Decoder)	$ts2'$	0			ns	Figs.13, 14

**NOTES**

1. The Encoded ternary outputs ( $O_1, O_2$ ) are delayed by 3/2 clock periods from NRZ data in (Fig.3).
2. The decoded NRZ output is delayed by 3 clock periods from the HDB3 inputs ( $A_{in}, B_{in}$ ) (Fig.4).

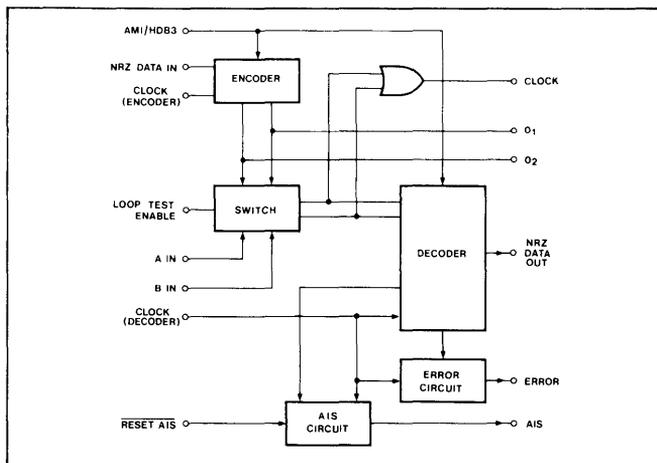


Fig. 2 MJ1471 Block diagram

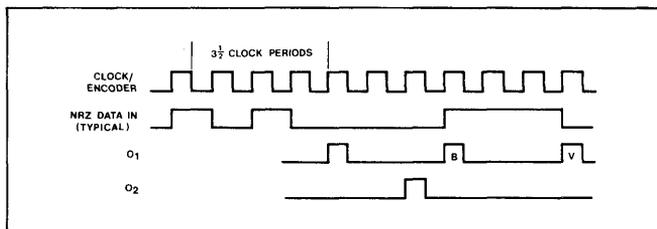


Fig. 3 Encode waveforms

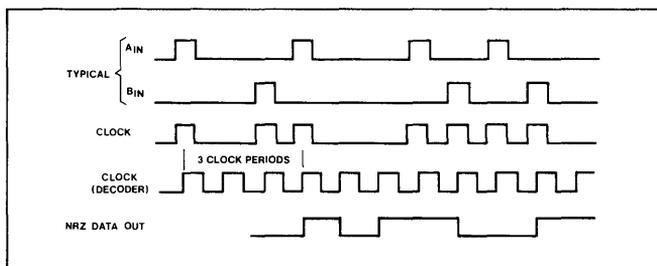


Fig. 4 Decode waveforms

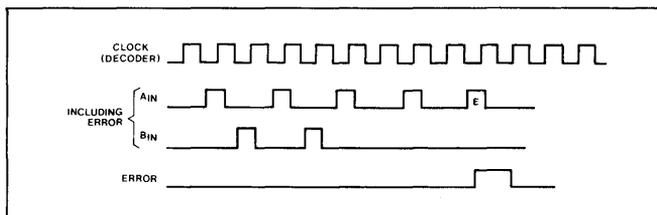


Fig. 5 HDB3 error output waveforms

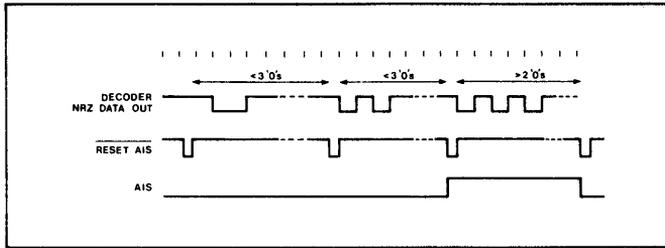


Fig.6 A/S error and reset waveforms

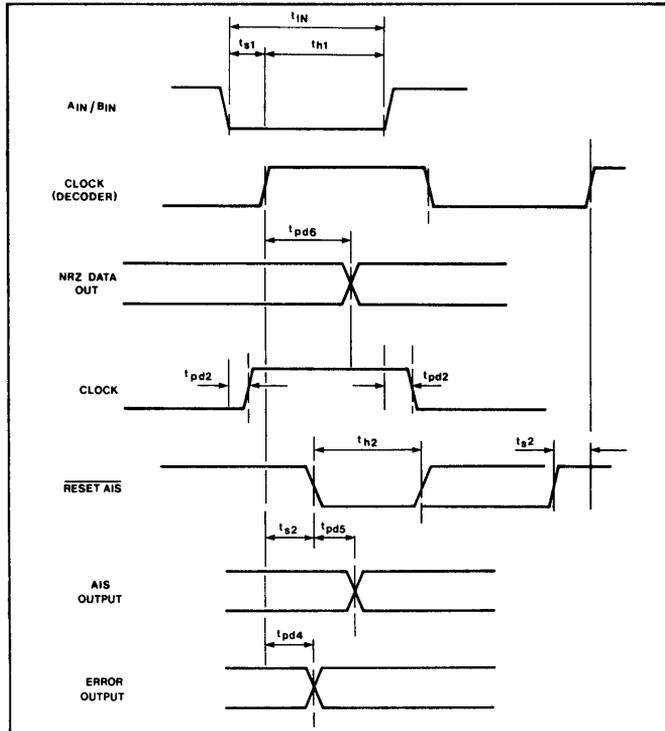


Fig. 7 Decoder timing relationship

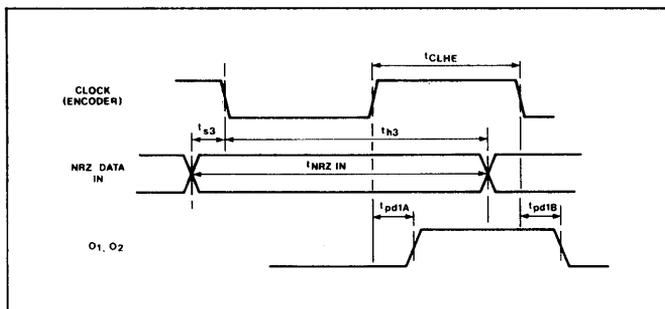


Fig. 8 Encoder timing relationship

**DEFINITION OF THE HDB3 CODE**

Coding of a binary signal into an HDB3 signal is done according to the following rules:

1. The HDB3 signal is pseudo-ternary; the three states are denoted B<sub>+</sub>, B<sub>-</sub> and O.
2. Spaces in the binary signal are coded as spaces in the HDB3 signal. For strings of four spaces however, special rules apply (see 4. below).
3. Marks in the binary signal are coded alternately as B<sub>+</sub> and B<sub>-</sub> in the HDB3 signal (alternate mark inversion). Violations of the rule of alternate mark inversion are introduced when coding strings of four spaces (see 4. below).
4. Strings of four spaces in the binary signal are coded according to the following rules:

- a The first space of a string is coded as a space if the preceding mark of the HDB3 signal has a polarity opposite to the polarity of the preceding violation and is not a violation by itself; it is coded as a mark, i.e. not a violation (i.e. B<sub>+</sub>, B<sub>-</sub>), if the preceding mark of the HDB3 signal has the same polarity as that of the preceding violation or is by itself a violation.  
This rule ensures that successive violations are of alternative polarity so that no DC component is introduced.
- b The second and third spaces of a string are always coded as spaces.

- c The last space of a string of four is always coded as a mark, the polarity of which is such that it violates the rule of alternate mark inversion. Such violations are denoted V<sub>+</sub> or V<sub>-</sub> according to their polarity.

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**ABSOLUTE MAXIMUM RATINGS**

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

**Electrical Ratings**

+Vcc	7V
Inputs	Vcc + 0.5V Gnd - 0.3V
Outputs	Vcc, Gnd - 0.3V

**Thermal Ratings**

Max Junction Temperature	175°C
Thermal Resistance: Chip to Case	40°C/Watt
Chip to Amb.	120°C/Watt

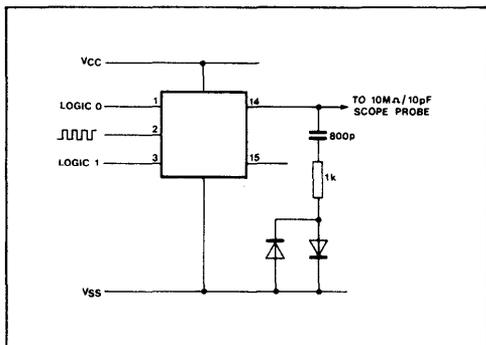


Fig. 9

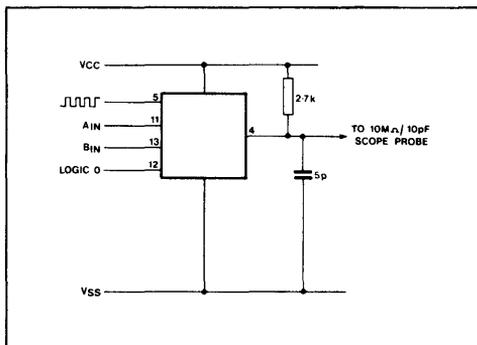


Fig. 10

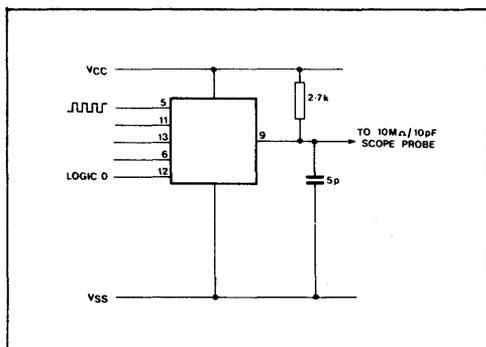


Fig. 11

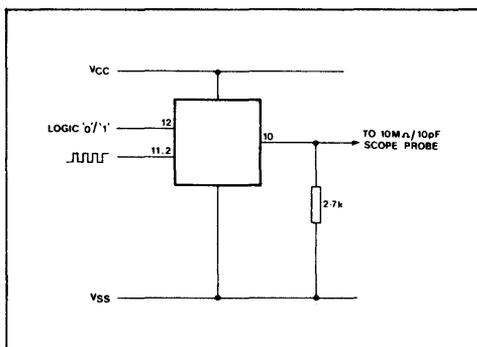


Fig. 12

# MJ1471

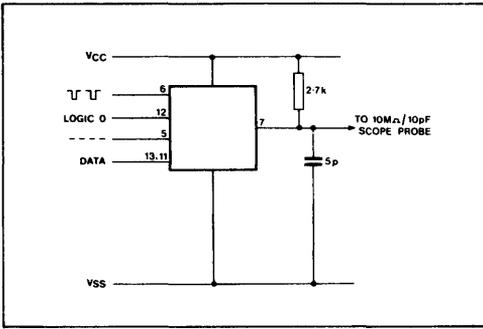


Fig. 13

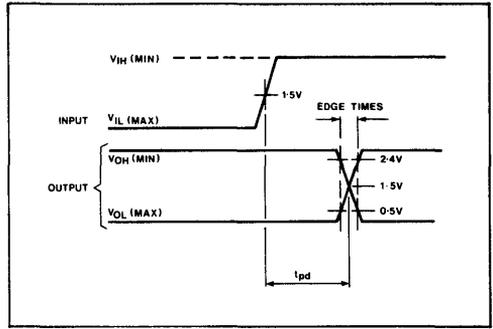


Fig. 14 Test timing definitions

Advance information is issued to advise Customers of new additions to the Plessey Semiconductors range which, nevertheless, still have 'pre-production' status. Details given may, therefore, change without notice although we would expect this performance data to be representative of 'full production' status product in most cases. Please contact your local Plessey Semiconductors Sales Office for details of current status.

# MJ1472

## PCM RECEIVING CIRCUIT

The MJ1471/1742/1473 circuits have been designed specifically for use in 30 channel PCM systems. All circuits conform to the appropriate CCITT recommendations. The range of circuits is realised in N-channel MOS technology. They all operate from a single 5V supply and all inputs and outputs are TTL compatible. Operating speed of 2.048MHz is guaranteed over 0°C to 70°C temperature range.

The MJ1472 block diagram is shown in Figure 2.

### FEATURES

- Line Time Generation (From 9 Stage Clock Driven Counter)
- Line Timing, Frame Alignment
- Alarm Signals FAT + MIR, ATL, AW, EPAT
- Test Points TP1, TP2, TP3, MR
- Inputs and Outputs LSTTL Compatible

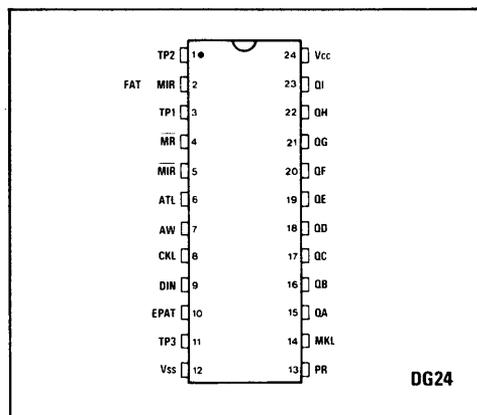


Fig.1 Pin connections (top view)

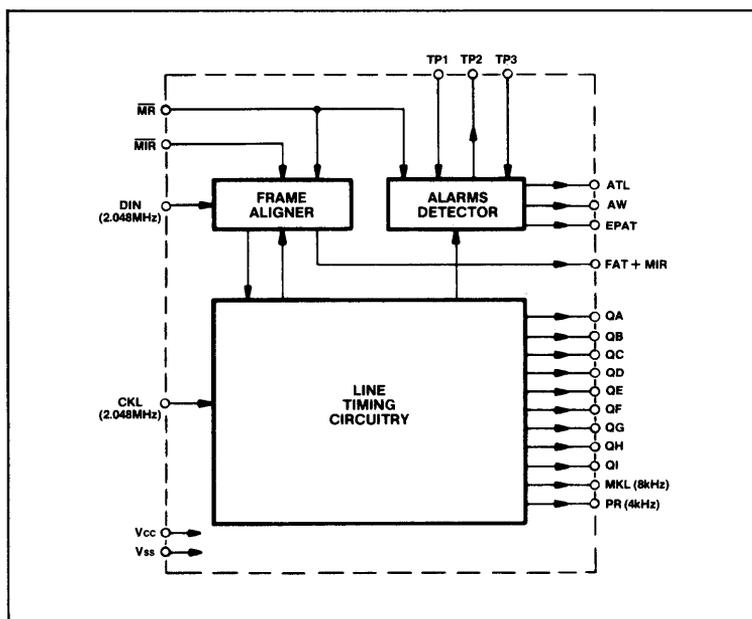


Fig.2 Block diagram



**LINE TIMING**

Nine stage clock (CKL) driven counter. All outputs (QA to QI) available externally.

**MKL** One bit positive pulse corresponding to 8th bit of TS15.

**PR** One bit positive pulse corresponding to position 8 of TS30 of frame A.

**TRANSMISSION ALARM DETECTION**

As already outlined in Fig.3. Three consecutive words A(TA) or B(TB) set an R-S flip-flop. This condition can also be forced by the external signal MIR.

**MIR** Input to R-S flip-flop.

**FAT + MIR** Output indication of state of R-S flip-flop.

**ATL** Output high when logic '1' is detected in position 3 of TS0, TB for two consecutive TB frames. Output low when logic '0' is detected in position 3 of TS0, TB. ATL output inhibited by the presence of output FAT + MIR.

**AW** Output high whenever  $\bar{A}(TA)$  is detected. Output is removed only when word  $\bar{A}(TA)$  is detected.

**EPAT** The output is high when for eight consecutive times at least 15 words A(TA) are detected in 512ms. EPAT alarm is removed (EPAT = 0) when less than 15  $\bar{A}(TA)$  words are detected in (512 x 8)ms. The 512ms timer interval is obtained by an 11 bit binary counter clocked every double frame.

**TEST POINTS**

TP1, TP2, TP3 and Master Reset MR are test points.

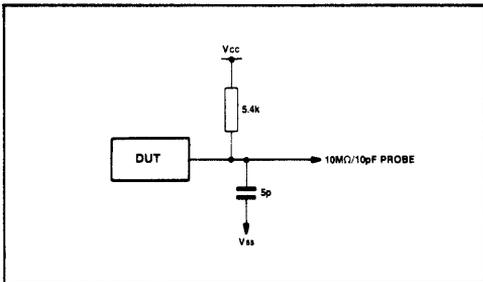


Fig.4 Propagation delay test circuit

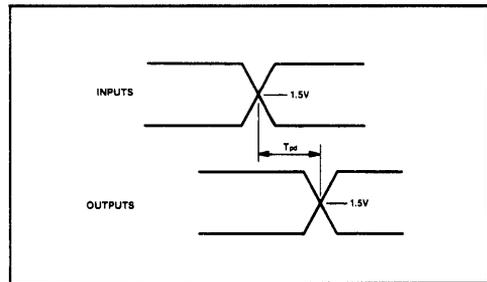


Fig.5 Waveforms for t<sub>pd</sub>



# MJ1473

## PCM TRANSMITTER CIRCUIT

The MJ1400 Series of circuits have been specifically designed for use in 30 channel PCM systems.

The MJ1473 is designed to simplify the transmit section of a 30 channel, 2 MBit PCM link by converting NRZ PCM data to either AMI or HDB3 format after inserting a synchronising word in channel 0 (conforming to CCITT recommendations G.703 and G.732).

The data is output in pseudo-ternary form to facilitate driving the line interface via a transformer and AMI or HDB3 code may be remotely selected using bits 2 and 3 in channel 0 of the incoming data stream.

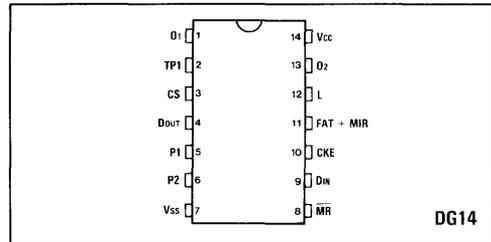


Fig.1 Pin connections - top view

### FEATURES

- 5V - 30mA Power Requirements
- 0-70°C Operation
- Complies with Relevant CCITT Recommendations
- Control Signals Compatible with MJ1472,4
- NRZ, AMI or HDB3-Transmission Format
- Transmission Format Controlled Locally or Remotely Via TSO Data
- Fabricated in NMOS Technology
- Inputs and Outputs TTL Compatible

Bit	1	2	3	4	5	6	7	8
Channel 0 TS0.TA	X	0	0	1	1	0	1	1
Channel 0 TS0.TB	X	1	ATL	X	X	X	X	X

Table 1

### ABSOLUTE MAXIMUM RATINGS

Voltage on any pin with respect to V<sub>SS</sub> : 7V  
Storage temperature : -55°C to +155°C

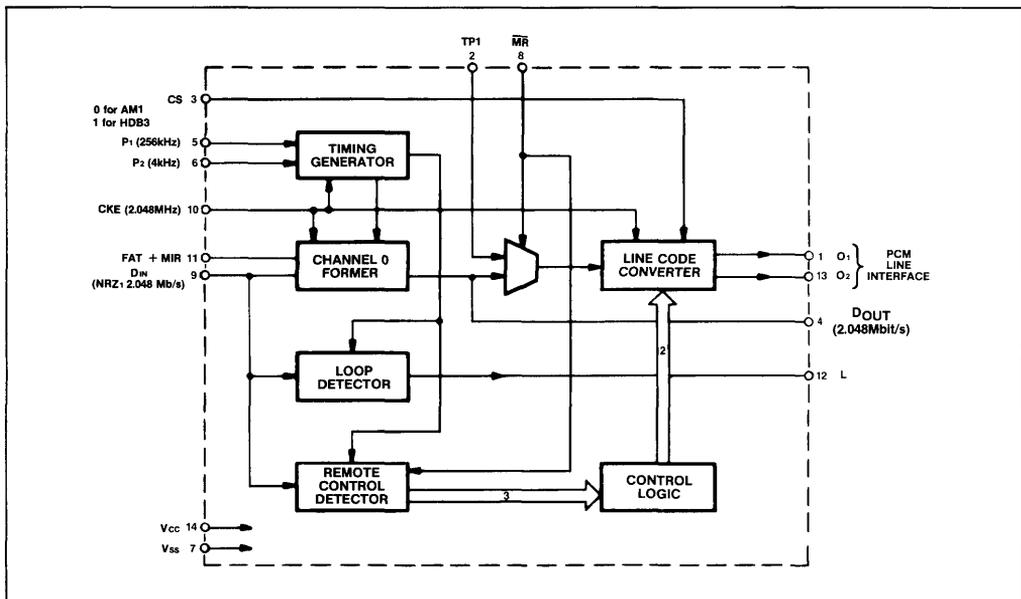


Fig.2 Block diagram of MJ1474

# MJ1473

## ELECTRICAL CHARACTERISTICS

### Test conditions (unless otherwise stated):

Supply voltage 5V ± 0.25V  
 Ambient operating temperature 0° C to +70° C  
 Package thermal resistance 95° C/watt

### DC CHARACTERISTICS

Characteristic	Symbol	Inputs/outputs	Value			Units	Test conditions
			Min.	Typ.	Max.		
High-level input voltage	V <sub>IH</sub>	All inputs	2.0			V	
Low-level input voltage	V <sub>IL</sub>	All inputs			0.8	V	
High-level output voltage	V <sub>OH</sub>	Outputs L & D <sub>OUT</sub>	2.7			V	-60µA
Low-level output voltage	V <sub>OL</sub>	Outputs L & D <sub>OUT</sub>			0.5	V	0.8mA
High-level input current	I <sub>IH</sub>	All inputs			50	µA	V <sub>IN</sub> = 5.25V 25° C
High-level output current	I <sub>OH1</sub>	Outputs L & D <sub>OUT</sub>	60			µA	V <sub>OH</sub> = 2.7V
High-level output current	I <sub>OH2</sub>	Outputs O <sub>1</sub> & O <sub>2</sub>	2			mA	V <sub>OH</sub> = 2.8V
Low-level output current	I <sub>OL</sub>	Outputs L & D <sub>OUT</sub>	0.8			mA	V <sub>OH</sub> = 0.5V
Input capacitance	C <sub>IN1</sub>	All inputs except CKE			10	pF	1MHz 100mV
	C <sub>IN2</sub>	Input CKE			20	pF	
Supply current	I <sub>CC</sub>			30	45	mA	V <sub>CC</sub> = 5.25V

### AC CHARACTERISTICS

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
O <sub>1</sub> & O <sub>2</sub>	t <sub>pd1</sub>			100	ns	Fig. 4 for loading; measure from CKE leading edge. See Fig. 5 for definition: total delay in t <sub>pd1</sub> + 4 CKE periods.
L	t <sub>pd2</sub>			200	ns	
D <sub>OUT</sub>	t <sub>pd3</sub>			180	ns	
Rise and fall times of O <sub>1</sub> & O <sub>2</sub>	t <sub>tr</sub>			20	ns	Fig. 3 for loading; measure from CKE trailing edge. See Fig. 5 for definition: total delay is t <sub>pd3</sub> + 8 CKE periods.
Required delay from D <sub>IN</sub> P1.P2 transition to CKE TE	t <sub>1</sub>	50		430	ns	Fig. 4 for loading. Measured between 0.5V and 2.4V points.
Required delay from FAT + MIR transition to CKE LE	t <sub>2</sub>	50		430	ns	
Required delay from CS transition to CKE TE	t <sub>3</sub>	50		430	ns	

### CIRCUIT DESCRIPTION

The MJ1473 generates exchange timing by a synchronous 9-bit counter driven by exchange clock CKE and preset by P1,P2. The exchange clock also clocks data, D<sub>IN</sub>, through the channel 0 former and to D<sub>OUT</sub> via an eight bit shift register. In the channel 0 former, data bits of channel 0 are modified as shown in Table 1.

An X in Table 1 indicates transparency through the circuit, bits 2 and 3 of the shift register are concerned with the loop command circuitry. When '01' is detected an internal latch is set and the loop condition on output L is registered.

D<sub>OUT</sub> may also be routed through the HDB3/AMI Encoder. The CS control is logic '0' for AMI and logic '1' for HDB3. Encoded data is then output to O<sub>1</sub> and O<sub>2</sub> in a form suitable for driving the PCM interface.

The line code converter can also be controlled by the

remote control commands present on bits 2 and 3 of the shift register. These commands are as follows:

1. The presence of '00' in the first frame yields AMI transmission except channel 0 and 1, which are transmitted in a code determined by CS.  
 The presence of '00' in each consecutive frame yields unipolar transmission except in channel 0 and 1 as above. The polarity of unipolar transmission is constant for any number of consecutive '00' frames but will alternate with respect to the previous unipolar transmission provided there has been an intermediate frame where '00' was not detected.
2. The presence of '11' in any frame yields AMI transmission except for channel 0 and 1 which are transmitted in a code determined by CS.



**MJ1473**

Advance information is issued to advise Customers of new additions to the Plessey Semiconductors range which, nevertheless, still have 'pre-production' status. Details given may, therefore, change without notice although we would expect this performance data to be representative of 'full production' status product in most cases. Please contact your local Plessey Semiconductors Sales Office for details of current status.

# MJ1474

## PCM ELASTIC STORE

The MJ1400 Series of circuits have been specifically designed for use in 30 channel PCM systems.

The MJ1474 retimes the received 30 (+2) channel PCM data stream to the exchange clock and also produces a 5-bit output which identifies the individual channels within the retimed data stream.

Slip is handled by control logic which causes a repetition (or jump) of channel 0 for two consecutive frames whenever the Store capacity is about to be exceeded.

### FEATURES

- 5V - 50mA Power Requirements
- Performance Guaranteed Over 0-70°C Temperature Range
- Performs Slip/Alignment Function in 2.048 MBit PCM Systems
- Conforms to Relevant CCITT Recommendations
- Compatible with MJ1472, 3 Control Formats
- Fabricated in NMOS Technology
- Inputs and Outputs TTL Compatible

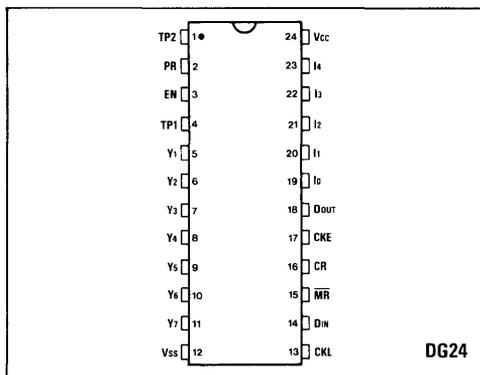


Fig.1 Pin connections - top view

### ABSOLUTE MAXIMUM RATINGS

Voltage on any pin with respect to V<sub>SS</sub> : 7V  
Storage temperature : -55°C to +155°C

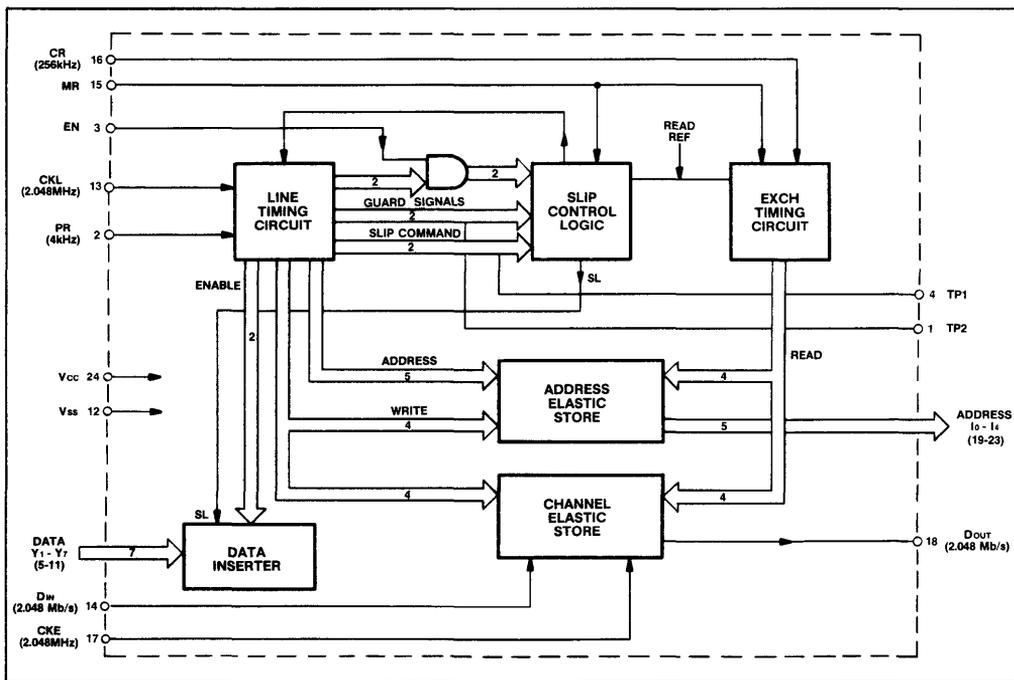


Fig. 2 Block diagram of MJ1473

**ELECTRICAL CHARACTERISTICS**

**Test conditions (unless otherwise stated):**

Supply voltage 5V ± 0.25V

Ambient operating temperature 0° C to +70° C

Package thermal resistance 60° C/watt

**DC CHARACTERISTICS**

Characteristic	Symbol	Inputs/outputs	Value			Units	Test conditions
			Min.	Typ.	Max.		
High-level input voltage	V <sub>IH</sub>	All inputs	2.0			V	
Low-level input voltage	V <sub>IL</sub>	All inputs			0.8	V	
High-level output voltage	V <sub>OH</sub>	All outputs	2.7			V	-60µA
Low-level output voltage	V <sub>OL</sub>	All outputs except I <sub>0</sub> - I <sub>4</sub>			0.5	V	0.8mA
High-level input current	I <sub>IH</sub>	All inputs			50	µA	V <sub>IN</sub> = 5.25V 25° C
Low-level output voltage	V <sub>OL1</sub>	Outputs I <sub>0</sub> - I <sub>4</sub>			0.4	V	3mA
High-level output current	I <sub>OH</sub>	All outputs	60			µA	V <sub>OH</sub> = 2.7V
Low-level output current	I <sub>OL0</sub>	All outputs except I <sub>0</sub> - I <sub>4</sub>	0.8			mA	V <sub>OH</sub> = 0.5V
Low-level output current	I <sub>OL1</sub>	Outputs I <sub>0</sub> - I <sub>4</sub>	3.0			mA	V <sub>OL</sub> = 0.4V
Input capacitance	C <sub>IN</sub>	All inputs			10	pF	1MHz 100mV
Supply current	I <sub>CC</sub>			50	80	mA	

**AC CHARACTERISTICS**

Characteristics	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
D <sub>OUT</sub>	t <sub>pd1</sub>			100	ns	Fig. 4 for loading; measure from CKL leading edge. See Fig. 5 for definition. Fig. 3 for loading; measure from CR and CKL. See Fig. 5 for definition. Fig. 3 for loading; measure from CKL trailing edge. See Fig. 5 for definition. Fig. 4 for loading; measure from CR trailing edge.
TP1	t <sub>pd2</sub>			150	ns	
TP2	t <sub>pd3</sub>			150	ns	
I <sub>0</sub> - I <sub>4</sub>	t <sub>pd4</sub>			200	ns	
Required delay from D <sub>IN</sub> transition to CKL leading edge	t <sub>1</sub>	50		430	ns	
Required delay from FAT + MIR transition to CKL leading edge	t <sub>2</sub>	50		430	ns	
Required delay from CS transition to CKL trailing edge	t <sub>3</sub>	50		430	ns	

**CIRCUIT DIAGRAM**

The line timing circuit consists of a 9-bit counter clocked by CKL and preset by PR. Counter states are decoded to form slip commands for the slip control logic and enable signals for the data inserter. The counter also controls the switching logic that delivers the write signals for the two elastic stores, i.e. channel and address, and the guard signals for the slip control circuit.

The channel elastic store has the function of retiming the 32 channels from D<sub>IN</sub>, clocked by CKL, to D<sub>OUT</sub> clocked by the exchange clock CKE. The address elastic store has the function of retiming the address of the 32 channels from the line clock CKL to parallel I<sub>0</sub> to I<sub>4</sub> outputs clocked by the exchange clock CKE.

The elastic stores are controlled by a slip control logic, which compares guard signals and the read reference signal. The read reference is generated together with 4 read signals from a 2-bit counter, driven by CR, in the exchange timing circuit. When the store capacity is about to be exceeded the slip control logic becomes active. The effects are a repetition (or jump) of channel zero for the two consecutive frames. Full capacity is always recovered after a normal slip. The

contents of all other channels are unchanged during a slip.

A slip may also be forced in the presence of signal EN. This effect is a repetition (or jump) of channel 0 and address 0 for one frame only.

The data inserter modifies channel 0 data out according to Table 1:

Position	1	2	3	4	5	6	7	8
Frame TA	X	X	Y <sub>1</sub>	Y <sub>2</sub>	Y <sub>3</sub>	Y <sub>4</sub>	Y <sub>5</sub>	Y <sub>6</sub>
Frame TB	X	1	Y <sub>7</sub>	SL	X	X	X	X

Table 1 TSO format

Where SL is generated by the slip control logic Y<sub>1</sub> to Y<sub>7</sub> are external inputs and X indicates transparency through the circuit.

The circuit also has a master reset (MR) input for initialization of slip control and exchange timing circuits. TP1 and TP2 are also available as test points.

All inputs and outputs are compatible with LSTTL. Outputs I<sub>0</sub> - I<sub>4</sub> are capable of sinking 3mA at 0.4V.

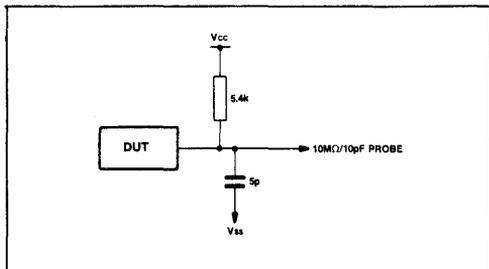


Fig.3

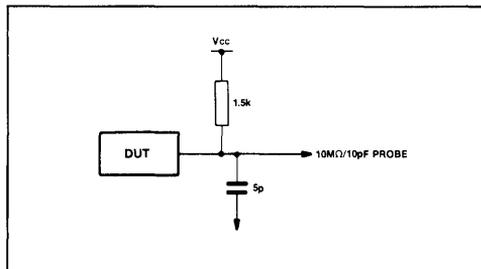


Fig.4

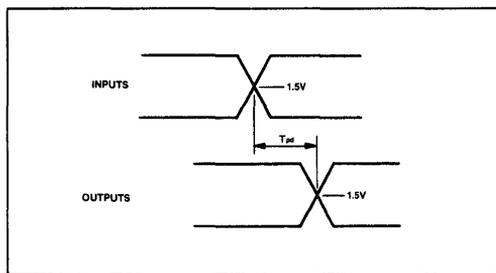


Fig.5 Waveforms for  $t_{pd}$

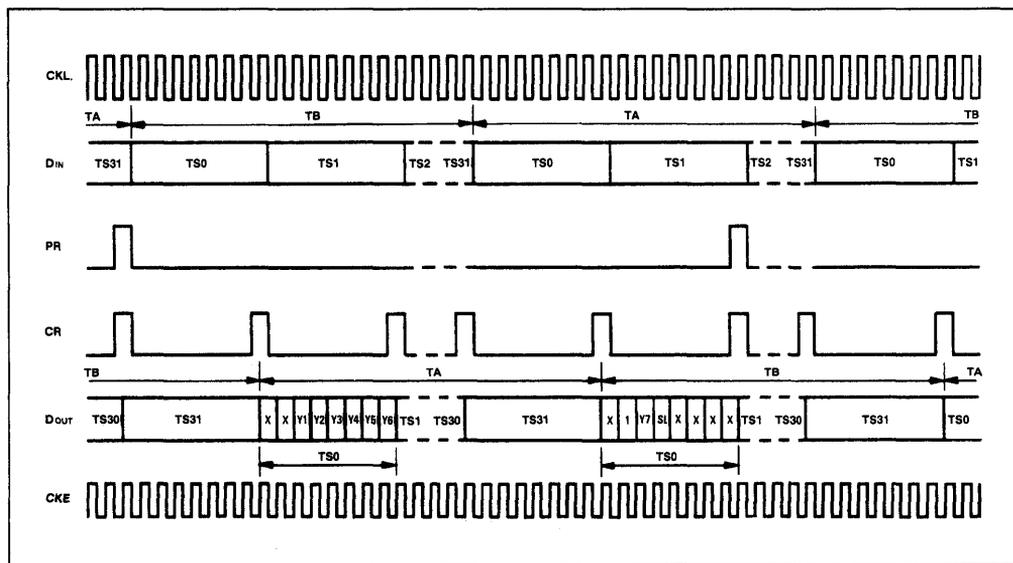


Fig.6 Timing diagram

**MJ1474**



## PRELIMINARY INFORMATION

Preliminary Information is issued to advise Customers of potential new products which are designated 'Experimental' but are, nevertheless, serious development projects and is supplied without liability for errors or omissions. Details given may change without notice and no undertaking is given or implied as to current or future availability.

Customers incorporating 'Experimental' product in their equipment designs do so at their own risk. Please consult your local Plessey Semiconductors sales outlet for details of the current status.

## MS2002EXP

## DIGITAL SWITCH MODULE (DSM)

The Plessey MS2002 is an n-channel MOS LSI integrated circuit providing digital switching for 256 channels in PCM systems. The device is unidirectional in operation and is capable of switching data from any incoming channel to any outgoing channel. Input data can be either serial or parallel. The DSM is designed to be easily expandable to provide a greater switching capacity.

## FEATURES

- Single 5V Supply
- TTL Compatible
- Interfaces Directly with European Standard CCITT 32 Channel 2.048Mb/s Format
- 256 Input/256 Output Channels
- Inputs and Outputs can be either Serial or Parallel
- Open Drain Outputs Allow Easy Expansion
- Only One System Clock Required with One Frame Synchronisation Pulse

## APPLICATION

- Circuit Switched PCM or Data Systems

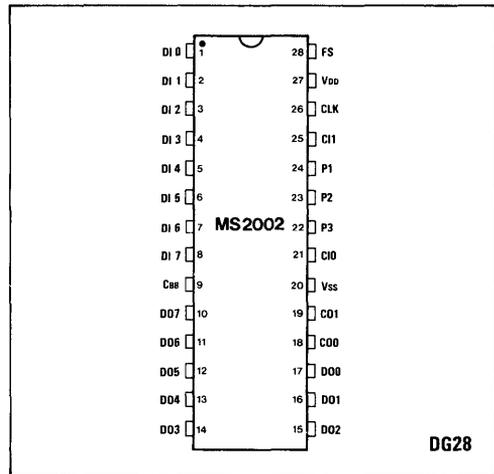


Fig.1 Pin connections - top view

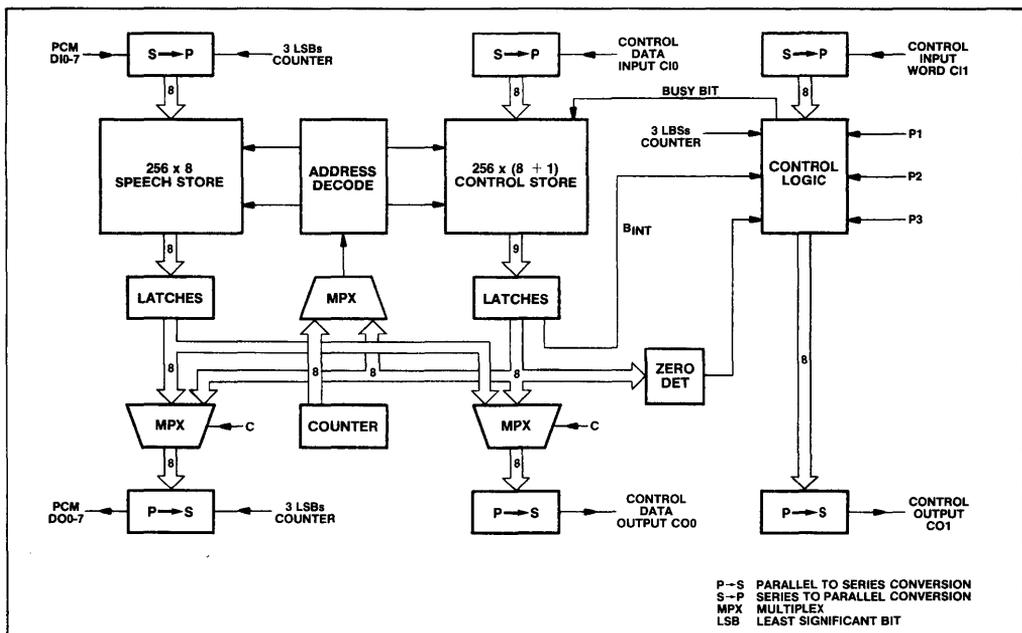


Fig.2 Block diagram of DSM

# MS2002

## RECOMMENDED OPERATING CONDITIONS

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Supply voltage	V <sub>DD</sub>	4.75	5	5.25	V	+1 Schottky load
High input voltage	V <sub>IH</sub>	2.4		V <sub>DD</sub>	V	
Low input voltage	V <sub>IL</sub>	-0.5		0.8	V	
O/P pull up resistor	R <sub>PU</sub>	950			Ω	
C <sub>BB</sub> capacitor			1		nF	

## ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

V<sub>DD</sub> = +5V, T<sub>amb</sub> = 25°C

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Supply current	I <sub>DD</sub>		40		mA	V <sub>IH</sub> = 2.7V Logic V <sub>IL</sub> = 0.4V inputs R <sub>PU</sub> = 1kΩ Logic R <sub>PU</sub> = 1kΩ outputs
Input current	I <sub>IH</sub>			50	μA	
	I <sub>IL</sub>			50	μA	
Output voltage	V <sub>OH</sub>	2.7			V	
	V <sub>OL</sub>			0.5	V	
Input capacitance	C <sub>i</sub>			5	pF	Logic inputs
Output capacitance	C <sub>o</sub>			5	pF	Logic outputs

## AC CHARACTERISTICS

Test conditions (unless otherwise stated):

T<sub>amb</sub> = 0°C to +70°C, V<sub>DD</sub> = 5V ± 5%

Characteristic	Symbol	Value		Units
		Min.	Max.	
System clock period	t <sub>c</sub>	243	245	ns
System clock low period	t <sub>cl</sub>	82		ns
System clock high period	t <sub>ch</sub>	82		ns
Frame sync period	t <sub>f</sub>	512	512	Clock periods
Frame sync set up time	t <sub>fss</sub>	60		ns
Frame sync hold time	t <sub>fsh</sub>	90		ns
Input data set up time	t <sub>ds</sub>	60		ns
Input data hold time	t <sub>dh</sub>	90		ns
Clock to output delay *	t <sub>cd</sub>	5	150	ns

\* Loaded with 7 similar outputs + 1 Schottky TTL input + 1kΩ pull up resistor to V<sub>DD</sub> + 16pF.

## PIN NAMES

DIO-7	Speech data input channels
DOO-7	Speech data output channels
CO0	Control data out
CO1	Control word out
CI0	Control data in
CI1	Control word in
P1-3	Programming pins
CLK	Clock
FS	Frame sync. pulse
V <sub>SS</sub>	Negative supply (0V)
V <sub>DD</sub>	Positive supply (5V)
C <sub>BB</sub>	Substrate bias decoupling

## ABSOLUTE MAXIMUM RATINGS

Supply voltage range (V <sub>DD</sub> )	-0.5V to +7V
Input voltage	-0.5V to +7V
Output voltage	-0.5V to +7V
Temperature: Storage	-65°C to +150°C
Operating	0°C to +70°C

## NOTE

All voltages with respect to V<sub>SS</sub>

## PIN DESCRIPTIONS

Symbol	Pin No.	Pin name and description
DI0-DI7	1-8	<b>Speech Data Inputs</b> accept the 256 incoming speech channels at a 2.048Mb/s data rate and are latched on every alternate negative edge of the 4.096MHz system clock. The eight data bits of each channel may be arranged in serial format with each input line carrying 32 time multiplexed channels in standard CCITT PCM format. Frame and bit synchronisation is provided by the negative edge of FS as shown in Fig.4. The eight lines must be time slot synchronous with each other. Alternatively the speech data may be arranged in 8 bit parallel format, the eight input lines now operating as an eight bit wide bus carrying 256 consecutive channels. Channel 0 appears on the first negative edge of the clock after the FS negative transition as shown in Fig.4. The width of the frame sync. pulse FS is used to select the required format as shown in Table 2.
C <sub>BB</sub>	9	<b>Substrate Bias Decoupling</b> for the -2.7V on-chip substrate bias generator is provided by a single capacitor between this pin and V <sub>SS</sub> .
DO0-DO7	17-10	<b>Speech Data Outputs</b> carry the 256 switched outgoing speech channels at a 2.048Mb/s rate. As with the speech data inputs the data may be arranged in either serial or parallel format, the frame sync. pulse FS width designating the selected mode. The outgoing channels are delayed by 21 bit periods with respect to the incoming lines and are timed by the negative clock edges alternate to those used for input data. The timing relationships are shown in Fig.4. The speech data outputs use open drain drivers allowing wire OR-ing of up to 8 DSMs. The correspondence of the Speech and Control store data as seen at the Speech data outputs is shown in Fig.5(a).
CI0	21	<b>Control Data Input</b> allows updating of control memory contents (excluding B <sub>int</sub> ). Data format is 8 bit serial at a 2.048Mb/s rate. Thirty two words are received per frame, the frame sync. pulse designating the first bit (MSB) of the first word, as shown in Fig.4. Each Control Data word corresponds to a specific output channel and carries the number (in bit inverted format) of the input channel which is to be switched to that output. The format of the Control data input is shown in Fig.5(b). The numbering system for incoming channels is shown in Fig.5(a). The Control Data words are written to the appropriate locations in the control store determined by the current state of the Control Word CI1, received on pin 25, and the timeslot (0-31) in which the Control Data is received. The address construction is shown below (Outgoing Channel Address Construction). Table 1 shows those conditions under which a control store modification occurs.
CI1	25	<b>Control Word Input</b> accepts 8 bit serial data, word synchronised with the Control Data input CI0, thirty two Control Words being received per frame. Each Control Word corresponds to and controls the processing of the 8 bits of Control Data (CI0) received in the same timeslot on pin 21. The Control Word format is shown below.  <b>CONTROL WORD FORMAT</b> (MSB) S3 A2 A1 A0 W BEXT S2 S1 (LSB) (T = $\Phi$ )  The outgoing speech channel address to which the present Control Data relates is determined by the combination of the present timeslot number (0-31 represented as a 5 bit number TS0-TS4) and the bits A0-A2 of the present Control Word as shown below.  <b>OUTGOING CHANNEL ADDRESS CONSTRUCTION</b> (MSB) TS4 TS3 TS2 TS1 TS0 A2 A1 A0 (LSB)  The remaining bits of the Control Word have the following functions: S1-S3 allows the message to be addressed to a specific DSM. These bits are compared with the status of the 3 Programming Pins P1-P3. W indicates whether the present operation is a control store write (W = 0) or a speech/control store read (W = 1) operation. B <sub>ext</sub> is the external busy bit. If the operation is a control store write to this DSM then B <sub>ext</sub> replaces the control store busy bit (B <sub>int</sub> ) for this channel, setting the channel to busy (B <sub>ext</sub> = 0), or free (B <sub>ext</sub> = 1) status. If the operation is a read then (B <sub>ext</sub> = 1) data is to be read. The flow diagram of Fig.3 gives the precise interpretation of the control word.
CO0	18	<b>Control Data Output</b> allows interrogation of control or speech store contents. Data output is 8 bit serial with 32 words per frame. Each outgoing word corresponds to an incoming Control Data word but is delayed from it by 21 bit periods. The precise contents of each outgoing word are determined by the state of the related incoming Control Word CI1 as shown in the flow diagram of Fig.3. The Control Data Output uses an open drain driver allowing wire OR-ing of up to 8 DSMs.
CO1	19	<b>Control Word Out</b> is a reflection of the input Control Word delayed by 21 bit periods. The S1-S3 and B <sub>ext</sub> bits may be modified depending on the internal state of the DSM, details are shown in Fig.3. The CO1 uses an open drain driver allowing wire OR-ing of up to 8 DSMs.

**PIN DESCRIPTIONS**

Symbol	Pin No.	Pin name and description
P1-P3	22-24	<b>Programming Pins</b> allow up to 8 DSMs to share a common control highway (C10,C11) and simplify the control structure when arrays of DSMs are used to construct larger switches. The Programming Pins should be hardwired to V <sub>ss</sub> or V <sub>DD</sub> to give each DSM a unique address. The state of the P1-P3 pins in combination with the S1-S3 and W bits (Control Word Format) of the control word determine how the control store is modified and also influence the contents of the outgoing CO0 and CO1 words. The complete control flow is shown in Fig.3. Table 1 summarises the effects on the control memory.
CLK	26	<b>Clock</b> input requires a 4.096MHz TTL level signal. All input signals are strobed in on alternate negative clock edges, the active edge being denoted by the position of the frame sync. signal FS, as shown in Fig.4.
FS	28	<b>Frame Sync.</b> provides a frame datum for the incoming data (both speech and control), marks the active edge of the system clock, and controls the speech input and output formats (serial or parallel) Fig.4 shows the timing relationship of the frame sync. signal to clock and data. The duration of the frame sync. low period determines the I/O format as shown in Table 2. Following a change in I/O mode the operation of the DSM is undefined for the remainder of that frame and the whole of the following frame.

W	S3 = P3	S2 = P2	S1 = P1	Action on Control Store
0	1	1	1	C10 → Control Store, BEXT → BINT
0	1	0	1	*FF → Control Store, 1 → BINT
0	1	1	0	*FF → Control Store, 1 → BINT
0	1	0	0	*FF → Control Store, 1 → BINT
X	0	X	X	No action on Control Store
1	X	X	X	No action on Control Store

Table 1 Control Store modification

\*Denotes hexadecimal notation.

**OPERATION**

The DSM (block diagram is shown in Fig.2) is a 256 channel non-blocking digital switch capable of connecting all 256 incoming channels to all 256 outgoing channels in any desired order. Alternatively, selected input channels may be broadcast to any number of output channels. Each output channel may, however, receive from only one input channel at a time, i.e. conferencing facilities are not provided. Speech input to the device is via 8 lines (DI0-DI7) that can accept 8 bit data in either serial or parallel format at a 2.048Mb/s rate. Speech output is via a further 8 lines which may be set independently of the input lines to give out serial or parallel format data.

Call routings are held in an on-chip control memory in the form of a nine bit word for each outgoing speech channel, bit nine (B<sub>int</sub>) indicating the busy status of the channel (0 = busy). In the case of a busy outgoing channel the remaining eight bits denote the number of the input channel to be connected to that outgoing channel. The numbering system for incoming channels is shown in Fig.5(a). If B<sub>int</sub> indicates the channel is free then the remaining eight bits of the control word are used as the contents of the outgoing channel, hence allowing free choice of idle code. The contents of the control store can be modified, and speech or control store interrogated, via control messages received over the control interface C10, C11. Data generated by interrogation of either the control or speech memories appears on the two control output lines CO0, CO1.

**SPEECH PATH DELAY CHARACTERISTICS**

The switching function of the DSM is achieved by storing the incoming speech channels sequentially in the 256 x 8

Low period *	I/O format
1	SISO
2	SIPO
3	PISO
4	PIPO

Table 2 I/O format control

\*Low period is shown in multiples of 4.096MHz system clock periods.

speech memory (after conversion to parallel format) and then sending them to the output channels in the order specified by the control memory. The delay encountered by each channel consists of a fixed delay, determined by the format conversion circuitry and the memory read/write cycle time, and a variable delay determined by the time spent in memory waiting for the relevant outgoing timeslot. The delay is given by the relations:

$$\begin{aligned}
 D &= 21 + (N - M) \text{ for } N \geq M \\
 D &= 277 + (N - M) \text{ for } N < M
 \end{aligned}
 \left. \begin{array}{l} \\ \\ \end{array} \right\} \text{PIPO format}$$

$$\begin{aligned}
 D &= 21 + \left( \text{INT} \frac{N}{8} - \text{INT} \right) \times 8 \text{ for } N \geq M \\
 D &= 277 + \left( \text{INT} \frac{N}{8} - \text{INT} \right) \times 8 \text{ for } N < M
 \end{aligned}
 \left. \begin{array}{l} \\ \\ \end{array} \right\} \text{SISO format}$$

where D = delay in bit periods (488ns)  
M = incoming channel No. (as shown in Fig.5)  
N = outgoing channel No.

**CONSTRUCTION OF 512 CHANNEL SWITCH**

Fig.6 demonstrates the use of the address facilities of the DSM control structure to build larger switches (512 channels in this case). The four devices share common control and speech highways, each device being assigned a unique address designated by the programming pins P1-P3. It should be noted that devices sharing a common output highway have been allocated a common value for P3. This allocation of addresses reduces the number of control messages required to set up or clear down calls as inspection of table 1 reveals; a message sent to one DSM setting or clearing a channel will automatically clear the same channel on any DSM which outputs to the same highway (has the same P3 value).

*Note*

CI = Input control interface  
CO = Output control interface

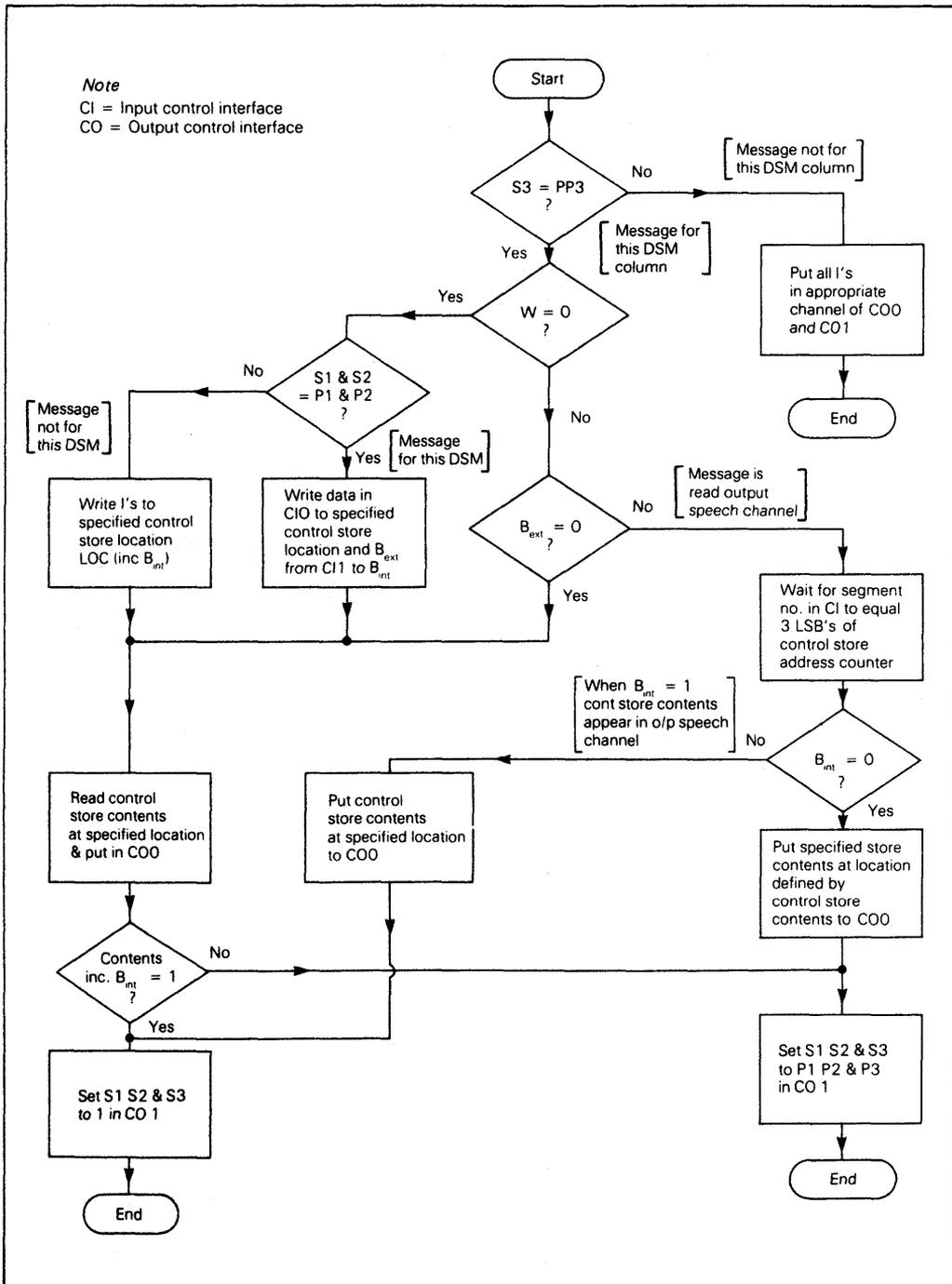


Fig.3 DSM control logic flowchart

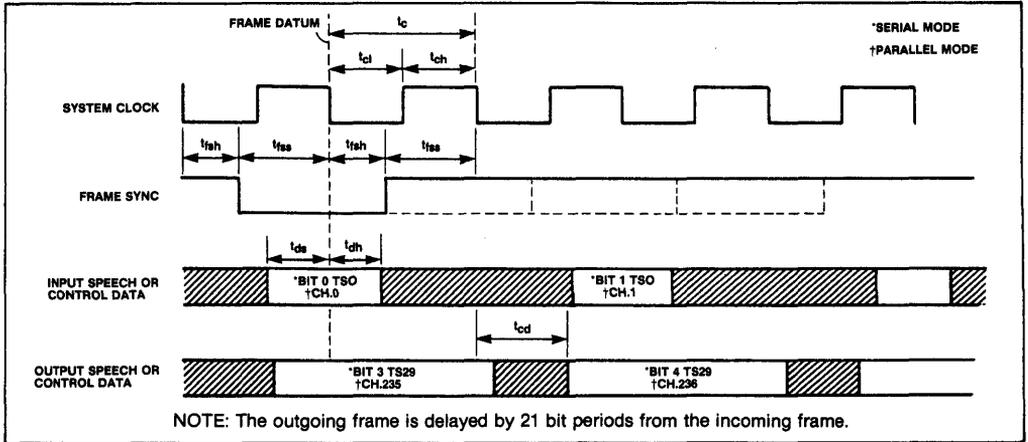


Fig.4 Clock, data, and frame sync timing relationships

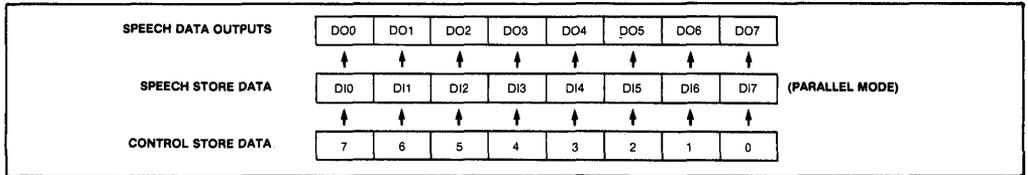


Fig.5(a) Correspondence of Speech and Control data

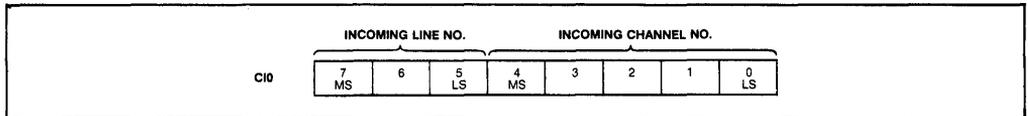


Fig.5(b) Format of Control data input

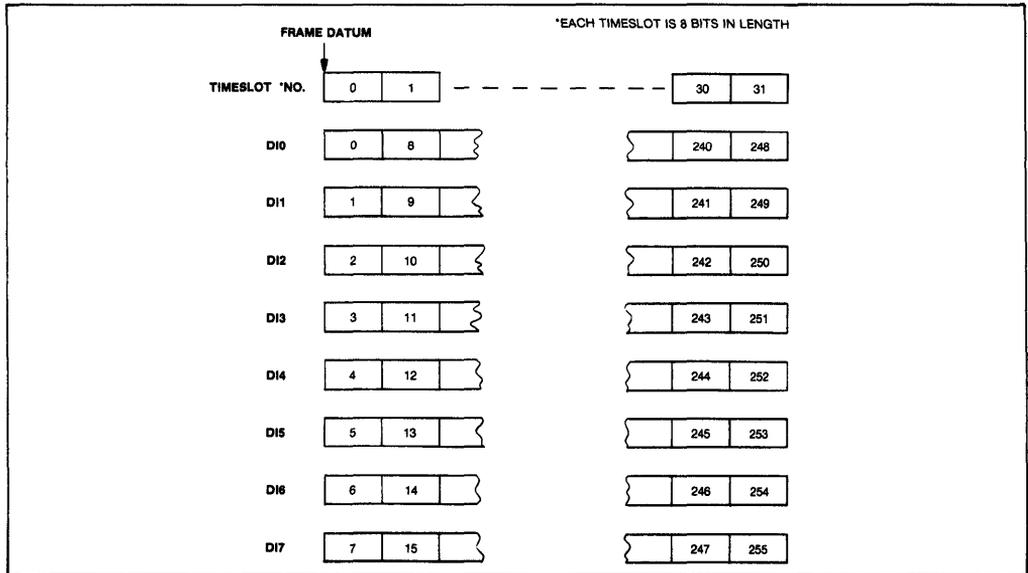


Fig.5(c) Channel numbering for incoming speech data (serial mode)

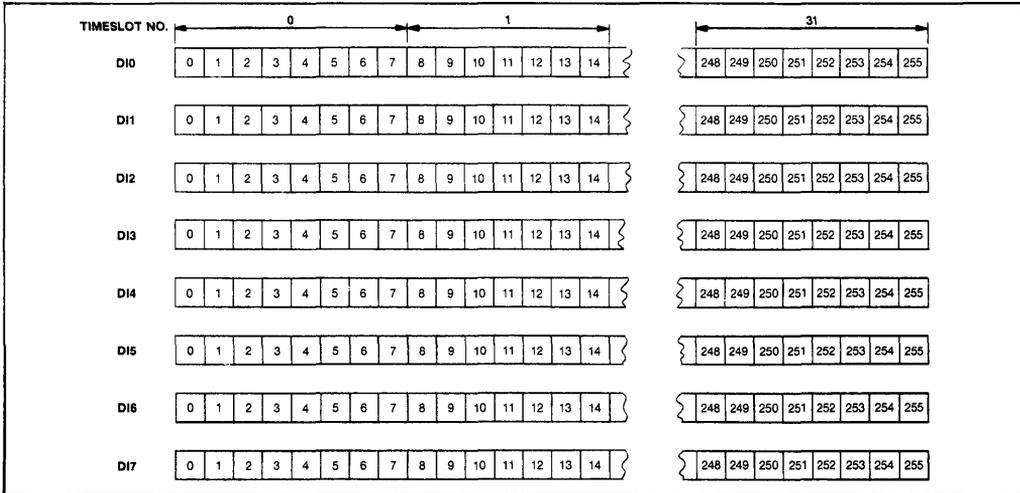


Fig.5(d) Channel numbering for incoming speech data (parallel mode).

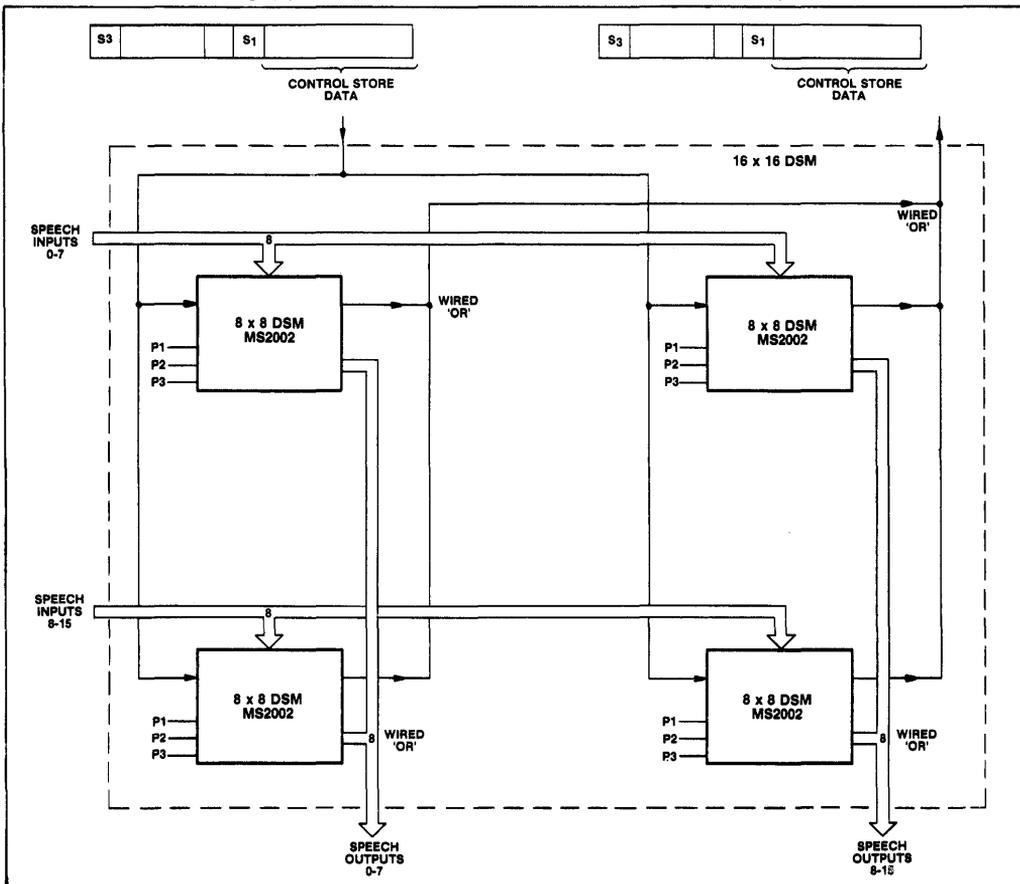


Fig.6 512 channel DSM made from four 8 x 8 DSMs

**MS2002**

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## MS2014

### DIGITAL FILTER AND DETECTOR (FAD)

The MS2014 is a real time general purpose digital signal processor (DSP) which is easily programmed to perform digital filtering and level detection. The architecture of the FAD comprises a cascadable second order recursive filter and level detector using dedicated multipliers, adders and delay elements.

The data controlling the response of the MS2014 is stored in an external PROM or RAM and consists of a list of filter coefficients and comparison levels. This simple data format means that the user does not need an expensive development system at the design stage (in contrast to other DSP devices, which use microprocessor-based structures and require considerable software development effort to realise their function). The off-chip data memory allows for easy adaptive control, even when complicated algorithms are to be implemented.

The filter and detector have been designed to give maximum flexibility in use and can easily generate most of the functions required in tone detector, spectral analysis, adaptive filter and speech synthesis systems.

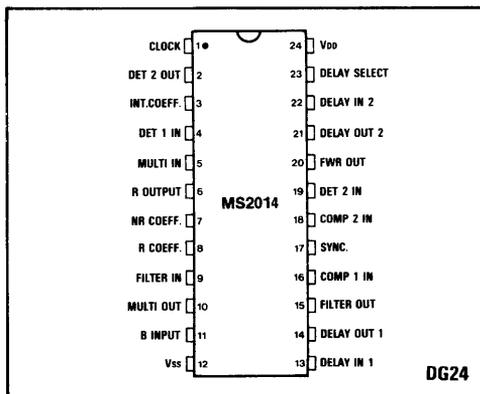


Fig.1 Pin connections - top view

#### FEATURES

- Linear 16-Bit Data
- 13-Bit Coefficient
- 2MHz Operating Clock Frequency
- Serial Operation
- 448 Bits of On-Chip Shift Register Data Storage for 8th Order Multiplex
- Nth Order Multiplexing ( $N \leq 8$ )
- TTL Compatible
- Single +5V Supply

#### APPLICATIONS

- Low Cost Digital Filtering
- Level Detection
- Spectral Analysis
- Tone Detectors (Multi-Frequency Receivers)
- Speech Synthesis and Analysis
- Data Modems
- Group Delay Equalisers (All-Pass Networks)

#### ABSOLUTE MAXIMUM RATINGS

Supply voltage ( $V_{DD}$ )	-0.5V to +7V
Input voltage	-0.5V to +7V
Maximum output voltage	+7V
Temperature: Storage	-65°C to 125°C
Operating	0°C to 70°C

#### NOTE

All voltages with respect to  $V_{SS}$

#### PIN NAMES

Name	Function	I/O
1 Clock	Single phase clock input	I
2 Detect 2 Out	Output from detector 2	O
3 Int.Coeff	Integrator coefficients	I
4 DET 1 In	Detector 1 input	I
5 Mult In	Input to NR B multiplier	I
6 R Output	Output of recursive section	O
7 NR Coeff	Non-recursive (NR) coefficient input	I
8 R Coeff	Recursive coefficient input	I
9 Filter In	Data input to filter section	I
10 Mult Out	Output from B multiplier	O
11 B Input	Input from B multiplier	I
12 Vss	0V	
13 Delay In 1	Input from filter external delay	I
14 Delay Out 1	Output to filter external delay	O
15 Filter Out	Data output from filter section	O
16 Comp 1 In	Comparison level 1 input	I
17 Sync	Synchronisation pulse input	I
18 Comp 2 In	Comparison level 2 input	I
19 DET 2 In	Input for detector 2 via FWR	I
20 FWR Out	FWR output from Det 2 In data	O
21 Delay Out 2	Output from detectors 1 and 2, and connection to detector external delay	O
22 Delay In 2	Input from detector external delay	I
23 Delay Select	Internal/External delay selector	I
24 VDD	+5V supply	

**MS2014**

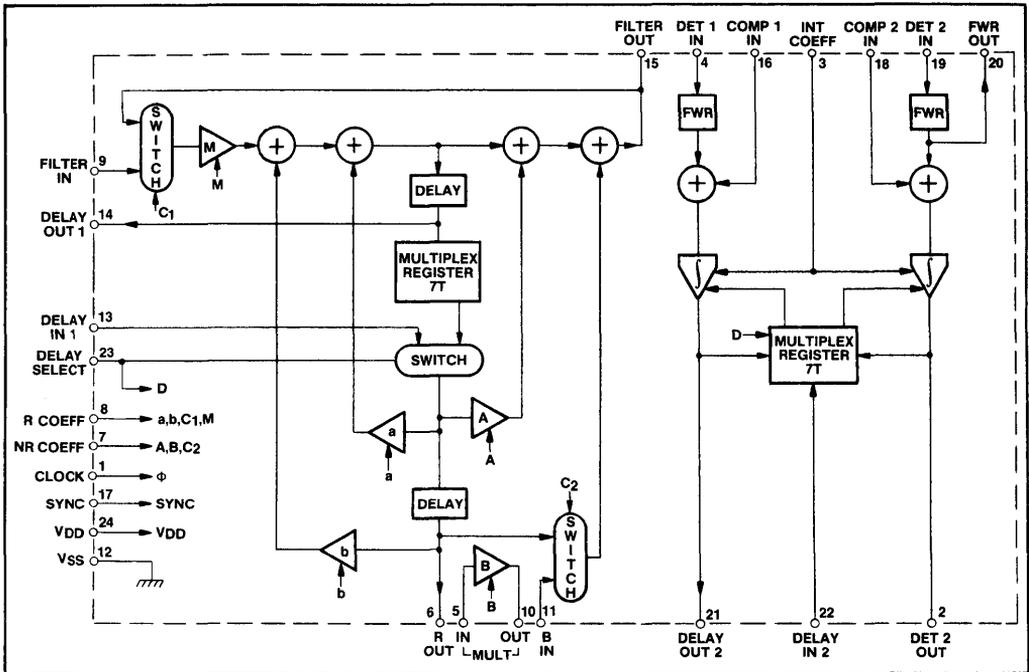


Fig.2 Block diagram

**PERFORMANCE**

A sample throughput of 64000 samples/s is guaranteed. Thus using a sampling period of 125µs (8000 samples/s) the following may be realised:

- 8 bi-quadratic 2nd-order recursive filter sections;
- plus 16 full-wave rectification operations;
- plus 16 1st-order leaky integrations;
- plus 16 level comparisons.

Filters of more than 16th order are possible but will require a lower sampling rate or more than one MS2014.

**RECOMMENDED OPERATING CONDITIONS**

Characteristic	Symbol	Value		Units	Conditions
		Min.	Max.		
Supply voltage	V <sub>DD</sub>	4.75	5.25	V	10% - 90% (Note 1)
Input voltage (high state) except clock	V <sub>IH</sub>	2.2	-	V	
Input voltage (low state) except clock	V <sub>IL</sub>	-	0.7	V	
Input voltage (high state) clock	V <sub>IHC</sub>	4.5	-	V	
Input voltage (low state) clock	V <sub>ILC</sub>	-	0.5	V	
Clock rise and fall time	t <sub>cl</sub>	-	30	ns	
Clock frequency	f <sub>cl</sub>	0.5	2.048	MHz	
Operating temperature	T <sub>amb</sub>	0	70	°C	

## ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

$$V_{DD} = +5V \quad T_{amb} = 25^\circ C$$

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Supply current	$I_{DD}$		90	120	mA	
Output voltage, low	$V_{OL}$	-	-	0.5	V	$I_{OL} = 0.4mA$ (Note 2)
Output voltage, high	$V_{OH}$	2.7	3.4	-	V	$I_{OH} = -40\mu A$ (Note 2)
Input capacitance (except clock)	$C_{in}$		5	7	pF	
Input capacitance (clock)	$C_{inc}$		25		pF	
Input data set up time	$t_{is}$	50	-	-	ns	Fig.7
Input data hold time	$t_{ih}$	150	-	-	ns	Fig.7
Output data delay time	$t_{os}$	-	-	200	ns	Fig.7

### NOTES

1. An operating clock frequency of 2.048MHz is guaranteed over the supply voltage range and the full operating temperature range.
2. The output stage is designed to drive a standard TTL LS gate (74LS series).

## FUNCTIONAL DESCRIPTION

### The Filter Section

The filter section provided in the MS2014 is a second order recursive type (see Fig.3). This structure was chosen because of its good coefficient sensitivity and predictable round-off, limit-cycle and overflow properties. Higher order filters are easily produced by cascading sections in a similar manner to analogue active filter design.

The transfer function of the section is given by:

$$H(z) = M \frac{[1 + Az^{-1} + Bz^{-2}]}{[1 - az^{-1} - bz^{-2}]} \quad \dots (1)$$

The coefficients  $a$  and  $b$  define a pair of complex poles, whilst  $A$  and  $B$  define a pair of complex zeros. The Scaling Factor  $M$  is necessary because many filters have greater than unity gain, hence there is a danger of numeric overflow in the filter arithmetic. In the MS2014 this scaler multiplies by a factor of

$$M = \left(\frac{1}{2}\right)^n \text{ where } 0 \leq n \leq 13$$

The multipliers in the MS2014 are serial/parallel types which require the coefficient data as a static parallel word. To minimise the number of pins on the device, this data is loaded serially and stored in a SIPO shift register. Each multiplier requires the coefficient data to be in 2s complement form with 12 bits for the fractional part of the number.

The range for the coefficients are:

$$\begin{aligned} 2 > A &\geq -2 \\ 2 > a &\geq -2 \\ 1 \geq B &\geq -1 \\ 1 > b &\geq -1 \end{aligned}$$

For the  $A, a$  coefficients there is an added bit ( $a_s, A_s$ ) to give the extra  $\pm 1$  range, which gives a total of 14 bits for the  $A, a$  coefficients and 13 bits for  $B, b$ .

The second-order filter is very easily multiplexed by increasing the delay function in steps of  $T$  (where  $T$  is the computation period\*) and time-sharing the arithmetic elements. The limit on this process is the maximum clock rate of the MS2014. With a 32 bit computation cycle the clock rate  $f_{cl}$  is given by:

$$f_{cl} = 32 \times f_s \times Y$$

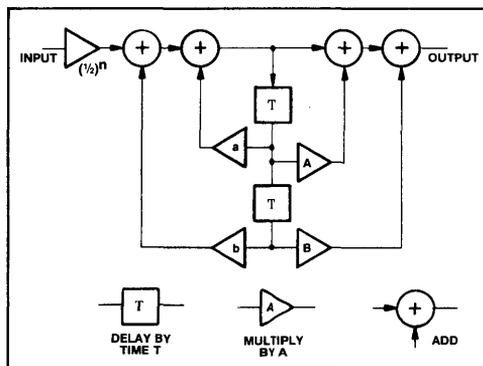


Fig.3 Basic 2nd order filter section

where  $Y$  is the number of times the filter is multiplexed and  $f_s$  is the sampling rate (the reciprocal of the sampling period  $T_s$  \*\*). In telephony applications it is usual for  $f_s$  to be 8000 samples/s; hence at the maximum guaranteed clock rate of 2048kHz,  $Y$  must be less than or equal to 8.

By presenting an input sample during every 32-bit computation cycle, 8 separate second-order filters can be implemented. As the inputs can be independent of each other the filter is then said to be 'channel multiplexed'.

Filters of higher order can be built by feeding the output data emerging from one second-order section back to the input via an on-chip data selector, which is enabled by the control bit  $C_1$ ; since the delay between the input and output of the filter section is 32 clock periods, the data arrives at the beginning of the next computation cycle. Thus by controlling the data selector two or more second-order filter sections can be cascaded. This arrangement allows any combination of filter and channel multiplexing to be achieved.

Higher orders of channel or filter multiplex require the connection of additional delay. For 8th-order multiplex, a delay of  $7T$  (224 bits) is provided on chip; together with the inherent delay  $T$  (32 bits) of the computation cycle, this

\* $T$  = computation period =  $32 \times (1/2048k)s = 15.63\mu s$  i.e. 32 bits at 2048 kbit/s clock rate.

\*\* $T_s$  = sampling period =  $(1/8000)s = 125\mu s$  at a sampling rate of 8kHz i.e. 256 bits at 2048 kbit/s clock rate.

**MS2014**

makes up the necessary  $8T$  delay. Other orders of multiplex require the external connection of  $(Y - 1) \times 32$  bits of delay.

The detector function is carried out by 'full wave rectifiers' followed by comparators and leaky integrators. By interconnecting these in different ways various absolute and relative level decisions can be made.

**The 'Full Wave Rectifiers'**

Data entering the 'full wave rectifiers' is inverted if the sign bit of the word is a '1' (i.e. negative). The 1LSB error generated by this is insignificant and does not materially affect operation of the detector.

**The Integrators**

The integrators in the MS2014 are unity gain variable-leak-factor types. Fig.4 shows the internal arrangement. The leak factor

$$1 - 2^{-(K + 1)}$$

controls the rise time of the integrator, the relationship is given in Table 1.

**Level Detection**

Both relative and absolute level detectors can be implemented in the MS2014. Fig.5 shows the arrangement for an absolute level detector. The sign bit of the data word emerging from the integrator is '1' if the mean level of the filter output is greater than the comparator input level.

Relative level detection can be achieved by using the arrangement of Fig.6. In most applications where relative level sensing is required, the filtering can be arranged such that  $B = 1$  (i.e. the complex zeros are located on the unit circle in the  $z$  plane), this allows the  $B$  multiplier to be used for scaling the relative levels. In this application the  $B$  coefficient must be negative.

Leak factor	Rise time (0 to 90%)
1/2	$3 T_s + T$
3/4	$8 T_s + T$
7/8	$17 T_s + T$
15/16	$35 T_s + T$
31/32	$72 T_s + T$
63/64	$146 T_s + T$
127/128	$293 T_s + T$
255/256	$588 T_s + T$

Table 1 Integrator rise times

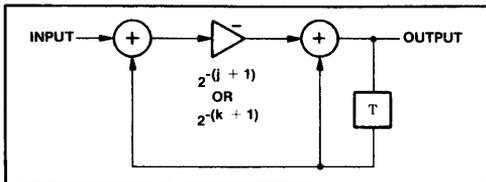


Fig.4 Leaky integrator

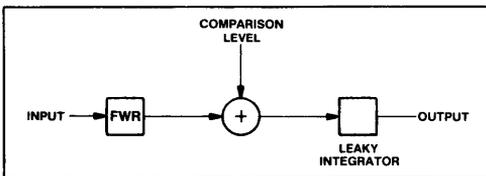


Fig.5 Simple level detector

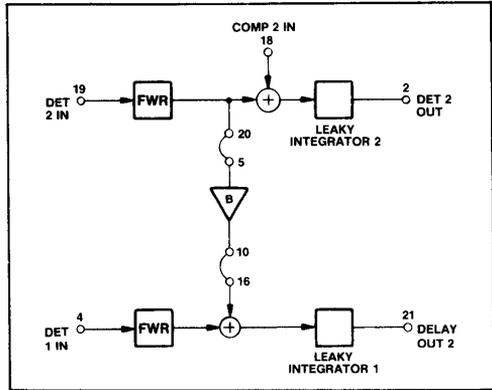


Fig.6 Relative level detection

**FILTER DESIGN WITH THE MS2014**

One of the commonest techniques for designing analogue filters is to factor the transfer function into blocks which can be realised by second order filter sections. Most designs of this type are done using tables which give coefficients for equations of the form:

$$H(s) = \frac{Cs^2 + Ds + K}{Es^2 + Fs + 1} \quad \dots (2)$$

Since the MS2014 filter section is a general second-order structure, the same design technique can be employed. By using the Bilinear Transform:

$$s = \frac{2(1 - z^{-1})}{T(1 + z^{-1})} \quad \dots (3)$$

it is possible to design digital filters from analogue prototypes. By substituting equation (3) into (2) and rearranging the result into the form of equation (1) the following relationships are derived:

$$A = \frac{2KT^2 - 8C}{4C + 2DT + T^2}$$

$$a = \frac{8E - 2T^2}{4E + 2FT + T^2}$$

$$M = \frac{4C + 2DT + KT^2}{4E + 2FT + T^2} \quad \dots (4)$$

$$B = \frac{4C - 2DT + KT^2}{4C + 2DT + KT^2}$$

$$b = \frac{2FT - 4E - T^2}{4E + 2FT + T^2}$$

These five equations allow an analogue filter design to be transformed into digital form.

In addition to the four coefficients required by the filter section the data streams fed to the NR and R coefficient inputs include the four bits setting the Scaling Factor  $M$  ( $M_1$  to  $M_4$ ) and two selector control bits  $C_1$  and  $C_2$ .

When  $C_1 = 1$ , data applied to FILTER IN (pin 9) goes to the filter section, when  $C_1 = 0$  data emerging on FILTER OUT (pin 15) is fed back to the filter at the start of the next computation cycle.

When  $C_2 = 0$  the  $B$  multiplier is by-passed by a direct connection, setting  $B = 1$ .

Table 2 shows the format of the serial data words for the NR and R coefficient inputs. The timing diagram (Fig.7) shows where this fits into the computation cycle. The synchronising pulse (SYNC) is coincident with the first clock pulse of the cycle and must be low before the rising edge of

32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	Clock Pulse Number	
b Coeff.												a Coeff. (Recursive)																					
C <sub>1</sub>	M <sub>1</sub>	M <sub>2</sub>	M <sub>3</sub>	M <sub>4</sub>	msb.....lsb												msb.....lsb																
B Coeff.												A Coeff. (Non-Recursive)																					
X	X	X	X	C <sub>2</sub>	msb.....lsb												msb.....lsb																
0.125				0												0.73217773437																	
1	0	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	1	1	1	0	1	1	0	1	1	1	R
0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	NR

Table 2 Filter data format

the clock. The SYNC pulse is applied every Y clock pulses, where Y = CLOCK RATE/SAMPLING RATE.

**Coefficient Conversion**

After the coefficients have been obtained (from the Bilinear Transform or FAD Development Program) they must be assembled in the format given in Table 2. The FAD Development Program gives the multiplier coefficients in a ready-to-use binary string format, other techniques will give numerical values for the coefficients which must be converted into binary strings.

**Coefficient Conversion Algorithm for 'A'**

The algorithm for converting A or a to binary is as follows:

$$\text{Obtain } A = \frac{|A|}{2} . 8191$$

Convert A into a binary number (13 bits)

If A is positive INVERT THE MSB AND APPEND '0' AS NEW MSB.

If A is negative INVERT ALL BITS AND APPEND '1' AS NEW MSB, then ADD '1' LSB.

**Conversion of 'B' Coefficients**

Obtain B = B.4096

Convert B into a binary number (12 bits)

If B is negative INVERT ALL BITS, ADD '1' LSB AND APPEND '1' AS NEW MSB.

If B is positive APPEND '0' AS NEW MSB.

In addition to the coefficient data streams one further input must be set up. DELAY SELECT (pin 23) is the control pin used to select the internal 7T delay. A '1' maintained on pin 23 selects the internal delay and a '0' the external option. The B multiplier is independent of the rest of the circuit and may be used for any purpose, although usually it will form part of either the filter or detect functions. In each case the appropriate connections must be made externally.

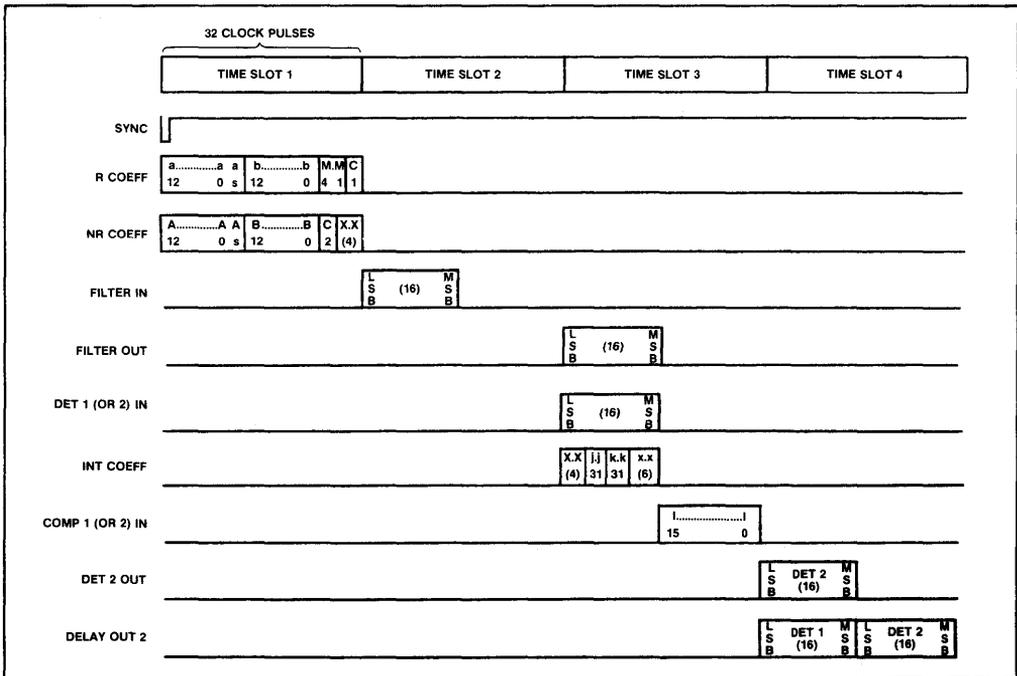


Fig.7 Timing diagram

## MS2014

Clock pulse number	32	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1
Integrator coefficients	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	K <sub>1</sub>	K <sub>2</sub>	K <sub>3</sub>	J <sub>1</sub>	J <sub>2</sub>	J <sub>3</sub>	X	X	X
Comparison level 1 or 2	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	P <sub>3</sub>	P <sub>4</sub>	P <sub>5</sub>	P <sub>6</sub>	P <sub>7</sub>	P <sub>8</sub>	P <sub>9</sub>	P <sub>10</sub>	P <sub>11</sub>	P <sub>12</sub>	P <sub>13</sub>	P <sub>14</sub>	P <sub>15</sub>	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X

Table 3 Detector data format

### Programming the Detector

Control data for the detect function is supplied by an external memory to the INT COEFF input (pin 3) and to the COMP 1 IN and COMP 2 IN inputs (pins 16 and 18) of the MS2014. The relative positions in time of the input sample data, detect function control data and output sample data are shown on the timing diagram (Fig.7).

Note that it is possible to economise on memory by strapping pin 3 either to pin 16 or to pin 18, since valid data for either combination of pins occurs at different times in the computation cycle. There are two integrator scaling factors in the INT COEFF data stream. The  $j_1, j_2, j_3$  data bits determine the integrator coefficient for the data stream applied to DET 1 IN (pin 4) and the  $k_1, k_2, k_3$  data bits for the DET 2 IN (pin 19) data stream; their definitions and clock pulse positions are given in Table 3.

In most applications, the comparison levels  $l$  and  $m$  applied to COMP 1 IN (pin 16) and COMP 2 IN (pin 18) will be negative quantities, and as they are coded in two's complement, each sign bit at clock pulse 32 will be a '1'. However, a positive quantity can be input by setting the sign bit to '0'. In this case, care must be taken to ensure that the addition of the DET data and the COMP data does not result in a number greater than unity and cause overflow, since no protection against overflow is provided in either detect function.

**NOTE** Round-off errors in the detector section may result in the integrator 'jamming' if the signal is below the 4 LSBs. Consequently, the available dynamic range is limited to the 12 MSBs.

### TYPICAL APPLICATIONS CIRCUITS

#### A Second-Order High Sampling Rate Filter (Fig.8)

This is the simplest filter arrangement for the MS2014. No external delay is required so that DELAY 1 IN is connected to DELAY 1 OUT and DELAY SELECT is grounded.

A  $\div 32$  counter generates the 5-bit wide address for the coefficient ROM. A 5-input OR gate on the address lines generates the SYNC pulse every 32 clock cycles so that at a 2.048MHz clock rate the sample rate is 64000 samples/second giving a maximum bandwidth of 32kHz.

If the desired  $B$  coefficient is not unity then  $R_{out}$  (pin 16) must be connected to MULT IN (pin 5) and MULT OUT (pin 10) to  $B$  INPUT (pin 11).

#### A 16th Order Filter 8kHz Sample Rate Fig.9)

In this example DELAY SELECT (pin 23) is high so that the internal  $7T$  delay is switched in. Input data is applied during the first computation cycle (the one with the SYNC pulse in it) and coefficient data is loaded in the last computation cycle.

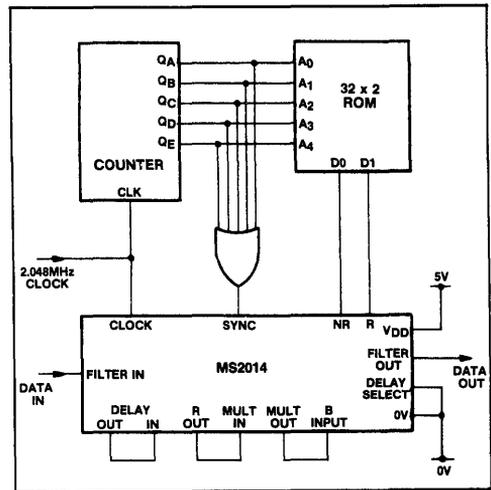


Fig.8 2nd order 32kHz bandwidth filter

#### Channel Multiplexed Second Order Filter 8kHz Sampling

The hardware for this filter is identical to Fig.9. However, input data is provided during each computation cycle and each cycle contains a separate output. If the filter required for each channel is identical, then the coefficient memory need only be  $32 \times 2$  bits.

#### Other Configurations

Sampling rates other than 64kHz and 8kHz can be achieved either by reducing the clock rate and/or by using external delays in place of the internal  $0/7T$ . The use of external delay also allows different orders of multiplexing.

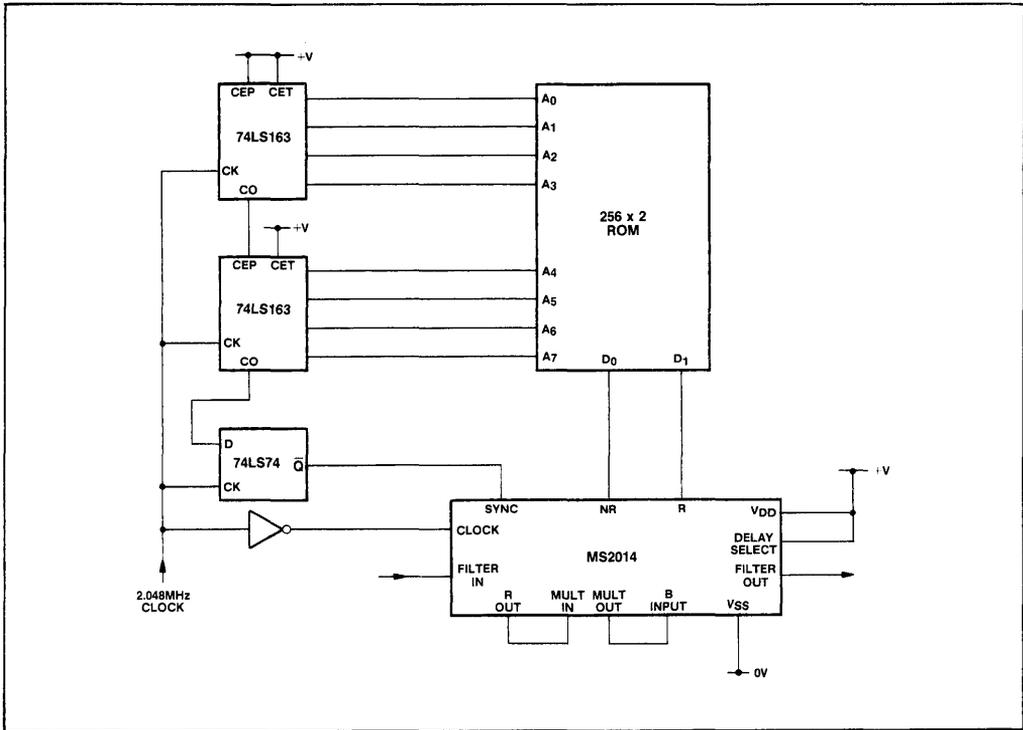


Fig.9 A 16th order 4kHz bandwidth filter

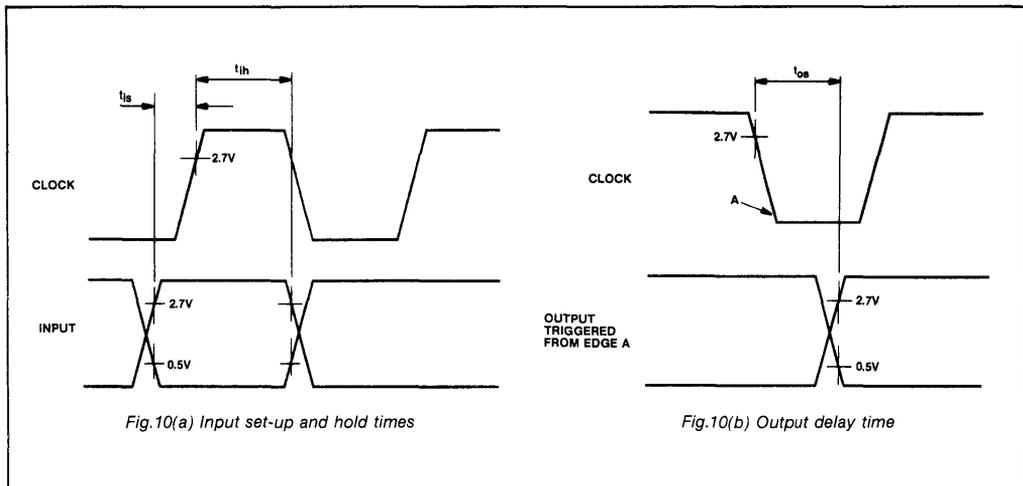


Fig.10(a) Input set-up and hold times

Fig.10(b) Output delay time

Fig.10 Input and output timing

**MS2014**

Advance information is issued to advise Customers of new additions to the Plessey Semiconductors range which, nevertheless, still have 'pre-production' status. Details given may, therefore, change without notice although we would expect this performance data to be representative of 'full production' status product in most cases. Please contact your local Plessey Semiconductors Sales Office for details of current status.

## 2MBIT PCM SIGNALLING CIRCUIT

# MV1441

## HDB3 ENCODER/DECODER/CLOCK REGENERATOR

The 2.048MBit PCM Signalling Circuits comprise a group of circuits which will perform the common signalling and error detection functions for a 2.048MBit PCM transmission link operating to the appropriate CCITT recommendations. The circuits are fabricated in CMOS and operate from a single 5 volt supply with relevant inputs and outputs TTL compatible.

The MV1441 is an encoder/decoder for the pseudo-ternary transmission code, HDB3 (CCITT Orange Book Vol.III.2 Annex to Rec. G703). The device encodes and decodes simultaneously and asynchronously. Error monitoring functions are provided to detect violations of HDB3 coding, all ones detection and loss of input (all zeros detection). In addition a loop back function is provided for terminal testing. A clock recovery circuit is provided using a 16.384MHz crystal (12.352MHz for 1.544MHz operation), which may be shared between several separate devices.

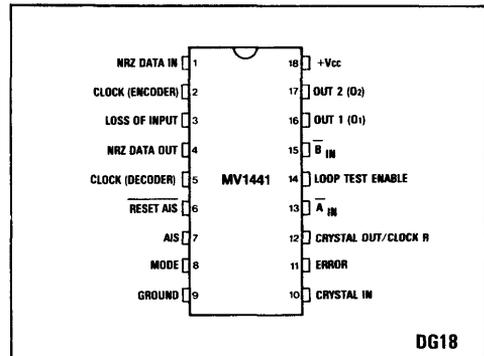


Fig.1 Pin connections - top view

### FEATURES

- On-Chip Digital Clock Regenerator
- HDB3 Encoding and Decoding to CCITT rec. G703
- Asynchronous Operation
- Simultaneous Encoding and Decoding
- Clock Recovery Signal allows Off-Chip Clock Regeneration
- Loop Back Control
- HDB3 Error Monitor
- 'All Ones' Error Monitor
- Loss of Input Alarm (All Zeros Detector)
- Decode Data in NRZ Form
- Low Power Operation
- 2.048MHz or 1.544MHz Operation

### ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

#### Electrical Ratings

+V <sub>cc</sub>	-0.5V to +7V
Inputs	V <sub>cc</sub> +0.5V Gnd -0.3V
Outputs	V <sub>cc</sub> , Gnd -0.3V

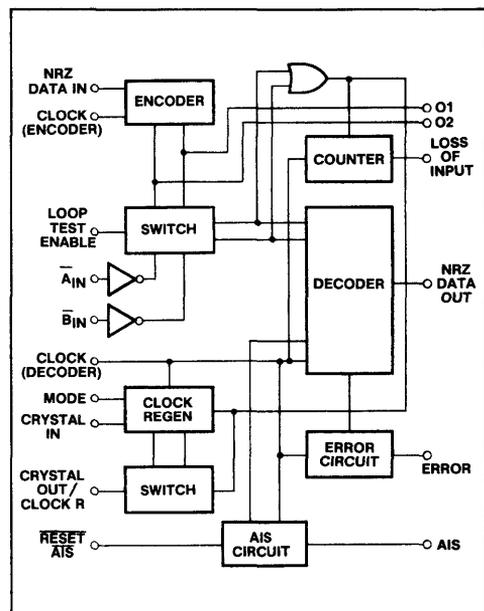


Fig.2 Block diagram

**ELECTRICAL CHARACTERISTICS****Test conditions (unless otherwise stated):**Supply voltage  $V_{CC} = 5V \pm 0.5V$  Ambient temperature  $T_{amb} = 0^{\circ}C$  to  $+70^{\circ}C$ **Static characteristics**

Characteristic	Symbol	Pins	Value			Units	Conditions
			Min	Typ	Max		
Low level input voltage	$V_{IL}$	All inputs	-0.3		0.8	V	$V_{IL} = 0V$  $V_{IH} = 5V$ $I_{sink} = 2.0mA$ $I_{source} = 1mA$ apply All inputs to 0V All outputs open circuit
Low level input current	$I_{IL}$				50	$\mu A$	
High level input voltage	$V_{IH}$	2.0	$V_{CC}$	V			
High level input current	$I_{IH}$		50	$\mu A$			
Low level output voltage	$V_{OL}$	All outputs		0.4	V		
High level output voltage	$V_{OH}$			2.8	V		
Supply current	$I_{CC}$		$V_{CC}-0.75$	2	4	mA	

**Dynamic Characteristics**

Characteristic	Symbol	Value			Units	Conditions
		Min	Typ	Max		
Max. Clock (Encoder) frequency	$f_{maxenc}$	4.0	10		MHz	Figs.10,15
Max. Clock (Decoder) frequency	$f_{maxdec}$	2.2	5		MHz	Figs.11,15
Propagation Delay Clock (Encoder) to $O_1, O_2$	$t_{pd1A/B}$			100	ns	Figs.8,10,15 See Note 1
Rise and Fall times $O_1, O_2$				20	ns	Figs.10,15
$t_{pd1A} - t_{pd1B}$ difference				20	ns	Figs.10,15
Propagation Delay Clock (Encoder) to Clock Regenerate	$t_{pd3}$			150	ns	Loop test enable = '1', Figs.10,15
Setup time of NRZ data in to Clock (Encoder)	$t_{s3}$	75			ns	Figs.7,10,15
Hold time of NRZ data in	$t_{h3}$	55			ns	Figs.7,10,15
Propagation delay $\bar{A}_{IN}, \bar{B}_{IN}$ to Clock Regenerate	$t_{pd2}$			150	ns	Loop test enable = '0' Figs.13,15
Propagation delay Clock (Decoder) to error	$t_{pd4}$			200	ns	Figs.12,15
Propagation delay $\overline{\text{Reset AIS}}$ falling edge to AIS output	$t_{pd5}$			200	ns	Loop test enable = '0', Figs.14,15
Propagation delay Clock (Decoder) to NRZ data out	$t_{pd6}$			150	ns	Figs.7,11,15 See Note 2
Setup time of $\bar{A}_{IN}, \bar{B}_{IN}$ to Clock (Decoder)	$t_{s1}$	75			ns	Figs.7,11,15
Hold time of $\bar{A}_{IN}, \bar{B}_{IN}$ to Clock (Decoder)	$t_{h1}$	5			ns	Figs.7,11,15
Hold time of $\overline{\text{Reset AIS}} = '0'$	$t_{h2}$	30			ns	Figs.7,14,15
Setup time Clock (Decoder) to $\overline{\text{Reset AIS}}$	$t_{s2}$	100			ns	Figs.7,14,15
Setup time $\overline{\text{Reset AIS}} = 1$ to Clock (Decoder)	$t_{s2}$	0			ns	Figs.14,15
Propagation Delay Clock (Decoder) to LIP				150	ns	

## NOTES

- The Encoded ternary outputs ( $O_1, O_2$ ) are delayed by 3.5 clock periods from NRZ Data In (Fig.3).
- The decoded NRZ output is delayed by 3 clock periods from the HDB3 inputs ( $\bar{A}_{IN}, \bar{B}_{IN}$ ) (Fig.4).

High Density Bipolar 3 (HDB3) is a pseudo-ternary signal in which the number of consecutive zeros that may occur is restricted to a maximum number of three. In any sequence of four consecutive binary zeros, the ultimate zero is substituted by a 'mark' (+ or -) of the same polarity as the previous mark, i.e. it violates AMI code (Alternate Mark

Inversion) and is termed a 'violation'. To ensure parity between marks of opposite polarity, the first zero is substituted by an additional mark when there would otherwise be an even number of marks between 'violations'. Thus violations alternate in polarity.

**FUNCTIONAL DESCRIPTION**

**Functions Listed by pin number**

**1. NRZ data in**

Input data for encoding into ternary form. The data is clocked by the negative-going edge of the Clock (Encoder).

**2. Clock (Encoder)**

Clock for encoding data on pin 1.

**3. LIP**

Loss of input circuit detects eleven consecutive zeros at the decoder input and then gives an output high. Any logic '1' at the input ( $\bar{A}_{IN}$  or  $\bar{B}_{IN} = '0'$ ) resets this count.

**4. NRZ data out**

Decoded binary data from pseudo-ternary inputs  $\bar{A}_{IN}$ ,  $\bar{B}_{IN}$

**5. Clock (Decoder)**

Clock for decoding data on  $\bar{A}_{IN}$  and  $\bar{B}_{IN}$ , or  $O_1$  and  $O_2$  in loop test mode.

**6,7. Reset AIS, AIS**

Logic '0' on Reset AIS resets a decoded zero counter and either resets AIS output to '0' provided 3 or more zeros have been decoded in the preceding Reset AIS = 1 period, or sets AIS to '1' if less than 3 zeros have been decoded in the preceding Reset AIS = 1 period to indicate loss of time slot Zero. Logic '1' on Reset AIS enables the internal decoded zero counter.

**8. Mode**

Mode at logic '1' selects internal crystal controlled clock regeneration and Mode at logic '0' selects external clock regeneration using, for example, a tuned circuit.

**9. Ground**

Zero volts.

**10. Crystal In**

Input to amplifier forming crystal oscillator when crystal is connected between pins 10 and 12. This pin may also be used as a 16.384MHz clock input if one oscillator is to be shared over several HDB3 encoders/decoders.

**11. Error**

A logic '1' indicates that a violation of the HDB3 encoding law has been detected i.e. 3 '1's of the same polarity.

**12. Clock R/Crystal Out**

If pin 8 is at '0' pin 12 is Clock Regenerate, giving OR function of  $\bar{A}_{IN}$ ,  $\bar{B}_{IN}$  for clock regeneration when pin 14 = '0', OR function of  $O_1$ ,  $O_2$  when pin 14 = '1'. If pin 8 is at '1' then pin 12 becomes Crystal Out and forms oscillator with pin 10.

**13,15.  $\bar{A}_{IN}$ ,  $\bar{B}_{IN}$**

Inputs representing the received ternary PCM signal.  $\bar{A}_{IN} = '0'$  represents a positive going '1'.  $\bar{B}_{IN} = '0'$  represents a negative going '1'.  $\bar{A}_{IN}$  and  $\bar{B}_{IN}$  are sampled by the positive going edge of the clock decoder.  $\bar{A}_{IN}$  and  $\bar{B}_{IN}$  may be interchanged.

**14. Loop test enable**

TTL input to select normal or loop back operation. Pin 14 = '0' selects normal operation, encode and decode are independent and asynchronous. When pin 14 = '1'  $O_1$ , is connected internally to  $A_{IN}$  and  $O_2$  to  $B_{IN}$ . Clock R becomes the OR function of  $O_1$ ,  $O_2$ . N.B. A decode clock has to be supplied, or regenerated. The delay from NRZ in (pin 1) to NRZ out (pin 4) is about  $7\frac{1}{2}$  clock periods in loop back.

**16,17.  $O_1$ ,  $O_2$**

Outputs representing the ternary encoded PCM HDB3 signal for line transmission.  $O_1$  and  $O_2$  are in Return to zero form and are clocked out on the positive going edge of the encode clock. The length of  $O_1$  and  $O_2$  pulses is set by the positive clock pulse length. Use suitable line drivers from these two outputs such that  $O_1$  gives positive going pulse and  $O_2$  gives negative going pulse.

**18. +Vcc**

Positive 5V  $\pm$  10% supply.

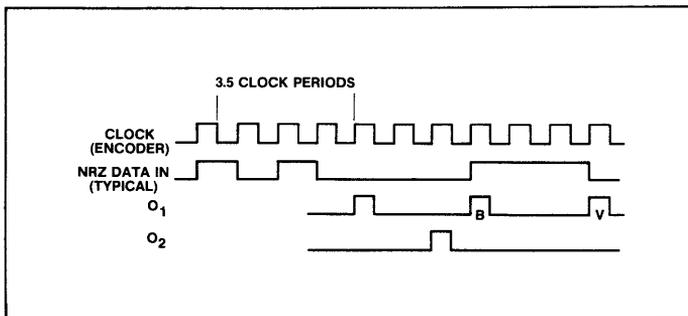


Fig.3 Encode waveforms

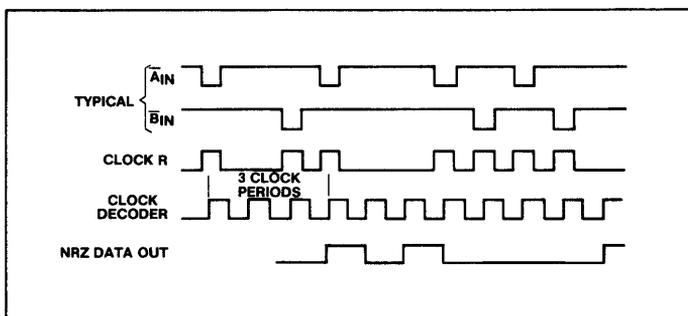


Fig.4 Decode waveforms

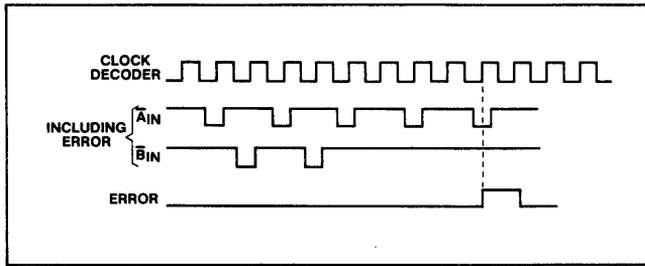


Fig.5 HDB3 error output waveforms

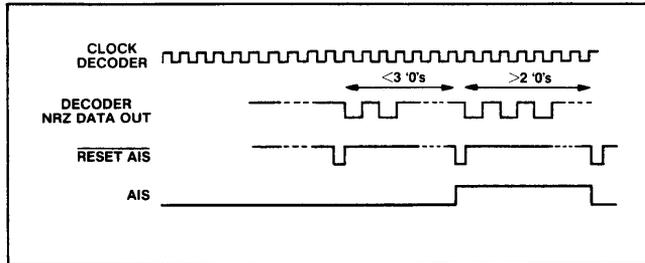


Fig.6 AIS error and Reset waveforms

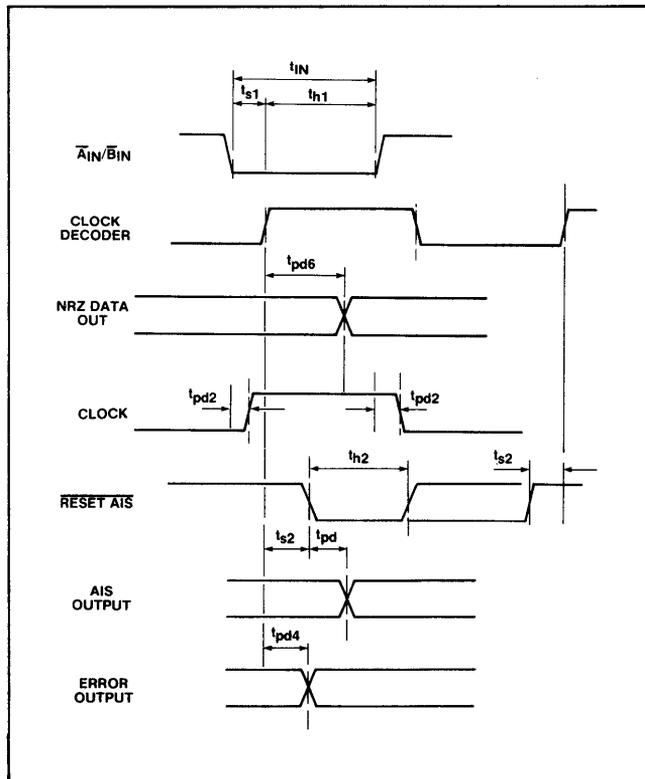


Fig.7 Decoder timing relationship

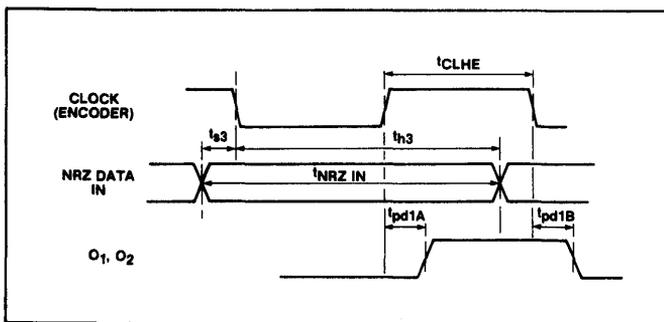


Fig.8 Encoder timing relationship

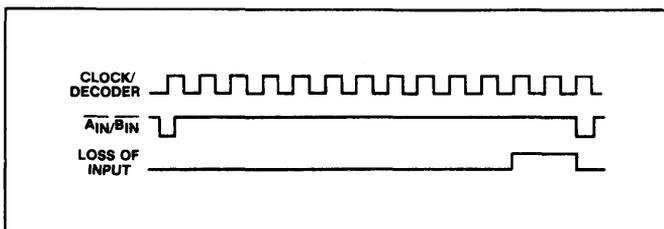


Fig.9 Loss of input waveforms

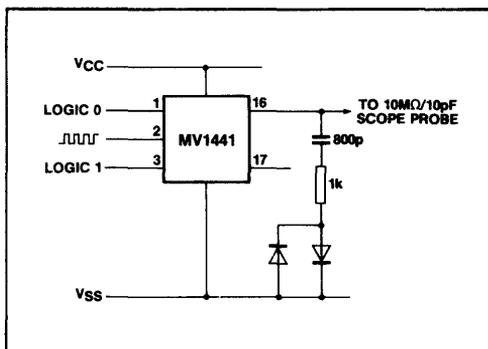


Fig.10

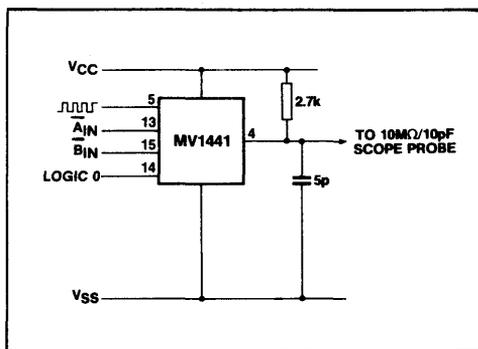


Fig.11

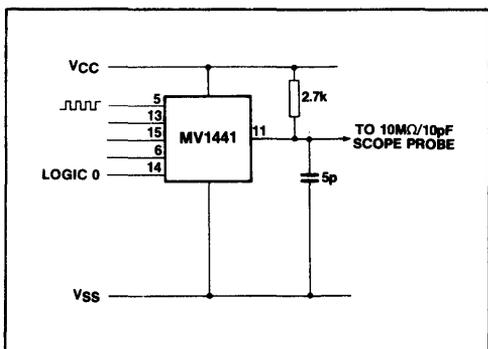


Fig.12

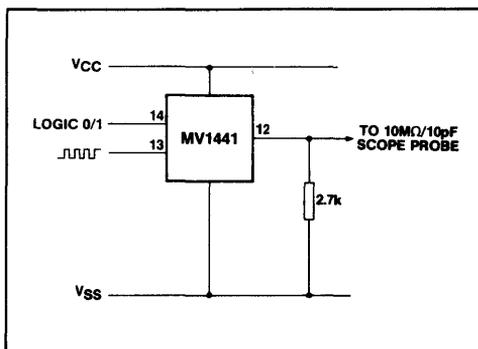


Fig.13

# MV1441

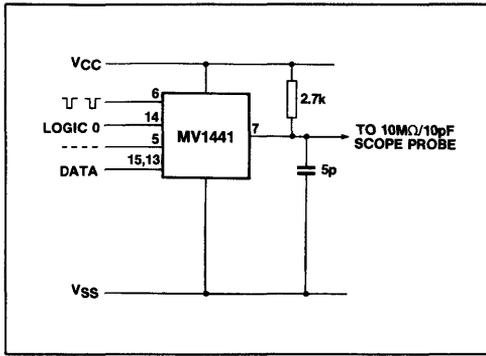


Fig.14

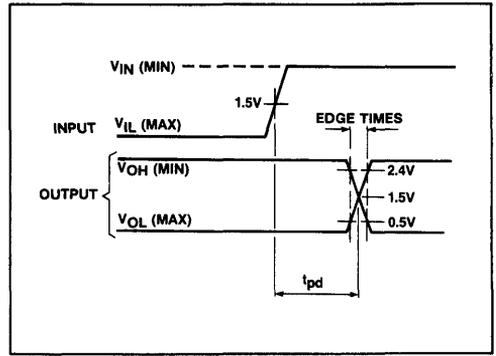


Fig.15 Test timing definitions

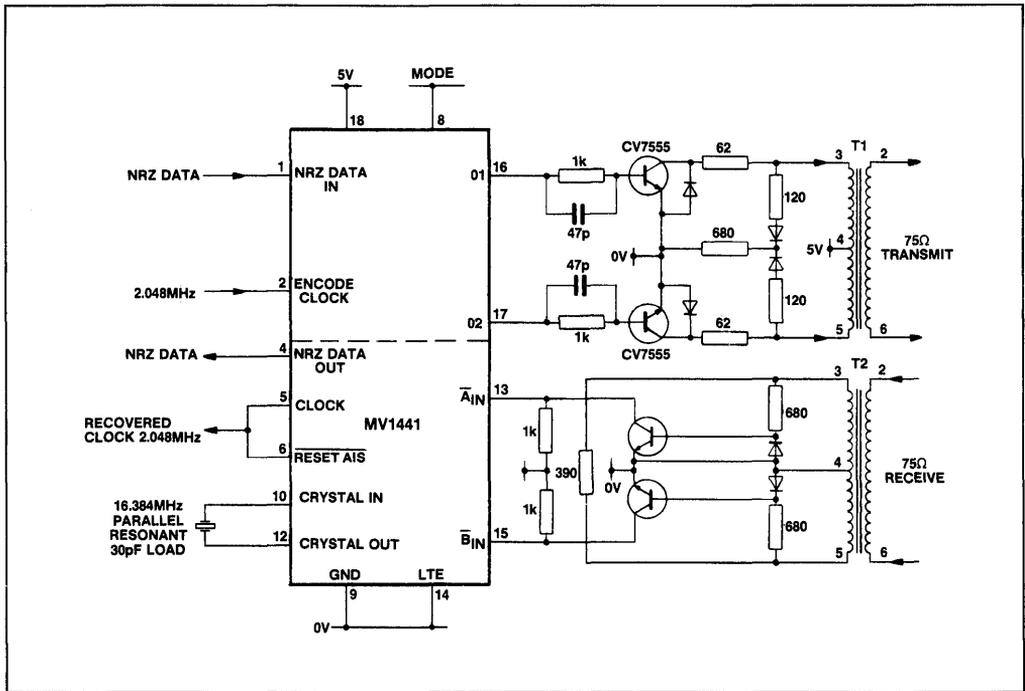


Fig.16 A typical application of the MV1441 with the interfacing to the transmission lines included

Advance information is issued to advise Customers of new additions to the Plessey Semiconductors range which, nevertheless, still have 'pre-production' status. Details given may, therefore, change without notice although we would expect this performance data to be representative of 'full production' status product in most cases. Please contact your local Plessey Semiconductors Sales Office for details of current status.

## 8.5MBIT PCM SIGNALLING CIRCUIT MV1448 HDB3 ENCODER/DECODER

This 8.544MBit PCM Signalling Circuit will perform the signalling and error detection functions for a 8.544MBit PCM transmission link operating to the appropriate CCITT recommendations. The circuit is fabricated in CMOS and operates from a single 5V supply with TTL compatible inputs and outputs.

The MV1448 is an encoder/decoder for the pseudo-ternary transmission code, HDB3 (CCITT Orange Book Vol. III.2 Annex to Rec. G703). The device encodes and decodes simultaneously and asynchronously. Error monitoring functions are provided to detect violations of HDB3 coding, all ones detection and loss of input (all zeros detection). In addition a loop back function is provided for terminal testing.

**FEATURES**

- HDB3 Encoding and Decoding to CCITT rec. G703
- Asynchronous Operation
- Simultaneous Encoding and Decoding
- Clock Recovery Signal Allows Clock Regeneration from Incoming HDB3 Data
- Loop Back Control
- HDB3 Error Monitor
- 'All Ones' Error Monitor
- Loss of Input Alarm (All Zeros Detector)
- Decoded Data in NRZ Form
- Low Power Operation
- 2.048MHz or 8.544MHz Operation

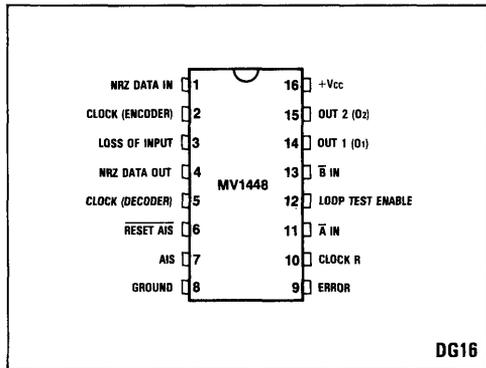


Fig.1 Pin connections - top view

**ABSOLUTE MAXIMUM RATINGS**

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

**Electrical Ratings**

+Vcc -0.5V to +7V  
 Inputs Vcc +0.5V to GND -0.3V  
 Outputs Vcc to GND -0.3V

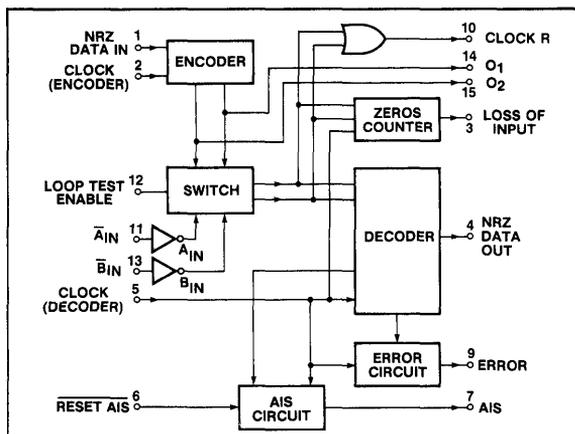


Fig.2 Block diagram

# MV1448

## ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

Supply voltage  $V_{CC} = 5V \pm 0.5V$  Ambient temperature  $T_{amb} = 0^{\circ}C$  to  $+70^{\circ}C$

### Static characteristics

Characteristic	Symbol	Pins	Value			Units	Conditions
			Min.	Typ.	Max.		
Low level input voltage	$V_{IL}$	All inputs	-0.3		0.8	V	
Low level input current	$I_{IL}$				50	$\mu A$	$V_{IL} = 0V$
High level input voltage	$V_{IH}$		2.0		$V_{CC}$	V	
High level input current	$I_{IH}$				50	$\mu A$	$V_{IH} = 5V$
Low level output voltage	$V_{OL}$	All outputs			0.4	V	$I_{sink} = 2.0mA$
High level output voltage	$V_{OH}$		2.8			V	$I_{source} = 2mA$ } both $I_{source} = 1mA$ } apply
Supply current	$I_{CC}$		$V_{CC}-0.75$	2	4	mA	
							All inputs to 0V All outputs open circuit

### Dynamic characteristics

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Max. clock (encoder) frequency	$F_{max_{enc}}$	10			MHz	Figs. 10, 15
Max. clock (decoder) frequency	$F_{max_{dec}}$	10			MHz	Figs. 11, 15
Propagation delay clock encoder to $O_1, O_2$	$tpd1A/B$		50		ns	Figs. 8, 10, 15 See Note 1
Rise and fall times $O_1, O_2$				20	ns	Figs. 10, 15
$tpd1A - tpd1B$ difference				20	ns	Figs. 10, 15
Propagation delay clock to clock regenerate (clock R)	$tpd3$		50		ns	Loop test enable = '1', Figs. 10, 15
Setup time of NRZ data in to clock (encoder)	$ts3$		40		ns	Figs. 7, 10, 15
Hold time of NRZ data in	$th3$		40		ns	Figs. 7, 10, 15
Propagation delay $\bar{A}_{IN}, \bar{B}_{IN}$ to clock regenerate	$tpd2$		50		ns	Loop test enable = '0', Figs. 13, 15
Propagation delay clock (decoder) to error	$tpd4$		50		ns	Figs. 12, 15
Propagation delay Reset AIS falling edge to AIS output	$tpd5$		50		ns	Loop test enable = '0', Figs. 14, 15
Propagation delay clock (decoder) to NRZ data out	$tpd6$		50		ns	Figs. 7, 11, 15 See Note 2
Setup time of $\bar{A}_{IN}, \bar{B}_{IN}$ to clock (decoder)	$ts1$		40		ns	Figs. 7, 11, 15
Hold time of $\bar{A}_{IN}, \bar{B}_{IN}$ to clock (decoder)	$th1$		5		ns	Figs. 7, 11, 15
Hold time of Reset AIS = '0'	$th2$	30			ns	Figs. 7, 14, 15
Setup time clock (decoder) to Reset AIS	$ts2$		50		ns	Figs. 7, 14, 15
Setup time Reset AIS = '1' to clock (decoder)	$ts2$	0			ns	Figs. 14, 15
Propagation delay clock (decoder) to LIP			50		ns	

High Density Bipolar 3 (HDB3) is a pseudo-ternary signal in which the number of consecutive zeros that may occur is restricted to a maximum number of three. In any sequence of four consecutive binary zeros, the ultimate zero is substituted by a 'mark' (+ or -) of the same polarity as the previous mark, i.e. it violates AMI code (Alternate Mark Inversion) and is termed a 'violation'. To ensure parity between marks of opposite polarity, the first zero is substituted by an additional mark when there would otherwise be an even number of marks between 'violations'. Thus violations alternate in polarity.

**FUNCTIONAL DESCRIPTION**

**Functions listed by pin number**

- 1. NRZ data in**  
Input data for encoding into ternary form. The data is clocked by the negative going edge of the Clock (Encoder).
- 2. Clock (Encoder)**  
Clock for encoding data on pin 1.
- 3. LIP**  
Loss if input circuit detects eleven consecutive zeros at the decoder input and then gives an output high. Any logic '1' at the input ( $A_{IN}$  or  $B_{IN} = '0'$ ) resets this count.
- 4. NRZ data out**  
Decoded binary data from pseudo-ternary inputs  $A_{IN}$  and  $B_{IN}$ .
- 5. Clock (Decoder)**  
Clock for decoding data on  $A_{IN}$  and  $B_{IN}$ , or  $O_1$  and  $O_2$  in loop test mode.
- 6,7. Reset AIS, AIS**  
Logic '0' on Reset AIS resets a decoded zero counter and either resets AIS output to '0' provided 3 or more zeros have been decoded in the preceding Reset AIS = 1 period, or sets AIS to '1' if less than 3 zeros have been decoded in the

preceding  $\text{Reset AIS} = 1$  period to indicate loss of time slot zero. Logic '1' on Reset AIS enables the internal decoded zero counter.

- 8. Ground**  
Zero volts.
- 9. Error**  
A logic '1' indicates that a violation of the HDB3 encoding law has been detected i.e. 3 '1's of the same polarity.
- 10. Clock R**  
OR function of  $\bar{A}_{IN}$ ,  $\bar{B}_{IN}$  for clock regeneration when pin 12 = '0'. OR function of  $O_1$ ,  $O_2$  when pin 12 = '1'.
- 11,13.  $\bar{A}_{IN}$ ,  $\bar{B}_{IN}$**   
Inputs representing the received ternary PCM signal.  $\bar{A}_{IN} = '0'$  represents a positive going '1',  $\bar{B}_{IN} = '0'$  represents a negative going '1'.  $\bar{A}_{IN}$  and  $\bar{B}_{IN}$  are sampled by the positive going edge of the clock decoder.  $\bar{A}_{IN}$  and  $\bar{B}_{IN}$  may be interchanged.
- 12. Loop test enable**  
TTL input to select normal or loop back operation. Pin 14 = '0' selects normal operation, encode and decode are independent and asynchronous. When pin 14 = '1'  $O_1$ , is connected internally to  $A_{IN}$  and  $O_2$  to  $B_{IN}$ . Clock R becomes the OR function of  $O_1$ ,  $O_2$ . N.B. A decode clock has to be supplied, or regenerated. The delay from NRZ in (pin 1) to NRZ out (pin 4) is about 6¼ clock periods in loop back.
- 14,15.  $O_1$ ,  $O_2$**   
Outputs representing the ternary encoded PCM HDB3 signal for line transmission.  $O_1$  and  $O_2$  are in Return to zero from and are clocked out on the positive going edge of the encode clock. The length of  $O_1$  and  $O_2$  pulses is set by the positive clock pulse length. Use suitable line drivers from these two outputs such that  $O_1$  gives positive going pulse and  $O_2$  gives negative going pulse.
- 16. +Vcc**  
Positive 5V ± 10% supply.

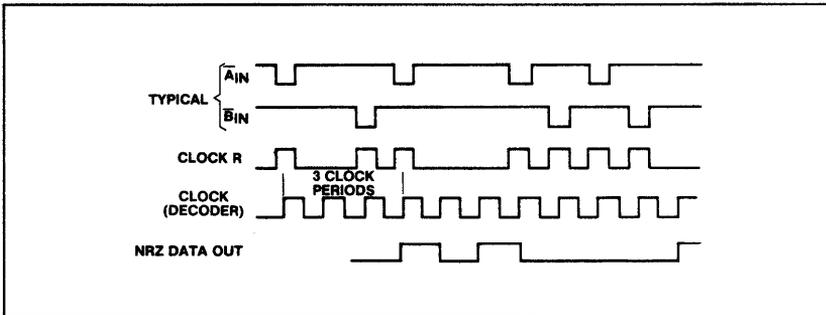


Fig. 3 Decode waveforms

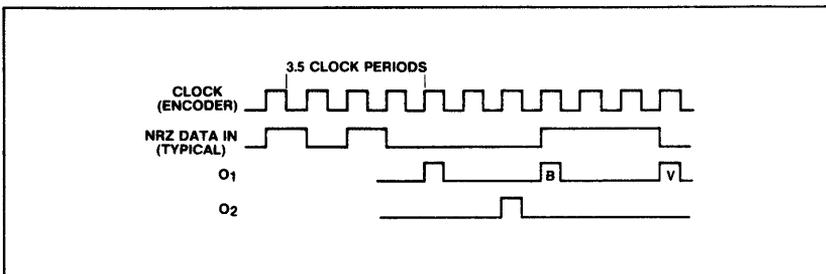


Fig.4 Encode waveforms

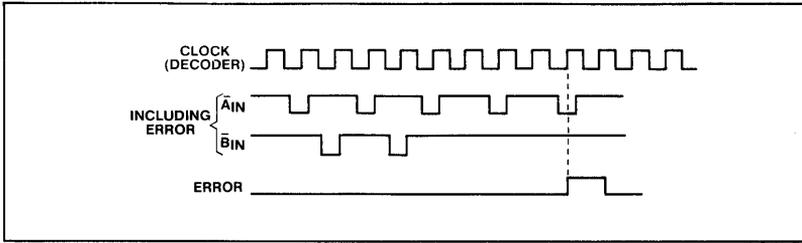


Fig.5 HDB3 error output waveforms

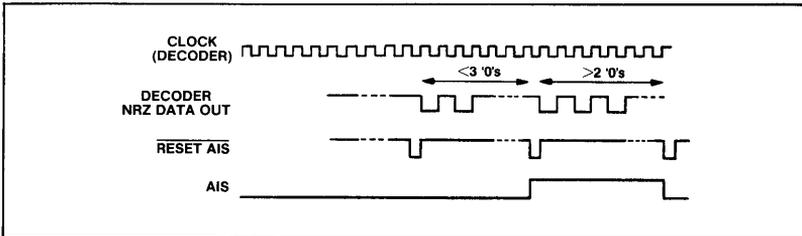


Fig.6 AIS error and Reset waveforms

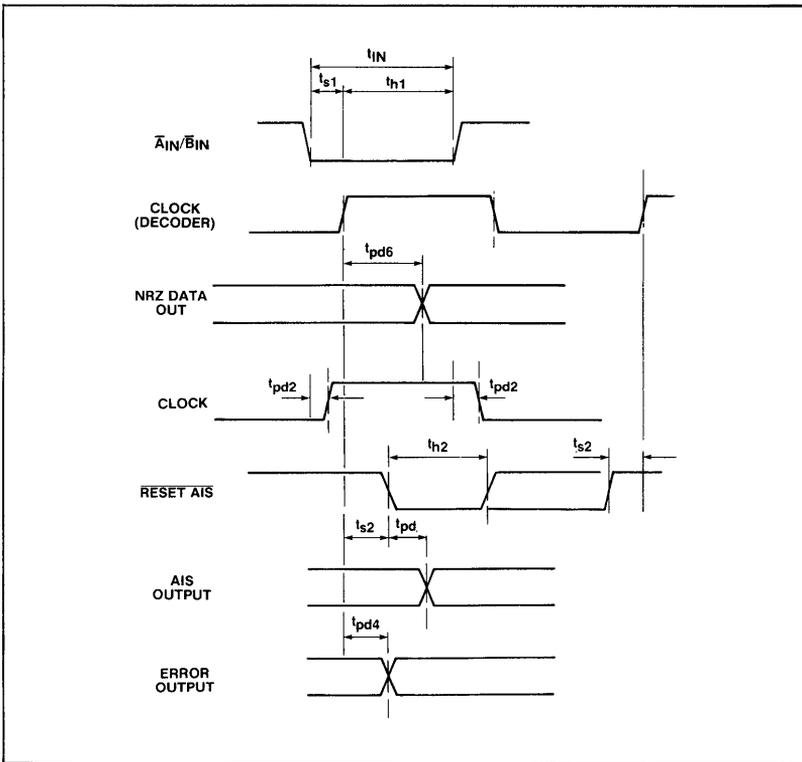


Fig.7 Decoder timing relationship

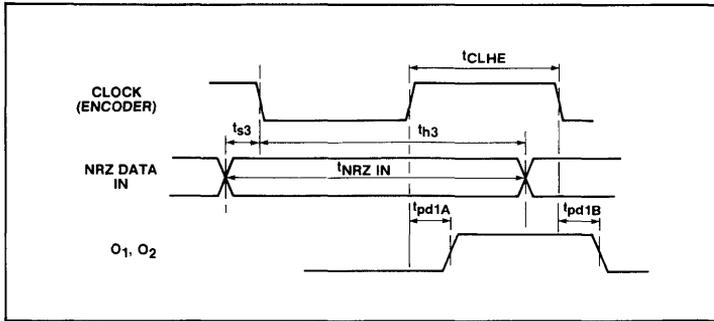


Fig.8 Encoder timing relationship

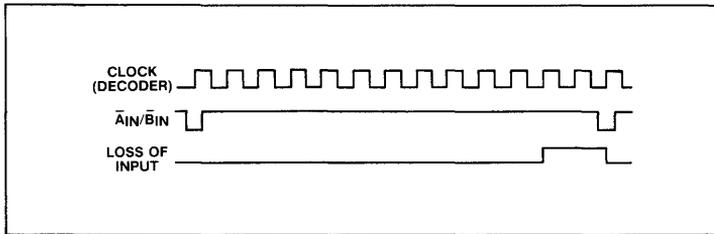


Fig.9 Loss of input waveforms

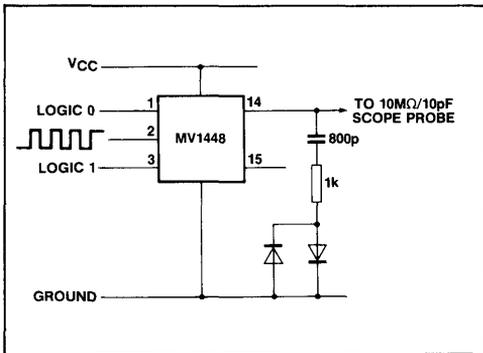


Fig.10

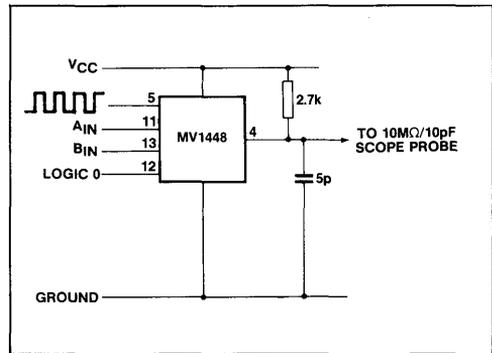


Fig.11

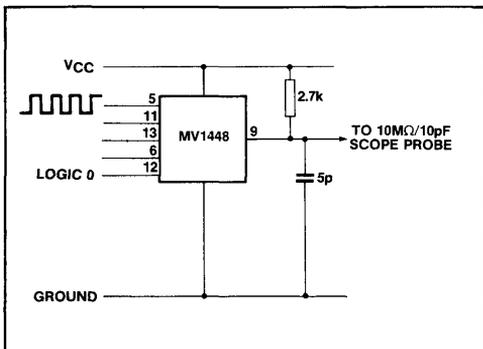


Fig.12

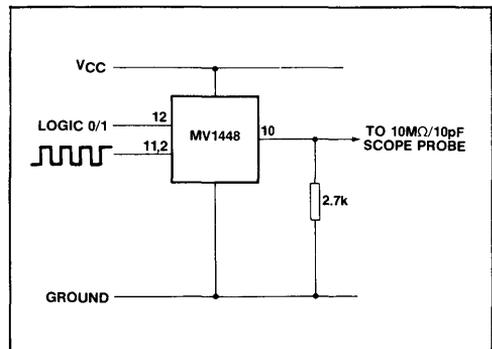


Fig.13

# MV1448

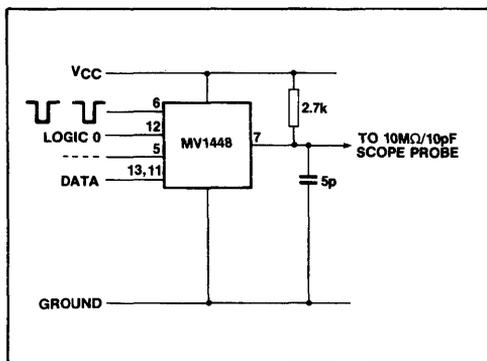


Fig.14

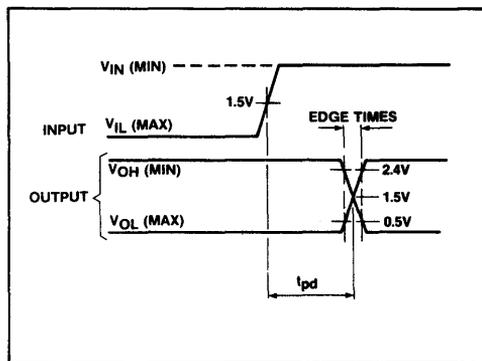


Fig.15 Test timing definitions

## MV3506 A-LAW CODEC WITH FILTER

## MV3507 $\mu$ -LAW CODEC WITH FILTER

## MV3507A $\mu$ -LAW CODEC WITH FILTER AND A/B SIGNALLING

The MV3506 and MV3507 are silicon gate CMOS Companding Encoder/Decoder integrated circuits designed to implement the per channel voice frequency Codecs used in PCM systems. The chips contain the band-limiting filters and the analogue to digital conversion circuits that conform to the desired transfer characteristic. The MV3506 provides the European A-Law companding and the MV3507 provides the North American  $\mu$ -Law companding characteristic.

These circuits provide the interface between the analogue signals of the subscriber loop and digital signals of the PCM highway in a digital telephone switching system. The devices operates from dual power supplies of  $\pm 5V$ .

For a sampling rate of 8kHz, PCM input/output data rate can vary from 64kb/s to 2.1Mb/s. Separate transmit/receive timing allows synchronous or asynchronous operation.

In 22-pin packages (0.400in centres) the MV3506/MV3507 are ideally suited for PCM applications: Exchange, PABX, Channel Bank or Digital Telephone as well as fibre optic and other non-telephone uses. A 28 pin version, the MV3507A, provides standard  $\mu$ -Law A/B signalling capability.

### FEATURES

- Independent Transmit and Receive Sections with 75dB Isolation
- Low power CMOS 80mW (Operating) 10mW (Standby)
- Stable Voltage Reference On-chip
- Meets or Exceeds AT&T D3, and CCITT G.711, G.712 and G.733 Specifications
- Input Analogue Filter Eliminates Need for External Anti-aliasing Prefilter
- Input/Output Op. Amps for Programming Gain
- Output Op. Amp Provides  $\pm 3.1V$  Into a 1200 Ohms load or Can Be Switched Off for Reduced Power (70mW)
- Special Idle Channel Noise Reduction Circuitry
- Encoder has Dual-speed Auto-zero Loop for Fast Acquisition on Power-up
- Low Absolute Group Delay = 410 $\mu$ sec. at 1kHz

### ABSOLUTE MAXIMUM RATINGS

DC Supply Voltage  $V_{DD}$ : +6.0V  
 DC Supply Voltage  $V_{SS}$ : -6.0V  
 Operating Temperature: -40°C to +125°C  
 Storage Temperature: -65°C to +150°C  
 Power Dissipation at 25°C: 1000mW  
 Digital Input:  $V_{SS} - 0.3 \leq V_{IN} \leq V_{DD} - 0.3$   
 Analogue Input:  $V_{SS} - 0.3 \leq V_{IN} \leq V_{DD} - 0.3$

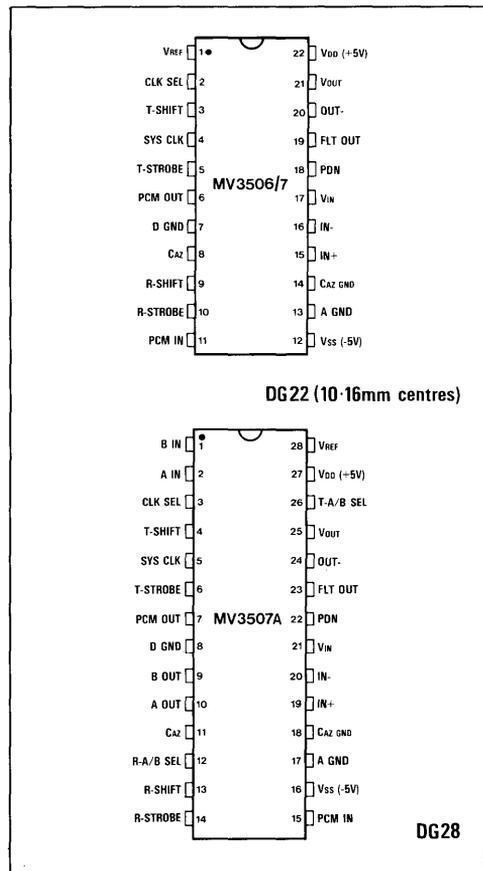


Fig.1 Pin connections - top view

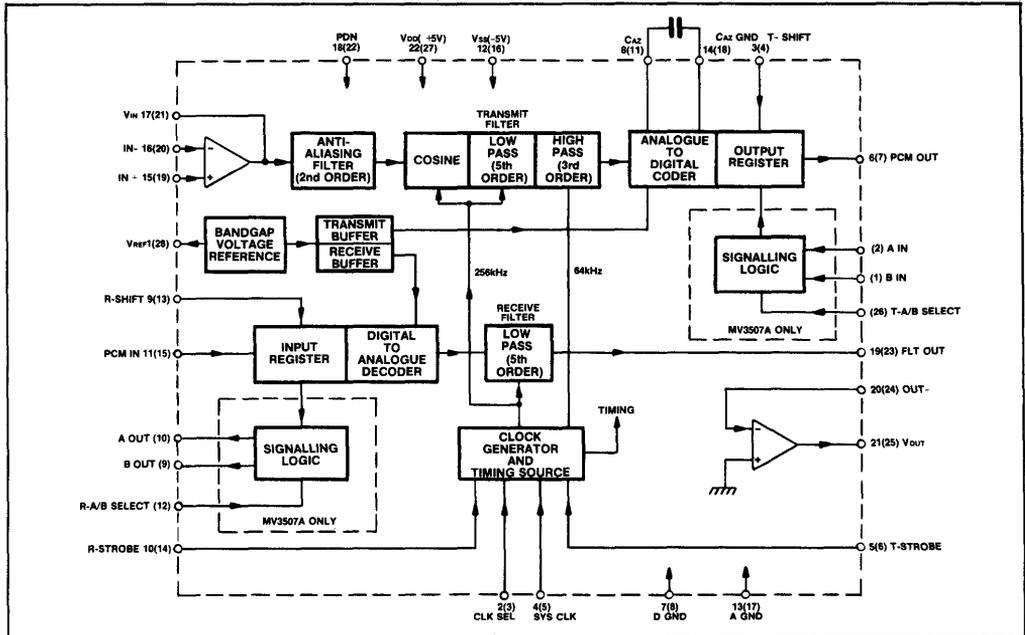


Fig.2 MV3506/MV3507/MV3507A block diagram. Pin numbers for the MV3507A are shown in brackets.

**ELECTRICAL CHARACTERISTICS**

Test conditions (unless otherwise stated):

T<sub>amb</sub> = 0° C to +70° C

**Power Supply Requirements**

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Positive supply	V <sub>DD</sub>	4.75	5.0	5.25	V	} V <sub>DD</sub> = 5.0V, V <sub>SS</sub> = -5.0V
Negative supply	V <sub>SS</sub>	-4.75	-5.0	-5.25	V	
Power dissipation (operating)	P <sub>OPR</sub>		80	110	mW	
Power dissipation (operating w/o output op. amp)	P <sub>OPR</sub>		70		mW	
Power dissipation (standby)	P <sub>STBY</sub>		10	20	mW	

**AC Characteristics (see Fig. 6)**

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
System clock duty cycle	D <sub>sys</sub>	40	50	60	%	At 1.544MHz or 2.048MHz
Shift clock frequency	f <sub>sc</sub>	0.064		2.048	MHz	
Shift clock duty cycle	D <sub>sc</sub>	40	50	60	%	At 2.048MHz, 700ns min at 1.544MHz
Shift clock rise time	t <sub>rc</sub>			100	ns	
Shift clock fall time	t <sub>fc</sub>			100	ns	
Strobe rise time	t <sub>rs</sub>			100	ns	
Strobe fall time	t <sub>fs</sub>			100	ns	
Shift clock to strobe (On) delay	t <sub>sc</sub>	-100	0	200	ns	
Strobe width	t <sub>sw</sub>	600ns		124.3µs		
Shift clock to PCM out delay	t <sub>cd</sub>		100	150	ns	
Shift clock to PCM in set-up time	t <sub>dc</sub>	60			ns	
PCM output rise time C <sub>L</sub> = 100pF	t <sub>rd</sub>		50	100	ns	
PCM output fall time C <sub>L</sub> = 100pF	t <sub>fd</sub>		50	100	ns	
A/B select to strobe trailing edge	t <sub>dss</sub>	100			ns	

DC Characteristics at  $V_{DD} = +5V$ ,  $V_{SS} = -5V$ ,  $V_{ref} = -3.075V$ 

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Analogue input resistance	$R_{INA}$	100			$k\Omega$	All logic and analogue inputs $V_{IL} = 0.8V$ $V_{IH} = 2.0V$ $V_{IL} = 0.8V$ $V_{IH} = 2.0V$ 510 $\Omega$ pull-up to $V_{DD}$ + 2 LS TTL $I_{OL} = 1.6mA$ $I_{OH} = 40\mu A$ $C_L = 50pF$ max.
Input capacitance	$C_{IN}$		7	15	$pF$	
Logic input low current (Shift clock, PCM IN, System clock)	$I_{INL}$			1	$\mu A$	
Logic input high current	$I_{INH}$			1	$\mu A$	
Logic input low current (Strobe, A/B Sel, A IN B IN, PDN)	$I_{INL}$			600	$\mu A$	
Logic input high current	$I_{INH}$			600	$\mu A$	
Logic input 'low' voltage	$V_{IL}$			0.8	V	
Logic input 'high' voltage	$V_{IH}$	2.0			V	
Logic output 'low' voltage (PCM out)	$V_{OL}$			0.4	V	
Logic output 'low' voltage (A/B out)	$V_{OL}$			0.4	V	
Logic output 'high' voltage	$V_{OH}$	2.6			V	
Output load resistance $V_{OUT}$	$R_L$	1200			$\Omega$	

## Transmission Delays

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Encoder			125		$\mu s$	From $T_{STROBE}$ to the start of digital transmitting $T =$ Period in $\mu s$ of $R_{SHIFT}$ CLOCK At 1kHz
Decoder		30	8T + 25		$\mu s$	
Transmit section filter				182	$\mu s$	
Receive section filter				110	$\mu s$	

## MV3506 Single-Chip A-Law Filter/Codec Linear Characteristics

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Idle channel noise (weighted noise)	$ICN_w$		-85	-73	$dBm_0p$	CCITT G.712 5.1
Idle channel noise (single frequency noise)	$ICN_{SF}$			-60	$dBm_0$	CCITT G.712 5.2
Idle channel noise (receive section)	$ICN_R$			-78	$dBm_0p$	CCITT G.712 5.3
Spurious out-of-band signals at the channel output				-30	$dBm_0$	CCITT G.712 7.1
Intermodulation (2 tone method)	$IMD_{2F}$			-35	$dBm_0$	CCITT G.712 8.1
Intermodulation (1 tone + power frequency)	$IMD_{PF}$			-49	$dBm_0$	CCITT G.712 8.2
Spurious in-band signals at the channel output port				-40	$dBm_0$	CCITT G.712 10
Inter-channel crosstalk $V_{IN-VOUT}$		75	80		$dB$	CCITT G.712 12
Max.coding analogue input level	$V_{IN(max)}$		$\pm 3.1$		$V_{Opk}$	$R_L = 1.2k\Omega$
Max.coding analogue output level	$V_{OUT(max)}$		$\pm 3.1$		$V_{Opk}$	
Gain variation with temperature and power supply	$\Delta G$		$\pm 0.25$		$dB$	
Transmit gain repeatability			$\pm 0.1$	$\pm 0.2$	$dB$	
Receive gain repeatability			$\pm 0.1$	$\pm 0.2$	$dB$	
Zero transmission level point (decoder) (see Fig. 3)	$0TLP_R$		+5.8		$dBm$	$V_{OUT}$ digital milliwatt response
Zero transmission level point (encoder)	$0TLP_T$		+5.8		$dBm$	$V_{IN}$ to yield same as digital milliwatt response at decoder

# MV3506/3507/3507A

## MV350(7)A Single-Chip $\mu$ -Law Filter/Codec Linear Characteristics

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Idle channel noise (weighted noise)	ICN <sub>w</sub>		5	17	dBrnc0	CCITT G.712 5.1
Idle channel noise (single frequency noise)	ICN <sub>sf</sub>			-60	dBm0	CCITT G.712 5.2
Idle channel noise (receive section)	ICN <sub>R</sub>			15	dBrnc0	CCITT G.712 5.3
Spurious out-of-band signals at the channel output				-28	dBm0	CCITT G.712 7.1
Intermodulation (2 tone method)	IMD <sub>2F</sub>			-35	dBm0	CCITT G.712 8.1
Intermodulation (1 tone + power frequency)	IMD <sub>PF</sub>			-49	dBm0	CCITT G.712 8.2
Spurious in-band signals at the channel output port				-40	dBm0	CCITT G.712 10
Inter-channel crosstalk V <sub>IN</sub> -V <sub>OUT</sub>		75	80		dB	CCITT G.712 12
Max.coding analogue input level	V <sub>IN(max)</sub>		±3.1		V <sub>0pk</sub>	
Max.coding analogue output level	V <sub>OUT(max)</sub>		±3.1		V <sub>0pk</sub>	R <sub>L</sub> = 1.2k $\Omega$
Gain variation with temperature and power supply	$\Delta G$		±0.25		dB	
Transmit gain repeatability			±0.1	±0.2	dB	
Receive gain repeatability			±0.1	±0.2	dB	
Zero transmission level point (decoder) (see Fig. 3)	OTL <sub>P<sub>R</sub></sub>		+5.8		dBm	V <sub>OUT</sub> Digital milliwatt response
Zero transmission level point (encoder)	OTL <sub>P<sub>T</sub></sub>		+5.8		dBm	V <sub>IN</sub> to yield same as digital milliwatt response at decoder

## PIN/FUNCTION DESCRIPTIONS

Name	Pin		Description
	MV3506/ MV3507	MV3507A	
<b>SYS CLK</b>	4	5	<b>System Clock</b> This pin is a TTL compatible input for either a 1.544MHz or a 2.048MHz clock that is divided down to provide the filter clocks. The status of CLK SEL pin must correspond to the provided clock frequency.
<b>T-SHIFT</b>	3	4	<b>Transmit Shift Clock</b> This TTL compatible input shifts PCM data out of the coder on the positive going edges after receiving a positive edge on the T-STROBE input. The clocking rate can vary from 64kHz to 2.048MHz.
<b>R-SHIFT</b>	9	13	<b>Receive Shift Clock</b> This TTL compatible input shifts PCM data into the decoder on the negative going edges after receiving a positive edge on the R-STROBE input. The clocking rate can vary from 64kHz to 2.048MHz.
<b>T-STROBE</b>	5	6	<b>Transmit Strobe</b> This TTL compatible pulse input (8kHz) is used for analogue sampling and for initiating the PCM output from the coder. It must be synchronised with the T-SHIFT clock with its positive going edges occurring after the falling edge of the shift clock. The width of this signal is not critical. An internal bit counter generates the necessary timing for PCM output.
<b>R-STROBE</b>	10	14	<b>Receive Strobe</b> This TTL compatible pulse input (typ. 8kHz) initiates clocking of PCM input data into the decoder. It must be synchronised with the R-SHIFT clock with its positive going edges occurring after the falling edge of the shift clock. The width of the signal is not critical. An internal bit counter generates necessary timing for PCM input.
<b>CLK SEL</b>	2	3	<b>Clock Select</b> This pin selects the proper divide ratios to utilise either 1.544MHz or 2.048MHz as the system clock. The pin is tied to V <sub>DD</sub> (+5V) for 2.048MHz and to V <sub>SS</sub> (-5V) for 1.544MHz operation. If this pin is connected to DGND, 256kHz may be used as the system clock.
<b>PCM OUT</b>	6	7	<b>PCM Output</b> This is a LS TTL compatible open-drain output. It is active only during transmission of PCM output for 8-bit periods of T-SHIFT clock signal following a positive edge on the T-STROBE input. Data is clocked out by the positive edge of the T-SHIFT clock into one 510 $\Omega$ pull-up per system plus 2 LS TTL inputs.
<b>PCM IN</b>	11	15	<b>PCM Input</b> This is a TTL compatible input for supplying PCM input data to the decoder. Data is clocked in by the negative edge of T-SHIFT clock.

## PIN/FUNCTION DESCRIPTIONS

Name	Pin		Description
	MV3506/ MV3507	MV3507A	
<b>CAZ</b>	8	11	<b>Auto Zero Capacitor</b> A capacitor of $0.1\mu\text{F} \pm 20\%$ should be connected between these pins for coder auto zero operation. Sign bit of the PCM data is integrated and fed back to the comparator for DC offset cancellation.
<b>CAZGND</b>	14	18	
<b>VREF</b>	1	28	Output of the internal <b>Band-gap Reference Voltage</b> ( $-3.075\text{V}$ ) generator is brought out to VREF pin.
<b>IN +</b>	15	19	<b>Analogue input.</b> IN- and IN + are the inputs of a high input impedance op. amp and VIN is the output of this op. amp. These three pins allow the user complete control over the input stage so that it can be connected as a unity gain amplifier, amplifier with gain, amplifier with adjustable gain or as a differential input amplifier. The adjustable gain configuration will facilitate calibration of the transmit channel.
<b>IN-</b>	16	20	
<b>VIN</b>	17	21	
<b>FLT OUT</b>	19	23	<b>Filter Out</b> This is the output of the low pass filter which represents the recreated analogue signal from the received PCM data words. The filter sample frequency of $256\text{kHz}$ is down $37\text{dB}$ at this point. This is a high impedance output which can be used by itself or connected to the output amplifier stage which has a low output impedance. It should not be loaded by less than $20\text{k}\Omega$ .
<b>OUT-</b>	20	24	<b>Output and input of the uncommitted output amplifier stage.</b> Signal at the FLT OUT pin can be connected to this amplifier to realise a low output impedance with unity gain, increased gain or reduced gain. This allows easier calibration of the receive channel. The Vout pin has the capability of driving $0\text{dBm}$ into $600\Omega$ load. (See Fig. 3.) If OUT- is connected directly to Vss the op. amp will be powered down, reducing power consumption by $12\text{mW}$ , typically.
<b>Vout</b>	21	25	
<b>VDD</b>	22	27	<b>Power supply pins.</b> VDD and Vss are positive and negative supply pins, respectively (typ. $+5\text{V}$ , $-5\text{V}$ ).
<b>Vss</b>	12	16	
<b>A GND</b>	13	17	<b>Analogue and Digital Ground pins</b> are separate for minimising crosstalk and digital interference.
<b>D GND</b>	7	8	
<b>PDN</b>	18	22	<b>Power Down</b> This TTL compatible input when held low puts the chip into the powered down mode regardless of strobes. The chip will also power down if the strobes stop. The strobes can be high, low or floating, but as long as they are static, the powered down mode is in effect.
<b>A IN</b>		2	The <b>Transmit A/B select</b> input (T-A/B SEL) selects the <b>A signal</b> input in a positive transition and the <b>B signal</b> input on the negative transition. These inputs are TTL compatible. The A/B signalling bits are sent in bit 8 of the PCM word in the frame following the frame in which T-A/B SEL input makes a transition. A common A/B select input can be used for all channels in a multiplex operation, since it is synchronised to the T-STROBE input in each device.
<b>B IN</b>		1	
<b>T-A/B SEL</b>		26	
<b>A OUT</b>		10	In the decoder the A/B signalling bits received in the PCM input word are latched to the respective outputs in the same frame in which the <b>Receive A/B select</b> ( <b>R-A/B SEL</b> ) input makes a transition. A bit is latched on a positive transition and B bit is latched on a negative transition. A common A/B select input can be used for all channels in a multiplex operation.
<b>B OUT</b>		9	
<b>R-A/B SEL</b>		12	

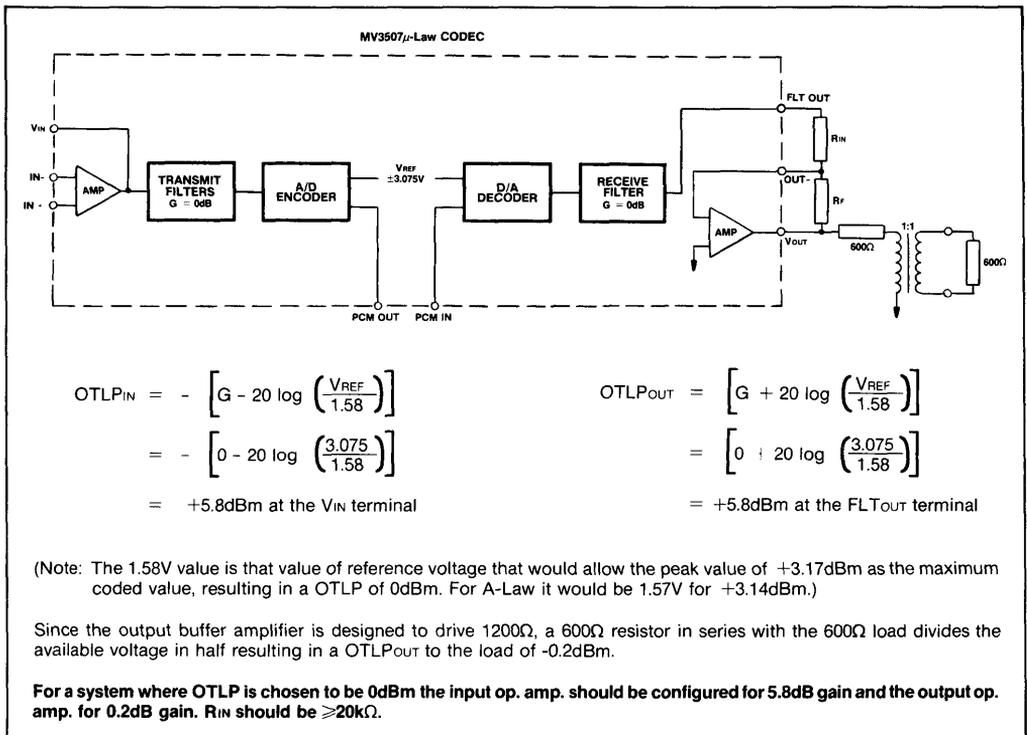


Fig.3 MV3507 and MV3507A μ-law Codec input/output reference signal levels

**Power Down Logic**

Powering down the Codec can be done in several ways. The most direct is to drive the PDN pin to a low level. Stopping both the transmit strobe and the receive strobe will also put the chip into the stand-by mode. The strobes can be held high, low or disconnected.

**Voltage Reference Circuitry**

A temperature compensated band-gap voltage generator (-3.075V) provides a stable reference for the coder and decoder. Two amplifiers buffer the reference and supply the coder and decoder independently to minimise crosstalk. This reference voltage is trimmed to within ±27mV during assembly to ensure a minimum gain error of ±0.2dB due to all causes.

**FUNCTIONAL DESCRIPTION**

Figure 2 shows the simplified block diagram of the MV3506/MV3507. The device contains independent circuitry for processing transmit and receive signals. Switched capacitor filters provide the necessary bandwidth limiting of voice signals in both directions. Circuitry for coding and decoding operates on the principle of successive approximation, using charge redistribution in a binary weighted capacitor array to define segments and a resistor chain to define steps. A band-gap voltage generator supplies the reference level for the conversion process.

**Transmit Section**

Input analogue signals first enter the chip at the uncommitted op. amp terminals. This op. amp allows gain trim to be used to set OTLP in the system. From the V<sub>IN</sub> pin the signal enters the 2nd Order analogue anti-aliasing filter. This filter eliminates the need for any off-chip filtering as it provides attenuation of 34dB (typ) at 256kHz and 44dB (typ)

at 512kHz. From the cosine filter the signal enters a 5th Order low-pass filter clocked at 256kHz, followed by a 3rd Order high-pass filter clocked at 64kHz. The resulting band-pass characteristics meet the CCITT G.711, G.712 and G.733 specifications. Some representative attenuations are 26dB (typ) from 0 to 60Hz and 35dB (typ) from 4.6kHz to 100kHz. The output of the high pass filter is sampled by a capacitor array at the sampling rate of 8kHz. The polarity of the incoming signal selects the appropriate polarity of the reference voltage. The successive approximation analogue-to-digital conversion process requires 9 1/2 clock cycles, or about 72μs. The 8 bit PCM data is clocked out by the transmit shift clock which can vary from 64kHz to 2.048MHz. A switched capacitor dual-speed, auto-zero loop using a small non-critical external capacitor (0.1μF) provides DC offset cancellation by integrating the sign bit of the PCM data and feeding it back to the non-inverting input of the comparator.

Included in the circuitry of the MV3507 is 'All Zero' code suppression so that negative input signal values between decision values numbers 127 and 128 are encoded as 00000010. This prevents loss of repeater synchronisation by T1 line clock recovery circuitry as there are never more than 15 consecutive zeroes.

An additional feature of the Codec is a special circuit to eliminate any transmitted idle channel noise during quiet periods. When the input of the chip is such that for 250ms the only code words generated were +0, -0, +1 or -1, the output word will be a +0. The steady +0 state prevents alternating sign bits or LSB from toggling and thus results in a quieter signal at the decoder. Upon detection of a different value, the output resumes normal operation resetting the 250ms timer. This feature is a form of Idle Channel Noise 'Squelch' or 'Crosstalk Suppression'. It is of particular importance in the MV3506 A-Law version because the A-Law transfer characteristic has 'mid-riser' bias which enhances low level signals from crosstalk.

**Receive Section**

A receive shift clock, variable between the frequencies of 64kHz to 2.048MHz, clocks the PCM data into the input buffer register once every sampling period. A charge proportional to the received PCM data word appears on the decoder capacitor array. A sample and hold initialised to zero by a narrow pulse at the beginning of each sampling period integrates the charge and holds for the rest of the sampling period. A switched-capacitor 5th Order low-pass filter clocked at 256kHz smooths the sampled and held signal. It also performs the loss equalisation to compensate for the  $\sin x/x$  distortion due to the sample and hold operation. The filter output is available for driving electronic hybrids directly as long as the impedance is greater than 20k $\Omega$ . When used in this fashion the low impedance output amp can be switched off for a considerable savings in power consumption. When it is required to drive a 600 $\Omega$  load the output is configured as shown in Fig. 3 allowing gain trimming as well as impedance matching. With this configuration a transmission level of 0dBm can be delivered into the load with the +3.14dB or +3.17dB overload level being the maximum expected level.

**Timing Requirements**

The internal design of the Single-Chip Codec paid careful attention to the timing requirements of various systems. In North America, central office and channel bank designs follow the American Telephone and Telegraph Company's T1 Carrier PCM format to multiplex 24 voice channels at a data rate of 1.544Mb/s. PABX designs, on the other hand, may use their own multiplexing formats with different data rates. Nevertheless, in digital telephone designs, Codec's may be used in a non-multiplexed form with a data rate as low as 64kb/s. The MV3507 and MV3507A fulfil these requirements.

In Europe, telephone exchange and channel bank designs follow the CCITT carrier PCM format to multiplex 30 voice channels at a data rate of 2.048Mb/s. The MV3506 is designed for this market and will also handle PABX and digital telephone applications requiring the A-Law transfer characteristics.

The timing format chosen for the Plessey Codec allows operation in both multiplexed or non-multiplexed form with data rates variable from 64kb/s to 2.048Mb/s. Use of separate internal clocks for filters and for shifting of PCM input/output data allows the variable data rate capability. Additionally, the MV3506/MV3507 does not require that the 8kHz transmit and receive sampling strobes be exactly 8 bit periods wide. The device has an internal bit counter that counts the number of data bits shifted. It is reset on the leading (+)edges of the strobe, forcing the PCM output in high impedance state after the 8th bit is shifted out. This allows the strobe signal to have any duty cycle as long as its repetition rate is 8kHz and transmit/receive shift clocks are synchronised to it. Figures 4 and 5 show the waveforms in typical multiplexed uses of the Codec.

**System Clock**

The basic timing of the Codec is provided by the system clock. This 2.048MHz or 1.544MHz clock is divided down internally to provide the various filter clocks and the timing for the conversions. In most systems this clock will also be used as the shift clock to clock in and out the data. However, the shift clock can actually be any frequency between 64kHz and 2.048MHz as long as one of the two system clock frequencies is provided. Independent strobes and shift clocks allow asynchronous operation of transmit and receive.

**Signalling in  $\mu$ -Law Systems**

The MV3506 and MV3507 are compact 22-pin devices to meet the two worldwide PCM standards. In  $\mu$ -Law systems there can be a requirement for signalling information to be carried in the bit stream with the coded analogue data. This coding scheme is sometimes called 7 5/6 bit rather than 8 bit because of the LSB every 6th frame being replaced by a signalling bit. This is referred to as A/B Signalling and if a signalling frame carries the 'A' bit, then 6 frames later the LSB will carry the 'B' bit. To meet this requirement, the MV3507A is available in a 28-pin package, as 6 more pins are required for the inputs and outputs of the A/B signalling.

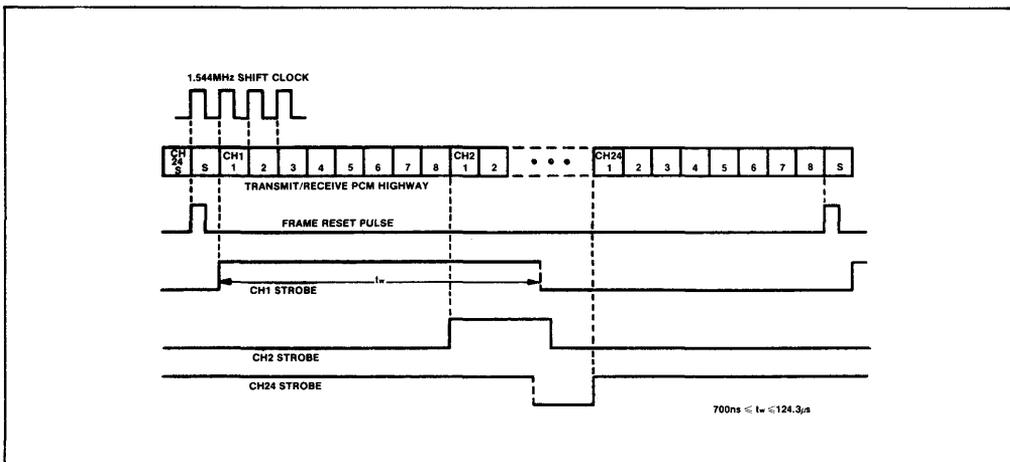


Fig.4 Waveforms in a 24 channel PCM system

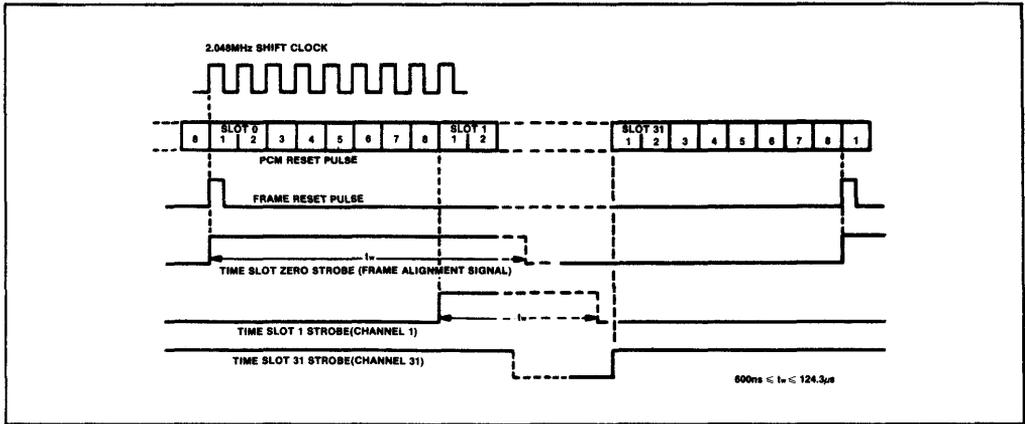


Fig.5 Waveforms in a 30 channel PCM system

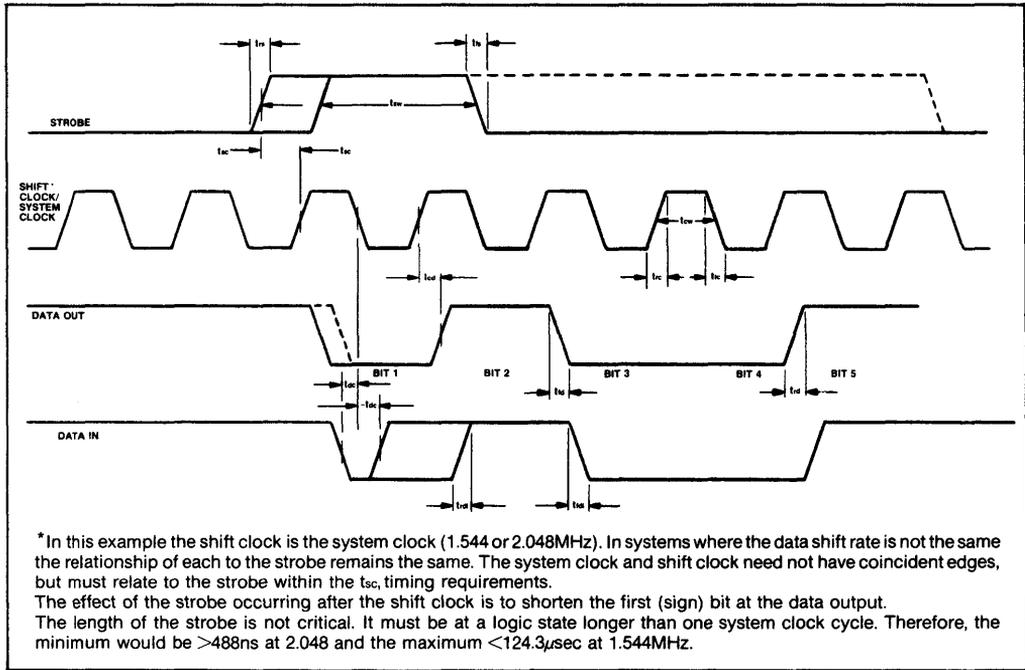


Fig.6 Waveform details

	Min.	Max.
$t_{cw}$	195nsec	9.38µsec
$t_{rs}$		100ns
$t_{ts}$		100ns
$t_{sc}$	-100ns	200ns**
$t_{rc}$		100ns
$t_{fc}$		100ns
$t_{sw}$	600ns*	124.3µsec
$t_{cd}$	100ns	150ns
$t_{dc}$	60ns	
$t_{rdi}$		100ns
$t_{tdi}$		100ns

\* At 2.048MHz, 700ns at 1.544MHz  
 \*\* That is, the strobe can produce the shift clock by 200ns, or follow it by as much as 100ns.

### Signalling Interface

In the AT&T T1 carrier PCM format an A/B signalling method conveys channel information. It might include the on-or-off hook status of the channel, dial pulsing (10 or 20 pulses per second), loop closure, ring ground, etc., depending on the application. Two signalling conditions (A and B) per channel, giving four possible signalling states per channel are repeated every 12 frames (1.5 milliseconds). The A signalling condition is sent in bit 8 of all 24 channels in frame 6. The B signalling conditions is sent in frame 12. In each frame, bit 193 (the S bit) performs the terminal framing function and serves to identify frames 6 and 12.

The MV3507A in a 28-pin package is designed to simplify the signalling interface. For example, the A/B select input pins are transition sensitive. The Transmit A/B select pin selects the A signal input on a positive transition and the B

signal input on the negative transition. Internally, the device synchronises the A/B select input with the strobe signal. As a result, a common A/B select signal can be used for all 24 transmit channels in the channel bank. The A and B signalling bits are sent in the frame following the frame in which the A/B select input makes the transition. Therefore, A/B select input must go positive in the beginning of frame 5 and negative in the beginning of frame 11 (see Fig. 7).

The decoder uses a similar scheme for receiving the A and B signalling bits, with one difference. They are latched to the respective outputs in the same frame in which the A/B select input makes a transition. Therefore, the Receive A/B select input must go high at the beginning of frame 6 and go low at the beginning of frame 12.

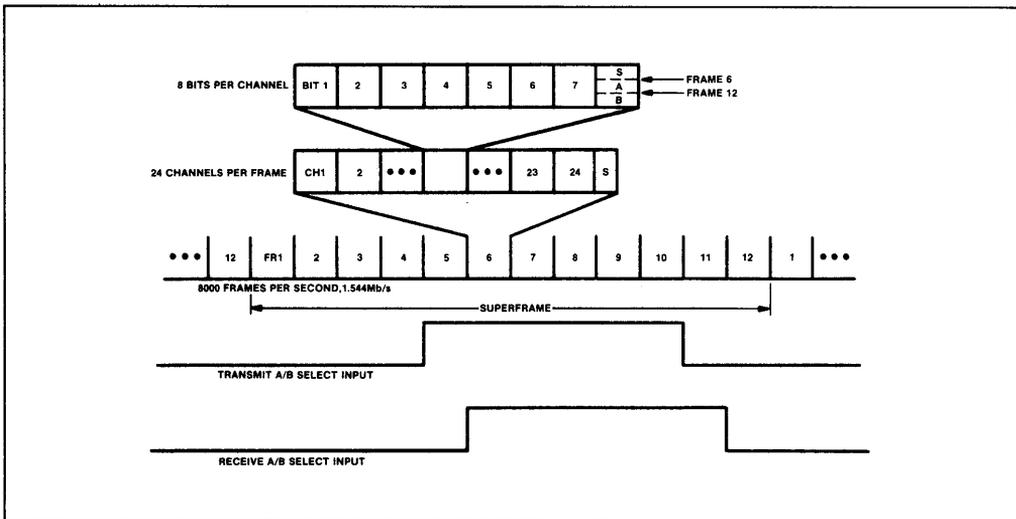


Fig.7 Signalling waveforms in a T1 carrier system

In the T1 carrier system, 24 voice channels are multiplexed to form the transmit and receive PCM highways, 8 data bits from each channel plus a framing bit called the S bit form a 193 bit frame. Since each channel is sampled 8000 times per second, the resultant data rate is 1.544Mb/s. Within the channel bank the transmit and receive channels of a Codec can occupy the same time slot for a synchronous operation or they can be independent of each other for asynchronous operation. Asynchronous operation helps minimise switching delays through the system. Since the timing interface for the coder and decoder sections is independent of each other in the MV3507A, it can be operated in either manner.

In the CCITT carrier system 30 voice channels and 2 framing and signalling channels are multiplexed to form the transmit and receive PCM highways, 8 data bits from each channel. Since each channel is sampled 8000 times per

second, the resultant data rate is 2.048Mb/s.

The line supervision and control circuitry within each subscriber line interface can generate all the timing signals for the associated Codec under control of a central processor. Alternatively, a common circuitry within the channel bank can generate the timing signals for all channels. Generation of the timing signals for the MV3506 and MV3507A is straightforward because of the simplified timing requirements (see timing requirements for details). Figures 9 and 10 show design schemes for generating these timing signals in a common circuitry. Note that only three signals; a shift clock, a frame reset pulse (coincident with the S bit) and a superframe reset pulse (coincident with the S bit in Frame 1) are needed. These signals are generated by clock recovery circuitry in the channel bank. Since the Plessey Codec does not need channel strobes to be exactly 8-bit periods wide, extra decoding circuitry is not needed.

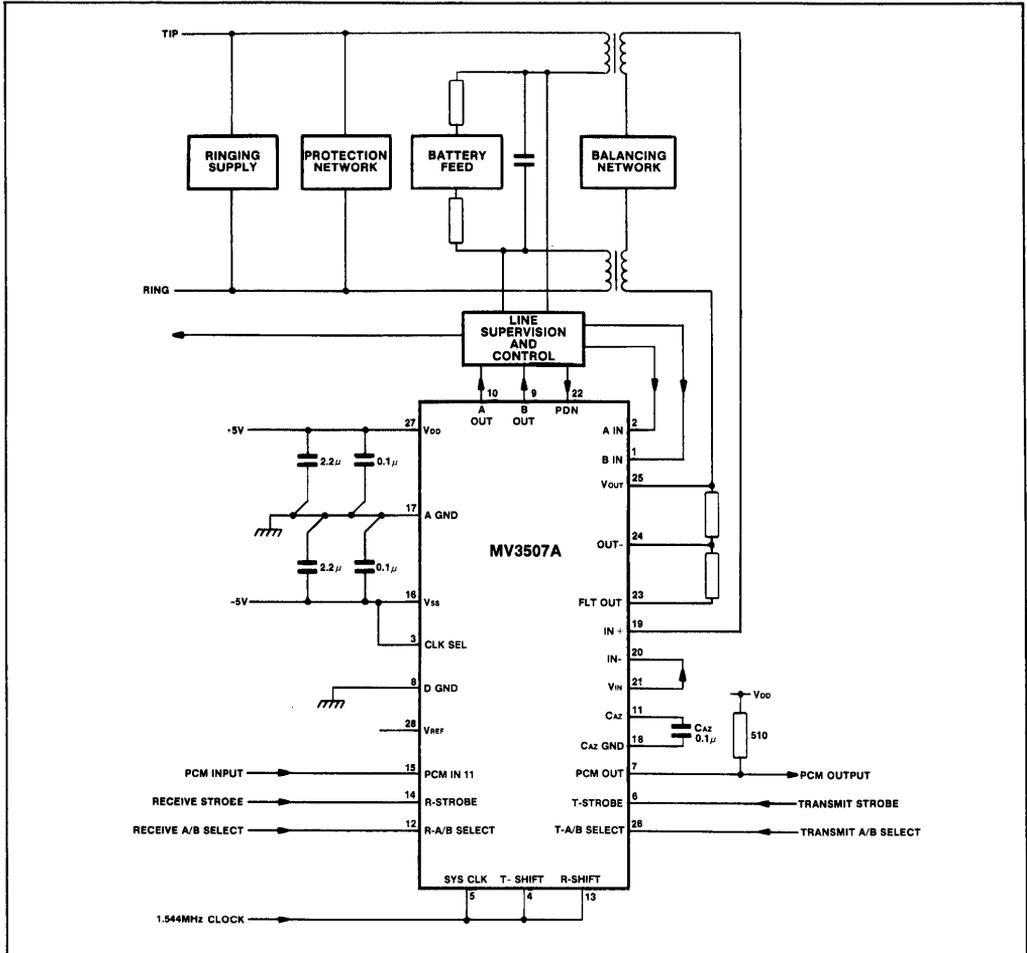


Fig.8 A subscriber line interface circuit

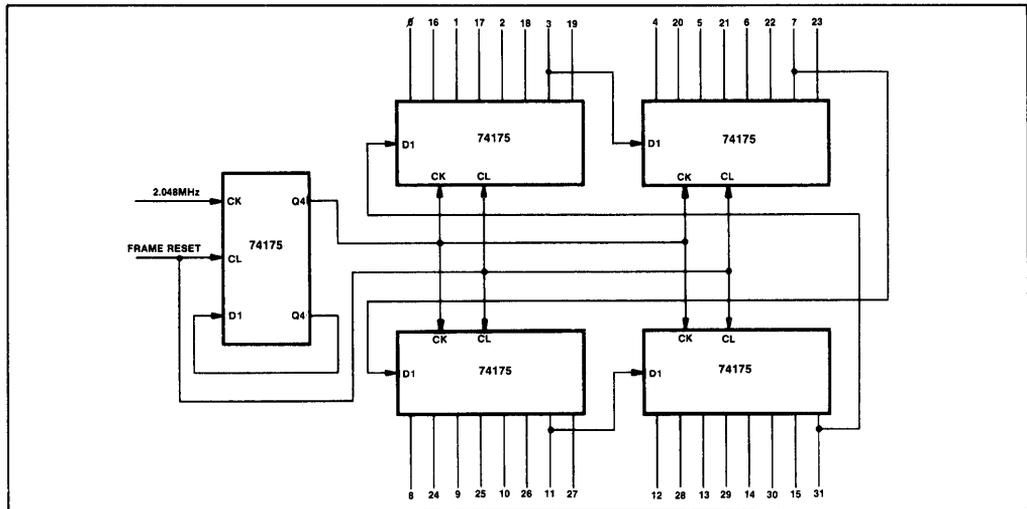


Fig.9 Generating timing signals in a CCITT carrier system (30 + 2 channels)

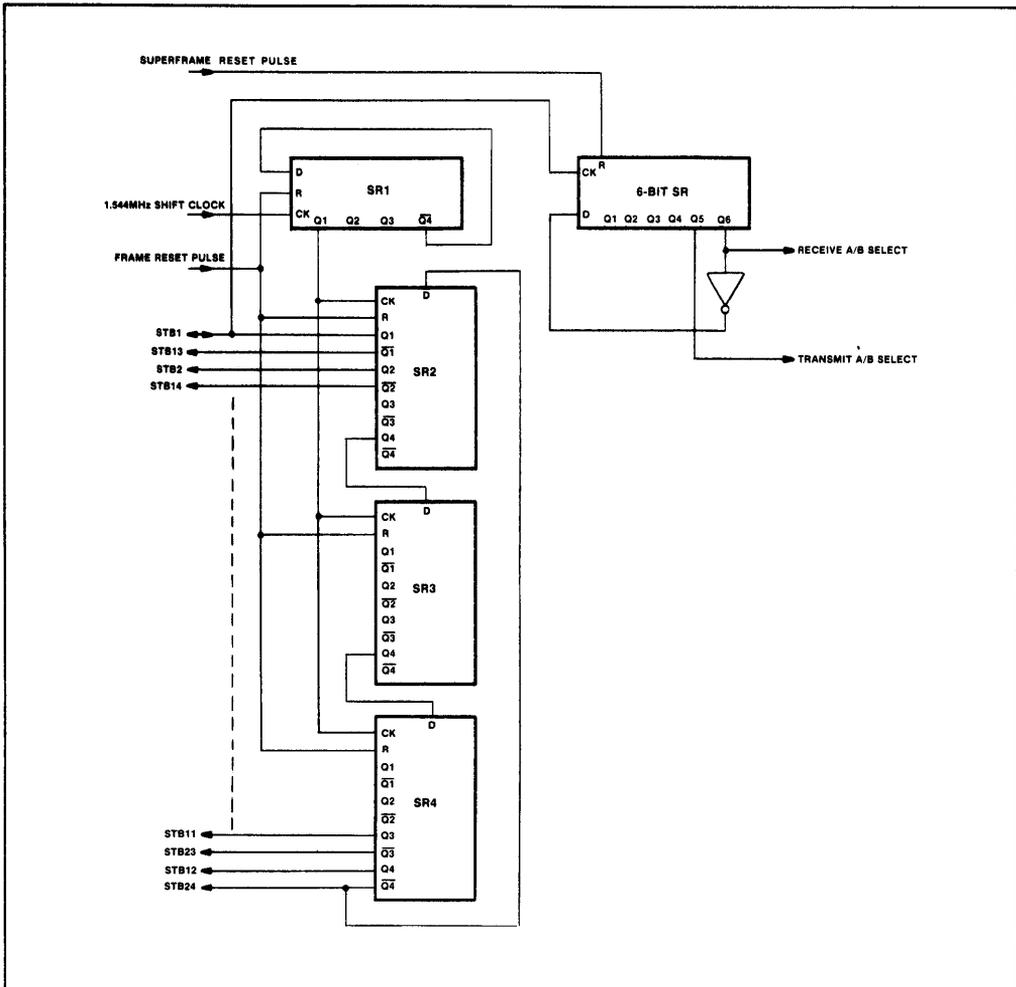


Fig.10 Generating timing signals in a T1 carrier system

### A Digital Telephone Application

Most new PABX designs are using PCM techniques for voice switching with an increasing trend toward applying them at the telephone level. The simplest form of a digital telephone design uses four wire pairs of interface to the switch. Two pairs carry transmit and receive PCM voice data. One pair supplies an 8kHz synchronising clock signal and the remaining pair supplies power to the telephone. More sophisticated techniques minimise the number of wire pairs. The Plessey Single-Chip Codec is ideally suited for this application because of the low component count and its simplified timing requirements. Figure 11 shows a schematic

for a typical digital telephone design.

Since asynchronous operation is not necessary, transmit and receive timing signals are common. A phase-lock-loop derives the 2048kHz system clock and 64kHz shift clock from the 8kHz synchronising signal received from the switch. The synchronising signal also serves as the transmit/receive strobe signal since its duty cycle is not important for Codec operation. Microphone output directly feeds into the coder input while the decoder output drives the receiver through an impedance transformer to complete the design.

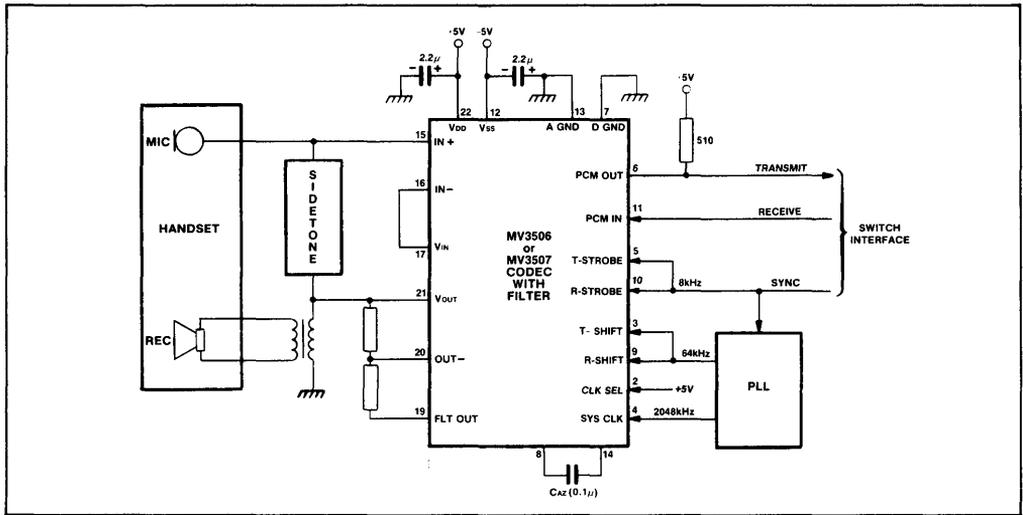


Fig.11 Voice processing in a digital telephone application

# MV4320

## KEYPAD PULSE DIALLER

The MV4320 series is fabricated using ISO-CMOS high density technology. The device is a pin-for-pin replacement for the DF320 Loop Disconnect Dialler and offers wider operating supply voltage range and lower power dissipation. The MV4320 accepts up to 20 digits from a standard 2 of 7 keypad and offers a REDIAL option activated by key #. The device provides dial pulsing and muting outputs and has a HOLD pin for interrupting a dialling sequence. Outpulsing mark/space ratio and dialling speed are pin selectable.

The MV4320 is available in Ceramic DIL (DG, -40°C to +85°C).

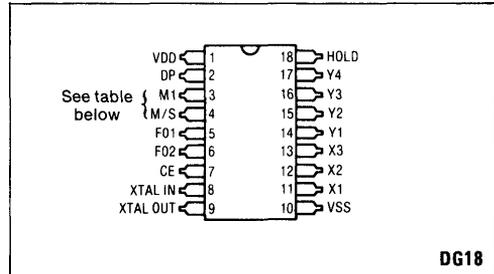


Fig.1 Pin connections (top view)

### FEATURES

- Pin for Pin Replacement for the DF320
- 2.5V to 5.5V Supply Voltage Operating Range
- 375 $\mu$ W Dynamic Power Dissipation at 3V
- Uses Inexpensive 3.58 MHz Ceramic Resonator or Crystal
- Stores up to 20 Digits
- Selectable Outpulsing Mark/Space Ratio
- Selectable Dialling Speeds of 10, 16, 20 and 932 Hz
- Low Cost

### APPLICATIONS

- Pushbutton Telephones
- Tone to Pulse Converters
- Mobile Telephone
- Repertory Dialers

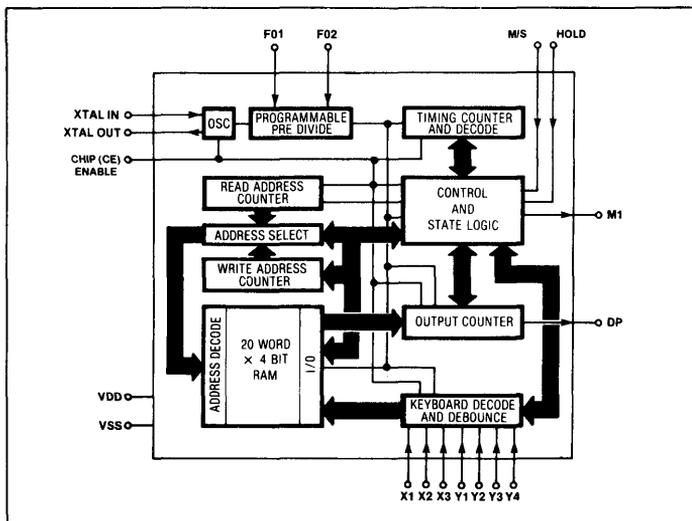


Fig.2 MV4320 functional block diagram

**DC ELECTRICAL CHARACTERISTICS**

**Test conditions (unless otherwise stated):**

V<sub>DD</sub> = 3.0V; T<sub>amb</sub> = +25°C; f<sub>CLK</sub> = 3.579545 MHz  
 All voltages wrt V<sub>SS</sub>

	CHARACTERISTICS		SYMBOL	MIN	TYP*	MAX	UNITS	TEST CONDITIONS
1 S U P P L Y	Supply Voltage Operating Range		V <sub>DD</sub>	2.5		5.5	V	
	Standby Supply Current		I <sub>DDs</sub>		1.0	10.0	μA	CE = V <sub>SS</sub>
	Operating Supply Current		I <sub>DD</sub>		125	200	μA	3.579545 MHz Crystal, C <sub>X TALOUT</sub> = 12pF
4 I N P U T	Pull-Up Transistor Source Current		I <sub>IL</sub>	-0.5	-3.0	-12.0	μA	V <sub>IN</sub> = V <sub>SS</sub>
	Input Leakage Current		I <sub>IH</sub>		0.1		nA	V <sub>IN</sub> = V <sub>DD</sub>
	Input Leakage Current		I <sub>IL</sub>		-0.1		nA	V <sub>IN</sub> = V <sub>SS</sub>
	Pull-Down Transistor Sink Current		I <sub>IH</sub>	0.5	3.0	12.0	μA	V <sub>IN</sub> = V <sub>DD</sub>
	Logic '0' Level		V <sub>IL</sub>			0.9	V	All inputs
	Logic '1' Level		V <sub>IH</sub>	2.1			V	
	10 O U T P U T	Voltage Levels	Low-Level	V <sub>OL</sub>		0	0.01	V
High-level			V <sub>OH</sub>	2.99	3		V	
Drive Current		N-Channel Sink	I <sub>OL</sub>	0.8	2.0		mA	V <sub>OUT</sub> = 2.3V
		P-Channel Source	I <sub>OH</sub>	-0.8	-2.0		mA	

**AC ELECTRICAL CHARACTERISTICS**

**Test conditions (unless otherwise stated):**

V<sub>DD</sub> = 3.0V; T<sub>amb</sub> = +25°C; f<sub>CLK</sub> = 3.579545 MHz  
 All voltages wrt V<sub>SS</sub>

	CHARACTERISTICS		SYMBOL	MIN	TYP*	MAX	UNITS	TEST CONDITIONS
14	Output Rise Time		t <sub>R</sub>		1.0		us	DP, M <sub>1</sub>
15	Output Fall Time		t <sub>F</sub>		1.0		us	C <sub>L</sub> = 50pF
16	Maximum Clock Frequency		f <sub>CLK</sub>	3.58			MHz	3.579545 MHz Crystal
17	Mark to Space Ratio		M/S		2:1			Note 1
18					3:2			
19	Impulsing Rate = $\frac{1}{T}$				10		Hz	Note 1
20					16			
21					20			
22					932			
23	Clock Start Up Time		t <sub>on</sub>		1.5	4	ms	Timed from CE '1'
24	Input Capacitance		C <sub>in</sub>		5.0		pF	Any Input

\* Typical parametric values are for Design Aid Only, not guaranteed and not subject to production testing. Timing waveforms are subject to production functional test.

NOTES:

1. See Pin Function, Table 1.

**OPERATING NOTES**

The first key entered in any dialling sequence initiates the oscillator by internally taking CE high. Digits may be entered asynchronously from the keypad. Dialling and mute functions are output as shown in figures 3 and 4. Figure 3 shows use of the circuits with external control of CE. This mode is useful if a bistable latching relay is used to mute and switch the complete pulse dialler circuit. In

this mode, the pulse occurring on M1 when CE is taken high, with no keypad input, can be used to initiate the bistable latching relay. Figure 4 shows the timing diagram for the CE internal control mode. Initially CE is low and goes high on recognition of the first valid key input. Keypad data is entered asynchronously.

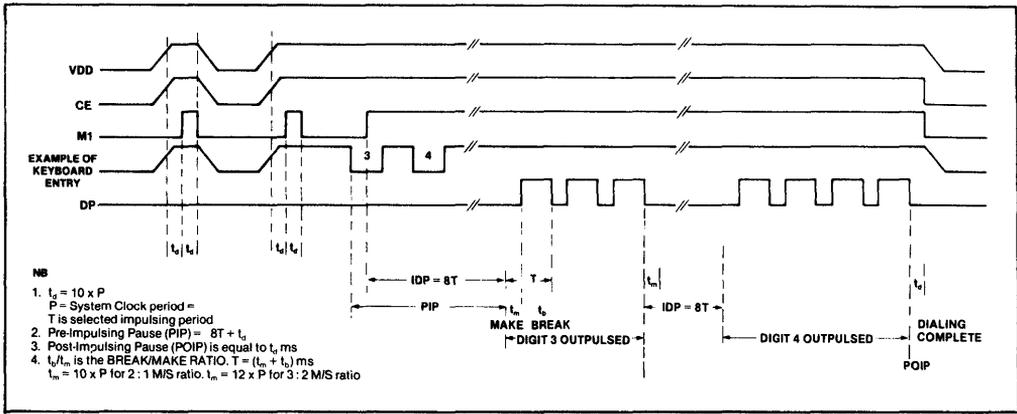


Fig.3 Keypad pulse dialer timing diagram, CE-External control

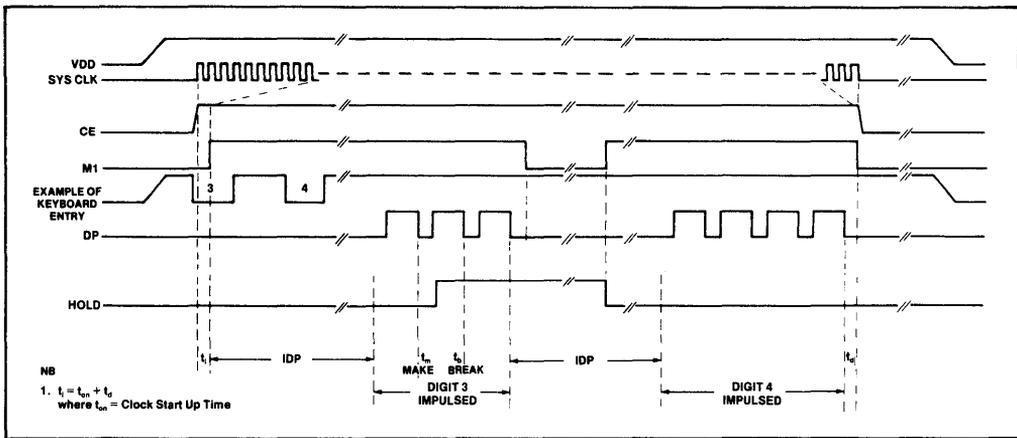


Fig.4 Keypad pulse dialer timing diagram, CE-Internal control

**ABSOLUTE MAXIMUM RATINGS**

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

	MIN.	MAX.
V <sub>DD</sub> -V <sub>SS</sub>	-0.3V	10V
Voltage on any pin	V <sub>SS</sub> - 0.3V	V <sub>DD</sub> + 0.3V
Current at any pin		10mA
Operating Temperature	-40°C	+85°C
Storage Temperature	-65°C	+150°C
Power Dissipation		1000mW
Derate 16mW/°C above 75°C. All leads soldered to PC board.		

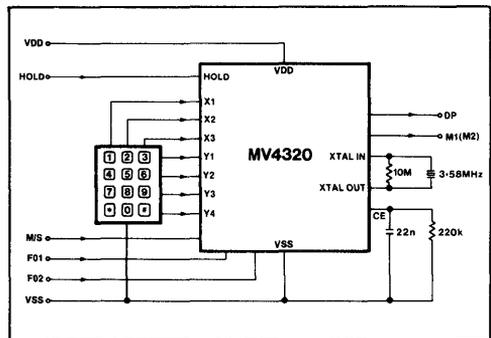


Fig.5 Application diagram

PIN FUNCTIONS

V <sub>DD</sub>	Positive voltage supply						
DP	Dial Pulsing Output Buffer						
M1	Mute Output (Off Normal) Buffer						
M/S	Mark/Space (Break/Make) Ratio select. On-chip pull-down transistor to V <sub>SS</sub> :					O/C	2:1
	Note: O/C = Open Circuit					V <sub>DD</sub>	3:2
F01,F02	Impulsing Rate Selection. On-chip pull-down transistor to V <sub>SS</sub> .  * Assumes f <sub>CLK</sub> = 3.579545MHz.	F01	F02	Nominal Impulsing Rate	Actual* Impulsing Rate	System Clock frequency	
		O/C	O/C	10Hz	10.13Hz	303.9Hz	
		O/C	V <sub>DD</sub>	20Hz	19.42Hz	582.6Hz	
		V <sub>DD</sub>	O/C	932Hz	932.17Hz	27,965.1Hz	
		V <sub>DD</sub>	V <sub>DD</sub>	16Hz	15.54Hz	466.1Hz	
CE	Chip Enable. An active input. Control is internal via static keyboard decode, or by external forcing.						
XTAL IN	Crystal Input. Active, clamped low if CE = '0', high impedance if CE = '1'.						
XTAL OUT	Crystal Output Buffer to drive crystal.						
V <sub>SS</sub>	System ground						
X <sub>1</sub> ,X <sub>2</sub> ,X <sub>3</sub>	Column keyboard Inputs. On-chip pull-up transistors to V <sub>DD</sub> . Active LOW.						
Y <sub>1</sub> ,Y <sub>2</sub> ,Y <sub>3</sub> ,Y <sub>4</sub>	Row keyboard Inputs. On-chip pull-up transistors to V <sub>DD</sub> . Active LOW.						
HOLD	Prevents further impulsing. On-chip pull-down transistor to V <sub>SS</sub> .	O/C	Normal Operation				
		V <sub>DD</sub>	No impulsing. If activated during impulsing, hold occurs when the current digit is complete				

# MV4325

## PROGRAMMABLE KEYPAD PULSE DIALLER

The MV4325 Keypad Pulse Dialler contains all the logic necessary to interface a 2 of 7 keypad and convert this key information to control and mute pulses simulating a telephone rotary dial. The MV4325 has programmable access pause capability to provide automatic interruption of dialling needed when accessing the toll network, WATS line or public network. The device is fabricated using Plessey Semiconductors' ISO-CMOS technology which enables the device to function down to 2.0V making it ideal for long loop operation.

The MV4325 will accept up to 20 digits and access pauses and will redial stored information at a later time by activation of # key. Device current in standby is less than  $1\mu\text{A}$  at 1.0V.

The MV4325 is available in Ceramic DIL (DG,  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ).

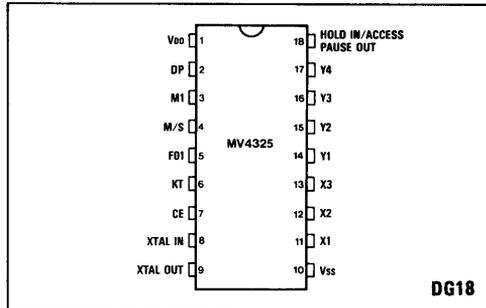


Fig.1 Pin connections (top view)

### APPLICATIONS

- Pushbutton Telephones with Last Number Redial
- Repertory Dialers
- Tone to Pulse Converters

### FEATURES

- Last Number Redial
- Multiple Access Pause Programming
- Any Valid Keypad Input or HOLD IN Causes Exit from Access Pause
- Oscillator Start Up Controlled from Keypad Input
- Oscillator Power Down whilst not Dialling
- 300 Hz Key Tone indicates Valid Key
- 2.0V to 7.0V Supply Voltage Operating Range
- Stores up to 20 Digits and Access Pauses
- Digit Memory Retained down to 1.0V at  $1\mu\text{A}$
- Selectable Mark/Space Ratio  $66\frac{2}{3} : 33\frac{1}{3}$  or 60 : 40
- 10Hz Dialling Speed (932Hz Fast Test):)

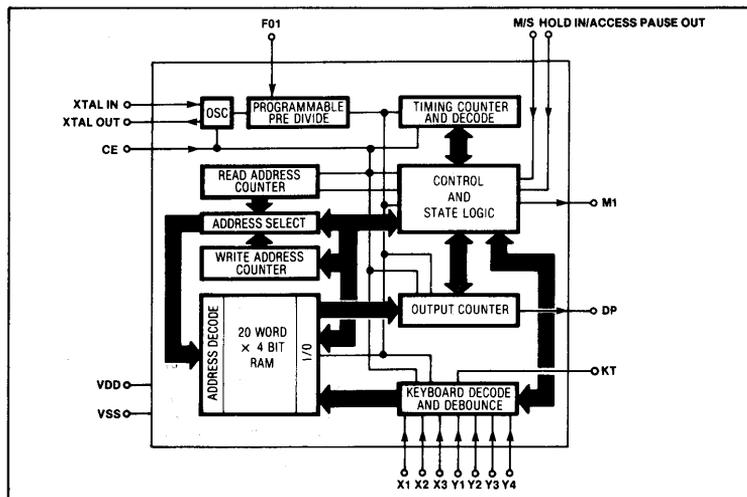


Fig.2 MV4325 function diagram

# MV4325

## ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

	MIN	MAX		MIN	MAX
$V_{DD}-V_{SS}$	-0.3V	10V			
Voltage on any pin	$V_{SS}-0.3V$	$V_{DD} + 0.3V$			
Current at any pin		10mA			
Operating Temperature	-40 °C	+85 °C	Power Dissipation		1000mW
Storage Temperature	-65 °C	+ 150 °C			

\* Derate 16mW/°C above 75 °C. All leads soldered to PC board.

## DC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

$T_{amb} = +25^{\circ}C$ ,  $f_{CLK} = 3.579545MHz$ ;  $V_{DD} = +3.0V$   
All voltages wrt  $V_{SS}$

		CHARACTERISTIC	SYMBOL	MIN	TYP*	MAX	UNITS	TEST CONDITIONS			
1	SUPPLY	Supply Voltage Operating Range	$V_{DD}$	2.0		7.0	V				
2		Standby Supply Current	$I_{DDs}$			1.0	$\mu A$	CE = M/S = F01 = HOLD IN = $V_{SS}$ ; $V_{DD} = 1.0V$			
3		Operating Supply Current	$I_{DD}$		100	150	$\mu A$	3.579545 MHz Crystal, $C_{XTALOUT} = 12pF$			
4	INPUT	Pull-Up Transistor Source Current	$I_{IL}$	-0.5	-3.0	-12	$\mu A$	$V_{IN} = V_{SS}$	$X_1, X_2, X_3$		
5		Input Leakage Current	$I_{IH}$		0.1		nA	$V_{IN} = V_{DD}$	$Y_1, Y_2, Y_3, Y_4$		
6		Input Leakage Current	$I_{IL}$		-0.1		nA	$V_{IN} = V_{SS}$	M/S, F01		
7		Pull-Down Transistor Sink Current	$I_{IH}$	0.5	3.0	8.0	$\mu A$	$V_{IN} = V_{DD}$			
8		Input Low Level Voltage	$V_{IL}$			0.9	V	All inputs			
9		Input High Level Voltage	$V_{IH}$	2.1			V				
10	OUTPUT	Voltage Levels	Low-Level	$V_{OL}$		0	0.01	V	No Load	DP, M1, M2, KT	
11			High-level	$V_{OH}$	2.99	3		V			
12		Drive Current	N-Channel	$I_{OL}$	0.8	2.0		mA			$V_{OUT} = 2.3V$
13				$I_{OL}$	0.2	0.5		mA			$V_{OUT} = 0.5V$
14			P-Channel Source	$I_{OH}$	-0.8	-2.0		mA			$V_{OUT} = 0.7V$
15			$I_{OH}$	-0.2	-0.5		mA	$V_{OUT} = 2.5V$			
16	INPUT / OUTPUT	Input Low Level Voltage	$V_{IL}$			0.9	V	CE, HOLD IN/ACCESS PAUSE OUT			
17		Input High Level Voltage	$V_{IH}$	2.1			V				
18		Output Low Level Current	$I_{OL}$		15		$\mu A$			$V_{OUT} = 0.5V$	
19		Output High Level Current	$I_{OH}$		-12		$\mu A$			$V_{OUT} = 2.5V$	
20		Input Force High Current (from $V_{OL}$ )	$I_{FH}$		55		$\mu A$			$V_{IN} = 2.5V$	
21		Input Force Low Current (from $V_{OH}$ )	$I_{FL}$		-70		$\mu A$			$V_{IN} = 0.5V$	

\* Typical parametric values are for Design Aid Only, not guaranteed and not subject to production testing. Timing waveforms are subject to production functional test.

**AC ELECTRICAL CHARACTERISTICS**

**Test conditions (unless otherwise stated):**

$T_{amb} = +25^{\circ}C$ ;  $f_{CLK} = 3.579545 MHz$ ;  $V_{DD} = +3.0V$

	CHARACTERISTIC	SYMBOL	MIN	TYP*	MAX	UNITS	TEST CONDITIONS	
1	D Y N A M I C	Output Rise Time	$t_R$	1.0		$\mu s$	DP, M <sub>1</sub>	
2		Output Fall Time	$t_F$	1.0		$\mu s$	$C_L = 50pF$	
3		Maximum Clock Frequency	$f_{CLK}$	3.58			MHz	3.579545 MHz Crystal
4		Mark to Space Ratio	M/S		2:1			M/S = O/C (V <sub>SS</sub> )
5					3:2			M/S = V <sub>DD</sub>
6		System Clock Frequency (Internal)			300		Hz	F01 = V <sub>SS</sub>
7		Impulsing Rate = I/T			10		Hz	F01 = V <sub>SS</sub>
8		Fast Test Impulsing Rate			14.9		Hz	F01 = V <sub>DD</sub>
9		Clock Start Up Time	$t_{on}$		1.5	4	ms	Timed from CE ↑ '1'
10		Input Capacitance	$C_{in}$		5.0		pF	Any Input

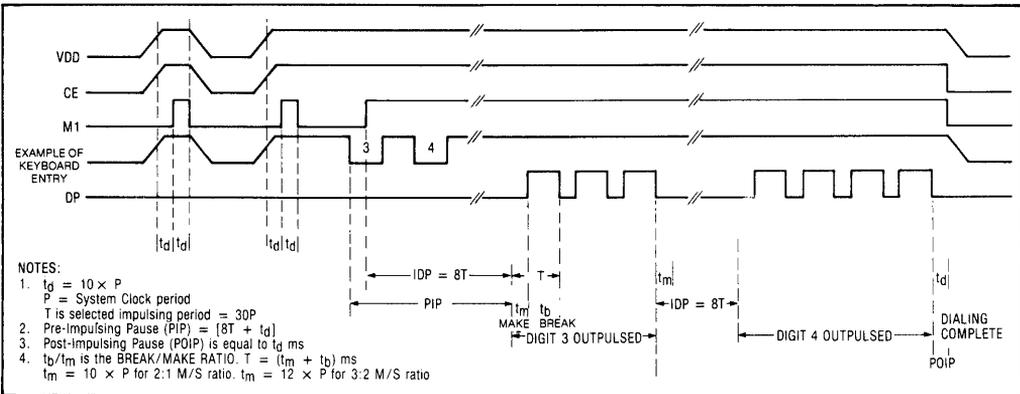


Fig.3 MV4325 timing diagram, CE External control

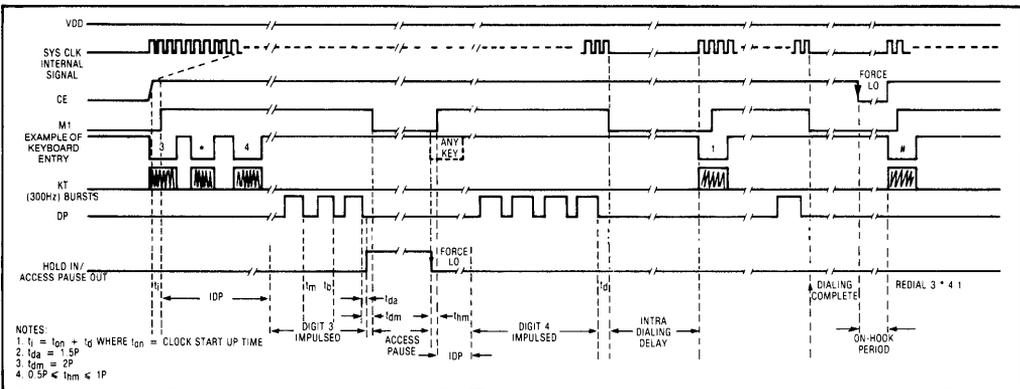


Fig.4 MV4325 timing diagram, CE Internal control

**PIN FUNCTIONS**

V <sub>DD</sub>	Positive voltage supply				
DP	Dial Pulsing Output Buffer				
M1	Mute Output Buffer				
M/S	Mark/Space (Break/Make) Ratio select. On-chip pull-down transistor to V <sub>SS</sub> .			O/C	2:1
	Note: O/C = Open Circuit			V <sub>DD</sub>	3:2
F01	Impulsing Rate Selection. On-chip pull-down transistor to V <sub>SS</sub> .	F01	Nominal Impulsing Rate	Actual* Impulsing Rate	System Clock frequency
		O/C	10Hz	10.13Hz	303.9Hz
		V <sub>DD</sub>	932Hz	932.17Hz	27.965.1Hz
* Assumes f <sub>CLK</sub> = 3.579545MHz.					
CE	Chip Enable. An active input. Control is internal via static keyboard decode, or by external forcing.				
XTAL IN	Crystal Input. Active, clamped low if CE = '0', high impedance if CE = '1'.				
XTAL OUT	Crystal Output. Buffer to drive crystal. Capacitive load on-chip.				
V <sub>SS</sub>	System ground				
X <sub>1</sub> ,X <sub>2</sub> ,X <sub>3</sub>	Column keyboard Inputs. On-chip pull-up transistors to V <sub>DD</sub> . Active LOW.				
Y <sub>1</sub> ,Y <sub>2</sub> ,Y <sub>3</sub> ,Y <sub>4</sub>	Row keyboard Inputs. On-chip pull-up transistors to V <sub>DD</sub> . Active LOW.				
HOLD IN/ ACCESS PAUSE OUT	INPUT/OUTPUT	O/C	Normal Operation		
	INPUT	V <sub>DD</sub>	No impulsing. If activated during impulsing, hold occurs when the current digit is complete.		
PAUSE OUT	OUTPUT	V <sub>DD</sub>	Logic "1" level output indicates access pause condition.		
KT	300Hz Square wave bursts indicate valid keypad input.				

No. of O/P Pulses	Digit	KEYPAD INPUT CODE						
		Y <sub>1</sub>	Y <sub>2</sub>	Y <sub>3</sub>	Y <sub>4</sub>	X <sub>1</sub>	X <sub>2</sub>	X <sub>3</sub>
1	1	0	1	1	1	0	1	1
2	2	0	1	1	1	1	0	1
3	3	0	1	1	1	1	1	0
4	4	1	0	1	1	0	1	1
5	5	1	0	1	1	1	0	1
6	6	1	0	1	1	1	1	0
7	7	1	1	0	1	0	1	1
8	8	1	1	0	1	1	0	1
9	9	1	1	0	1	1	1	0
10	0	1	1	1	0	1	0	1
RE-DIAL		1	1	1	0	1	1	0
ACCESS PAUSE		1	1	1	0	0	1	1

Table 1

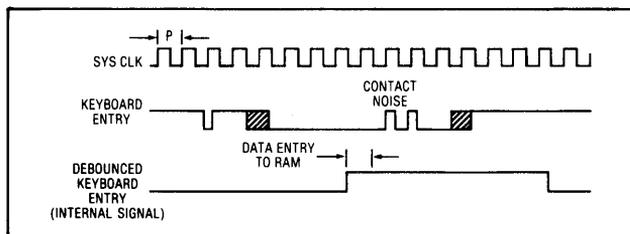


Fig.5 Keypad input debounce timing diagram

## OPERATING NOTES

The MV4325 programmable keypad pulse dialer is optimized for use in key operated pulse dialling telephone sets and contains features which make it particularly suitable for applications where redial of last number dialled and repertory dial facilities are required.

Keypad information is accepted directly from a dual contact keypad having two single pole switches per key: one switch common to the column and one switch common to the row. The common row contacts are connected Y1 to Y4 and the common column contacts connected X1 to X3. The other side of each switch is connected to a common VSS line. The keypad code is shown in Table 1.

The MV4325 will accept up to 20 digits and access pauses, e.g. 18 digits plus 2 access pauses or alternately 19 digits plus 1 access pause. Prior to a keypad input being accepted contact bounce is eliminated by a circuit which ensures that any input which is valid for less than 10ms is rejected and any input valid for greater than 17ms is accepted as a valid key input. This circuit operates similarly on the trailing edge of a valid key input preventing multiple digit recognition in the presence of noise. Debounce operation is shown in Fig.5.

The first key entered in any dialling sequence initiates the oscillator on the MV4325 by internally taking CE high. Digits may be entered asynchronously from the keypad. Dialling and mute functions are output as shown in Fig.3 and Fig.4. Fig.3 shows use of the MV4325 with external control of CE. This mode is useful if a bistable latching relay is used to mute and switch the complete pulse dialer circuit. In this mode the pulse occurring on M1 when CE is taken high with no keypad input can be used to initiate the bistable latching relay.

Fig.4 shows the timing diagram of the MV4325 including access pause and redial mode. Initially CE is low and goes high on recognition of the first valid key input. Keypad data is entered asynchronously and dialling commences after recognition of the leading edge of the first valid key input. When an access pause is reached M1 goes low and Hold In/Access Pause Out goes high indicating the device is in an access pause. This output signal can be used to enable an external dial tone recognition circuit. Exit from the access

pause is achieved by one of two methods. One method is by the next valid key operation. If a valid digit is entered, the digit will be entered in the next consecutive storage location in the digit memory. If the key # is activated, redialling of the number in memory will occur only if the device is in the redial mode. The alternative method to exit from an access pause is to pulse Hold In/Access Pause Out low, resetting the output latch associated with this input/output pin.

Fig.4 shows a pause in dialling between the completion of dialling digit 4 and keying digit 1. In this condition, the oscillator powers down to minimize power consumption and interfering signals, whilst CE remains high. On recognition of the next digit, the digit is entered in the next consecutive memory location and dialling resumes.

The end of a key entry sequence is indicated to the MV4325 by externally pulsing or clamping CE low. This causes the on-chip latch holding CE high to reset.

If the first key entered after a CE low period is #, redial of the last number dialled will occur. Access pause operation is as previously described. In the standby condition the MV4325 dissipates less than 1.0µW.

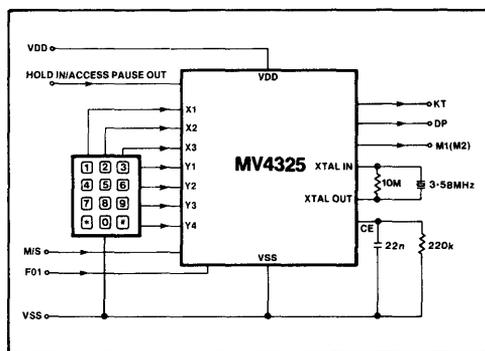


Fig.6 Application diagram





# MV4330/MV4332

## DC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

T<sub>amb</sub> = +25°C

CHARACTERISTIC	SYMBOL	TEST CONDITIONS		LIMIT			UNIT			
		V <sub>O</sub> Volts	V <sub>DD</sub> Volts	Min.	Typ.	Max.				
Quiescent Device Current	I <sub>L</sub>			5	–	0.5	50	µA		
				10	–	1	100			
Output Voltage	Low-Level VOL			5	–	0	0.01	V		
				10	–	0	0.01			
	High-Level VOH			5	4.99	5	–			
				10	9.99	10	–			
Noise Immunity (Any Input)	V <sub>NL</sub>			0.8	5	1.5	2.25	V		
				1.0	10	3	4.5		–	
	V <sub>NH</sub>				4.2	5	1.5		2.25	–
					9.0	10	3		4.5	
Output Drive Current	D OUT	I <sub>DN</sub>	N-Channel	0.5	5	0.8	1.7	mA		
				0.5	10	1.0	3.0		–	
		I <sub>DP</sub>	P-Channel	4.5	5	–0.35	–0.9		–	
				9.5	10	–0.8	–1.9		–	
	Q OUT	I <sub>DN</sub>	N-Channel	0.5	10	50	250	–	µA	
				I <sub>DP</sub>	P-Channel	9.5	10	–50		–250
Input Current	I <sub>I</sub>				–	10	–	pA		

## AC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

T<sub>amb</sub> = +25°C, C<sub>L</sub> = 50 pF

All input rise and fall times = 20ns

CHARACTERISTIC	SYMBOL	TEST CONDITIONS		LIMIT			UNIT
			V <sub>DD</sub> Volts	Min.	Typ.	Max.	
Propagation Delay Time	t <sub>PHL</sub> t <sub>PLH</sub>		10	–	300	–	ns
Transition Time	t <sub>THL</sub>	D OUT (CL=50pF)	10	–	70	130	ns
	t <sub>TLH</sub>	Q OUT (CL=15pF)	10	–	300	–	ns
Maximum Clock Frequency	f <sub>CL</sub>		10	1.0	3.0	–	MHz
Minimum Clock Pulse Width	t <sub>WL</sub> t <sub>WH</sub>		10	–	200	–	ns
Minimum Reset Pulse Width	t <sub>WH(R)</sub>		10	–	200	–	ns
Input Capacitance	C <sub>I</sub>	Any Input		–	5	–	pF

Note 1. Voltages with respect to V<sub>SS</sub>

Note 2. Typical temperature coefficient for all values = 0.3%/°C

**ABSOLUTE MAXIMUM RATINGS**

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

PARAMETER	SYMBOL	LIMIT	UNIT
DC Supply Voltage	VDD	-0.5 to 18	V
Input Voltage	VIN	-0.5 to VDD+0.5	V
DC Current Drain per Pin	I	10	mA
Operating Temperature Range	TA	0 to 70	°C
Storage Temperature Range	Ts	-65 to 125	°C

**OPERATING NOTES**

The MV4330 and MV4332 accept a serial input DI which is shifted into the register on the positive transition of the clock (CLK) input. A feature of these devices is that the clock input and the true/complement control (T/C) input have wave-shaping circuits (Fig.3) to ensure fast edges on-chip regardless of the shape of the incoming signals.

The MV4330 also has the reset (RST) input gated with the clock input for synchronous reset on the positive transition of the clock. The MV4332 has asynchronous reset (RST) inputs which are active HIGH.

The parallel outputs of the shift registers are available in either true or complementary form dependent on the state of the true/complement control input. When input is logic-level LOW, the true form is available at all parallel outputs and when the input goes HIGH, the parallel outputs immediately revert to the complementary form of the data stored in each register. This action is independent of the clock input condition. A serial data (DO) output is provided for applications using longer shift registers, etc. This output is the true form of the last stage of the register.

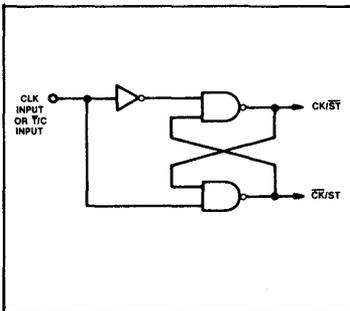


Fig.3 Wave shaping circuit

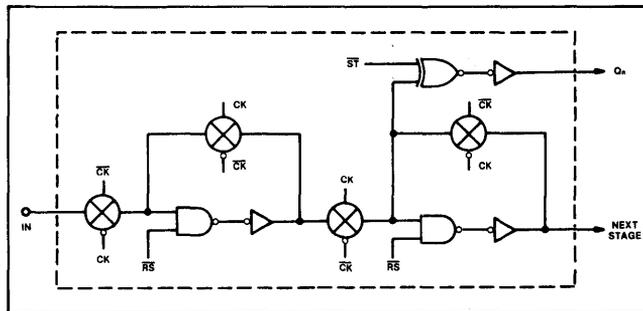


Fig.4 One stage of shift register

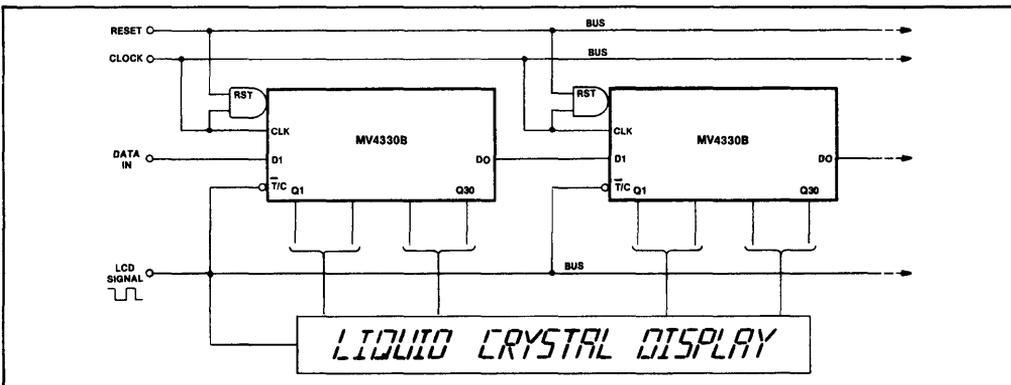


Fig.5 Typical application



# MV5087

## DTMF GENERATOR

The MV5087 is fabricated using Plessey Semiconductors' ISO-CMOS high density technology and offers low power and wide voltage operation. An inexpensive 3.58MHz TV crystal completes the reference oscillator. From this frequency are derived 8 different sinusoidal frequencies which, when appropriately mixed, provide Dual-Tone Multi-Frequency (DTMF) tones.

Inputs are compatible with either a standard 2-of-8, or single contact (form A), keyboard. The keyboard entries determine the correct division of the reference frequency by the row and column counters.

D-to-A conversion, using R-2R ladder networks, results in a staircase approximation of a sinewave with low total distortion.

Frequency and amplitude stability over operating voltage and temperature range are maintained within industry DTMF specifications.

### FEATURES

- Pin-for-Pin Replacement for MK5087
- Low Standby Power
- Minimum External Parts Count
- 3.5V to 10V Operation
- 2-of-8 Keyboard or Calculator-Type Single Contact (Form A) Keyboard Input
- On-Chip Regulation of Output Tone
- Mute and Transmitter Drivers On-Chip
- High Accuracy Tones Provided by 3.58MHz Crystal Oscillator
- Pin-Selectable Inhibit of Single Tone Generation

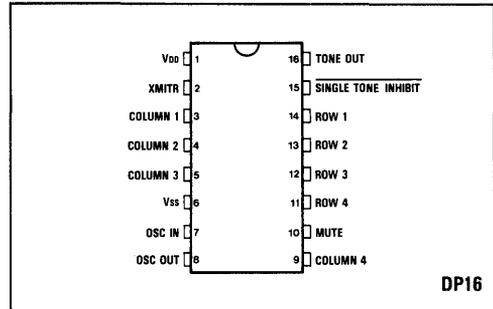


Fig.1 Pin connections - top view

### APPLICATIONS

#### DTMF Signalling for

- Telephone Sets
- Mobile Radio
- Remote Control
- Point-of-Sale and Banking Terminals
- Process Control

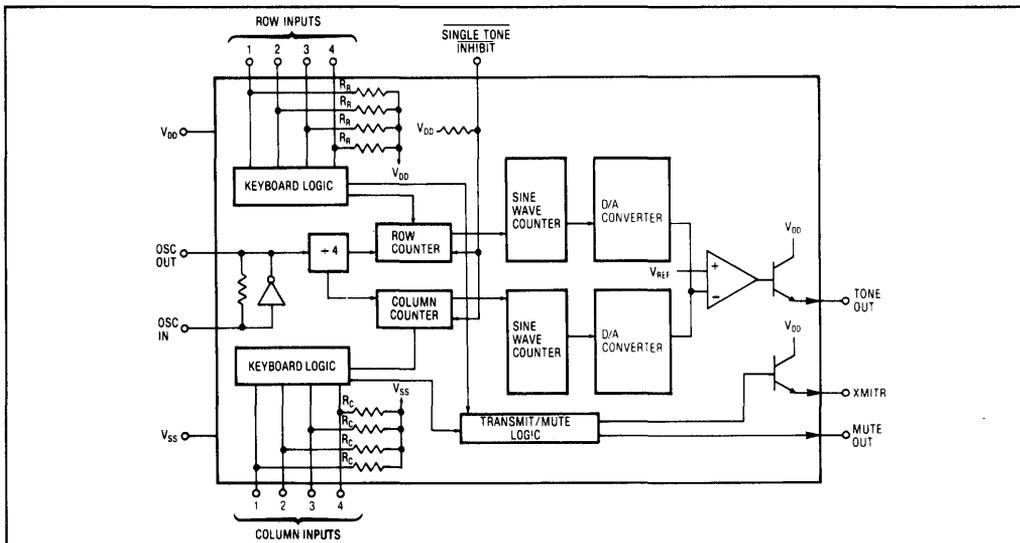


Fig.2 Functional block diagram

## ABSOLUTE MAXIMUM RATINGS

	MIN.	MAX	MIN.	MAX.
$V_{DD}-V_{SS}$	-0.3V	10.5V	Power dissipation Derate 16 mW/°C above 75°C (All leads soldered to PCB)	850 mW
Voltage on any pin	$V_{SS} - 0.3V$	$V_{DD} + 0.3V$		
Current on any pin		10 mA		
Operating temperature	-40°C	+85°C		
Storage temperature	-65°C	+150°C		

## DC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

 $T_{amb} = +25^{\circ}C$ ,  $V_{DD} = 3.5V$  to  $10V$ 

CHARACTERISTICS		SYMBOL	MIN	TYP	MAX	UNITS			
S U P P L Y	Operating Supply Voltage	$V_{DD}$	3.5		10	V	Ref. to $V_{SS}$		
	Standby Supply Current	$I_{DDs}$		0.2	100	$\mu A$	$V_{DD} = 3.5V$	No Key Depressed	
				0.5	200	$\mu A$	$V_{DD} = 10V$	All outputs Unloaded	
	Operating Supply Current	$I_{DD}$		1.0	2.0	mA	$V_{DD} = 3.5V$	One Key Depressed	
			5.0	10.0	mA	$V_{DD} = 10V$	All outputs Unloaded		
I N P U T S	SINGLE TONE INHIBIT	INPUT HIGH VOLTAGE	$V_{IH}$	$0.7V_{DD}$		$V_{DD}$	V		
		INPUT LOW VOLTAGE	$V_{IL}$	0		$0.3V_{DD}$	V		
		INPUT RESISTANCE	$R_{IN}$		60		$k\Omega$		
	ROW 1-4	INPUT HIGH VOLTAGE	$V_{IH}$	$0.9V_{DD}$			V		
		INPUT LOW VOLTAGE	$V_{IL}$			$0.3V_{DD}$	V		
	COLUMN 1-4	INPUT HIGH VOLTAGE	$V_{IH}$	$0.7V_{DD}$			V		
INPUT LOW VOLTAGE		$V_{IL}$			$0.1V_{DD}$	V			
O U T P U T S	XMTR	SOURCE CURRENT	$I_{OH}$	-15	-25		mA	$V_{DD} = 3.5V, V_{OH} = 2.5V$	No Keyboard Entry
				-50	-100		mA	$V_{DD} = 10V, V_{OH} = 8V$	Keyboard Entry
		LEAKAGE CURRENT	$I_{OZ}$		0.1	10	$\mu A$	$V_{DD} = 10V, V_{OH} = 0V$	Keyboard Entry
	MUTE	SINK CURRENT	$I_{OL}$	0.5			mA	$V_{DD} = 3.5V, V_{OL} = 0.5V$	No Keyboard Entry
				1.0			mA	$V_{DD} = 10V, V_{OL} = 0.5V$	Keyboard Entry
		SOURCE CURRENT	$I_{OH}$	-0.5			mA	$V_{DD} = 3.5V, V_{OH} = 3.0V$	Keyboard Entry
			-1.0			mA	$V_{DD} = 10V, V_{OH} = 9.5V$	Keyboard Entry	

## AC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

 $T_{amb} = +25^{\circ}C$ ,  $V_{DD} = 3.5V$  to  $10V$ 

CHARACTERISTICS		SYMBOL	MIN	TYP	MAX	UNITS	
TONE OUT	ROW TONE OUTPUT VOLTAGE	$V_{OR}$	320	400	500	$mV_{RMS}$	Single Tone $R_L = 1K\Omega$
	COLUMN TONE OUTPUT VOLTAGE	$V_{OC}$	400	500	630	$mV_{RMS}$	
	EXTERNAL LOAD IMPEDANCE	$R_L$	700			$\Omega$	$V_{DD} = 3.5V$
			330			$\Omega$	$V_{DD} = 10V$
OUTPUT DISTORTION					-20	dB	Total out-of-band power relative to sum of row and column fundamental power
PRE EMPHASIS, High Band			1		3	dB	
Tone Output Rise Time		$t_r$		3	5	ms	

**PIN FUNCTIONS**

PIN	NAME	DESCRIPTION
1	V <sub>DD</sub>	Positive Power Supply
2	XMITR	Emitter output of a bipolar transistor whose collector is connected to V <sub>DD</sub> . With no keyboard input this output remains at V <sub>DD</sub> and a keyboard input changes the output to a high impedance state. The state of Single Tone Inhibit input has no effect on XMITR output.
3,4,5,9	Column 1-4	These inputs are held at V <sub>SS</sub> by resistors R <sub>c</sub> and sense a valid logic level (approx 1/2 V <sub>DD</sub> ) when tied to a Row input.
6	V <sub>SS</sub>	Negative Power Supply (0V)
7,8	OSC In, OSC Out	On-chip inverter completes the oscillator when a 3,579545 MHz crystal is connected to these pins. OSC In is the inverter input and OSC Out is the output.
10	Mute	This CMOS Output switches to V <sub>SS</sub> with no keyboard input and to V <sub>DD</sub> with a keyboard input. This output is unaffected by the state of Single Tone Inhibit.
11,12,13,14	Row 1-4	These inputs are held at V <sub>DD</sub> by resistors R <sub>R</sub> and sense a valid logic level (Approx 1/2 V <sub>DD</sub> ) when tied to a column input.
15	Single Tone Inhibit	This input has a pull-up resistor to V <sub>DD</sub> and when left unconnected or tied to V <sub>DD</sub> , single or dual tones may be generated. When V <sub>SS</sub> is applied dual tones only are generated and no input combinations will cause generation of a single tone.
16	Tone Out	Emitter output of a bipolar NPN transistor whose collector is tied to V <sub>DD</sub> . Input to this transistor is from an op-amp which mixes, and regulates the output level of, the row and column tones.

**ROW AND COLUMN INPUTS**

These inputs are compatible with the standard 2-of-8 keyboard, single contact (form A) keyboard and electronic input. Figures 3 and 4 show these input configurations, and Fig. 5 shows the internal structure of these inputs.

When operating with a keyboard, dual tones are generated when any single button is pushed. Single tones are generated when more than one button is pushed in any row

or column. No tones are generated when diagonally-positioned buttons are simultaneously pressed.

An electronic input to a single column generates that single column tone. Inputs to multiple columns generates no tone. An electronic input to a single row generates no tone and a single row tone may be generated only by activating 2 columns and the desired row.

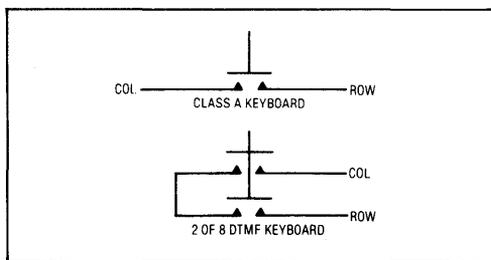


Fig.3 Keyboard configuration

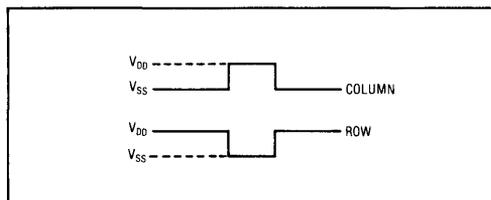


Fig.4 Electronic input

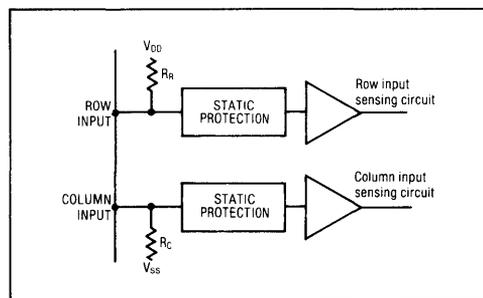


Fig.5 Row and column inputs

**OUTPUT FREQUENCY**

Table 1 shows the output frequency deviation from the standard DTMF frequencies when a 3.58MHz crystal is used as the reference.

The row and column output waveforms are digitally synthesised using R-2R D-to-A converters (see Fig.6), resulting in a 'staircase' approximation to a sinewave. An op-amp mixes these tones to produce a dual-tone waveform. Single tone distortion is typically better than 7% and all distortion components of the mixed dual-tone should be -30dB relative to the strongest fundamental (column tone).

	Standard DTMF (Hz)	Tone Output Frequency Using 3.579545 MHz Crystal	% Deviation From Standard
Row	f <sub>1</sub> 697	701.3	+0.62
	f <sub>2</sub> 770	771.4	+0.19
	f <sub>3</sub> 852	857.2	+0.61
	f <sub>4</sub> 941	935.1	-0.63
Column	f <sub>5</sub> 1209	1215.9	+0.57
	f <sub>6</sub> 1336	1331.7	-0.32
	f <sub>7</sub> 1477	1471.9	-0.35
	f <sub>8</sub> 1633	1645.0	+0.73

Table 1 Output frequency deviation

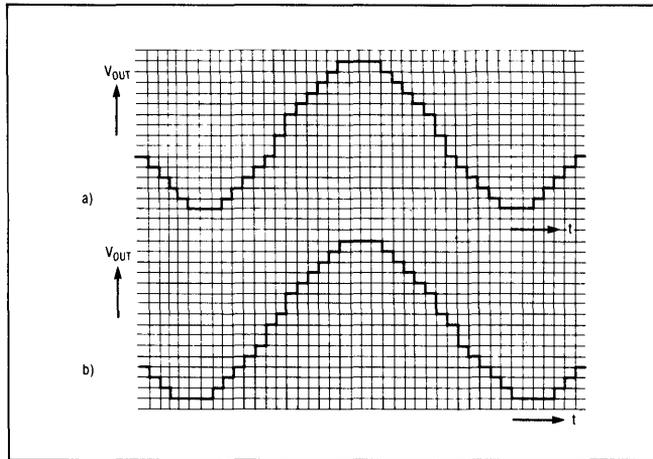


Fig.6 Typical sinewave output (a) Row tones (b) Column tones

**DISTORTION MEASUREMENTS**

THD for the single tone is defined by:

$$100 \left( \frac{\sqrt{V_{2f}^2 + V_{3f}^2 + V_{4f}^2 + \dots + V_{nf}^2}}{V_{\text{fundamental}}} \right) \%$$

Where V<sub>2f</sub> – V<sub>nf</sub> are the Fourier components of the waveform.

THD for the dual tone is defined by:

$$100 \left( \frac{\sqrt{V_{2R}^2 + V_{3R}^2 + \dots + V_{nR}^2 + V_{2C}^2 + V_{3C}^2 + \dots + V_{nC}^2 + V_{\text{IMD}}^2}}{\sqrt{V_{\text{ROW}}^2 + V_{\text{COL}}^2}} \right)$$

where V<sub>ROW</sub> is the row fundamental amplitude  
 V<sub>COL</sub> is the column fundamental amplitude  
 V<sub>2R</sub> – V<sub>nR</sub> are the Fourier component amplitudes of the row frequencies  
 V<sub>2C</sub> – V<sub>nC</sub> are the Fourier component amplitudes of the column frequencies  
 V<sub>IMD</sub> is the sum of all intermodulation components.

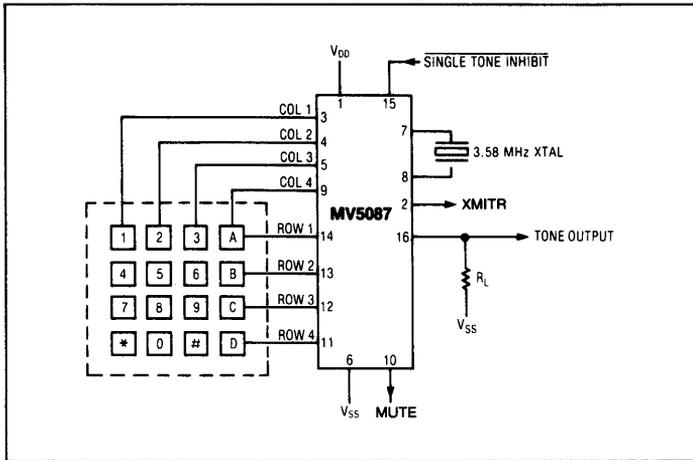


Fig.7 Connection diagram

**MV5087**

# MV5089

## DTMF GENERATOR

The MV5089 is fabricated using Plessey Semiconductors' ISO-CMOS high density technology and offers low power and wide voltage operation. An inexpensive 3.58MHz TV crystal completes the reference oscillator. From this frequency are derived 8 different sinusoidal frequencies which, when appropriately mixed, provide Dual-Tone Multi-Frequency (DTMF) tones.

Inputs are compatible with a standard 2-of-8 active-low keyboard and the keyboard entries determine the correct division of the reference frequency by the row and column counters. D-to-A conversion, using R-2R ladder networks, results in a 'staircase' approximation of a sine wave with low total distortion.

Frequency stability over operating voltage and temperature range are maintained within industry DTMF standards.

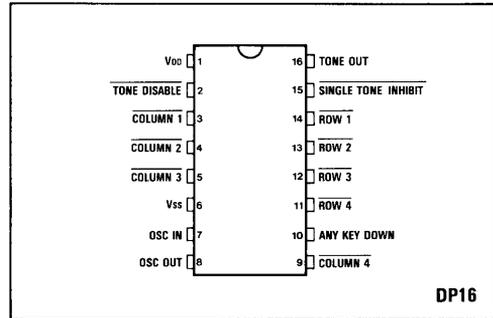


Fig.1 Pin connections - top view

### FEATURES

- Pin-for-Pin Replacement for MK5089
- Low Standby Power
- Minimum External Parts Count
- 2.75V to 10V. Operation
- 2-of-8 Keyboard Input
- High Accuracy Tones Provided by 3.58MHz Crystal Oscillator
- Pin-Selectable Inhibit of Single Tone Generation

### APPLICATIONS

#### DTMF Signalling for

- Telephone Sets
- Mobile Radio
- Remote Control
- Point of Sale and Banking Terminals
- Process Control

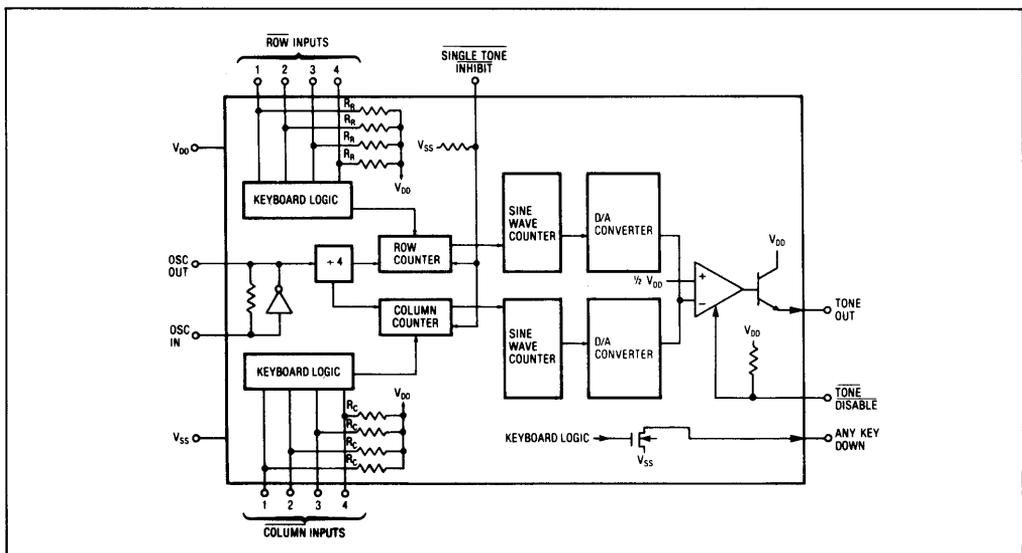


Fig.2 Functional block diagram

## ABSOLUTE MAXIMUM RATINGS

	MIN.	MAX	MIN.	MAX.
$V_{DD}-V_{SS}$	-0.3V	10.5V	Power dissipation Derate 16 mW/°C above 75°C (All leads soldered to PCB)	850 mW
Voltage on any pin	$V_{SS} - 0.3V$	$V_{DD} + 0.3V$		
Current on any pin		10 mA		
Operating temperature	-40°C	+85°C		
Storage temperature	-65°C	+150°C		

## DC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

 $T_{amb} = +25^{\circ}C$ ,  $V_{DD} = 3V$  to  $10V$ 

CHARACTERISTICS		SYMBOL	MIN	TYP	MAX	UNITS		
S U P P L Y	Operating Supply Voltage	$V_{DD}$	2.75		10	V	Ref. to $V_{SS}$	
	Standby Supply Current	$I_{DDS}$		0.2	100	$\mu A$	$V_{DD} = 3V$ No Key Depressed	
				0.5	200	$\mu A$	$V_{DD} = 10V$ All outputs Unloaded	
Operating Supply Current	$I_{DD}$		1.0	2.0	mA	$V_{DD} = 3V$ One Key Depressed		
			5.0	10.0	mA	$V_{DD} = 10V$ All outputs Unloaded		
I N P U T S	SINGLE TONE INHIBIT.	INPUT HIGH VOLTAGE	$V_{IH}$	$0.7V_{DD}$		$V_{DD}$	V	
	TONE DISABLE	INPUT LOW VOLTAGE	$V_{IL}$	0		$0.3V_{DD}$	V	
		INPUT RESISTANCE	$R_{IN}$		60			k $\Omega$
R O W 1-4 C O L U M N 1-4	INPUT HIGH VOLTAGE	$V_{IH}$	$0.7V_{DD}$			$V_{DD}$	V	
	INPUT LOW VOLTAGE	$V_{IL}$	0			$0.3V_{DD}$	V	
O U T P U T S	ANY KEY DOWN	SINK CURRENT	$I_{OL}$	0.5			mA	$V_{DD} = 3V, V_{OL} = 0.5V$
				1.0			mA	$V_{DD} = 10V, V_{OL} = 0.5V$
	LEAKAGE CURRENT	$I_{OZ}$		1			$\mu A$	$V_{DD} = 3V$

## AC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

 $T_{amb} = +25^{\circ}C$ ,  $V_{DD} = 3V$  to  $10V$ 

CHARACTERISTICS		SYMBOL	MIN	TYP	MAX	UNITS	
TONE OUT	OUTPUT LEVEL, ROW	$V_{OUT}$	-10	-8	-7	dBm	$V_{DD} = 3V$ . Single Tone. $R_L = 100K\Omega$
	PRE EMPHASIS, High Band		2.4	2.7	3.0	dB	
	OUTPUT DISTORTION (Dual Tone)				-20	dB	Total out-of-band power relative to sum of row and column fundamental power
	Tone Output Rise Time	$t_r$		3	5	ms	Time for waveform to reach 90% of magnitude of either frequency from initial key stroke

**PIN FUNCTIONS**

PIN	NAME	DESCRIPTION
1	V <sub>DD</sub>	Positive Power Supply
2	TONE DISABLE	This input has an internal pull-up resistor to V <sub>DD</sub> . When connected to V <sub>SS</sub> no tones are generated by any key depression allowing the keyboard to be used for purposes other than DTMF signalling.
3,4,5,9	COLUMN 1-4	These CMOS inputs are held at V <sub>DD</sub> by an internal pull-up resistor and are activated by the application of V <sub>SS</sub> .
6	V <sub>SS</sub>	Negative Power Supply (0V)
7,8	OSC IN, OSC OUT	On-chip inverter completes the oscillator when a 3.58 MHz Crystal is connected to these pins. OSC IN is the inverter input and OSC OUT is the output.
10	Any Key Down	This is an NMOS transistor output which switches to V <sub>SS</sub> while any key is depressed. Otherwise this output is high impedance. Switching is independent of Tone Disable and Single Tone Inhibit.
11,12,13,14	Row 1-4	As Column 1-4 inputs.
15	Single Tone Inhibit	This input has a pull-down resistor to V <sub>SS</sub> . When left unconnected or tied to V <sub>SS</sub> , dual tones may be generated, but keyboard input combinations resulting in single tone generation are inhibited. When V <sub>DD</sub> is applied single or dual tones may be generated.
16	Tone Out	Emitter output of a bipolar NPN transistor whose collector is tied to V <sub>DD</sub> . Input to this transistor is from an op-amp which mixes the Row and Column tones.

**ROW AND COLUMN INPUTS**

These inputs are compatible with the standard 2-of-8 keyboard or with an electronic input. Figures 3 and 4 show these input configurations and Fig.5 shows the internal chip structure of these inputs.

When operating with a keyboard, dual tones are generated when any single button is pushed.

With Single Tone Inhibit at V<sub>DD</sub>, connection of V<sub>SS</sub> to a single column causes the generation of that Column tone. Connection of V<sub>SS</sub> to more than one Column will result in no Column tones being generated. Connection of V<sub>SS</sub> to Rows only generates no tone - a Column must be connected to V<sub>SS</sub>.

A single Row tone only may be generated by connecting 2 columns, and the desired row, to V<sub>SS</sub>.

**OUTPUT TONE LEVEL**

The output tone level of the MV5089 is proportional to the applied DC supply voltage.

A regulated supply will normally be used which may be designed to provide stability over the temperature range.

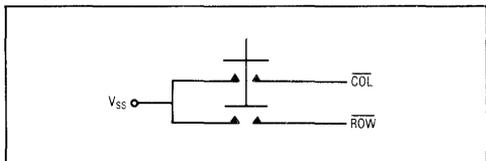


Fig.3 2 of 8 DTMF keyboard

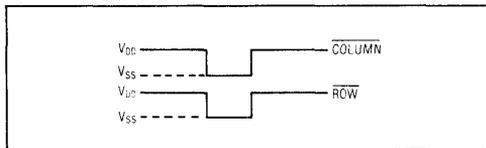


Fig.4 Electronic input

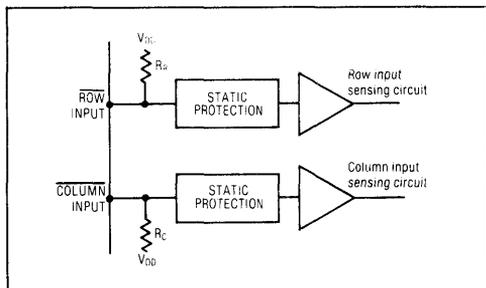


Fig.5 Row and Column inputs

**OUTPUT FREQUENCY**

Table 1 shows the output frequency deviation from the standard DTMF frequencies when a 3.58MHz crystal is used as the reference.

The row and column output waveforms are digitally synthesised using R-2R D-to-A converters (see Fig.6) resulting in staircase approximations to a sinewave. An op-amp mixes these tones to produce a dual-tone waveform. Single tone distortion is typically better than 7% and all distortion components of the mixed dual-tone should be -30dB relative to the strongest fundamental (column tone).

	Standard DTMF (Hz)	Tone Output Frequency Using 3.579545 MHz Crystal	% Deviation From Standard	
Row	f <sub>1</sub> 697	701.3	+0.62	Low Group
	f <sub>2</sub> 770	771.4	+0.19	
	f <sub>3</sub> 852	857.2	+0.61	
	f <sub>4</sub> 941	935.1	-0.63	
Column	f <sub>5</sub> 1209	1215.9	+0.57	High Group
	f <sub>6</sub> 1336	1331.7	-0.32	
	f <sub>7</sub> 1477	1471.9	-0.35	
	f <sub>8</sub> 1633	1645.0	+0.73	

Table 1 Output frequency deviation

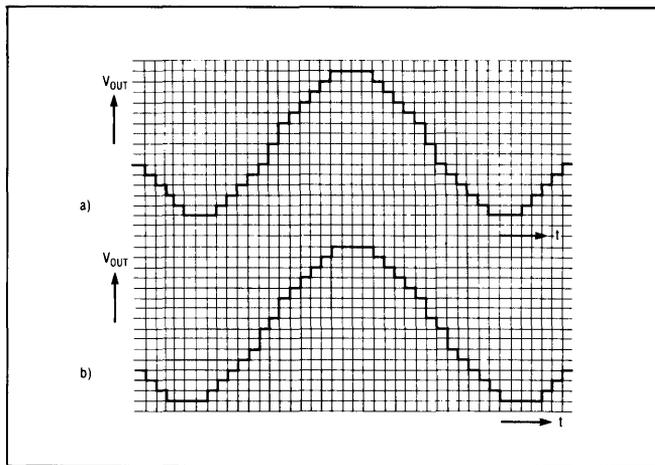


Fig.6 Typical sinewave output (a) Row tones (b) Column tones

**DISTORTION MEASUREMENTS**

THD for the single tone is defined by:

$$100 \left( \frac{\sqrt{V_{2f}^2 + V_{3f}^2 + V_{4f}^2 + \dots + V_{nf}^2}}{V_{\text{fundamental}}} \right) \%$$

Where V<sub>2f</sub> – V<sub>nf</sub> are the Fourier components of the waveform.

THD for the dual tone is defined by:

$$100 \left( \frac{\sqrt{V_{2R}^2 + V_{3R}^2 + \dots + V_{nR}^2 + V_{2C}^2 + V_{3C}^2 + \dots + V_{nC}^2 + V_{\text{IMD}}^2}}{\sqrt{V_{\text{ROW}}^2 + V_{\text{COL}}^2}} \right)$$

where V<sub>ROW</sub> is the row fundamental amplitude  
 V<sub>COL</sub> is the column fundamental amplitude  
 V<sub>2R</sub> – V<sub>nR</sub> are the Fourier component amplitudes of the row frequencies  
 V<sub>2C</sub> – V<sub>nC</sub> are the Fourier component amplitudes of the column frequencies  
 V<sub>IMD</sub> is the sum of all intermodulation components.

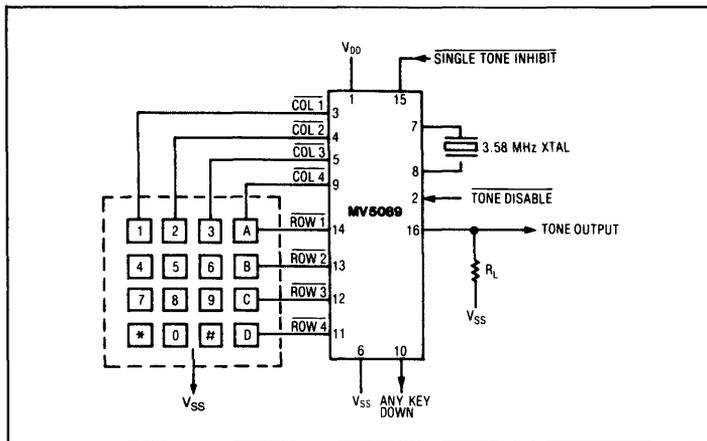


Fig.7 connection diagram





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# MV8804 EXP

## 8 x 4 BIDIRECTIONAL ANALOGUE SWITCH ARRAY

The MV8804 is a CMOS/LSI 8 x 4 Analogue Switch Array incorporating control memory (32 bits), decoder and digital logic level converters. The circuit has digitally-controlled analogue switches having very low 'ON' resistance and very low 'OFF' leakage current. The switches will operate with analogue signals at frequencies up to 40MHz and up to 13.0V peak-to-peak. A 'HIGH' on the Master Reset input switches all channels 'OFF' and clears the memory. The MV8804 is ideal for crosspoint switching applications.

### FEATURES

- Microprocessor Compatible Control Inputs
- On-Chip Control Memory And Address Decoding
- Row Addressing
- Master Reset
- 32 Crosspoint Switches in 8 x 4 Array
- 5.0V to 13.0V Operation
- Low Crosstalk Between Switches
- Low On Resistance: 90Ω (typ.) At 10V
- Matched Switch Characteristics
- Switches Frequencies Up To 40MHz

### APPLICATIONS

- PABX And Key Systems
- Data Acquisition Systems
- Test Equipment/Instrumentation
- Analogue/Digital Multiplexers

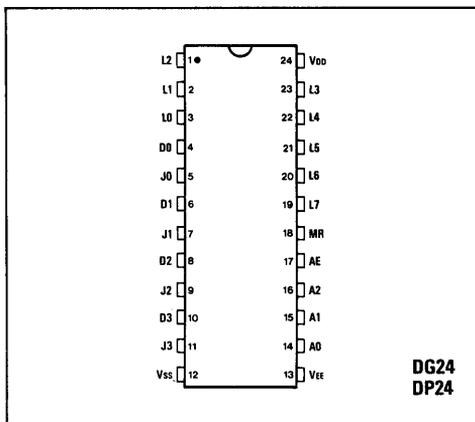


Fig.1 Pin connections - top view

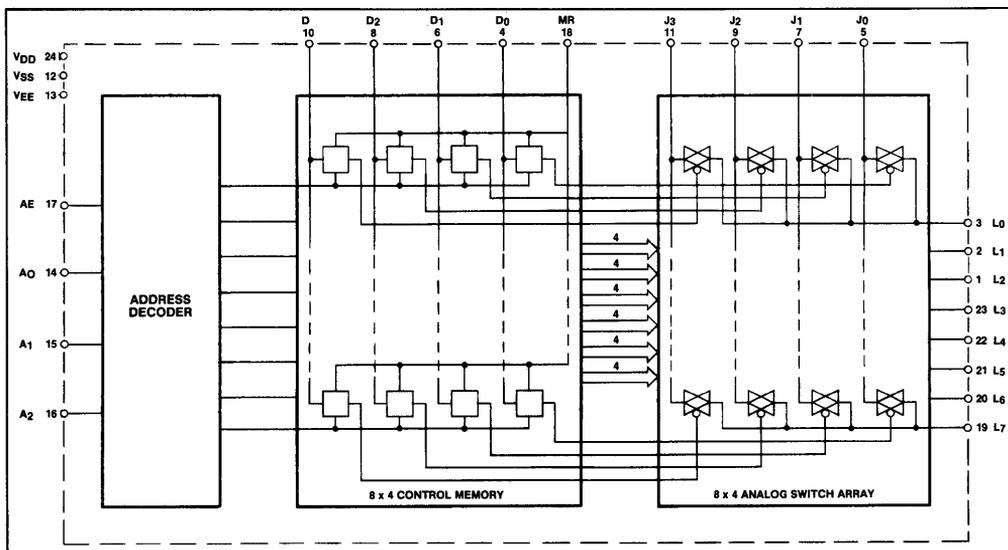


Fig.2 MV8804 functional block diagram

**ABSOLUTE MAXIMUM RATINGS**

Exceeding these ratings may cause permanent damage. Functional operation under these conditions is not implied.

	Min.	Max.		Min.	Max.
V <sub>DD</sub> - V <sub>SS</sub>	-0.3V	16V	Storage temperature (DP package)	-65° C	+125° C
V <sub>DD</sub> - V <sub>EE</sub>	-0.3V	16V			
V <sub>SS</sub> - V <sub>EE</sub>	-0.3V	16V	Power dissipation (DG package)		1200mW*
Voltage on any logic pin	V <sub>SS</sub> -0.3V	V <sub>DD</sub> +0.3V			
Voltage on any line (V <sub>L</sub> ) or junctor (V <sub>J</sub> )	V <sub>EE</sub> -0.3V	V <sub>DD</sub> +0.3V	Power dissipation (DP package)		600mW**
Current at any logic pin		10mA			
Operating temperature (all packages)	-40° C	+85° C			
Storage temperature (DG package)	-65° C	+150° C			

\* Derate 16mW/°C above 75° C. All leads soldered to PC board.

\*\* Derate 6.3mW/°C above 25° C. All leads soldered to PC board.

**AC ELECTRICAL CHARACTERISTICS**

Test conditions (unless otherwise stated):

T<sub>amb</sub> = +25° C, V<sub>SS</sub> - V<sub>EE</sub> = 0V, V<sub>is</sub> = 5V p-p, C<sub>L</sub> = 50pF, R<sub>L</sub> = 10kΩ, t<sub>r</sub> = t<sub>f</sub> = 20ns (input signal)

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Sine wave response (distortion)			0.1		%	V <sub>DD</sub> = 13V } V <sub>DD</sub> = 10V } fin = 1kHz V <sub>DD</sub> = 5V }
			0.2		%	
			1.0		%	
Frequency response channel 'ON' (sine wave input)			40		MHz	V <sub>C</sub> = V <sub>DD</sub> = 10V, $\frac{V_o}{V_i} = -3dB$
Feedthrough channel 'OFF'			-40		dB	V <sub>DD</sub> = 10V, V <sub>C</sub> = V <sub>EE</sub> , R <sub>L</sub> = 1kΩ, fin = 1MHz
Crosstalk between any two channels			-40		dB	fin = 1.0MHz } V <sub>DD</sub> = 10V, Switch A fin = 3.4kHz } 'ON', Switch B 'OFF'
			-90		dB	
Propagation delay Signal input to signal output	t <sub>PS</sub>		10		ns	V <sub>DD</sub> = 10V, Switch 'ON'
Turn 'ON' propagation delay Data input to signal output	t <sub>PLH</sub>		200		ns	V <sub>DD</sub> = 10V
	t <sub>PHL</sub>		400		ns	V <sub>DD</sub> = 5V
Address enable to signal output	t <sub>PAE</sub>		300		ns	V <sub>DD</sub> = 10V
			600		ns	V <sub>DD</sub> = 5V
Minimum address enable (AE) Pulse width	t <sub>AE</sub>		90		ns	V <sub>DD</sub> = 10V
			225		ns	V <sub>DD</sub> = 5V
Minimum set-up time Address to AE	t <sub>s</sub>	0	50		ns	V <sub>DD</sub> = 10V
		0	90		ns	V <sub>DD</sub> = 5V
Data in to AE	t <sub>s</sub>		50		ns	V <sub>DD</sub> = 10V
			90		ns	V <sub>DD</sub> = 5V
Minimum Hold Time Address or data in to address enable	t <sub>h</sub>		50		ns	V <sub>DD</sub> = 10V
			90		ns	V <sub>DD</sub> = 5V
Memory reset time	t <sub>MR</sub>		175		ns	V <sub>DD</sub> = 10V, R <sub>L</sub> = 1kΩ
Memory reset recovery time	T <sub>MRR</sub>		150		ns	V <sub>DD</sub> = 10V } V <sub>DD</sub> = 5V } R <sub>L</sub> = 1kΩ
			250		ns	

**DC ELECTRICAL CHARACTERISTICS**

Test conditions (unless otherwise stated):

T<sub>amb</sub> = +25°C, V<sub>SS</sub> = V<sub>EE</sub> = 0V

Characteristic	Symbol	Value			Units	Conditions
		Min.	Typ.	Max.		
Operating voltage range						
Digital	V <sub>DD</sub> - V <sub>SS</sub>	5	5	13	V	
Analogue	V <sub>DD</sub> - V <sub>EE</sub>	5	10	13	V	
Logic level converter	V <sub>SS</sub> - V <sub>EE</sub>	0	5	12	V	
On state resistance	R <sub>ON</sub>		75	108	Ω	V <sub>DD</sub> = 13V } V <sub>DD</sub> = 10V } V <sub>J</sub> = V <sub>L</sub> = 0.6V V <sub>DD</sub> = 5V }
			90		Ω	
			240		Ω	
Difference in On state Resistance between any switches	R <sub>ON</sub>		20		Ω	V <sub>DD</sub> = 13V
			30		Ω	V <sub>DD</sub> = 10V
Off state leakage current (any line to any junctor)	I <sub>OFF</sub>		±0.01	±500	nA	V <sub>DD</sub> = 13V, selected crosspoint in Off state
Input logic '0' level	V <sub>IL</sub>		4.5		V	V <sub>DD</sub> = 10V } V <sub>DD</sub> = 5V } V <sub>is</sub> = V <sub>DD</sub> through 1kΩ
			2.25	1.5	V	
Input logic '1' level	V <sub>IH</sub>		5.5		V	V <sub>DD</sub> = 10V } V <sub>DD</sub> = 5V } V <sub>is</sub> = V <sub>DD</sub> through 1kΩ
		3.5	2.75		V	
Quiescent device current (per package)	I <sub>Q</sub>		0.1	500	μA	V <sub>DD</sub> = 13V
Maximum current through crosspoint switch	I <sub>MAX</sub>		±8.0		mA	V <sub>DD</sub> = 13V
Switch input capacitance	C <sub>is</sub>		5		pF	V <sub>DD</sub> = 10V, V <sub>in</sub> = 0V
Switch output capacitance	C <sub>os</sub>		20		pF	V <sub>DD</sub> = 10V, V <sub>in</sub> = 0V
Feedthrough capacitance	C <sub>ios</sub>		0.2		pF	V <sub>DD</sub> = 10V, V <sub>in</sub> = 0V
Digital input capacitance	C <sub>in</sub>		5		pF	V <sub>DD</sub> = 10V, V <sub>in</sub> = 0V

NOTES

1. Typical parametric values are for Design Aid Only, not guaranteed and not subject to production testing.
2. V<sub>is</sub> is the analogue switch input voltage, V<sub>in</sub> is digital input voltage.

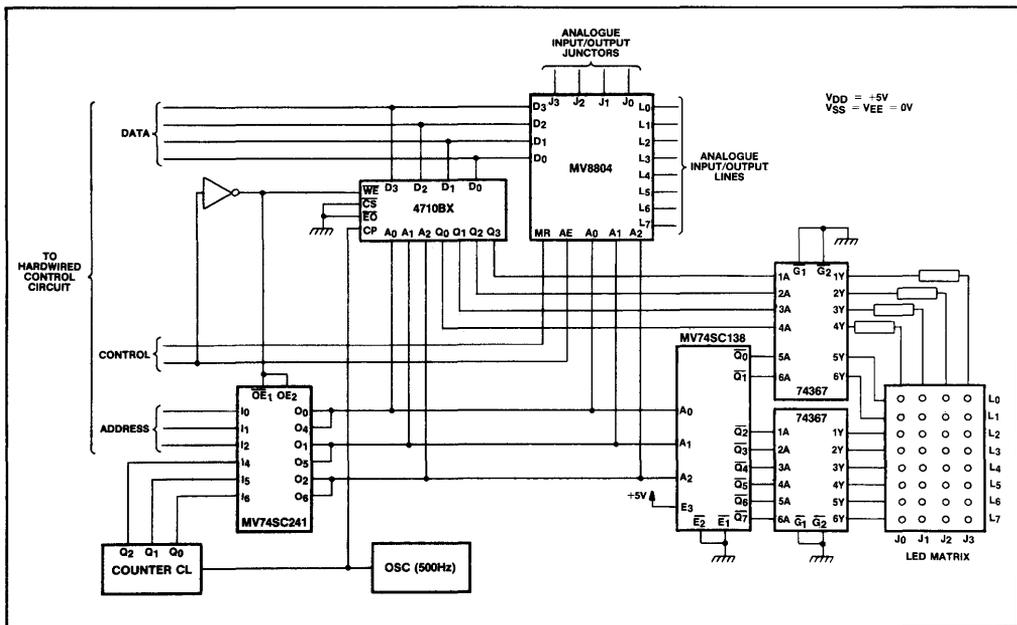


Fig.3 Visual indication of MV8804 control memory status

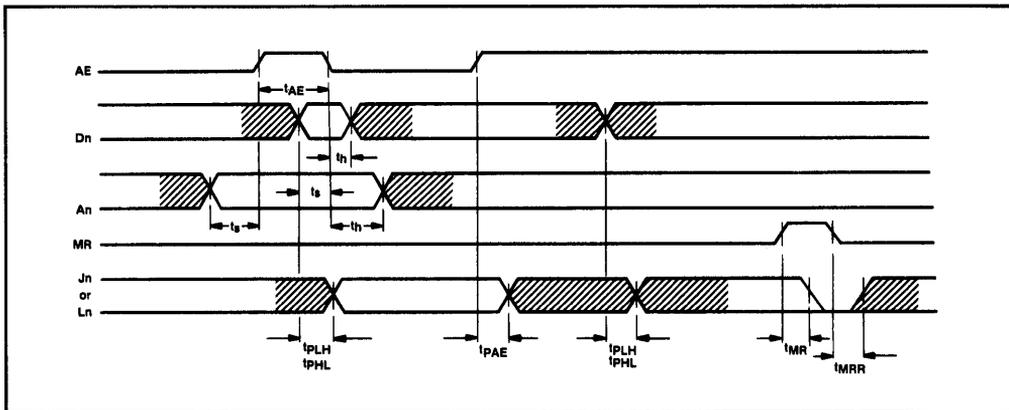


Fig.4 Timing waveforms

**PIN DESCRIPTION**

Pin	Name	Description
1	L <sub>2</sub>	Analogue Switch Array Input/Output Line
2	L <sub>1</sub>	Analogue Switch Array Input/Output Line
3	L <sub>0</sub>	Analogue Switch Array Input/Output Line
4	D <sub>0</sub>	Control Memory Data Line Input
5	J <sub>0</sub>	Analogue Switch Array Input/Output Junctor
6	D <sub>1</sub>	Control Memory Data Line Input
7	J <sub>1</sub>	Analogue Switch Array Input/Output Junctor
8	D <sub>2</sub>	Control Memory Data Line Input
9	J <sub>2</sub>	Analogue Switch Array Input/Output Junctor
10	D <sub>3</sub>	Control Memory Data Line Input
11	J <sub>3</sub>	Analogue Switch Input/Output Junctor
12	V <sub>SS</sub>	Negative Digital Power Supply
13	V <sub>EE</sub>	Negative Analogue Power Supply
14	A <sub>0</sub>	Control Memory Address Input
15	A <sub>1</sub>	Control Memory Address Input
16	A <sub>2</sub>	Control Memory Address Input
17	AE	Control Memory Address Enable Input (Strobe)
18	MR	Master Reset
19	L <sub>7</sub>	Analogue Switch Array Input/Output Line
20	L <sub>6</sub>	Analogue Switch Array Input/Output Line
21	L <sub>5</sub>	Analogue Switch Array Input/Output Line
22	L <sub>4</sub>	Analogue Switch Array Input/Output Line
23	L <sub>3</sub>	Analogue Switch Array Input/Output Line
24	V <sub>DD</sub>	Positive Analogue/Digital Power Supply

**FUNCTIONAL DESCRIPTION**

The analogue switch array is arranged in 8 rows and 4 columns. The row input/outputs are referred to as LINES (L0-L7) and the column input/outputs as JUNCTORS (J0-J3). The crosspoint analogue switches interconnect the lines and junctors when turned 'ON' and provide a high degree of isolation when turned 'OFF'. Interchannel crosstalk is minimal despite the high density of the analogue switch array.

The control memory of the MV8804 can be treated as an 8-word by 4-bit random access memory. The 8 words are selected by the ADDRESS (A0-A2) inputs through the on-chip address decoder. Data is presented to the memory via the 4 DATA inputs (D0-D3). This data is asynchronously written into the control memory whenever the ADDRESS ENABLE (AE) input is high. A high level written into a memory cell turns the corresponding crosspoint switch 'ON' while a low level causes the crosspoint to turn 'OFF'.

Only the crosspoint switches corresponding to the addressed memory word are affected when data is written

into the memory. The remaining switches retain their previous states. By establishing appropriate patterns in the control memory, any combination of lines and junctors may be interconnected. A high level on the MASTER RESET (MR) input returns all memory locations to a low level and turns all crosspoint switches 'OFF', effectively isolating the lines from the junctors. The digital logic level converters allow the digital input levels to differ from limits of the analogue levels switched through the array. For example, with V<sub>DD</sub> = 5V, V<sub>SS</sub> = 0V and V<sub>EE</sub> = -6V, the control inputs can be driven by a 5V system while the analogue voltages through the crosspoint switches can swing from +5V to -6V.

**8 x 8 ANALOGUE/DIGITAL SWITCH**

Two MV8804s configured as shown in Fig.7, implement an 8 x 8 analogue/digital switch. The switch capacity can be expanded to an M x N array of inputs/outputs. Expansion in the N dimension is as shown and connecting the lines (L0-L7) from the MV8804s in common.

LOGIC TRUTH TABLE

Memory reset	Address enable	Address			Addressed line	Input data to control memory				Junctors connected to addressed line			
		A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>		D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	0	J <sub>3</sub>	J <sub>2</sub>	J <sub>1</sub>	J <sub>0</sub>
H	X	X	X	X	All	X	X	X	X	All switches 'Off'			
L	L	X	X	X	None	X	X	X	X	No change of state			
L	H	L	L	L	L0	L	L	L	L	•	•	•	•
L	H	L	L	L	L0	L	L	L	H	•	•	•	+
L	H	L	L	L	L0	L	L	H	L	•	•	+	•
L	H	L	L	L	L0	L	L	H	H	•	•	+	+
L	H	L	L	L	L0	L	H	L	L	•	+	•	•
L	H	L	L	L	L0	L	H	L	H	•	+	•	+
L	H	L	L	L	L0	L	H	H	L	•	+	+	•
L	H	L	L	L	L0	L	H	H	H	•	+	+	+
L	H	L	L	L	L0	H	L	L	L	+	•	•	•
L	H	L	L	L	L0	H	L	L	H	+	•	•	+
L	H	L	L	L	L0	H	L	H	L	+	•	+	•
L	H	L	L	L	L0	H	L	H	H	+	•	+	+
L	H	L	L	L	L0	H	H	L	L	+	+	•	•
L	H	L	L	L	L0	H	H	L	H	+	+	•	+
L	H	L	L	L	L0	H	H	H	L	+	+	+	•
L	H	L	L	L	L0	H	H	H	H	+	+	+	+
L	H	L	L	H	L1	Each addressed line may have 16 different combinations of junctors connected to it by inputing data to the control memory as shown for L0.							
L	H	L	H	L	L2								
L	H	L	H	H	L3								
L	H	H	L	L	L4								
L	H	H	L	H	L5								
L	H	H	H	L	L6								
L	H	H	H	H	L7								

NOTES

- L = Low Logic Level
- H = High Logic Level
- X = Don't Care Condition
- + = Indicates Connection Between Junctor and Addressed Line
- = Indicates No Connection Between Junctor and Addressed Line

Expansion in the N dimension is accomplished by replicating the circuit shown and connecting the MV8804 junctors (J0-J3) in common. The address and data control inputs of the MV8804s can be connected in common for any size and switch provided that the address enable (AE) inputs are driven individually, for example by an MV74SC601 programmable AND gate.

A particular signal path is connected by setting up the appropriate signals on the address and data lines and taking the corresponding address enable input high. The master reset (MR), when taken high, disconnects all signal paths.

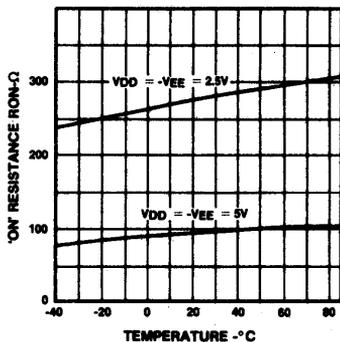


Fig.5 ON resistance vs temperature Expanding MV8804s (input signal voltage = supply voltage/2)

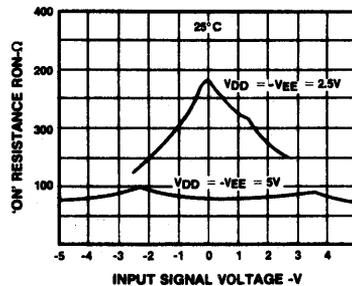


Fig.6 ON resistance vs input signal voltage

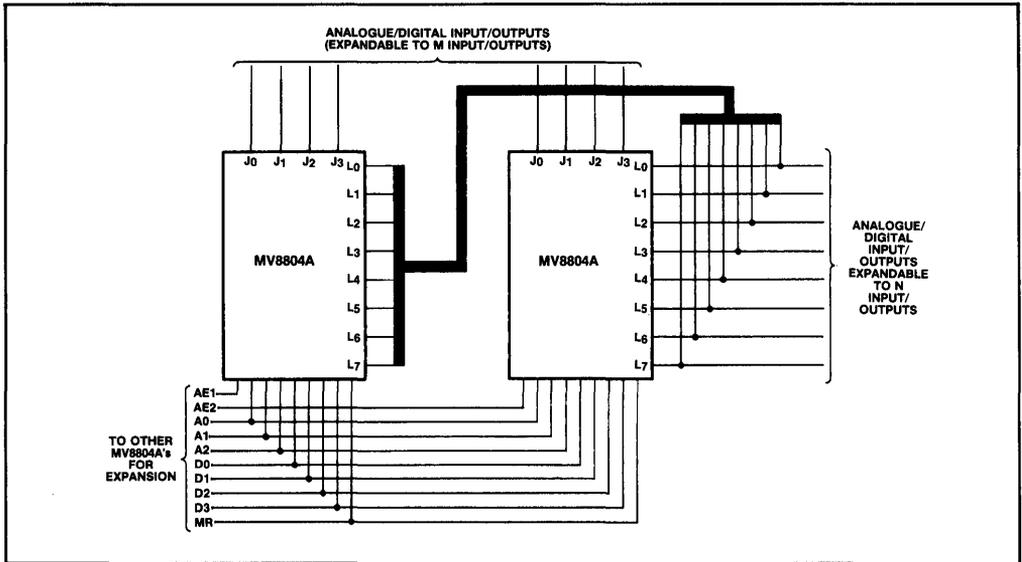


Fig.7 Expanding MV8804s

# MV8860

## DTMF DECODER

The MV8860 detects and decodes all 16 DTMF tone pairs. The device accepts the high group and low group square wave signals from a DTMF filter (MV8865) and provides a 3-state buffered 4-bit binary output. The clock signals are derived from an on-chip oscillator requiring only a single resistor and low cost crystal as external components. The MV8860 is implemented in CMOS technology and incorporates an on-chip regulator, providing low power operation and power supply flexibility.

The MV8860 is available in Plastic DIL (DP) and Ceramic DIL (DG), both with an operating temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

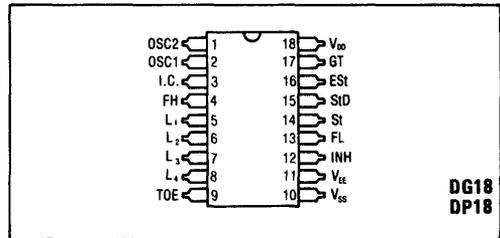


Fig.1 Pin connections (top view)

### FEATURES

- 18 Pin DIL Package
- Central Office Quality Detection
- Excellent Voice Talk-Off
- Detect Times down to 20ms
- Single Supply 5V, or 8 to 13V Operation
- Latched 3-State Buffered Outputs
- Detects All 16 DTMF Combinations
- Uses Inexpensive 3.58 MHz Crystal
- Low Power CMOS Circuitry
- Adjustable Acquisition and Release Times
- Equivalent to MT8860X

### APPLICATIONS

#### In DTMF Receivers For:

- End-to-end Signalling
- Control Systems
- PABX
- Central Office
- Mobile Radio
- Key Systems
- Tone to Pulse Converters

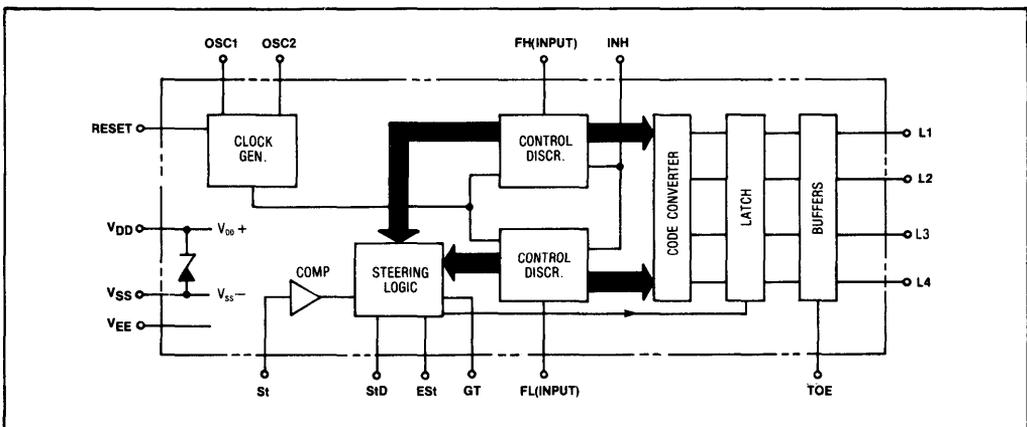


Fig.2 MV8860 functional block diagram

DC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

$T_{amb} = +25^{\circ}C$ ;  $f_c = 3.579545MHz$

5V operation:  $V_{DD} - V_{EE} = 5V$ ,  $V_{SS} = V_{EE}$ , connections as Fig.5a

12V operation:  $V_{DD} - V_{EE} = 12V$ ,  $R_{SSEE} = 900\Omega$ , connections as Fig.5b

Outputs not loaded

For input current parameters only,  $V_{IH} = V_{IHO} = V_{DD}$ ,  $V_{IL} = V_{EEL} = V_{SS}$

All voltages referenced to  $V_{EE}$  unless otherwise noted.

	Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions		
SUPPLY	Operating Supply Voltage ( $V_{DD} - V_{EE}$ )	$V_{DD}$	4.75	5	5.25	V	Connections Fig. 5a		
			8		13	V	Connections Fig. 5b		
	Internal Logic Ground Voltage ( $V_{DD} - V_{SS}$ )	$V_{DDSS}$	4.75		5.25	V	Connections Fig. 5a		
			6.0	6.5	7.5	V	Connections Fig. 5b		
	Operating Supply Current	$I_{DD}$		1.3	4	mA	5V		
				2.5	5	mA	12V $V_{DD} - V_{SS} = 5.5V$		
	Internal Logic Ground Pin Current	$I_{SS}$		5.5	6.7	mA	12V $R_{SSEE} = 900\Omega$		
	Operating Power Consumption	$P_o$			6.5		mW	5V	
					66		mW	12V	
INPUTS	High Level Input Voltage (All Inputs Except OSC1)	$V_{IH}$	3.5	4		V	5V		
	8.5		9		V	12V			
	Low Level Input Voltage (All Inputs Except OSC1)	$V_{IL}$		1	1.5	V	5V		
			3	3.5	V	12V			
	High Level Input Voltage OSC1	$V_{IHO}$	3.5	4.5		V	5V		
			10.5	11		V	12V		
	Low Level Input Voltage OSC1	$V_{ILO}$		0.5	1.5	V	5V Ref $V_{SS}$		
				0.5	1.5	V	12V Ref $V_{SS}$		
	Steering Input Threshold Voltage	$V_{Tst}$	2.04	2.27	2.5	V	5V		
			5.4	6.0	6.6	V	12V		
	Pull Down Sink Current (INT $\dagger$ )	$I_{IH}$	10	25	75	$\mu A$	5V		
			10	190	400	$\mu A$	12V		
	Pull Up Source Current (TOE)	$I_{ILT}$	2	7	45	$\mu A$	5V		
			10	55	250	$\mu A$	12V		
	Input High Leakage Current	$I_{IH}$		0.1	1.5	$\mu A$	5V or 12V		
Input Low Leakage Current	$I_{IL}$			0.1	1.5	$\mu A$			
OUTPUTS	High Level Output Voltage (All Outputs Except OSC2)	$V_{OH}$	4.9			V	5V		
			11.9			V	12V		
	Low Level Output Voltage (All Outputs Except OSC2)	$V_{OL}$			0.1	V	5V		
					0.1	V	12V		
	High Level Output Voltage OSC2	$V_{OHO}$	4.9			V	5V		
			11.9			V	12V		
OUTPUTS	Low Level Output Voltage OSC2	$V_{OLO}$			0.1	V	5V Ref $V_{SS}$		
					0.1	V	12V Ref $V_{SS}$		
	Output Drive Current (All Outputs Except OSC2)	P Channel Source	$I_{OH}$	0.4	0.6		mA	5V $V_{OH} = 4.5V$	
				0.5	0.8		mA	12V $V_{OH} = 11.5V$	
		N Channel Sink	$I_{OL}$	0.8	1.2		mA	5V $V_{OL} = 0.5V$	
				1.0	1.6		mA	12V $V_{OL} = 0.5V$	
	Output Drive Current OSC2	P Channel Source	$I_{OHO}$	90	120		$\mu A$	5V $V_{OH} = 4.5V$	
				90	120		$\mu A$	12V $V_{OH} = 11.5V$	
		N Channel Sink	$I_{OLO}$	100	160		$\mu A$	5V $V_{OL} = 0.5V$	
				100	160		$\mu A$	12V $V_{SS} = 0.5V$	
	Tristate Output Current (High Impedance State)	$L_1 - L_4 = H$ $L_1 - L_4 = L$ $L_1 - L_4 = H$ $L_1 - L_4 = L$	$I_{oz}$		0.035	1.5	$\mu A$	5V Appl $V_{OL} = 0V$	
						0.1	1.5	$\mu A$	5V Appl $V_{OH} = 5V$
						0.1	1.5	$\mu A$	12V Appl $V_{OL} = 0V$
						0.3	1.5	$\mu A$	12V Appl $V_{OH} = 12V$

All "typical" parametric information is for design aid only, not guaranteed and not subject to production testing.

## AC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

$$T_{amb} = +25^{\circ}\text{C}; V_{DD} = +5\text{V}; f_c = 3.579545\text{MHz}$$

		Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions			
1	D E T E C T O R	Tone Frequency Deviation Accept	$\Delta f_A$			$\pm 2.5$	% Nom.				
2		Tone Frequency Deviation Reject	$\Delta f_R$	$\pm 3.5$			% Nom.				
3		Tone Present Detection Time	$t_{DP}$	6		10	ms				
4		Tone Absent Detection Time	$t_{DA}$	0.6	4	10	ms				
5		Guard Time (Adjustable)	$t_{GT(P \text{ or } E)}$		20		ms	See Fig. 3			
6		Time to Receive = ( $t_{DP} + t_{GTP}$ )	$t_{REC}$	28	30	35	ms	Fig. 7a R = 300k $\Omega$			
7		Invalid Tone Duration ( $f_n$ of $t_{REC}$ )	$t_{REC}$			20	ms	C = 0.1 $\mu$ F			
8		Interdigit Pause = ( $t_{DA} + t_{GTA}$ )	$t_{ID}$	30			ms				
9		Acceptable Drop Out ( $f_n$ of $t_{ID}$ )	$t_{DO}$			20	ms				
10		I/P	FL FH Input Transition Time	$t_T$			1.0	us	10% - 90% $V_{DD}$		
11		Capacitance Any Input	C		5	7.5	pF				
12	O U T P U T S	Propogation Delay St to $L_1 - L_4$	$t_{PL}$		8	11	$\mu$ s	$V_{DD}$ 5V			
13					8	11	$\mu$ s	$V_{DD}$ 12V			
14				Propogation Delay St to StD	$t_{PSID}$		12	14	$\mu$ s	$V_{DD}$ 5V	
15		12	14			$\mu$ s	$V_{DD}$ 12V				
16	P R O P O G A T I O N	Propogation Delay TOE to $L_1 - L_4$	Enable	$t_{PTE}$		300	ns	$V_{DD}$ 5V			
17						200	ns	$V_{DD}$ 12V			
18		Disable	$t_{PTD}$		300	ns	$V_{DD}$ 5V				
19					200	ns	$V_{DD}$ 12V				
20		Crystal/Clock Frequency	$f_c$	3.5759	3.5795	3.5831	MHz	OSC 1	OSC 2		
21	C L O C K	Clock Input (OSC 1)	Rise Time	$t_{LHCl}$			110	ns	10% - 90%	Externally	
22			Fail Time	$t_{HLCI}$				110	ns	$V_{DD} = V_{SS}$	Applied
23			Duty Cycle (OSC 1)	$DC_{Cl}$	40	50	60	%			Clock
24	C L O C K	Clock Output (OSC 2)	Capacitive Load	$C_{LOC}$			30	pF	With Clock Drive to OSC 1		
25					$C_{LOX}$			nF	Sinusoidal Output With Crystal		

## ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

Parameter		Min	Max		Max
$V_{DD} - V_{EE}$			16	V	Power Dissipation
$V_{DD} - V_{SS}$ (Low Impedance Supply)			5.5	V	DP Package** 450mW
	Voltage on any pin except OSC1 OSC2	$V_{EE} - 0.3$	$V_{DD} + 0.3$	V	* Derate 16mW/ $^{\circ}\text{C}$ above 75 $^{\circ}\text{C}$ ** Derate 6.3mW/ $^{\circ}\text{C}$ above 25 $^{\circ}\text{C}$ All leads soldered to PC board.
Voltage OSC1 OSC2	$V_{SS} - 0.3$	$V_{DD} + 0.3$	V		
Max current at any pin (except $V_{DD}$ & $V_{EE}$ )			10	mA	
Operating Temperature	DP/DG Package	-40	+85	$^{\circ}\text{C}$	
Storage Temperature	DG Package	-55	+175	$^{\circ}\text{C}$	
	DP Package	-55	+125	$^{\circ}\text{C}$	

Original Tone Character		TOE	L4	L3	L2	L1
	X	L	Z	Z	Z	Z
DR	1	H	L	L	L	H
	2	H	L	L	H	L
	3	H	L	L	H	H
	4	H	L	H	L	L
	5	H	L	H	L	H
	6	H	L	H	H	L
	7	H	L	H	H	H
	8	H	H	L	L	L
	9	H	H	L	L	H
	0	H	H	L	H	L
D	*	H	H	L	H	H
	#	H	H	H	L	L
	A	H	H	H	L	H
	B	H	H	H	H	L
	C	H	H	H	H	L
D	H	L	L	L	L	

(a) Output coding

Detected Character	INH	EST
None	∅	L
X	L	H
DR	H	H
D	H	L

(b) Inhibit function

Est	St	GT	StD*
L	L	L	L
H	L	Z	L
L	H	Z	H
H	H	H	H

(c) Steering

\* DELAYED WRT St.  
 FOR THE PURPOSE OF THESE TABLES CONSIDER:  
 $V_{St} < V_{TSt}$  LOGIC LOW (L)  
 $V_{St} > V_{TSt}$  LOGIC HIGH (H)  
 H= LOGIC HIGH    L= LOGIC LOW  
 ∅= "DON'T CARE" LOGIC HIGH OR LOW  
 Z= HIGH IMPEDANCE    X= ANY CHARACTER

Table 1 Coding data

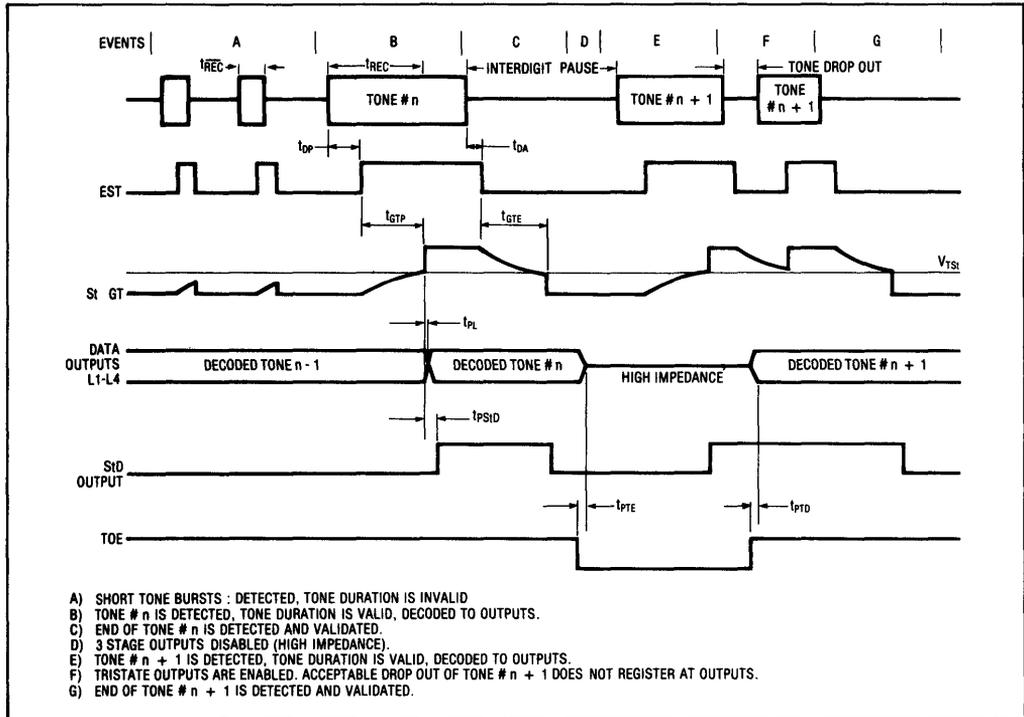


Fig.3 Timing diagram

## PIN FUNCTIONS

Pin	Name	Description	
1	OSC2	CLOCK OUTPUT	3.58MHz crystal with parallel 5M $\Omega$ resistor connected between these pins completes internal oscillator, running between V <sub>DD</sub> and V <sub>SS</sub> .
2	OSC1	CLOCK INPUT	
3	IC	Internal connection for testing only (reset) Note 1	
4	FH	High frequency group input. Accepts single rectangular wave High group tone from DTMF filter	
5	L1	Data Outputs. 3 state buffered Provides 4 Bit binary word corresponding to the tone pair decoded, when enabled by TOE See Table 1 for state table	
6	L2		
7	L3		
8	L4		
9	TOE	3 state output enable input. Logic high on this input enables outputs L1-L4. Internal pull up	
10	V <sub>SS</sub>	Internal logic ground. For V <sub>DD</sub> - V <sub>EE</sub> = 5V V <sub>SS</sub> connected to V <sub>EE</sub> . For V <sub>DD</sub> - V <sub>EE</sub> > 8V, V <sub>SS</sub> connected via resistor to V <sub>EE</sub> see Fig. 5	
11	V <sub>EE</sub>	Negative power supply. External logic ground	
12	INH	Inhibit input. Logic high inhibits detection of tones representing characters #, *, A, B, C, D. Internal pull down	
13	FL	Low frequency group input. Accepts single rectangular wave low group tone from DTMF filter	
14	St	Steering input. A voltage greater than V <sub>TSt</sub> on this input causes the device to accept validity of the detected tone pair and latch the corresponding codeword at the outputs Voltage < V <sub>TSt</sub> on this pin frees the device to accept a new tone pair. See Table 1c and Functional Description	
15	StD	Delayed Steering Output. Flags when a valid tone pair has been received. Presents logic high when output latch updated. When St voltage exceeds V <sub>TSt</sub> . Returns to logic low when St voltage falls below V <sub>TSt</sub>	
16	EST	Early Steering Output. Presents a logic high immediately the digital algorithm detects a recognisable tone pair. Any momentary loss of the incoming tone or excessive distortion of the tone will cause EST to return to a logic low	
17	GT	Guard Time Output. 3 state output. Normally connected to St, is used in the steering algorithm and is a function of St and EST (See Table 1c)	
18	V <sub>DD</sub>	Positive power supply	

Note 1: Must be left open circuit.

OPERATING NOTES

The MV8860 is a CMOS Digital DTMF detector and decoder. Used in conjunction with a suitable DTMF filter (MV8865) it can detect and decode all 16 Standard DTMF tone pairs, accurately discriminating between adjacent frequencies in both high and low groups in the presence of noise and normal voice signals.

To form a complete DTMF receiver the MV8860 must be preceded by a DTMF filter, the function of which is to separate the high group and low group components of the composite dual tone signal and limit the resulting pair of sinewave signals to produce rectangular wave signals having the same frequencies as the individual components of the composite DTMF input. The high group and low group rectangular waves are applied to the MV8860s FH and FL inputs, respectively. The MV8865 DTMF filter provides these functions.

Within the MV8860 the FL and FH signals are operated on by a complex averaging algorithm. This is implemented using digital counting techniques (Control/Discriminators, Fig.2) to determine the frequencies of the incoming tones and verify that they correspond to standard DTMF frequencies. When both high group and low group signals have been simultaneously detected, a flag ESt (Logic High), is generated. ESt is generated (cancelled) rapidly on detecting the presence (absence) of a DTMF tone pair (see Fig.3) and is used to perform a final validity check.

The final validity check requires the input DTMF signal to be present uninterrupted by drop out or excessive distortion (which would result in ESt being cancelled) for a minimum time ( $t_{REC}$ ) before being considered valid. This contributes greatly to the talk off performance of the system. The check also imposes a minimum period of 'tone absent' before a valid received tone is recognised as having ended. This allows short periods of drop out ( $t_{DO}$ ) or excessive noise to occur during a received tone, without it being misinterpreted as two successive characters by the steering circuit (ESt, St, GT). A capacitor C (Fig.7a) is charged via resistor R from ESt which a DTMF tone pair is detected. After a period  $t_{GTP}$ ,  $V_C$  exceeds the St input threshold voltage  $V_{TSt}$ , setting an internal flag indicating the detected signal is valid. Functioning of the check algorithm is completed by the three state output GT which is

normally connected to St and operates under the control of ESt and St. Its mode of operation is shown by the steering state table (Table 1c) and timing diagram (Fig.3).

Internally the presence of the ESt flag allows the control/discriminator to identify the detected tones to the code converter which in turn presents a 4 bit binary code word, corresponding to the original transmitted character, to the output latch. The appearance of the internal St flag clocks the latch, presenting the output code at the tristate outputs L<sub>1</sub> to L<sub>4</sub>. The St internal flag is delayed (by  $t_{PSID}$ ) and appears at the StD output to provide a strobe output function indicating that a new character has been received and the output updated. StD will return to a logic low after the St flag has been reset by  $V_C$  (Fig.7a) falling below  $V_{TSt}$ .

Increasing the 'time to receive' ( $t_{REC}$ ) tends to further improve talk off performance (discrimination against voice simulation of a DTMF tone pair) but degrades the acceptable signal to noise ratio for the incoming signal. Increasing interdigit pause  $t_{ID}$  further reduces the probability of receiving the same character twice and improves acceptable signal to noise ratio but imposes a longer interdigit pause. Reducing  $t_{REC}$  or  $t_{ID}$  has the opposite effect respectively. The values of  $t_{REC}$  and  $t_{ID}$  can be tailored by adjusting  $t_{GTP}$  and  $t_{GTA}$  as shown in Fig.7.

When L<sub>1</sub> to L<sub>4</sub> are connected to a data bus TOE may be controlled by external circuitry or connected directly to StD automatically enabling the outputs whenever a tone is received. In either case StD may be used to flag external circuitry indicating a character has been received.

The MV8860 may be operated from either a 5V or 8 to 13V supply by use of the internal zener reference. The relevant connection diagrams are shown in Fig.5.

When using the MV8860 with the MV8865 DTMF filter it is only necessary to use the MV8865 crystal oscillator (see Fig.6). When using the higher supply voltage range the MV8865 OSC2 output should be capacitively coupled to the MV8860 OSC1 input as shown in Fig.6.

Where it is desirable to receive only the characters available on a rotary dial telephone, taking INH to a logic high inhibits detection of the additional DTMF characters. Incidentally this also further improves talk off due to the reduced number of detectable tones.

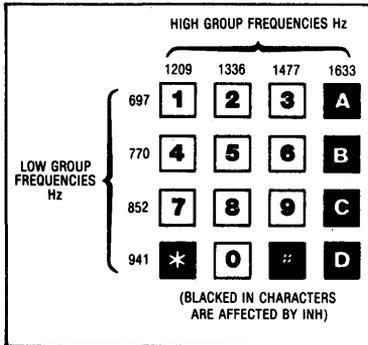


Fig.4 DTMF matrix, indicating character-tone pair correspondence

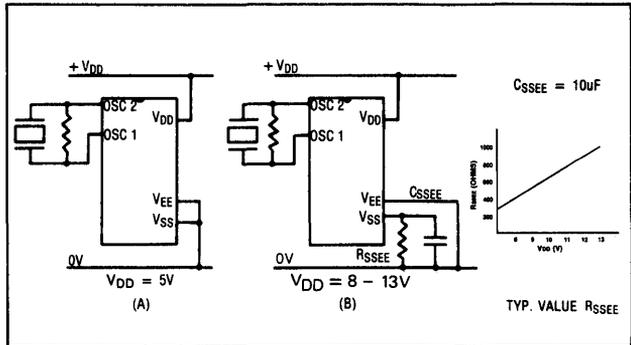


Fig.5 Power supply connection options

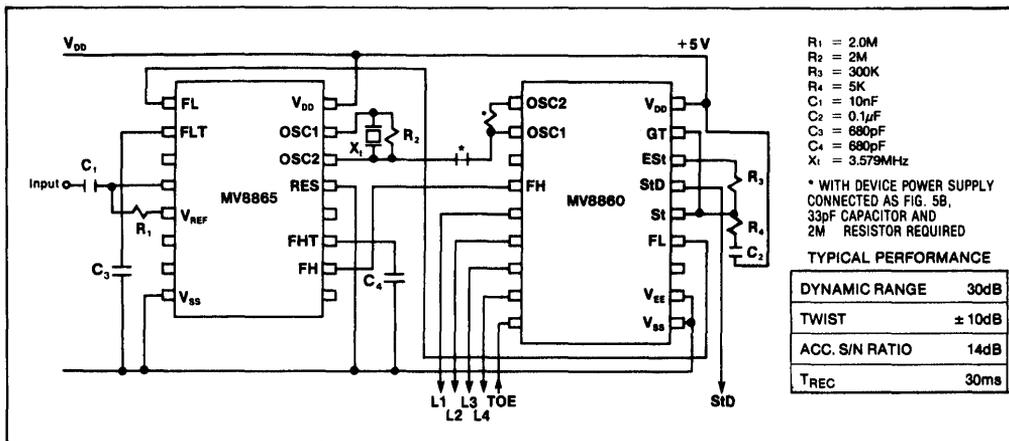


Fig.6 Single-ended input receiver using the MV8865 (5V operation)

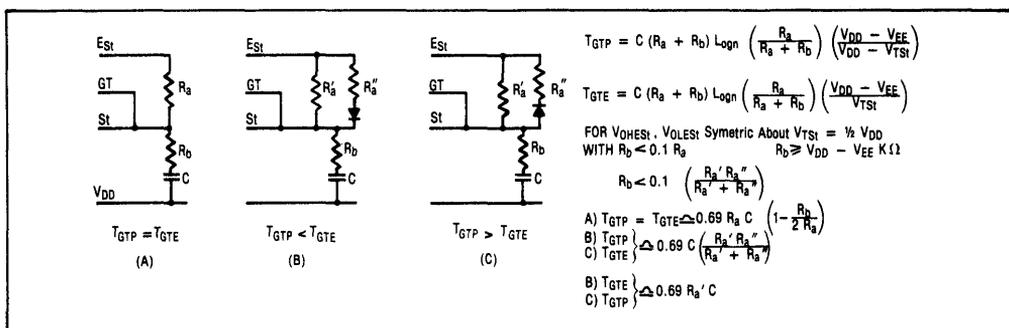


Fig.7 Guard time adjustment



# MV8865

## DTMF FILTER

The MV8865 contains both the high group and low group filtering and comparator functions required to implement a Dual Tone Multi Frequency tone receiver using a DTMF Digital Detector (i.e. MV8860/62/63). Switched capacitor techniques are used to implement the filters and the device is fabricated using Plessey Semiconductors' high density ISO/CMOS technology. The filter clocks are derived from an on-chip oscillator requiring only a low cost TV crystal as an external component. The MV8865 offers single supply operation over a wide supply voltage range and incorporates a logical power down facility.

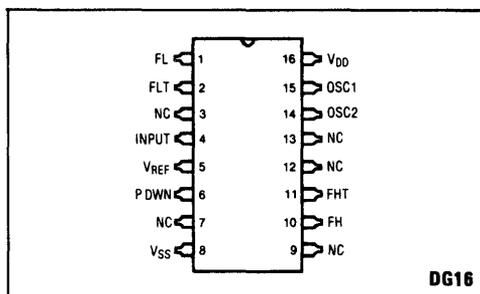


Fig.1 Pin connections (top view)

### FEATURES

- Provides DTMF High and Low Group Filtering
- Hard Limiting on Filter Outputs
- 6 Pole Band Pass High and Low Group Filters
- 38 dB Intergroup Attenuation
- Dial Tone Suppression
- +5 to +12 V Single Supply Operation
- Logical Power Down
- Uses Inexpensive 3.58 MHz Crystal
- Wide Dynamic Range 30 dB
- Equivalent to MT8865X

### APPLICATIONS

#### In DTMF Receivers for:

- End to End Signalling
- Control Systems
- PABX
- Central Office
- Mobile Radio
- Key Systems
- Tone to Pulse Converters

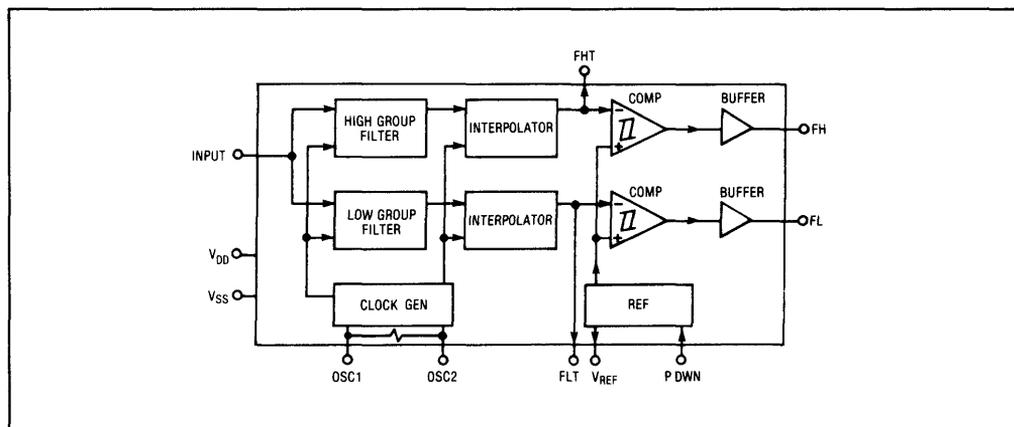


Fig.2 MV8865X functional block diagram

## DC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

 $T_{amb} = +25^{\circ}\text{C}$ ;  $f_{CLK} = 3.579545\text{ MHz}$ All voltages wrt  $V_{SS}$ 

Characteristic		Symbol	$V_{DD} = 5\text{V}$			$V_{DD} = 12\text{V}$			Unit	Test Conditions	
			Min	Typ	Max	Min	Typ	Max			
1	SUPPLY	Operating Supply Voltage	$V_{DD}$	4.75				13	V		
2		Operating Supply Current	$I_{DD}$		1.2	2.5		5	7.5	mA	PDWN = $V_{SS}$
3		Standby Supply Current	$I_{DDs}$		100	150			400	$\mu\text{A}$	PDWN = $V_{DD}$
4		Operating Power Consumption	$P_O$		6			60		mW	PDWN = $V_{SS}$ Fig. 6(c)
5		Standby Power Consumption	$P_S$		0.5			1.5		mW	PDWN = $V_{DD}$ C = 15pF
6	INPUTS	Low Level Input Voltage	PDWN & OSC 1	$V_{IL}$		1.5		3.5	V		
7		High Level Input Voltage	OSC 1	$V_{IH}$	3.5			8.5	V		
8		Pull Down Sink Current	PDWN	$I_{IH}$		3	6		12	24	$\mu\text{A}$
9		Input Current	OSC 1	$I_I$		$\pm 2.5$			$\pm 6$	$\mu\text{A}$	
10	OUTPUTS	Low Level Output Voltage	FL, FH	$V_{OL}$		0.1		0.1	V	No load	
11		High Level Output Voltage	OSC 2	$V_{OH}$	4.9			11.9	V		
12		Output Drive Current	N Channel	FL, FH	$I_{OL}$	0.2		0.5		mA	$V_{OL} = 0.4\text{V}$ (5V)
13			Sink	OSC 2		0.1		0.25		mA	$V_{OL} = 1.2\text{V}$ (12V)
14			P Channel	FL, FH	$I_{OH}$	0.2		0.5		mA	$V_{OH} = 4.6\text{V}$ (5V)
15	Source	OSC 2	0.1			0.25		mA	$V_{OH} = 10.8\text{V}$ (12V)		

## ABSOLUTE MAXIMUM RATINGS

The absolute maximum ratings are limiting values above which operating life may be shortened or specified parameters may be degraded.

Parameter		Min	Max		Parameter	Max	
$V_{DD} - V_{SS}$			15	V	Power Dissipation	DG package <sup>1</sup>	850mW
Voltage on any pin		$V_{SS} - 0.3$	$V_{DD} + 0.3$	V			
Max. current at any pin			10	mA	<sup>1</sup> Derate 16mW/°C above 75°C		
Operating Temperature		40°C	+ 85	°C			
Storage Temperature	DG package	- 65°C	+ 150	°C			

## AC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

 $t_{amb} = +25^{\circ}\text{C}$ ;  $f_c = 3.579545\text{ MHz}$ ;  $V_{DD} = 4.75\text{ V to }13\text{ V}$ 

Characteristic		Symbol	Min	Typ	Max	Unit	Test Conditions			
1	Dynamic Range		30		36	dB				
2	Valid Input Signal Levels				$V_{DD}/2$	$V_{DD}$				
3	(Each tone of composite signal)		27.9		883	mVrms	$V_{DD} = 5\text{ V}$			
4			67.5		2120	mVrms	$V_{DD} = 12\text{ V}$			
5	Input Impedance	$Z_I$	10			$\text{M}\Omega$				
6	Low Group Sensitivity (1)		-28.85			dBm	$V_{DD} = 5\text{ V}$			
7	Low Group Sensitivity (1)		-21.25			dBm	$V_{DD} = 12\text{ V}$			
8	High Group Sensitivity (1)		-28.85			dBm	$V_{DD} = 5\text{ V}$			
9	High Group Sensitivity (1)		-21.25			dBm	$V_{DD} = 12\text{ V}$			
10	Intergroup	Low Group with	$IR_{L1209}$	34	45	dB	1209Hz	w.r.t.		
11		High Tone	$IR_{L1477}$	36	40	dB	1477Hz	770Hz		
12	Rejection	High Group with	$IR_{H941}$	38	45	dB	941Hz	w.r.t.		
13		Low Tone	$IR_{H770}$	36	40	dB	770Hz	1336Hz		
14	Dial Tone	Low Group	$DR_{L440}$		60	dB	440Hz	w.r.t.		
15			$DR_{L350}$		30	dB	350Hz	770Hz		
16	Rejection	High Group	$DR_{H440}$		60	dB	440Hz	w.r.t.		
17			$DR_{H350}$		50	dB	350Hz	1336Hz		
18	FHT FLT Maximum Permissible Load		$R_{LFT}$	250			$\text{K}\Omega$			
19			$C_{LFT}$			2000	pF			
20	LIM	Output Rise Time	FL, FH	$t_{TLHO}$		90	150	ns	10% to	
21		Output Fall Time		$t_{THLO}$		60	100	ns	90% $V_{DD}$	
22	CLOCK	Crystal/Clock Freq.	OSC 1, OSC 2	$f_c$	3.5759	3.5795	3.5831	MHz		
23		Clock Input	Rise Time	$t_{LHCI}$			110	ns	10% to	Externally Applied
24			Fall Time	$t_{HLCI}$			110		90% $V_{DD}$	
25		(OSC 1)	Duty Cycle	$DC_{CI}$	40	50	60	%		Clock
26	Clock Output OSC 2	Capacitive Load	$C_{LOC}$			30	pF	Unbalanced load, see Operating Notes		
27	Capacitance Any Input		$C_I$		5	7.5	pF			

## NOTES

1. The sensitivity characteristic specifies correct operation of the post-comparator outputs at minimum input signal levels. It is valid for each of the four DTMF tones in each passband.

PIN FUNCTIONS

DIP Pin	Name	Description	
1	FL	Low group limiter output.	
2	FLT	Test output. Monitors low group filter output. Decouple to $V_{SS}$ with 680pF capacitor.	
3	NC	Not connected.	
4	INPUT	Tone signal input (single ended).	
5	$V_{REF}$	Internal reference, can be used to bias input via $2M\Omega$ resistor.	
6	PDWN	Power down active high. Internal pull down transistor. A high level signal powers down the device and inhibits the oscillator.	
7	NC	Not connected.	
8	$V_{SS}$	Negative (0V) power supply.	
9	NC	Not connected.	
10	FH	High group limiter output.	
11	FHT	Test output. Monitors high group filter output. Decouple to $V_{SS}$ with 680pF capacitor.	
12	NC	Not connected.	
13	NC	Not connected.	
14	OSC 2	Clock Output.	3.58MHz crystal connected between these pins completes internal oscillator.
15	OSC 1	Clock Input.	
16	$V_{DD}$	Positive power supply.	

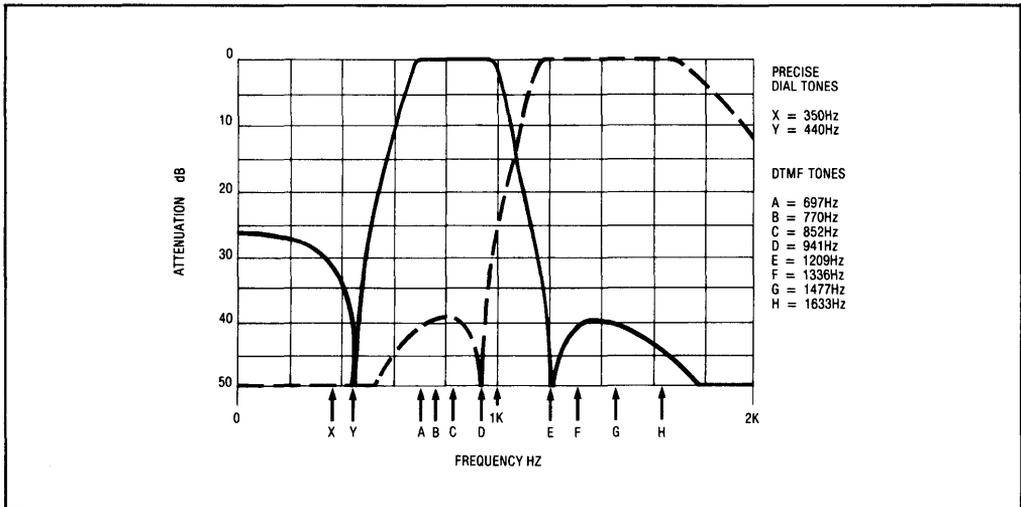


Fig.3 Typical filter characteristics

**OPERATING NOTES**

The MV8865 separates the high group and low group components of the dual tone signal and limits the resulting pair of sine waves, to produce square waves having the same frequencies as the individual input tones. These limited low group and high group tones appear at the FL and FH outputs respectively. To implement a complete DTMF receiver the FL and FH outputs are connected to the FL and FH inputs of one of Plessey Semiconductors' range of DTMF Digital Decoders (MV8860/62/63), see Fig.4.

Separation of the low group and high group tones is achieved by applying the dual tone signal simultaneously to the inputs of two sixth order switched capacitor band-pass filters, the bandwidths of which correspond to the bands enclosing the low group and high group tones. The frequency characteristic of each filter (see Fig.3) also incorporates a notch at 440 Hz to provide dial tone rejection. Each filter output is followed by a single order switched capacitor section which operates as an interpolator smoothing the signals prior to limiting.

The limiting functions are performed by high gain com-

parators which are provided with hysteresis to prevent detection of unwanted low level signals and noise. The comparator outputs are buffered to drive the FL and FH output pins and detector device inputs. The MV8865 has a single ended input allowing connection either to a PCM decoder, radio receiver (Fig.4) or via a differential buffer to a telephone line (Fig.5). The signal input (Pin 4) should be biased at  $V_{DD}/2$ . With the input capacitively coupled, this is achieved by connecting the signal input to  $V_{REF}$  (Pin 5) via a  $2M\Omega$  resistor.

FLT and FHT allow the filter outputs to be monitored prior to limiting, and should each be decoupled to  $V_{SS}$  by 680 pF capacitors.

**Unbalanced Loads**

Presenting a high unbalanced capacitive load to the oscillator crystal can cause attenuation of the oscillator output signal and increased supply current (see Fig.6). Where the MV8865 oscillator is required to drive a high capacitive load such as a number of other MV8865/8860s it is desirable to connect a capacitor between OSC1 and  $V_{SS}$ , the value of this capacitor being equal to the capacitive loading at OSC2.

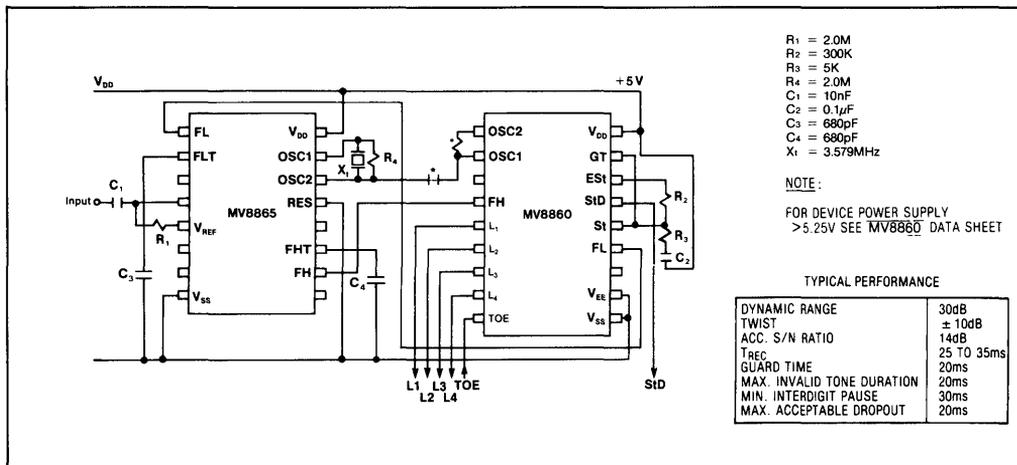


Fig.4 Single-ended input receiver using the MV8860 (5V operation)

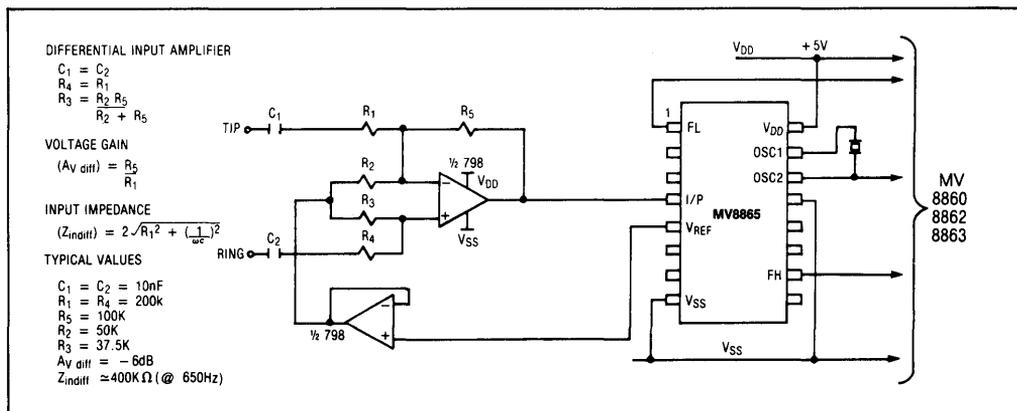


Fig.5 Connection to a telephone line

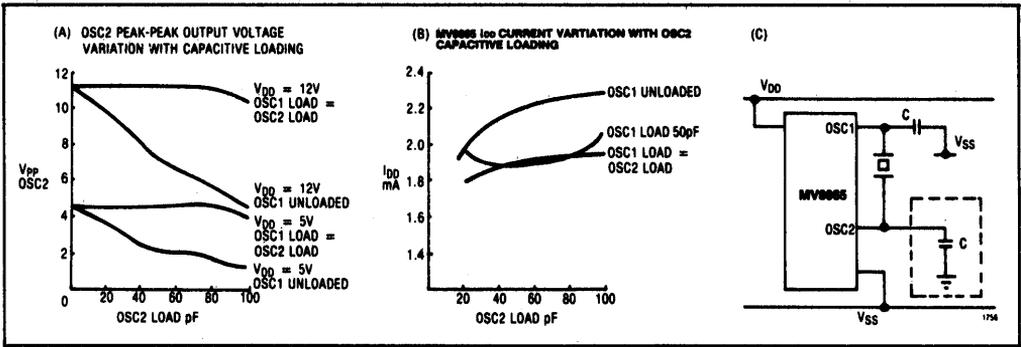


Fig.6 Crystal oscillator loading



**PRELIMINARY INFORMATION**

Preliminary Information is issued to advise Customers of potential new products which are designated 'Experimental' but are, nevertheless, serious development projects and is supplied without liability for errors or omissions. Details given may change without notice and no undertaking is given or implied as to current or future availability.

Customers incorporating 'Experimental' product in their equipment designs do so at their own risk. Please consult your local Plessey Semiconductors sales outlet for details of the current status.

# MV8870EXP

## DTMF RECEIVER

The MV8870 is a complete DTMF receiver integrating both the bandsplit filter and digital decoder functions, fabricated on Plessey Semiconductors' double-poly ISO<sup>2</sup>-CMOS technology. The filter section uses switched capacitor techniques for high- and low- group filters and dial-tone rejection; the decoder uses digital counting techniques to detect and decode all 16 DTMF tone-pairs into a 4-bit code. External component count is minimised by on-chip provision of a differential input amplifier, clock oscillator and latched 3-state bus interface.

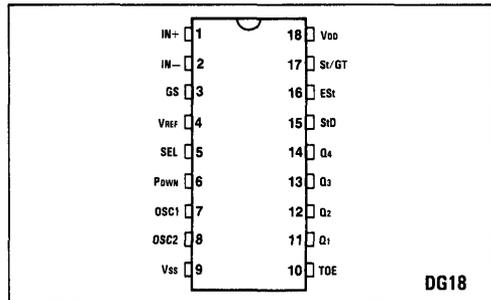


Fig.1 Pin connections (top view)

**APPLICATIONS**

- PABX
- Central Office
- Key Systems
- Mobile Radio
- Remote Control
- Remote Data Entry

**FEATURES**

- Full Receiver in Single 18-Pin Package
- Central Office Quality
- Lower Power Consumption
- Adjustable Acquisition and Release Times

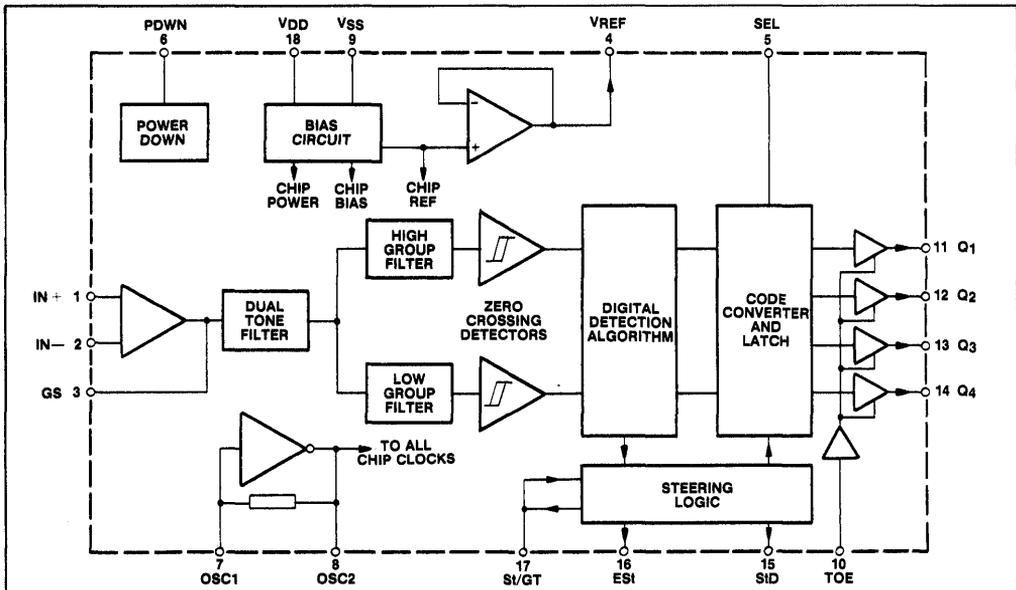


Fig.2 Functional block diagram

# MV8870

## ABSOLUTE MAXIMUM RATINGS (NOTE 1)

Parameter	Min.	Max.	Unit
Power supply voltage $V_{DD} - V_{SS}$		6	V
Voltage on any pin	$V_{SS} - 0.3$	$V_{DD} + 0.3$	V
Current at any pin		10	mA
Operating temperature	-40	+85	°C
Storage temperature	-65	+150	°C
Package power dissipation (Note 2)		1000	mW

### NOTES

- Exceeding these ratings may cause permanent damage. Functional operation under these conditions is not implied.
- Derate above 75°C at 16mW/°C. All leads soldered to board.

## DC ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

$V_{DD} = +5V$ ,  $V_{SS} = 0V$ ,  $T_{amb} = +25^{\circ}C$

Characteristic	Symbol	Value			Unit	Conditions
		Min.	Typ.	Max.		
Operating supply voltage	$V_{DD}$	4.75		5.25	V	
Operating supply current	$I_{DD}$		3.0	7	mA	
Power consumption	$P_O$		15	35	mW	$f = 3.579MHz$
Low level input voltage	$V_{IL}$			1.5	V	
High level input voltage	$V_{IH}$	3.5			V	
Input leakage current	$I_{IH}/I_{IL}$		0.1		$\mu A$	$V_{IN} = V_{SS}$ or $V_{DD}$
Pull up source current	$I_{SO}$		7.5	15.0	$\mu A$	TOE (Pin 10) = 0V
Input impedance (pins 1 & 2)	$R_{IN}$		10		$M\Omega$	At 1kHz
Steering threshold voltage	$V_{TST}$	2.2	2.35	2.5	V	
Low level output voltage	$V_{OL}$		0.03		V	No load
High level output voltage	$V_{OH}$		4.97		V	No load
Output low (sink) current	$I_{OL}$	1.0	2.5		mA	$V_{OUT} = 0.4V$
Output high (source) current	$I_{OH}$	0.4	0.8		mA	$V_{OUT} = 4.6V$
Output voltage, pin 4	$V_{REF}$	2.4		2.7	V	No load
Output resistance, pin 4	$R_{OR}$		10		$k\Omega$	

## OPERATING CHARACTERISTICS, GAIN SETTING AMPLIFIER

Test conditions (unless otherwise stated):

$V_{DD} = +5V$ ,  $V_{SS} = 0V$ ,  $T_{amb} = +25^{\circ}C$

Characteristic	Symbol	Value			Unit	Conditions
		Min.	Typ.	Max.		
Input leakage current	$I_{IN}$		$\pm 100$		nA	$V_{SS} < V_{IN} < V_{DD}$
Input resistance	$R_{IN}$		10		$M\Omega$	
Input offset voltage	$V_{OS}$		$\pm 25$		mV	
Power supply rejection	PSRR		60		dB	1kHz
Common mode rejection	CMRR		60		dB	$V_{IN} = V_{REF} \pm 1.3V$
DC open loop voltage gain	$A_{VOL}$		65		dB	
Open loop unity gain bandwidth	$f_c$		1.5		MHz	
Output voltage swing	$V_O$		4.5		V p-p	$R_L \geq 100k\Omega$ to $V_{SS}$
Tolerable capacitive load (GS)	$C_L$		100		pF	
Tolerable resistive load (GS)	$R_L$		50		$k\Omega$	
Common mode range	$V_{cm}$		3.0		V p-p	No load

## AC CHARACTERISTICS

Test conditions (unless otherwise stated):

V<sub>DD</sub> = +5V, V<sub>SS</sub> = 0V, T<sub>amb</sub> = +25°C, f<sub>CLK</sub> = 3.579545MHz, using test circuit of Fig.3.

Characteristic		Symbol	Value			Unit	Notes
			Min.	Typ.	Max.		
Valid input signal level (each tone of composite signal)	Min.				-29	dBm	1,2,3,5,6,9
					27.5	mVRMS	1,2,3,5,6,9
	Max.		+1			dBm	1,2,3,5,6,9
			883			mVRMS	
Twist accept limit	Positive		10			dB	2,3,6,9
	Negative		10			dB	2,3,5,9
Freq. deviation accept limit					±1.5% ±2Hz	Nom.	2,3,5,9
Freq. deviation reject limit			±3.5%			Nom.	2,3,5
Third tone tolerance				-16		dB	2,3,4,5,9,10
Noise tolerance				-12		dB	2,3,4,5,7,9,10
Dial tone tolerance				+18		dB	2,3,4,5,8,9,10
Tone present detection time		t <sub>DP</sub>	5	11	14	ms	Refer to Fig.5
Tone absent detection time		t <sub>DA</sub>	0.5	4	8.5	ms	
Tone duration accept		t <sub>REC</sub>			40	ms	(User adjustable) Refer to 'Guard Time Adjustment'
Tone duration reject		t <sub>REC</sub>	20			ms	
Interdigit pause accept		t <sub>ID</sub>			40	ms	
Interdigit pause reject		t <sub>DO</sub>	20			ms	
Propagation delay (St to Q)		t <sub>PQ</sub>		8	11	µs	TOE = V <sub>DD</sub>
Propagation delay (St to StD)		t <sub>PSID</sub>		12		µs	
Output data set up (Q to StD)		t <sub>QSID</sub>		3.4		µs	
Propagation delay (TOE to Q)		Enable	t <sub>PTE</sub>	50	60	ns	R <sub>L</sub> = 10kΩ
		Disable	t <sub>PTD</sub>	300		ns	C <sub>L</sub> = 50pF
Crystal/clock frequency		f <sub>CLK</sub>	3.5759	3.5795	3.581	MHz	
Clock output (OSC2)		Capacitive load	C <sub>LO</sub>		30	pF	

## NOTES

- dBm = decibels above or below a reference power of 1mW into a 600 ohm load.
- Digit sequence consists of all 16 DTMF tones.
- Tone duration = 40ms. Tone pause = 40ms.
- Nominal DTMF frequencies are used.
- Both tones in the composite signal have an equal amplitude.
- Tone pair is deviated by ±1.5% ±2Hz.
- Bandwidth limited (0 to 3kHz) Gaussian Noise.
- The precise dial tone frequencies are 350Hz and 440Hz ±2%.
- For an error rate of better than 1 in 10,000.
- Reference to lowest level frequency component in DTMF signal.

# MV8870

## INPUT CONFIGURATION

The input arrangement of the MV8870 provides a differential input operational amplifier as well as a bias source (VREF) which is used to bias the inputs at mid-rail.

Provision is made for connection of a feedback register to the op-amp output (GS) for adjustment of gain.

In a single-ended configuration the input pins are connected as shown in Fig.3 with the op-amp connected for unity gain and VREF biasing the input at 1/2 VDD. Fig.4 shows the differential configuration, which permits the adjustment of gain with the feedback resistor Rs.

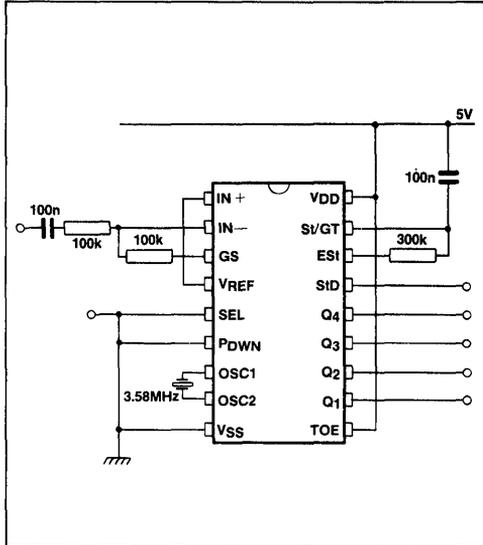


Fig.3 Single ended input configuration

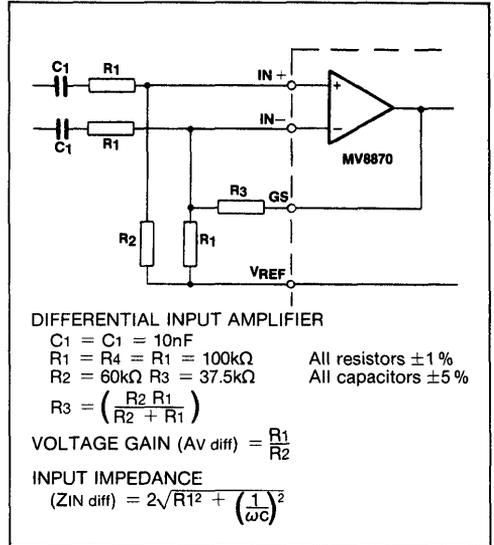


Fig.4 Differential input configuration

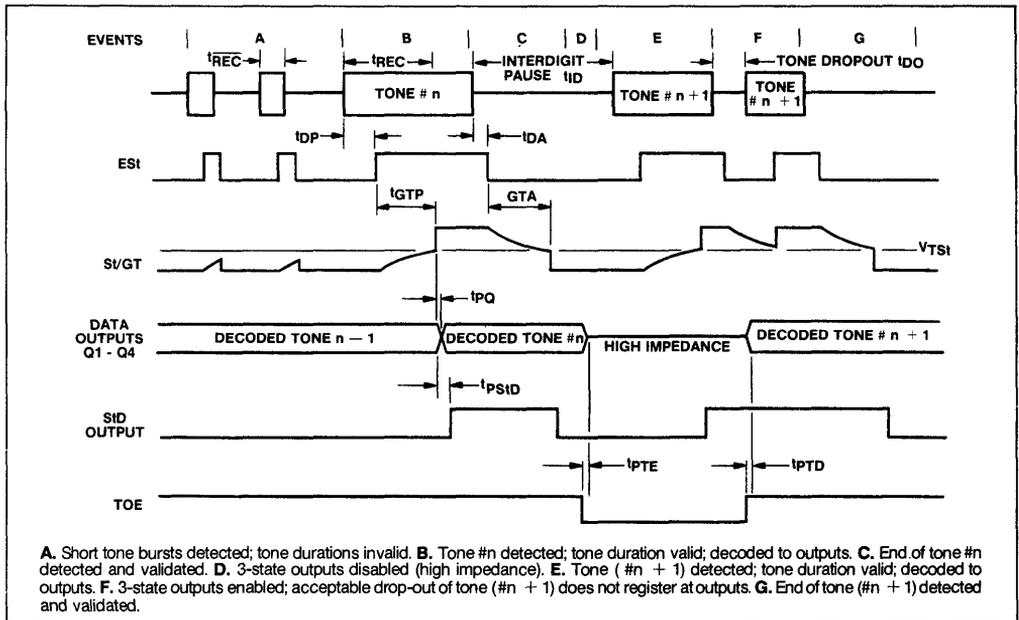


Fig.5 Timing diagram

## PIN DESCRIPTIONS

Pin	Name	Description	
1	IN +	Non-inverting input	Connections to the front-end differential amplifier
2	IN -	Inverting input	
3	GS	Gain select. Gives access to output of front-end differential amplifier for connections of feedback resistor.	
4	V <sub>REF</sub>	Reference voltage output, nominally V <sub>DD</sub> /2. May be used to bias the inputs at mid-rail (see application diagram).	
5	SEL	Logic '1' or '0' selects one of two truth tables (see Table 1).	
6	P <sub>DWN</sub>	Power down active high, internal pulldown resistor. A high level signal powers down and inhibits the oscillator.	
7	OSC1	Clock input	3.579545MHz crystal connected between these pins completes internal oscillator.
8	OSC2	Clock output	
9	V <sub>SS</sub>	Negative power supply, normally connected to 0V.	
10	TOE	3-state output enable (input). Logic high enables the outputs Q1 - Q4. Internal pull-up.	
11	Q1	3-state data outputs. When enabled by TOE, provide the code corresponding to the last valid tone-pair received (see Table 1).	
12	Q2		
13	Q3		
14	Q4		
15	StD	Delayed steering output presents a logic high when a received tone-pair has been registered and the output high latch updated; returns to logic low when the voltage on St/GT falls below V <sub>TS</sub> .	
16	ES <sub>t</sub>	Early steering output. Presents a logic high immediately when the digital algorithm detects a recognisable tone-pair (signal conditions). Any momentary loss of signal condition will cause ES <sub>t</sub> to return to a logic low.	
17	St/GT	Steering input/guard time output (bidirectional). A voltage greater than V <sub>TS</sub> detected at St causes the device to register the detected tone-pair and update the output latch. A voltage less than V <sub>TS</sub> frees the device to accept a new tone-pair. The GT output acts to reset the external steering time-constant; its state is a function of ES <sub>t</sub> and the voltage on St (see Table 1).	
18	V <sub>DD</sub>	Positive power supply.	

## FUNCTIONAL DESCRIPTION

The MV8870 monolithic DTMF receiver offers small size, low power consumption and high performance. Its architecture consists of a bandsplit filter section, which separates the high and low tones of a received pair, followed by a digital counting section which verifies the frequency and duration of the received tones before passing the corresponding code to the output bus.

## Filter Section

Separation of the low-group and high-group tones is achieved by applying the dual-tone signal to the inputs of two sixth-order switched-capacitor bandpass filters, the bandwidths of which correspond to the bands enclosing the low-group and high-group tones (see Fig.6).

The filter section also incorporates notches at 350Hz and 440Hz for exceptional dial-tone rejection. Each filter output is followed by a single-order switched capacitor section to smooth the signals prior to limiting.

Limiting is performed by high-gain comparators which are provided with hysteresis to prevent detection of unwanted

low-level signals and noise; the outputs of the comparators provide full-rail logic swings at the frequencies of the incoming tones.

## Decoder Section

The decoder uses digital counting techniques to determine the frequencies of the limited tones and to verify that they correspond to standard DTMF frequencies. A complex averaging algorithm protects against tone simulation by extraneous signals, such as voice, while providing tolerance to small frequency deviations and variations. The averaging algorithm has been developed to ensure an optimum combination of immunity to 'talk-off' and tolerance to the presence of interfering signals ('third tones') and noise. When the detector recognises the simultaneous presence of two valid tones (referred to as 'signal condition' in some industry specifications), it raises the 'Early Steering' flag (ES<sub>t</sub>). Any subsequent loss of signal condition will cause ES<sub>t</sub> to fall.

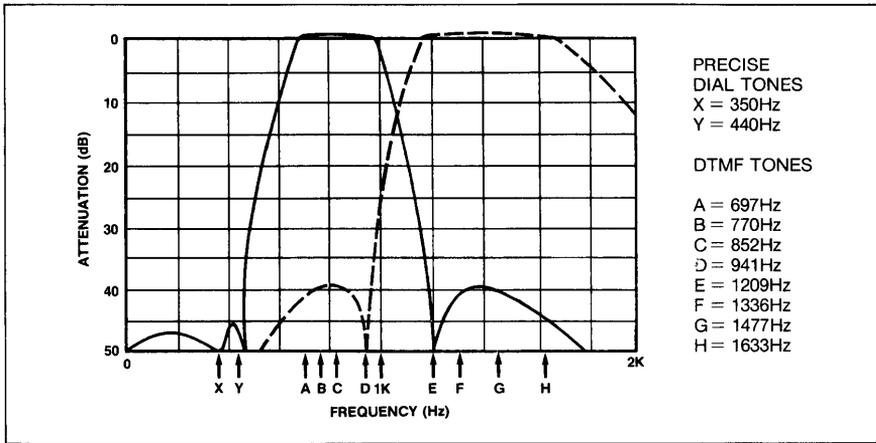


Fig.6 Typical filter characteristic

FLOW	FHIGH	KEY	TOE	SEL	Q <sub>4</sub>	Q <sub>3</sub>	Q <sub>2</sub>	Q <sub>1</sub>
697	1209	1	H	L	0	0	0	1
697	1336	2	H	L	0	0	1	0
697	1477	3	H	L	0	0	1	1
770	1209	4	H	L	0	1	0	0
770	1336	5	H	L	0	1	0	1
770	1477	6	H	L	0	1	1	0
852	1209	7	H	L	0	1	1	1
852	1336	8	H	L	1	0	0	0
852	1477	9	H	L	1	0	0	1
941	1336	0	H	L	1	0	1	0
941	1209	*	H	L	1	0	1	1
941	1477	#	H	L	1	1	0	0
697	1633	A	H	L	1	1	0	1
770	1633	B	H	L	1	1	1	0
852	1633	C	H	L	1	1	1	1
941	1633	D	H	L	0	0	0	0
697	1209	1	H	H	0	0	0	1
697	1336	2	H	H	0	0	1	0
697	1477	3	H	H	0	0	1	1
770	1209	4	H	H	0	1	0	0
770	1336	5	H	H	0	1	0	1
770	1477	6	H	H	0	1	1	0
852	1209	7	H	H	0	1	1	1
852	1336	8	H	H	1	0	0	0
852	1477	9	H	H	1	0	0	1
941	1336	0	H	H	0	0	0	0
941	1209	*	H	H	1	0	1	0
941	1477	#	H	H	1	0	1	1
697	1633	A	H	H	1	1	0	0
770	1633	B	H	H	1	1	0	1
852	1633	C	H	H	1	1	1	0
941	1633	D	H	H	1	1	1	1
		ANY	L	ANY	Z	Z	Z	Z

L = Logic low, H = Logic high, Z = High impedance

Table 1 Functional decode table

**STEERING CIRCUIT**

Before registration of a decoded tone-pair, the receiver checks for a valid signal duration (referred to as 'character recognition condition'). This check is performed by an external RC time constant driven by EST. A logic high on EST causes Vc (see Fig.7) to rise as the capacitor discharges. Provided signal-condition is maintained (EST remains high) for the validation period (tGTP), Vc reaches the threshold (VTST) of the steering logic to register the tone pair, latching its corresponding 4-bit code (see Table 1) into the output latch. At this point, the GT output is activated and drives Vc to VDD. GT continues to drive high as long as EST remains high. Finally, after a short delay to allow the output latch to settle, the 'delayed steering' output flag, StD, goes high, signalling that a received tone pair has been registered. The contents of the output latch are made available on the 4-bit output bus by raising the 3-state control input (TOE) to a logic high. The steering circuit works in reverse to validate the interdigit pause between signals. Thus, as well as rejecting signals too short to be considered valid, the receiver will tolerate signal interruptions ('drop-out') too short to be considered a valid pulse. The facility, together with the capability of selecting the steering time-constants externally, allows the designer to tailor performance to meet a wide variety of system requirements.

**Guard Time Adjustments**

In many situations not requiring independent selection of receive and pause, the simple steering circuit of Fig.7 is applicable. Component values are chosen according to the following formulae:

$$t_{REC} = t_{DP} + t_{GTP}$$

$$t_{ID} = T_{DA} + t_{GTA}$$

The value of tDP is a parameter of the device (see AC Characteristics) and tREC is the minimum signal duration to be recognised by the receiver. A value for C of 0.1µF is recommended for most applications, leaving R to be selected by the designer. For example, a suitable value of R for a tREC of 40ms would be 300kΩ.

Different steering arrangements may be used to select independently the guard times for tone-present (tGTP) and tone-absent (tGTA). This may be necessary to meet system specification which place both accept and reject limits on both tone duration and interdigital pause.

Guard time adjustment also allows the designer to tailor system parameters such as talk-off and noise immunity. Increasing tREC improves talk-off performance, since it reduces the probability that tones simulated by speech will maintain signal condition for long enough to be registered. On the other hand, a relatively short tREC with a long tID would be appropriate for extremely noisy environments where fast acquisition time and immunity to drop-outs would be requirements. Design information for guard time adjustment is shown in Fig.8.

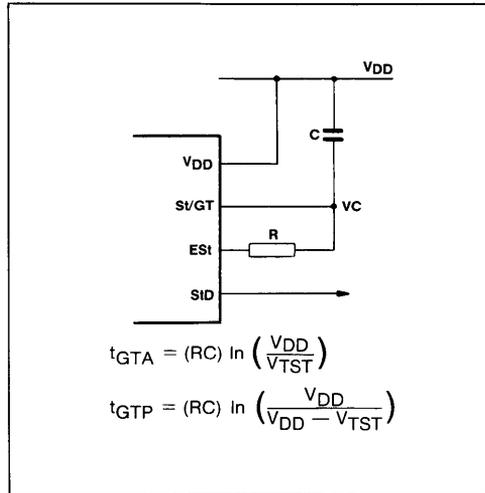
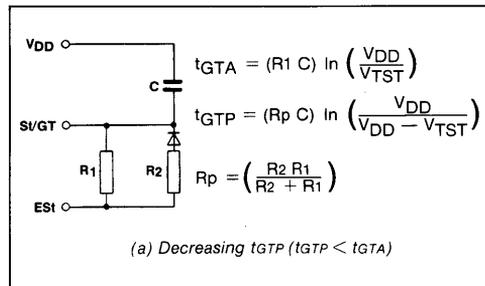
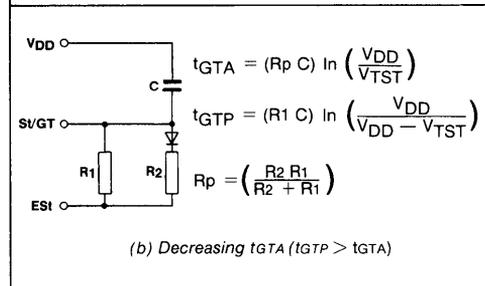


Fig.7 Basic steering circuit



(a) Decreasing tGTP (tGTP < tGTA)



(b) Decreasing tGTA (tGTP > tGTA)

Fig.8 Guard time adjustment

**MV8870**

Preliminary Information is issued to advise Customers of potential new products which are designated 'Experimental' but are, nevertheless, serious development projects and is supplied without liability for errors or omissions. Details given may change without notice and no undertaking is given or implied as to current or future availability.

Customers incorporating 'Experimental' product in their equipment designs do so at their own risk. Please consult your local Plessey Semiconductors sales outlet for details of the current status.

## MV9009 EXP

### V21 MODEM TX/RX

The MV9009 is a single chip modulator/demodulator fabricated in silicon gate ISO-CMOS and designed for use in V21 modems. The device can be used alone, or in conjunction with the SL9009 Adaptive Cancellation Filter.

#### FEATURES

- 300 Baud V21 Operation
- Square or Sinewave Transmit Output Waveforms
- Baseband Shaping to Reduce Out-of-Band Modulation Products
- 2nd Order Digital PLL Receiver
- Lock Detect Output
- Off-Chip Post Detection Filter Enables Optimisation of Received Data Jitter
- Meets R20/SCVF Specification when used with SL9009

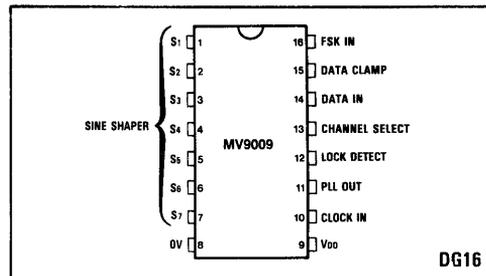


Fig.1 Pin connections - top view

#### ABSOLUTE MAXIMUM RATINGS

Operating temperature	0° C to +70° C
Storage temperature	-65° C to +150° C
Supply voltage range	-0.3V to +7V
Input voltage range	-0.3V to V <sub>DD</sub> +0.3V
Output voltage range	-0.3V to V <sub>DD</sub> +0.3V

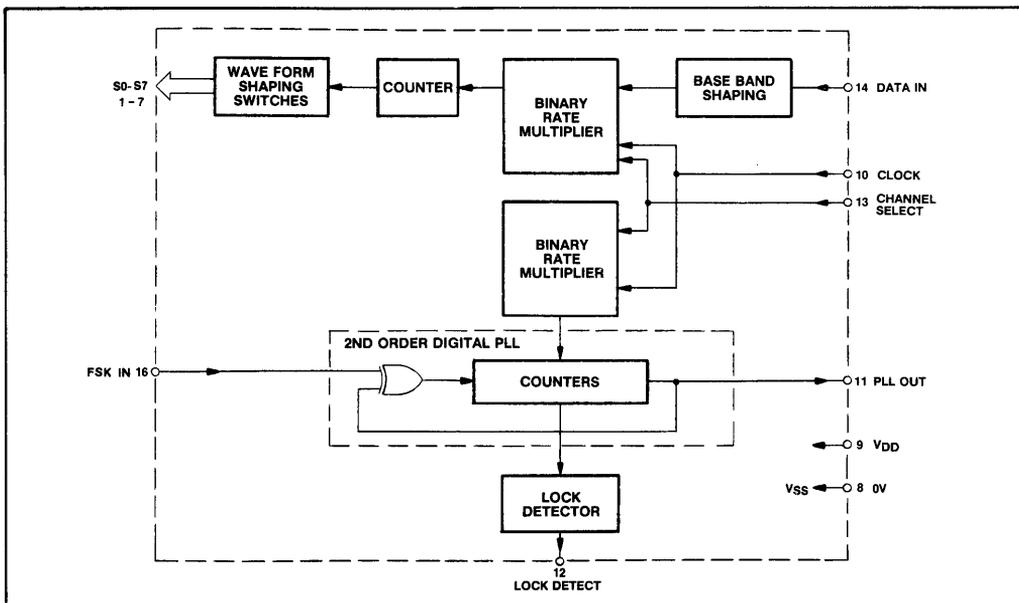


Fig.2 Block diagram

**ELECTRICAL CHARACTERISTICS**

Test conditions (unless otherwise stated):

T<sub>amb</sub> = +25°C All potentials referred to pin 8

Characteristic	Pin	Value			Units	Conditions
		Min.	Typ.	Max.		
<b>Supply</b>						
Voltage	9	4.5	5	5.5	V	For defined parametrics 0°C to +70°C
Current	9			2	mA	7.5MHz clock V <sub>DD</sub> = 5.25V
	9			100	μA	Static
<b>Clock input</b>	10					
Input voltage high		3.3			V	V <sub>DD</sub> = 4.75V
Input voltage low				1.58	V	V <sub>DD</sub> = 5.25V
Input current				20	μA	V <sub>DD</sub> = 5.25V, V <sub>IN</sub> = 5.5V
<b>Other inputs</b>	13,14,15,16					
Input voltage high		1.8			V	V <sub>DD</sub> = 4.75V
Input voltage low				0.9	V	V <sub>DD</sub> = 5.25V
Input current				20	μA	V <sub>DD</sub> = 5.25V, V <sub>IN</sub> = 5.5V
Hysteresis		30			mV	
<b>Sine outputs (open drain)</b>	1,2,3,4,5,6,7					
R <sub>DS (ON)</sub>		20	32	47	Ω	V <sub>DD</sub> = 4.75V
ΔR <sub>DS (ON)</sub>				10	Ω	I <sub>OL</sub> = 5mA, V <sub>OL</sub> = 0.5V
<b>Lock detect</b>	12					
Output voltage high		4.27			V	V <sub>DD</sub> = 4.75V, I <sub>O</sub> = 4.75mA
Output voltage low				0.525	V	V <sub>DD</sub> = 5.25V, I <sub>O</sub> = 5.25mA
<b>PLL out</b>	11					
Output voltage high		4.995			V	I <sub>O</sub> = 25μA, V <sub>DD</sub> = 5V
Output voltage low				0.005	V	
Output s/c current				50	mA	V <sub>DD</sub> = 5.25V

**OPERATING NOTES**

If it is desired to simplify the transmit filtering, the on-chip sine shaping circuit can be used. If this is not needed (for example when using the Reticon R5631 modem filter) then the square wave from pin 4 is used with a pull-up resistor.

The chip produces a sinewave output by scanning an array of 7 resistors as shown in Fig.3. The smallest resistor value should be chosen to be of the order Ron x 1000 ≈ 50kΩ.

Each resistor is successively connected to ground by N-channel MOS transistors within the chip then successively disconnected, as shown by Fig.4. Correct weighting of the resistors should give a sinewave output. If 1% matching of resistors is attained, the worst case distortion will be 2nd harmonic 47dB down on the fundamental. In Fig.4 a '0' indicates a closed switch, a '1' an open switch.

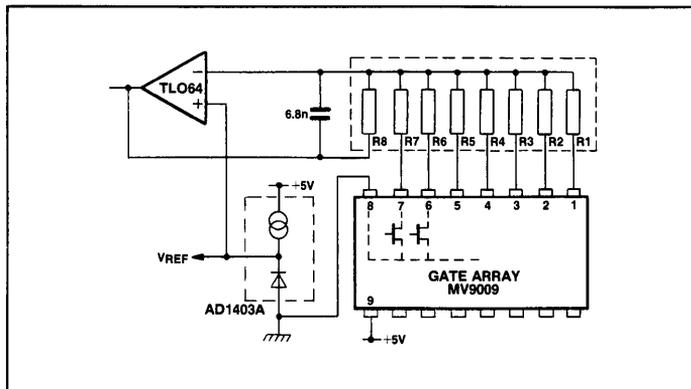


Fig.3 Output array scanning

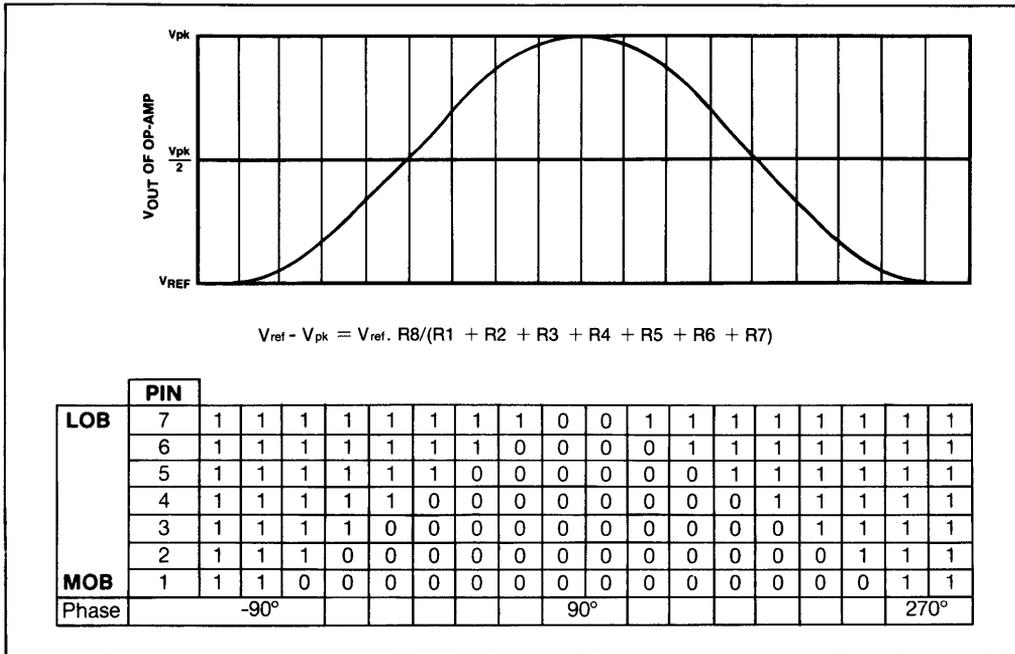


Fig.4 16 step sine wave produced by scanning 7 resistors

**OPERATING FREQUENCIES**

f<sub>LOCK</sub> = 5.24288MHz

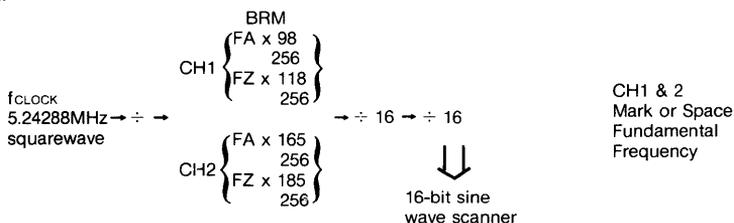
Parameter	Conditions	Frequency (Hz)
CH1 Mark FZ	Pins 13,14 = 0V	1650
CH1 Space FA	Pin 13 = 0V Pin 14 = 5V	1850
CH2 Mark FZ	Pin 13 = 5V Pin 14 = 0V	980
CH2 Space FA	Pins 13,14 = 5V	1180
<b>Receiver characteristics</b>		
Centre frequency CH1		1080
Lock range CH1		398
Centre frequency CH2		1750
Lock range CH2		335

**CIRCUIT DESCRIPTION**

The MV9009 forms a digital transmitter and 2nd order PLL for modulation/demodulation of 300 Baud FSK signals. The chip transmits on one channel and receives on the other as defined by the truth Table 1.

The transmitter works by dividing a 5.24288MHz crystal clock as follows:

Baseband shaping is also provided for the data signal, to reduce out of band modulation products. This is performed digitally by taking 8 steps to change the Binary Rate Multiplier from FA to FZ.



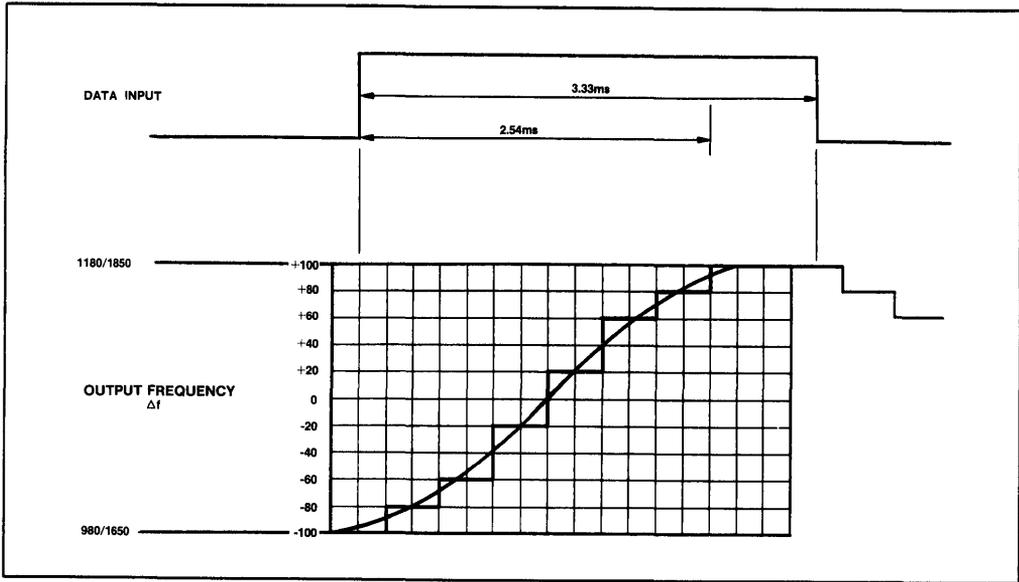


Fig.5

**EXAMPLE**

If the transmitter is operating at a continuous 980Hz output frequency and the data input goes to '1', the binary rate multiplier output is stepped from x 98/256 to x 118/256 as shown in Fig.5.

The receiver is a 2nd order digital phase locked loop, with an exclusive OR gate phase comparator. CMOS or TTL level FSK inputs are applied to the FSK input pin 16 and the demodulated signal appears at pin 11 as a twice carrier

variable mark space ratio signal. A third order low pass post-detection filter and comparator are required in order to produce a data signal. The 2nd order PLL time constants have been optimised to give minimum jitter at 300 baud. Due to finite load times in the 12-bit counters a small amount of bias distortion (0.5%) occurs in the demodulated signal, due to the loss of 1 or 2 least significant bits in the counters.

Fig.7 shows the block diagram for a complete modem also using the SL9009 Adaptive Cancellation Filter.

**CHIP TRUTH TABLE**

'1' = +5V '0' = 0V

Channel Select	Data IN	Data Clamp	FSK In	Transmitter Outputs	PLL Out	Lock Detect	
Pin	13	14	15	16	1 to 7	11	12
0	0	0	980Hz 1180Hz	1650Hz	0 1	0	
0	1	0	980Hz 1180Hz	1850Hz	0 1	0	
1	0	0	1650Hz 1850Hz	980Hz	0 1	0	
1	1	0	1650Hz 1850Hz	1180Hz	0 1	0	
X	X	1	Valid input signal	S1-S4 0 S5-S7 OFF	PLL still demodulating	0	
0	X	X	Inside Lock range 970-1190Hz and 1640-1860Hz	X	Undefined	1	
1	X	X		X	Undefined	i	
0	X	X	Outside Lock range	X	Undefined	Mainly 1	
1	X	X	Outside	X	Undefined	Mainly 1	

**NOTE**

The lock detector is mainly '1' when the input signal is outside the lock range. If a continuous signal is required a timer circuit is required to time out '0' intervals. Fig.6 shows a suggested circuit.

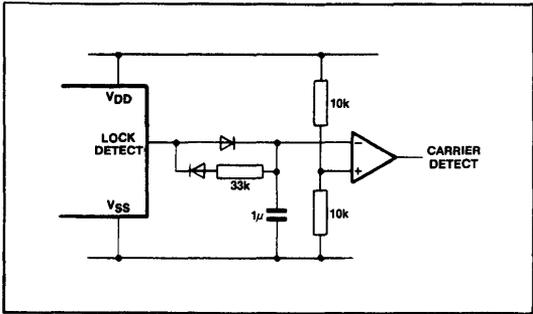


Fig.6

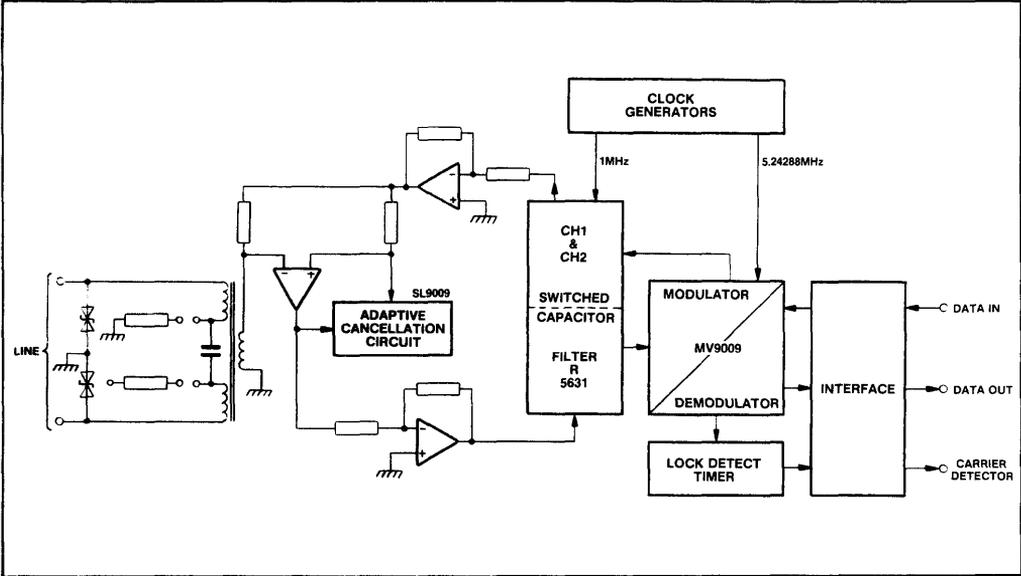


Fig.7 System block diagram



# SL650B & C SL651B & C

## MODULATOR/PHASE LOCKED LOOP CIRCUITS FOR MODEMS

The SL650/1 are versatile integrated circuits capable of performing all the common modulation functions (AM, PAM, SCAM, FM, FSK, PSK, PWM, tone-burst, delta-modulation, etc.). A wide variety of phase-locked loops can be realised using the SL650 or SL651, with all parameters accurately controllable; they can also be used to generate precise waveforms at frequencies up to 0.2MHz.

The highly accurate and stable variable frequency oscillator is programmable over a wide range of frequency by voltage, current, resistor or capacitor. In addition direct selection of one of four spot frequencies is facilitated by using the on-chip binary interface, which accepts standard logic levels at very low logic '1' input currents.

The differential input phase comparator has a wide common mode input voltage range. It has a high gain limiting amplifier at its input requiring only 1mV input to maintain lock range in a typical phase-locked loop. The current output is programmable from zero to over 2mA by an external resistor or current input, and the gain is voltage -, current -, or resistance - programmable from zero to greater than 10,000.

An auxiliary amplifier with a voltage gain of, typically, 5000 is incorporated in the SL650 for use when it is required to interface to specified levels and impedances. The auxiliary amplifier features low bias current (typically 25nA), fast recovery from overload, and a short-circuit output current of  $\pm 7.5\text{mA}$ .

The auxiliary amplifier is omitted from the SL651.

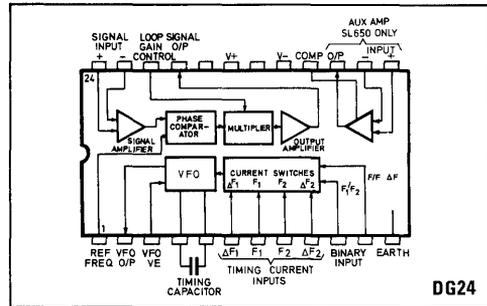


Fig.1 Pin connections (top view)

### FEATURES

- VFO Frequency Variable Over 100:1 Range With Same Capacitor: Linearity 0.2%
- VFO Temperature Coefficient:  
'B' Types 20 ppm/°C Max.  
'C' Types 20 ppm/°C Typ.
- Supply sensitivity 20 ppm/% Typ.
- VFO Phase-Continuous at Transitions
- Binary Interface
- Phase Comparator O/P Can Swing to Supply Voltages
- On-Chip Auxiliary Amplifier (SL650)

### APPLICATIONS

- Modems
- Modulators
- Demodulators
- Tone Decoders
- Tracking Filters
- Waveform Generators

### QUICK REFERENCE DATA

- Supply Voltages  $\pm 6\text{V}$
- Operating Temperature Range  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$

# SL650/SL651B/C

## ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated)  
 Supply voltage  $\pm 6V$   
 Temperature  $T_A + 22^\circ C \pm 2^\circ C$

Characteristics	Pins	Value			Units	Conditions
		Min.	Typ.	Max.		
Supply current $I_{CC}$	17, 19			3	mA	
<b>Variable frequency oscillator</b>						
Initial frequency offset error		-3	$\pm 1$	+3	%	
Normal mark/space ratio		0.98	1.00	1.02	-	
Temp. coefficient of frequency			$\pm 20$		ppm/ $^\circ C$	See note 1
Frequency variation with supplies	17, 19		$\pm 20$		ppm/%	
Voltage at timing current inputs	6, 7, 8, 9		$\pm 10$		mV	See note 2
VFO output, 'low' state	2		0	0.2	V	
VFO output, 'high' state	2	+1.1	+1.3		V	$R_L \geq 10k\Omega$
Max. freq. of oscillation			0.5		MHz	
<b>Binary inputs</b>						
$V_{in}$ to guarantee logic 'low'	10, 11			+0.6	V	See note 3
$V_{in}$ to guarantee logic 'high'	10, 11	+2.4			V	
Input current	10, 11		0.05	0.25	mA	$V_{in} = +3.0V$
<b>Phase comparator</b>						
Differential I/P offset voltage	23, 24		$\pm 2$		mV	$V_{out} = 0V$
Input bias current	23, 24		0.05	2.5	$\mu A$	$V_{in} = 0V$
Differential input resistance	23, 24		100		k $\Omega$	
Common mode I/P voltage range	23, 24	$\pm 4$			V	
Differential I/P to limit (AC)	23, 24		1.0	10	mV rms	See note 4
Output current	21, 22	$\pm 1.0$	$\pm 2.0$	$\pm 5.0$	mA	$I_{22} = 250\mu A$
Current gain (pin 22 to pin 21)	21, 22	$\pm 4$	$\pm 10$		-	See note 5
Transconductance, O/P/diff.I/P	21, 23, 24	$\pm 100$	$\pm 250$		mA/V	See note 5
Output voltage, linear range	21	$\pm 5$	$\pm 5.5$		V	
Output current	21			$\pm 2$	$\mu A$	$I_{22} = 0$
Phase comparator I/P 'low'	1	-4		-0.2	V	
Phase comparator I/P 'high'	1	+1.9		+5.3	V	
<b>Auxiliary amplifier (SL650 only)</b>						
Differential I/P offset voltage	13, 14		$\pm 2$		mV	$V_{out} = 0V$
Input bias current	13, 14		0.025	0.5	$\mu A$	$V_{in} = 0V$
Differential I/P resistance	13, 14	0.2	3		M $\Omega$	
Common mode I/P voltage range	13, 14	$\pm 4$			V	
Voltage gain (13-14) to 15	13, 14, 15	1000	5000		-	
Output voltage range	15	$\pm 4$	$\pm 4.8$		V	$R_L \geq 2k\Omega$
Output current limit	15	$\pm 4$	$\pm 6.5$	$\pm 12$	mA	

### NOTES

1. With a timing current of  $60\mu A$  and  $f = 1kHz$  ( $C = 0.01\mu F$ ,  $R = 100k\Omega$ , supply voltages =  $\pm 6V$ ), the temperature coefficient of frequency of the SL650C is typically  $\pm 2.5ppm/^\circ C$  over the range  $0^\circ C$  to  $+40^\circ C$ .
2. This voltage applies for timing currents in the range  $20\mu A$  to  $2mA$  and with the relevant input selected. In the unselected state the voltage is typically  $+0.6V$ .
3. The 'low' state is maintained when the inputs are open-circuited.
4. Limiting will occur earlier if the output (pin 21) voltage-limits first.
5. For a control current input to pin 22 of  $250\mu A$  The sign of the transconductance is positive when the signal input is positive and the VFO output (or phase comparator input) is 'high'.

### ABSOLUTE MAXIMUM RATINGS

Supply voltages	$\pm 7.5V$
Storage temperature	$-55^\circ$ to $+175^\circ C$
Operating temperature	$-55^\circ$ to $+125^\circ C$
Input voltages	Not greater than supplies

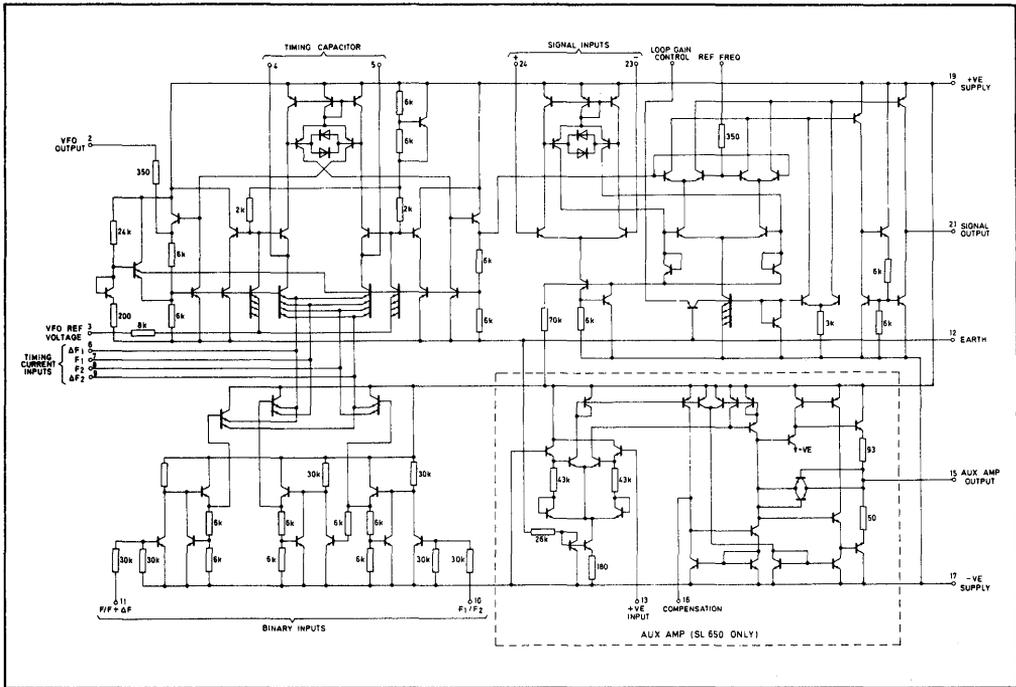


Fig. 2 Circuit diagram of SL650/SL651

**OPERATING NOTES**

**Basic VFO Relationships**

The VFO free-running frequency is inversely proportional to the value of the tuning capacitor C, connected to pins 4 and 5, and directly proportional to the VFO timing current (see Fig.3). Four current switches, controlled by TTL-compatible logic inputs on pins 10 and 11 select a combination of external resistors (connected to pins 6, 7, 8 and 9) which determine the VFO timing current. When both logic inputs are low, open-circuit, or connected to 0V however, then only the current switch associated with pin 7 is closed. the VFO timing current is then determined solely by the value of one resistor (R2 in Fig.3), and by the negative voltage connected to that resistor.

In this simplified configuration, as shown in Fig.4 the VFO frequency is determined by the relationship.

$$f = \frac{1}{CR} \cdot \frac{V_R}{V_3}$$

where f is in kHz, V in volts, C in  $\mu F$  and R in  $k\Omega$ .

If the timing resistor R is returned to the VFO negative supply (pin 3), then

$$V_R = V_3$$

$$\text{and } f = \frac{1}{CR}$$

Pin 3 is normally connected to the chip negative supply; if, however, pin 3 is connected to a separate

negative supply then the VFO can be voltage-controlled, and the VFO frequency will be:

$$f = \frac{1}{CR} \cdot \frac{V_-}{V_C}$$

where  $V_-$  is the chip and timing resistor negative supply and  $V_C$  is the control voltage connected to pin 3

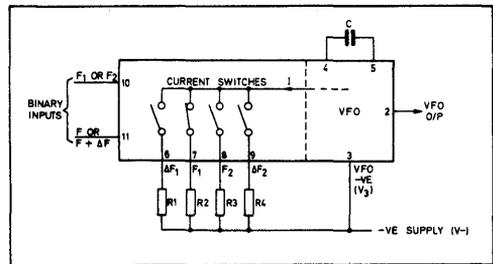


Fig. 3 VFO and binary interface

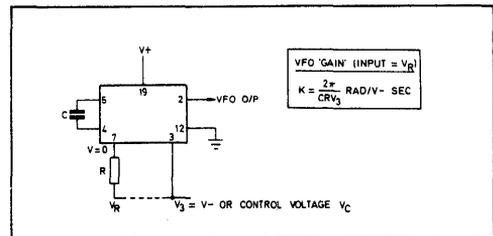


Fig. 4 VFO basic configuration

The timing current I should be between 20μA and 2mA, corresponding to a value for R between 3kΩ and 300kΩ with supplies of ±6V. For accurate timing, CR should be greater than 5μs.

When the binary interface is used as shown in Fig.3 the VFO free-running frequency is dependent on the logic input states, as shown in Table 1.

Pin 10	Pin 11	Timing Pins	VFO Frequency
LO	LO	7	$\frac{1}{CR_2}$
LO	HI	6 & 7	$\frac{1}{CR_2} + \frac{1}{CR_1}$
HI	LO	8	$\frac{1}{CR_3}$
HI	HI	8 & 9	$\frac{1}{CR_3} + \frac{1}{CR_4}$

Table 1 Binary interface relationships

**Auxiliary amplifier**

Internal compensation provides stability down to a closed loop gain of typically 20dB. A 30pF capacitor connected between pins 16 and 15 will give compensation down to a closed loop gain of unity. The output is short circuit protected but is not recommended for driving loads less than 2k

**Phase Comparator**

The phase comparator parameters are defined as follows (see Fig.5):

$$\text{Overall transconductance} = \frac{I_{21}}{V_{24} - V_{23}}$$

$$\text{Overall voltage gain} = \frac{V_{21}}{V_{24} - V_{23}}$$

The input amplifier will limit when the peak input ( $V_{24} - V_{23}$ ) exceed ±5mV (typ.). It is recommended that  $R_L$  is kept below 5kΩ to avoid saturating the output and introducing de-saturation delays.

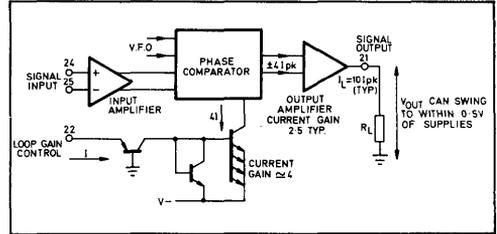


Fig. 5 Phase comparator

# SL652C

## MODULATOR/PHASE LOCKED LOOP

The SL652C is a versatile integrated circuit capable of performing all the common modulation functions (AM, PAM, SCAM, FM, FSK, PSK, PWM, tone-burst, delta-modulation, etc.). A wide variety of phase-locked loops can be realised using this device, with all parameters accurately controllable; they can also be used to generate precise waveforms at frequencies up to 0.2MHz.

The highly accurate and stable variable frequency oscillator is programmable over a wide range of frequency by voltage, current, resistor or capacitor. In addition direct selection of one of four spot frequencies is facilitated by using the on-chip binary interface, which accepts standard logic levels at very low logic '1' input currents.

The differential input phase comparator has a wide common mode input voltage range. It has a high gain limiting amplifier at its input requiring only 1mV input to maintain lock range in a typical phase-locked loop. The current output is programmable from zero to over 2mA by an external resistor or current input, and the gain is voltage – current – or resistance – programmable from zero to greater than 10,000.

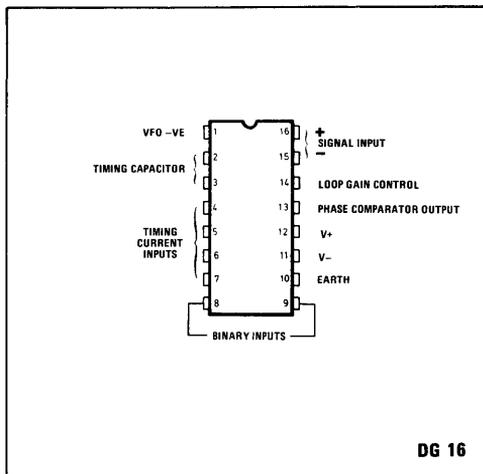


Fig. 1 Pin connections (top view)

### FEATURES

- VFO Frequency Variable Over 100: 1 Range With Same Capacitor: Linearity 0.2%
- VFO Temperature Coefficient: 20 ppm/°C Typ.
- Supply sensitivity 20 ppm/% Typ.
- VFO Phase-Continuous at Transitions
- Binary Interface

### QUICK REFERENCE DATA

- Supply Voltages ±6V
- Operating Temperature Range 0°C to +70°C
- Supply Currents 1.5mA typ.

### APPLICATIONS

- Modems
- Modulators
- Demodulators
- Tone Decoders
- Tracking Filters
- Waveform Generators
- Stable Current-Controlled Oscillators

### ABSOLUTE MAXIMUM RATINGS

Supply voltages	±7.5V
Storage temperature	-55° to +175°C
Operating temperature	-55° to +125°C
Input voltages	Not greater than supplies

ELECTRICAL CHARACTERISTICS

Test Conditions (unless otherwise stated):

Supply voltage:  $\pm 6V$

$T_A: +25^\circ C \pm 5^\circ C$

Characteristics	Pins	Value			Units	Conditions
		Min.	Typ.	Max.		
<b>Variable frequency oscillator</b>						
Initial frequency offset error		-3	$\pm 1$	+3	%	
Normal mark/space ratio		0.98	1.00	1.02	-	
Temp. coefficient of frequency			$\pm 20$		ppm/ $^\circ C$	See note 1
Frequency variation with supplies	11, 12		$\pm 20$		ppm/%	
Voltage at timing current inputs	4, 5, 6, 7		$\pm 10$		mV	See note 2
Max. freq. of oscillation			0.5		MHz	
<b>Binary inputs</b>						
$V_{in}$ to guarantee logic 'low'	8, 9			+0.6	V	See note 3
$V_{in}$ to guarantee logic 'high'	8, 9	+2.4			V	
Input current	8, 9		0.05	0.25	mA	$V_{in} = +3.0V$
<b>Phase comparator</b>						
Differential I/P offset voltage	15, 16		$\pm 2$		mV	$V_{out} = 0V$
Input bias current	15, 16		0.05	2.5	$\mu A$	$V_{in} = 0V$
Differential input resistance	15, 16		100		k $\Omega$	
Common mode I/P voltage range	15, 16	$\pm 4$			V	
Differential I/P to limit (AC)	15, 16		1.0	10	mV	See note 4
Output current	13, 14	$\pm 1.0$	$\pm 2.0$	$\pm 5.0$	mA	$I_{14} = 250\mu A$
Current gain (pin 14 to pin 13)	13, 14	$\pm 4$	$\pm 10$		-	See note 5
Transconductance, O/P/diff.I/P	13, 15, 16	$\pm 100$	$\pm 250$		mA/V	See note 5
Output voltage, linear range	13	$\pm 5$	$\pm 5.5$		V	
Output current	13			$\pm 2$	mA	$I_{14} = 0$

NOTES

1. With a timing current of  $60\mu A$  and  $f = 1kHz$  ( $C = 0.01\mu F$ ,  $R = 100k\Omega$ , supply voltages =  $\pm 6V$ ), the temperature coefficient of frequency of the SL652C is typically  $\pm 2.5ppm/^\circ C$  over the range  $0^\circ C$  to  $+40^\circ C$ .
2. This voltage applies for timing currents in the range  $20\mu A$  to  $2mA$  and with the relevant input selected. In the unselected state the voltage is typically  $+0.6V$ .
3. The 'low' state is maintained when the inputs are open-circuited.
4. Limiting will occur earlier if the output (pin. 13) voltage-limits first.
5. For a control current input to pin. 14 of  $250\mu A$ . The sign of the transconductance is positive when the signal input is positive and the VFO output (or phase comparator input) is 'high'.

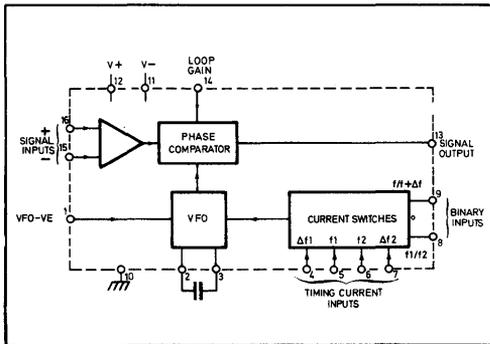


Fig. 2 SL652C block diagram

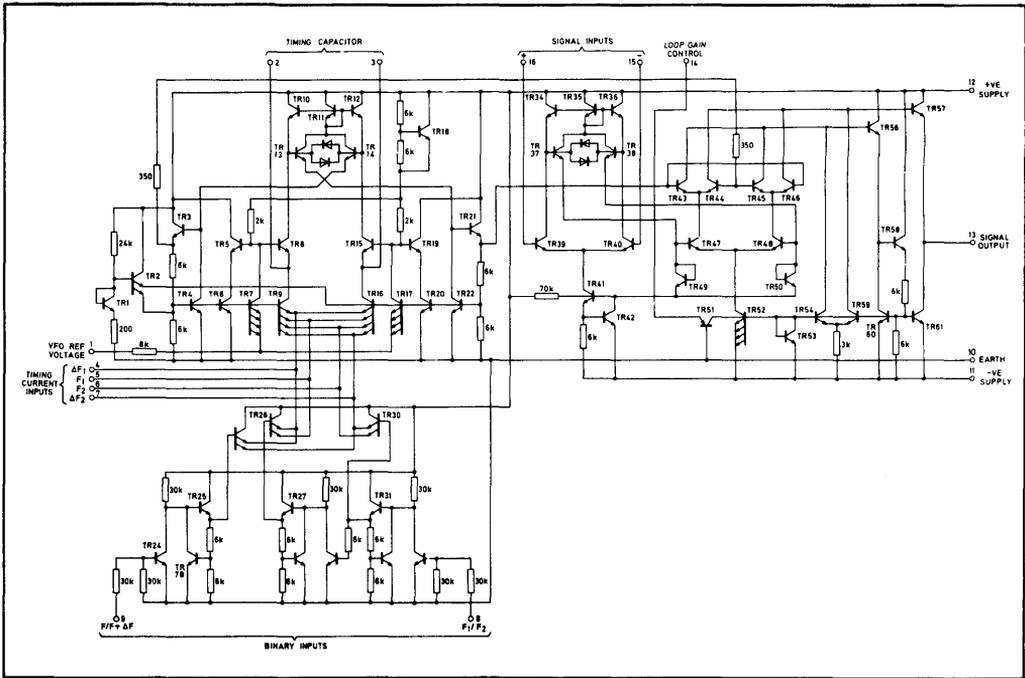


Fig. 3 Circuit diagram of SL652

**OPERATING NOTES**

**Basic VFO Relationships**

The oscillator output is normally taken from the phase comparator output by biasing the signal inputs a few hundred millivolts apart. If a direct oscillator output is required when the phase comparator is otherwise employed, it should be taken from pin 2 or 3 (which may affect oscillator stability). Alternatively, an SL651C can be used in place of the SL652C.

The VFO free-running frequency is inversely proportional to the value of the tuning capacitor C, connected to pins 2 and 3, and directly proportional to the VFO timing current (see Fig.4). Four current switches, controlled by TTL-compatible logic inputs on pins 8 and 9 select a combination of external resistors (connected to pins 4, 5, 6 and 7) which determine the VFO timing current. When both logic inputs are low, open-circuit, or connected to OV however, then only the current switch associated with pin 5 is closed. The VFO timing current is then determined solely by the value of one resistor (R2 in Fig.4), and by the negative voltage connected to that resistor.

In this simplified configuration, as shown in Fig.5 the VFO frequency is determined by the relationship.

$$f = \frac{1}{CR} \frac{V_R}{V_1}$$

where f is in kHz, V in volts, C in μF and R in kΩ.

If the timing resistor R is returned to the VFO negative supply (pin 1) then

$$V_R = V_1$$

$$\text{and } f = \frac{1}{CR}$$

Pin 1 is normally connected to the chip negative supply; if, however, pin 1 is connected to a separate negative supply then the VFO can be voltage-controlled, and the VFO frequency will be:

$$f = \frac{1}{CR} \frac{V_-}{V_C}$$

where V<sub>-</sub> is the chip and timing resistor negative supply and V<sub>C</sub> is the control voltage connected to pin 1.

The timing current should be between 20μA and 2mA, corresponding to a value for R between 3kΩ and 300kΩ with supplies of ±6V. For accurate timing, CR should be greater than 5μs.

When the binary interface is used as shown in Fig.4, the VFO free-running frequency is dependent on the logic input states, as shown in Table 1.

Pin 8	Pin 9	Timing Pins	VFO Frequency
LO	LO	5	$\frac{1}{CR_2}$
LO	HI	4 & 5	$\frac{1}{CR_2} + \frac{1}{CR_1}$
HI	LO	6	$\frac{1}{CR_3}$
HI	HI	6 & 7	$\frac{1}{CR_3} + \frac{1}{CR_4}$

Table 1 Binary interface relationships

**Phase Comparator**

The phase comparator parameters are defined as follows (see Fig. 6):

$$\text{Overall transconductance} = \frac{I_{13}}{V_{16} - V_{15}}$$

$$\text{Overall voltage gain} = \frac{V_{13}}{V_{16} - V_{15}}$$

The input amplifier will limit when the peak input ( $V_{16} - V_{15}$ ) exceeds  $\pm 5\text{mV}$  (typ.). It is recommended that  $R_L$  is kept below  $5\text{k}\Omega$  to avoid saturating the output and introducing de-saturation delays.

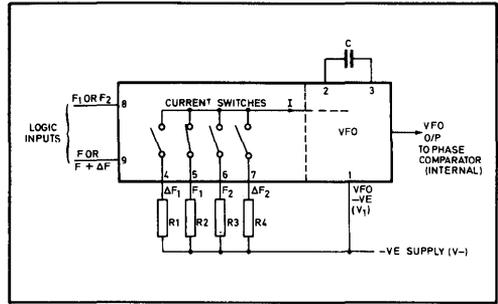


Fig. 4 VFO and binary interface

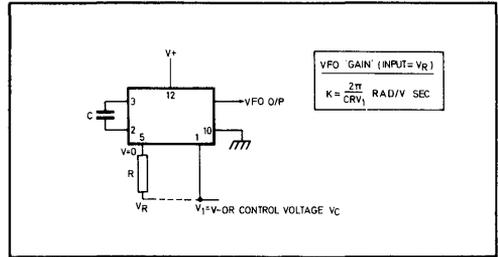


Fig. 5 VFO basic configuration

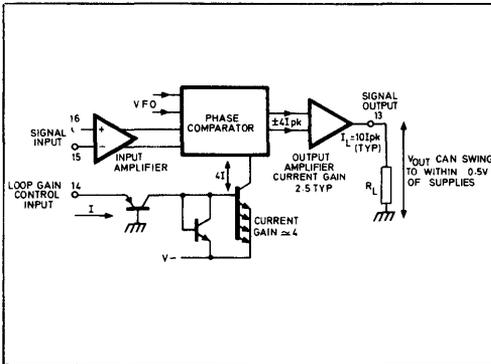


Fig 6. Phase comparator

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## SL8204

### TELEPHONE TONE RINGER

The SL8204 is a telephone set tone ringer IC. It is packaged in an 8 pin DIL Minidip. The unit is designed for use as a telephone set bell replacement, or as an extension ringer. The SL8204 will drive a speaker in place of the existing bell, using power supplied from the telephone line.

Two audio oscillators are incorporated. The low frequency oscillator shifts the high frequency oscillator between 508 and 635Hz at a 10Hz rate. These frequencies are determined by external components which may be changed as desired. The IC has a built-in threshold circuit with hysteresis which prevents false triggering, eliminates rotary dial 'chirps', and provides positive switching operation.

The IC may also be used for other applications requiring an attention-getting sound. Output power from the built-in amplifier is nominally 35mW, and will produce a maximum 90dBA sound pressure-level from a properly baffled 2 inch speaker.

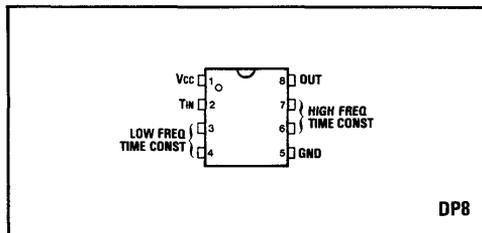


Fig.1 Pin connections - top view

#### FEATURES

- Low Current Drain
- Small Size (mini-DIP)
- Adjustable Frequency
- Threshold Circuit Prevents False Triggering and Rotary Dial 'Chirps'
- Built-In Hysteresis For Positive Enable
- Few External Components
- Up To 90dBA Sound Pressure Level

#### ABSOLUTE MAXIMUM RATINGS

Supply voltage	30V d.c.
Storage temperature range	-65°C to +150°C
Operating temperature range	-45°C to +65°C

#### APPLICATIONS

- Telephone Bell Replacement
- Extension Ringers

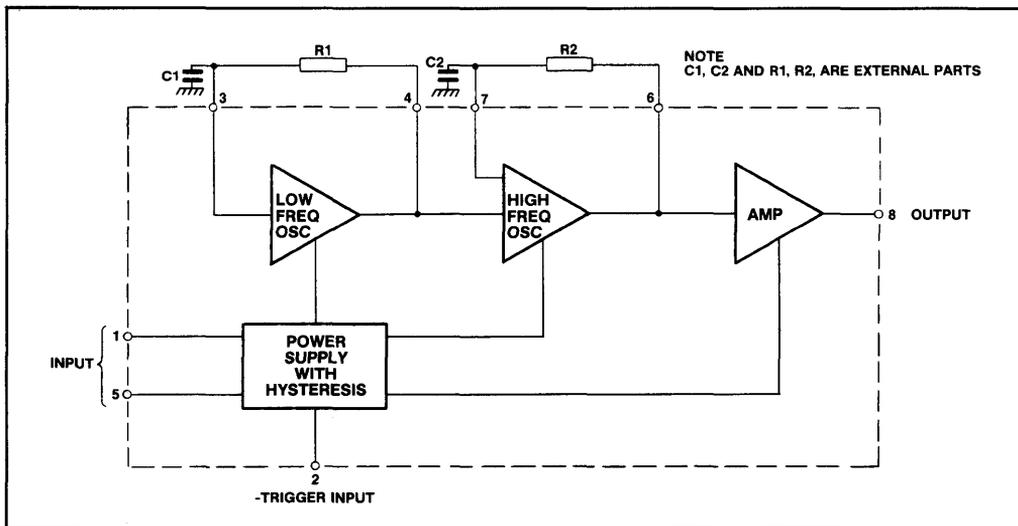


Fig.2 SL8204 block diagram

**ELECTRICAL CHARACTERISTICS**

Test conditions (unless otherwise stated):

 $T_{amb} = -45^{\circ}\text{C}$  to  $+65^{\circ}\text{C}$ 

Characteristic	Value			Units	Conditions
	Min.	Typ.	Max.		
Initiation supply voltage $V_{SI}$	17	19	21	V	See Fig.4
Sustaining voltage $V_{sus}$	9.7	11.5	13	V	See Fig.4
Supply current $I_{SI}$	1.4	2.5	4.2	mA	No load. See Fig.4
Supply current $I_{sus}$	0.7	1.4	2.5	mA	See Fig.4
K1, $f_{H1}$ (constant) See Eq.1	1/1.681	1/1.515	1/1.380		
$f_{H1}$ (frequency)	458	508	558	Hz	$R_2 = 191k$ $C_2 = 6800pF$
K2, $f_{H2}$ (constant) See Eq. 2	1.190	1.250	1.310		
$f_{H2}$ (frequency)	545	635	731	Hz	$R_2 = 191k$ $C_2 = 6800pF$
K3, $f_L$ (constant) See Eq. 3	1/1.367	1/1.234	1/1.118		
$f_L$ (frequency)	9	10	11	Hz	$R_1 = 173k$ $C_1 = 0.47\mu F$
Operating voltage	-	-	29	V	
Output voltage high	18.0	19.0	20.0	V	$V_{CC} = 21V$ $I(\text{Pin } 8) = -15mA$ $\text{Pin } 6 = 6V$ $\text{Pin } 7 = GND$
Output voltage low	0.5	0.9	1.3	V	$V_{CC} = 21V$ $I(\text{Pin } 8) = 15mA$ $\text{Pin } 6 = GND$ $\text{Pin } 7 = 6V$
Trigger voltage $V_T$	8.5	9.5	10.5	V	$V_{CC} = 15V$ See Note 1
Trigger current $I_T$		20.0	1000	$\mu A$	See Notes 1 and 3
Disable voltage $V_D$		0.4	0.8	V	$T_{amb} = 25^{\circ}\text{C}$ See Note 2
Disable current	-40	-50		$\mu A$	$T_{amb} = 25^{\circ}\text{C}$ See Note 2
$I_{IN}$ (Pin 3)	-	-	500	nA	$\text{Pin } 3 = 6V$ $\text{Pin } 4 = GND$
$I_{IN}$ (Pin 7)	-	-	500	nA	$\text{Pin } 7 = 6V$ $\text{Pin } 6 = GND$
I (Pin 4) Source $V_{CC} = V_{sus}$	150	300	600	$\mu A$	$\text{Pin } 3 = GND$ $\text{Pin } 4 = GND$
I (Pin 4) Sink $V_{CC} = V_{sus}$	100	200	350	$\mu A$	$\text{Pin } 3 = 6V$ $\text{Pin } 4 = 5V$
I (Pin 6) Source $V_{CC} = V_{sus}$	80	175	350	$\mu A$	$\text{Pin } 6 = GND$ $\text{Pin } 7 = GND$ $\text{Pin } 4 = GND$
I (Pin 6) Sink $V_{CC} = V_{sus}$	125	250	500	$\mu A$	$\text{Pin } 6 = GND$ $\text{Pin } 7 = GND$ $\text{Pin } 4 = 8V$
I (Pin 6) Sink $V_{CC} = V_{sus}$	70	125	250	$\mu A$	$\text{Pin } 6 = 5V$ $\text{Pin } 7 = 6V$ $\text{Pin } 4 = GND$
I (Pin 6) Sink $V_{CC} = V_{sus}$	100	200	300	$\mu A$	$\text{Pin } 6 = 5V$ $\text{Pin } 7 = 6V$ $\text{Pin } 4 = 8V$

## NOTES

- $V_T$  and  $I_T$  are the conditions applied to Pin 2 to start oscillation for  $V_{sus} < V_{CC} < V_{SI}$
- $V_D$  and  $I_D$  are the conditions applied to Pin 2 to inhibit oscillation for  $V_{SI} < V_{CC}$
- Trigger Current must be limited externally

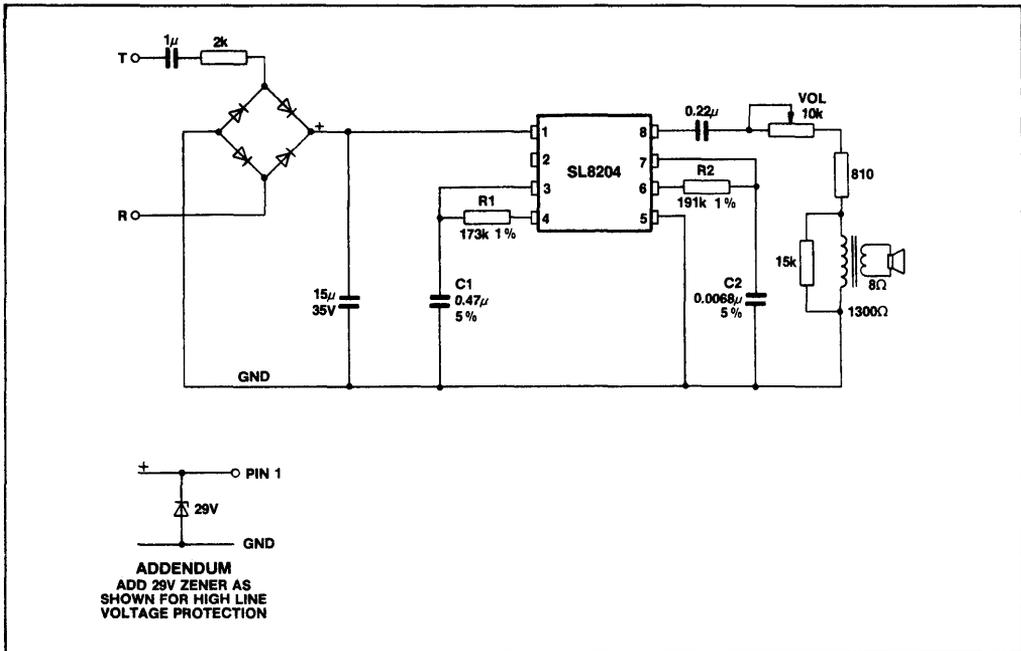


Fig.3 Circuit diagram - tone ringer

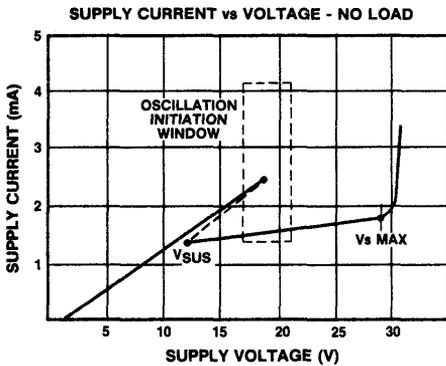


Fig.4 Tone ringer characteristics

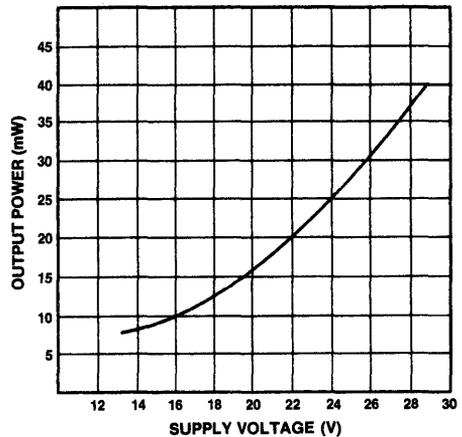


Fig.6 Typical power output

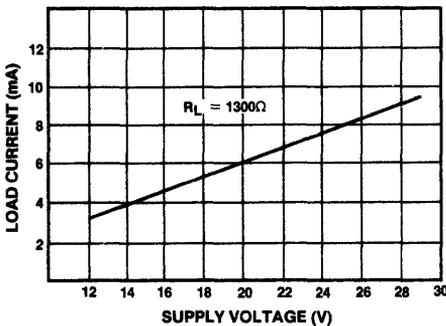


Fig.5 Typical RMS current



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## SL9009EXP

### ADAPTIVE CANCELLATION FILTER

The SL9009 is a bipolar integrated circuit designed for use in duplex modems on 600Ω telephone lines. It automatically optimises the duplexer such that the transmitted signal is cancelled at the input to the receiver.

- Automatically Simulates Impedance Characteristic of Line
- Independently Variable L,C,R Impedance Components
- Achieves Typical 40dB Rejection of Transmitted Signal
- Requires Only 2 External Op-Amps for Complete Adaptive Duplexer
- 16 Pin DIL Package
- $\pm 4.5$  to  $\pm 7V$  Supply Range

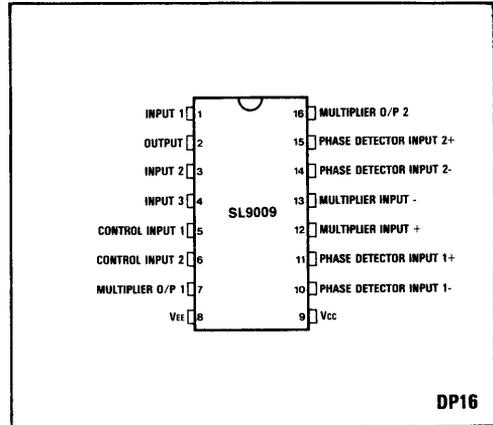


Fig.1 Pin connections - top view

#### ABSOLUTE MAXIMUM RATINGS

Operating temperature range	0° C to 70° C
Storage temperature range	-10° C to +125° C
Supply voltage range	$\pm 4.5V$ to $\pm 10V$
Input voltage range	V- to V +
Output voltage range	V- to V +
Pins 1,2,3,4,5,6,10,11,12,13,14,15	
Output voltage range	$\pm 5V$
Pins 16,7	
Input voltage range	$\pm 5V$
Pins 1,3 and 4 relative to Pin 2	
Supply voltage range	$\pm 4.5V$ to $\pm 7V$
For specified parameters	

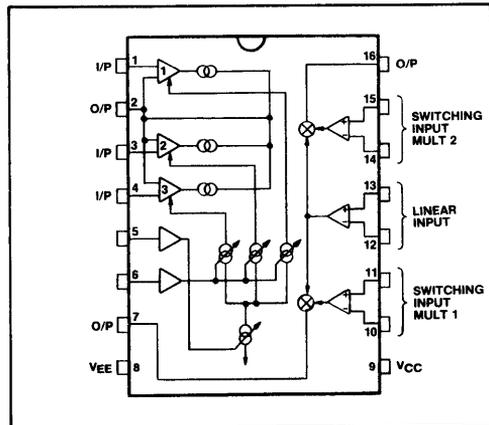


Fig.2 Block diagram

**ELECTRICAL CHARACTERISTICS**

**Test conditions (unless otherwise stated):**  
 $\pm 4.5V$  to  $\pm 7V$  supply,  $0^\circ C$  to  $70^\circ C$

Characteristic	Min.	Value		Units	Conditions
		Typ.	Max.		
Supply currents <b>4-Quadrant multipliers</b>	0.8	1.3	2.0	mA	Pin 5 at V-, all other inputs and outputs at 0V
Input offset voltage multiplier switching inputs			9	mV	Pins 14,15 and 10,11
Input offset voltage multiplier linear input			13	mV	Pins 12,13
Input bias current		0.1	0.7	$\mu A$	Pins 10 to 15
Input offset currents			$\pm 0.15$	$\mu A$	Pins 10,11,12,13,14 and 15
Input common-mode range	V- +2.7		V + -2.7	V	Pins 10 to 15
Output offset current pin 7(16)			$\pm 1.2$	$\mu A$	$V_{12} = V_{13} = 0V^*$ $V_{10} - V_{11} (V_{14} - V_{15}) = 200mV$ p-p sine wave
Transconductance $V_{12} - V_{13}$ to pin 7(16)	250	500	1000	$\mu ohm$	$V_{10} - V_{11} (V_{14} - V_{15})$ switched ( $\pm 100mV$ )
Output voltage compliance	V- +2.5		V + -2	V	$< 0.2\mu A$ change in output current, pin 7 or 16
<b>Transconductance cells</b>					
Offset current pin 2			$\pm 12$	$\mu A$	Cell under test set for gain = 4, other cells for gain 0, $V_2 = 0V$ Pin 2 = 0V
Input impedance					
Pin 1	3		10	k $\Omega$	
Pins 3 and 4	4		14	k $\Omega$	
Operating voltage range					
Pins 1,2,3,4	V- +2.7		V +2	V	
Gain range, each cell		0.05-10			
Input current range Pins 1,3,4	$\pm 10$			$\mu A$	For $< 1\%$ non-linearity
Control inputs					
Input current $I_5, I_6$			0.12	$\mu A$	$V_5, V_6 = +V$
Control voltage input range Pin 5	V- +2.7		V- +6	V	Cell gain 0.05-10
Input range Pin 6	-2		+1.8	V	For cell 2 or 3 gain $\leq 2$ x cell 1 gain, $V+ = -(V-)$

**PRINCIPLES OF OPERATION**

The cancellation principle is to use the conductance cells to simulate the characteristics of the line, in a bridge circuit to separate out the received signal from the transmitted signal. The bridge output goes to two phase-sensitive detectors which detect the out-of-balance signal components in phase and in quadrature with the cancellation signal, derived from the transmit signal. These out-of-balance currents are integrated and fed back to the conductance cells, to adjust the effective resistance and capacitance or inductance until the bridge is balanced and the transmit signal is completely cancelled out. The current source characteristics are arranged to keep the loop stable for all normal line characteristics.

**Description of Conductance Cell**

Each conductance cell is effectively a variable-gain current amplifier with a gain approximately equal to  $\frac{\text{CONTROL CURRENT}}{20\mu A}$

The input roughly follows the output voltage, with an effective input series resistance of about 5k $\Omega$ . Therefore, with an impedance Z connected from the input to ground, the impedance seen at the output is approximately

$$(Z + 5k\Omega) \times \frac{20\mu A}{\text{CONTROL CURRENT}}$$

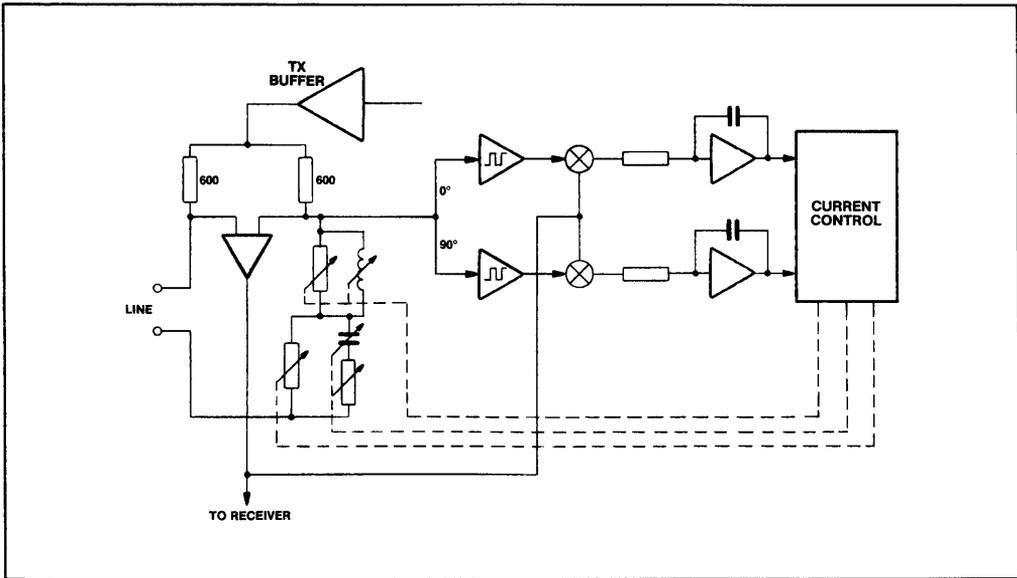


Fig.3 Simplified circuit illustrating cancellation principle

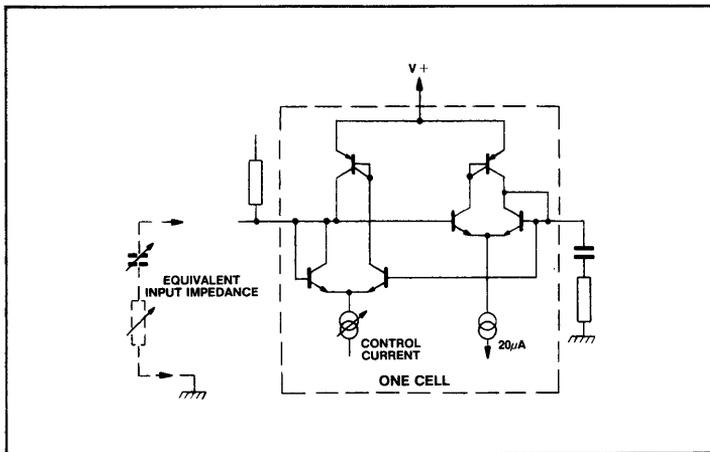
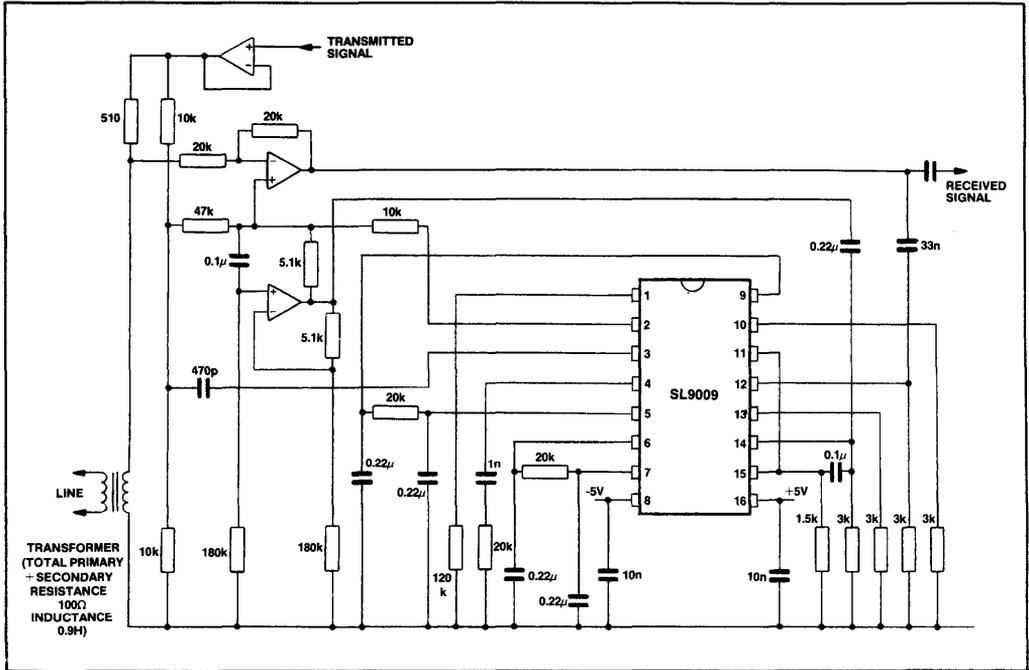


Fig.4 Conductance cell schematic



# SP1404BW, D3702

## HIGH VOLTAGE INTERFACE CIRCUIT

The SP1404 is a bipolar integrated circuit comprising five individual digital current amplifier circuits. Each circuit accepts a logic input from TTL, CMOS or a similar source and drives a high-current load at the output. The outputs are capable of withstanding high negative voltages in the 'off' state, making the SP1404 particularly suited to telecommunications applications.

The D3702 is a version of the SP1404BW in 14 pin plastic package approved to BT specification.

### CIRCUIT DESCRIPTION (FIG.2)

The SP1404 operates as a power amplifier interfacing from a voltage-level sensitive input to a high-current output switch. The input threshold is TTL-compatible, with a low input current requirement enabling one standard TTL output to drive many interfaces. The low input current requirement also makes it possible to use series current-limiting resistors to protect the SP1404 inputs.

Each element of the device performs an inverting function, i.e. a low voltage level on the input causes a high current in the output. If the input is left open-circuit, the output will be off and the output current will be zero.

The isolation of the integrated circuit is biased to the more negative of the two earth points by diodes D1 and D2 so that differences of up to  $(V_{CC} - 1)$  volts can be tolerated between the 'noisy' exchange earth and the 'quiet' electronic earth.

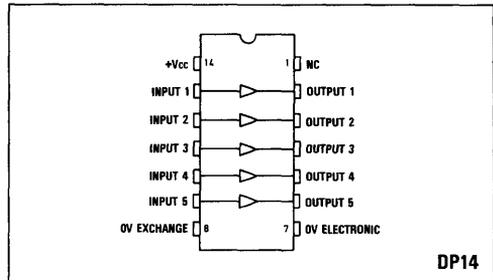


Fig. 1 Pin connections (viewed from underside)

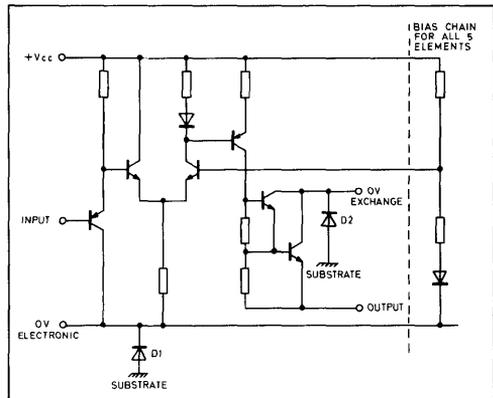


Fig. 2 Circuit diagram of one element

### ELECTRICAL CHARACTERISTICS

**Test Conditions (unless otherwise stated)**

Temperature range = 0°C to +70°C

$V_{CC} = +5V \pm 0.5V$

Characteristic	Value			Units	Conditions
	Min.	Typ.	Max.		
Input current		-20 -2		$\mu A$ $\mu A$	$V_{in} = 0V$ $V_{in} = V_{CC}$
Output voltage			1.5	V	$V_{in} = 0.8V, I_{out} = 50mA$
Output current (Off state)			100	$\mu A$	$V_{in} = 2V, V_{out} = -60V$
Output current (On state)	50	80		mA	$V_{in} = 0.8V$
$V_{CC}$ supply current		30		mA	$V_{CC} = 5V, \text{all inputs low}$
Total power dissipation		450		mW	$V_{CC} = 5V, \text{all inputs low}$ all outputs $I_{out} = 50mA$

## SP1404BW

### ABSOLUTE MAXIMUM RATINGS

Storage temperature	-55°C to +175°C
Chip operating temperature	+150°C
Ambient temperature ( $I_{out} = 50mA$ )	+85°C
Load current	80mA
Voltage between output and 'noisy' earth	-65V
$V_{cc}$ to output voltage	75V
$V_{cc}$ to electronic earth	7V
Input voltage	$V_{cc} + 1V$

# SP1450B(B) & SP1455B(B)

## PCM SIGNAL MONITOR CIRCUITS

The SP1450 and SP1455 are bipolar integrated circuits designed to monitor errors in three-level digital signals modulated by a three-alphabet 4B3T code such as MS43. They can also indicate the failure of positive or negative pulses in the signal. The high frequency capability allows operation in PCM systems up to 34M bit/s (SP1450) and 140M bit/s (SP1455). Facilities are provided to adjust input thresholds independently on each polarity of input and the error output can be interfaced with low speed CMOS circuitry or high speed ECL.

The SP1450B(B) and SP1455B(B) are similar to the SP1450B and SP1455B but are screened to MIL-STD-883, Method 5004, Class B.

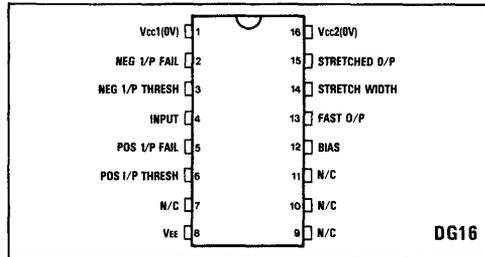


Fig.1 Pin connections (top view)

### FEATURES

- Suitable for 34, 120 and 140M bit/s PCM
- Positive and Negative Input Signal Fail Outputs
- High Speed Error Output
- Low Speed 'Stretched' Output
- Low Power Consumption

### APPLICATIONS

- PCM Telephone Transmission Terminal Equipment
- PCM Repeaters
- Error Checking Test Equipment

### QUICK REFERENCE DATA

- Supply Voltage -4.4V to -5.25V
- Operating Temperature Range -10°C to +70°C
- Power Consumption 100mW typ
- Input Voltage Range  $\pm 450\text{mV}$  to  $\pm 1100\text{mV}$  (SP1450)  
 $\pm 450\text{mV}$  to  $\pm 600\text{mV}$  (SP1455)
- Thermal Resistance  $\theta_{j-a}$  100°C/W

### ABSOLUTE MAXIMUM RATINGS

- Supply voltage -8V
- Reverse input current (pin 4) 5mA (continuous) 20mA (10us max)
- Forward input current (pin 4) 20mA (10us max)
- Storage temperature -55°C to +150°C
- Operating temperature -10°C to +70°C
- Junction temperature 150°C

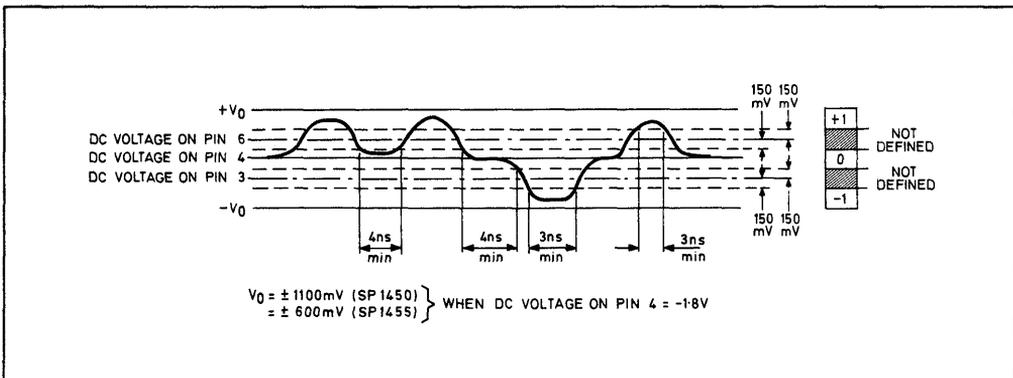


Fig.2 Input pulse wave form

# SP1450B(B)

## ELECTRICAL CHARACTERISTICS

Test conditions (unless otherwise stated):

V<sub>CC</sub> = Pins 1-16 = 0V

V<sub>EE</sub> = Pin 8 = -5.0V

T<sub>amb</sub> = +25°C

Input voltage range (pins 3,4,6) = -0.9V to -3.1V

## DC CHARACTERISTICS

Characteristic	Pin	Value			Units	Conditions
		Min.	Typ.	Max.		
Output low, current	2	0.9	1.2	1.9	mA	Pin 2 = 0V Pin 3 = -1.7V Pin 4 = -2.0V
Output low, current	2	0.7	—	—	mA	Pin 2 = 0V Pin 3 = -1.95V Pin 4 = -2.0V
Output high, current	2	—	—	1	μA	Pin 2 = 0V Pin 3 = -2.3V Pin 4 = -2.0V
Output high, current	2	—	—	0.4	mA	Pin 2 = 0V Pin 3 = -2.05V Pin 4 = -2.0V
Output low, current	5	0.9	1.2	1.9	mA	Pin 4 = -2.0V Pin 5 = 0V Pin 6 = -2.3V
Output low, current	5	0.7	—	—	mA	Pin 4 = -2.0V Pin 5 = 0V Pin 6 = -2.05V
Output high, current	5	—	—	1	μA	Pin 5 = 0V Pin 4 = -2.0V Pin 6 = -1.7V
Output high, current	5	—	—	0.4	mA	Pin 5 = 0V Pin 4 = -2.0V Pin 6 = -1.95V
Output low, current	13	6.0	7.0	9.0	mA	Pin 13,15 = 0V Pin 3 = -1.7V Pin 4 = -2.0V Pin 6 = -2.3V Pins 2,5 = 0V 470 Ω pin 12 to -5V 27 kΩ pin 14 to -5V Six pos. or neg. pulses on pin 4
Output high, current	15	—	—	1	μA	
Output high, current	13	—	—	1	μA	Pin 13, 15 = 0V Pin 3 = -2.3V Pin 4 = -2.0V Pin 6 = -1.7V Pins 2,5 = 0V 470 Ω pin 12 to -5V 27 kΩ pin 14 to -5V
Output low, current	15	0.5	0.75	—	mA	
Current consumption	1,16	—	20	25	mA	(Pins 2,5,13,15 = 0V (Pins 3,6 = -2.3V (Pin 4 = -2.0V (27 kΩ resistor between (Pin 14 and -5V (Pin 12 open
Input bias current	3	—	—	40	μA	Pin 2 = 0V Pin 3 = -1.7V Pin 4 = -2V
Input bias current	6	—	—	40	μA	Pin 4 = -2.0V Pin 5 = 0V Pin 6 = -1.7V
Input bias current	4	—	—	80	μA	Pins 2,5 = 0V Pins 3,6 = -2.3V Pin 4 = -2.0V

**AC CHARACTERISTICS**

Circuit reference: Fig.3  
 Input signal: Fig.2  
 $T_{amb} = -10^{\circ}\text{C}$  to  $+70^{\circ}\text{C}$   
 $V_{EE} = -4.4\text{V}$  to  $-5.25\text{V}$

Characteristic	Pin	Value			Units	Conditions
		Min.	Typ.	Max.		
Max. Input Frequency SP1450 SP1455	13		—	25.5	M band/s	See note 1 below
	13		—	105	M band/s	
Stretched output pulse width	15	0.5	0.7	2	$\mu\text{S}$	$C_1 = 390\text{ pF}$ $R_1 = 27\text{ k}\Omega$ using circuit of Fig. 7 (see note 2 below)
Error pulse width SP1455	13	4.25	—	5.25	nS	Input freq. 105 M band/s
Error pulse amplitude	13	300	—	—	mV	At max input frequency
Spurious pulse amplitude	13	—	—	50	mV	At max. input frequency

NOTE 1: These figures are the max.input symbol rates. For 4B3T codes, the effective bit rate is 4/3 x (input frequency).

NOTE 2: Resistor and capacitor values quoted are absolute values; temperature coefficients and tolerances have not been taken into account.

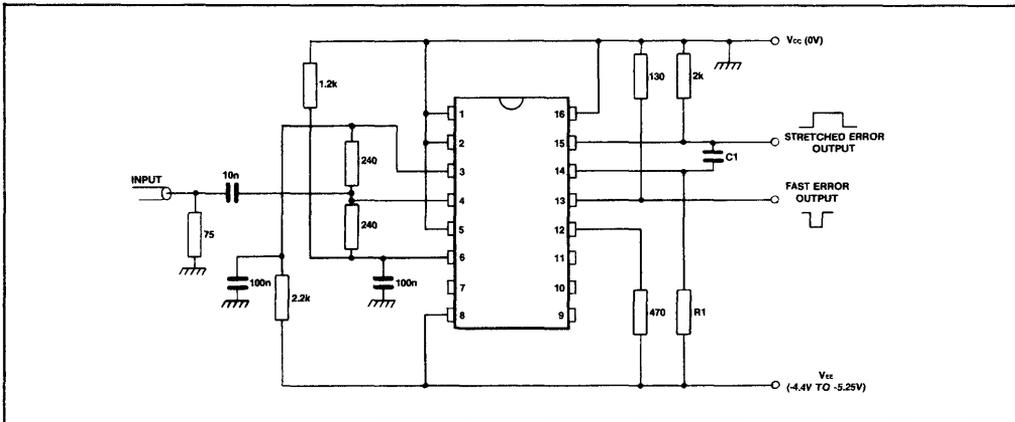


Fig.3 Functional test circuit

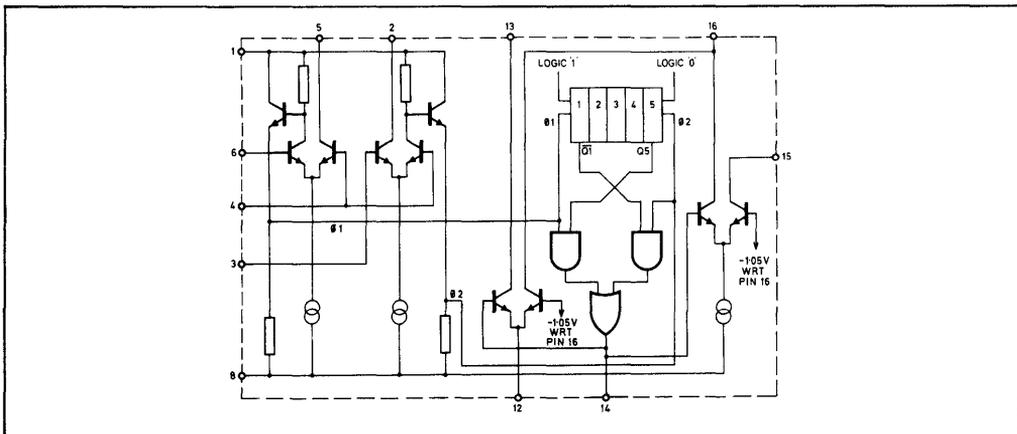


Fig.4 Circuit diagram of SP1450/SP1455

# SP1450B(B)

## APPLICATIONS

The circuit shown in Fig.3 is designed to accept a three level (ternary) input signal as shown in Fig.2. The input is applied to pin 4 whilst fixed bias levels are maintained on pins 3 and 6. When a positive input pulse is applied at a level more positive than the bias on pin 6 the positive comparator output 0 1 goes from '0' (V<sub>EE</sub>) to '1' (V<sub>CC</sub>). The 1-0 edge of this pulse clocks the five bit shift register one place to the right. Repeated operation will cause a pattern of logic '1's to be propagated along the shift register. When bit 5 is at logic '1' and the input is also positive an 'error' will occur at pins 13 and 15.

A negative input pulse at a level more negative than the voltage on bias pin 3 causes the negative comparator output 0 2 to clock the shift register one place to the left. Repeated operation causes a pattern of logic '0's to be propagated along the shift register. When bit 1 is at logic '0' and the input is also negative an 'error' output will again occur at pins 13 and 15.

During normal operation the shift register can assume one of only six possible states as shown in Fig.5.

State	1	2	3	4	5
A	0	0	0	0	0
B	1	0	0	0	0
C	1	1	0	0	0
D	1	1	1	0	0
E	1	1	1	1	0
F	1	1	1	1	1

Fig.5 Shift register states

When power is initially connected other states may occur.

Two 'error' outputs are available. The fast output at pin 13 is negative going; the peak current is defined by a resistor

connected between pin 12 and V<sub>EE</sub> according to the formula:

$$I = \frac{3.3}{R} \text{ (e.g. } 820 \text{ ohms; } 4\text{mA)}$$

A pullup resistor must then be connected between pin 13 and V<sub>CC</sub> to give a suitable voltage swing. A suitable ECL interface is shown in Fig.6.

If, as in a repeater application, a fast output is not required, pin 12 should be left open and pin 13 connected to V<sub>CC</sub> (pin 16).

A stretched output is available from pin 15 by connection of a capacitor between pins 14 and 15. A suitable circuit is shown in Fig.7.

Facilities are available at pins 2 and 5 to detect the absence of negative and positive going input signals. If these are not required pins 2 and 5 should be connected to V<sub>CC</sub> (pin 1). A CMOS interface circuit is shown in Fig.8.

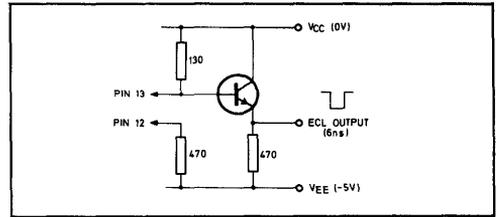


Fig.6 Interfacing with ECL at the output

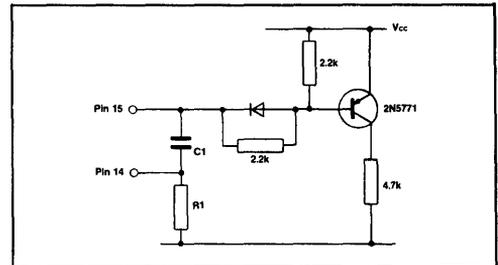


Fig.7(b) Interfacing with CMOS at the stretched output (SP1455)

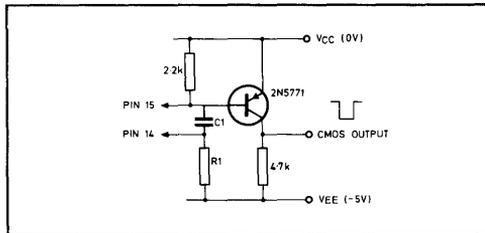


Fig.7(a) Interfacing with CMOS at the stretched output (SP1450)

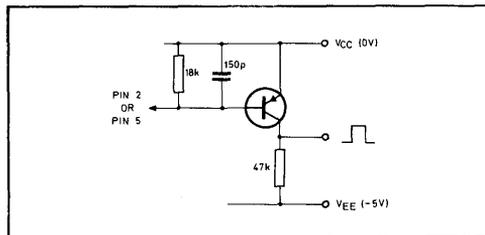
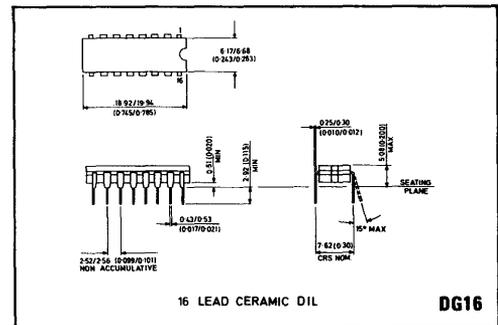
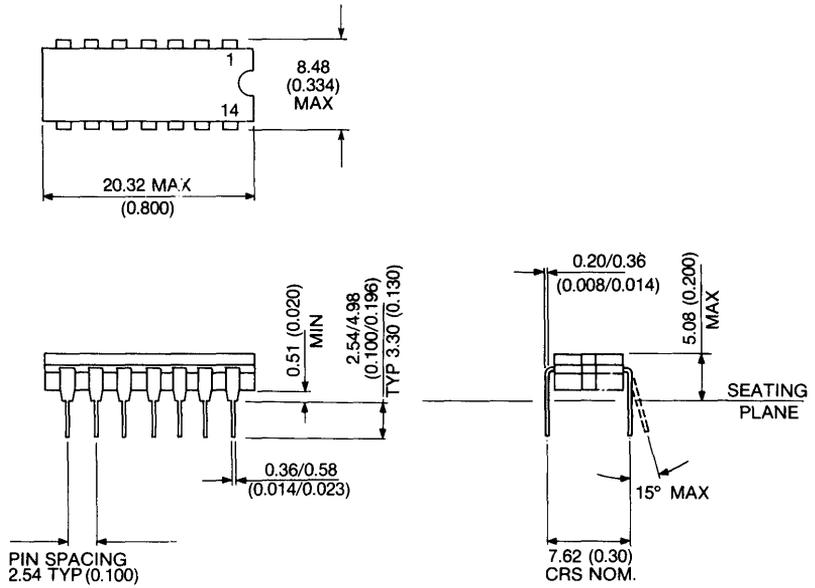


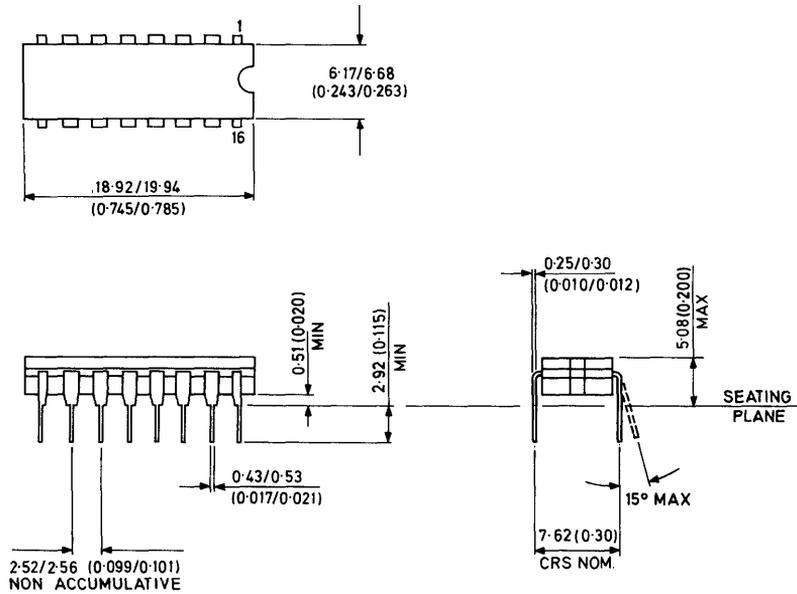
Fig.8 Interfacing with pulse fail output with CMOS



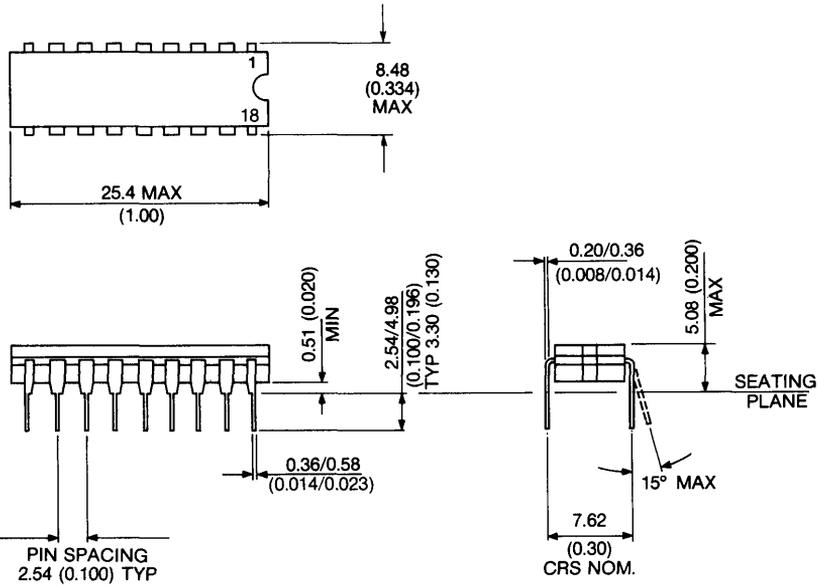
# Package Outlines



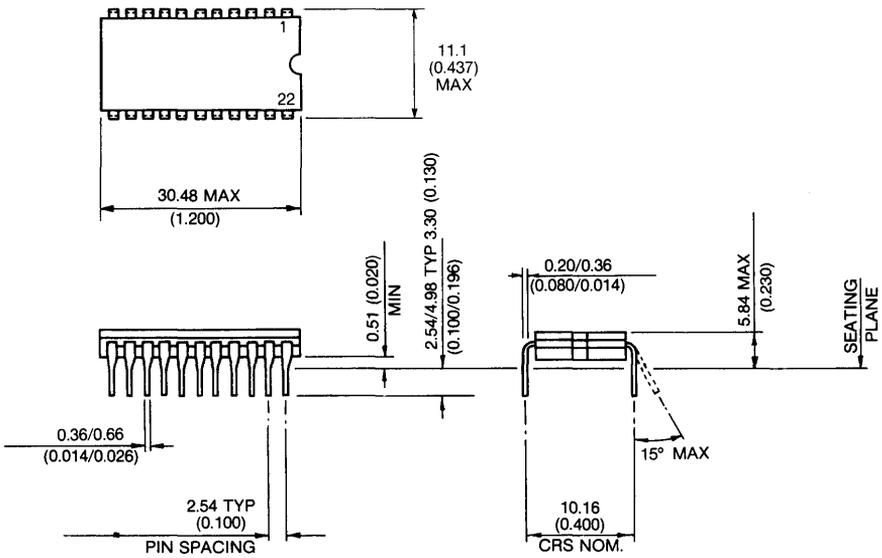
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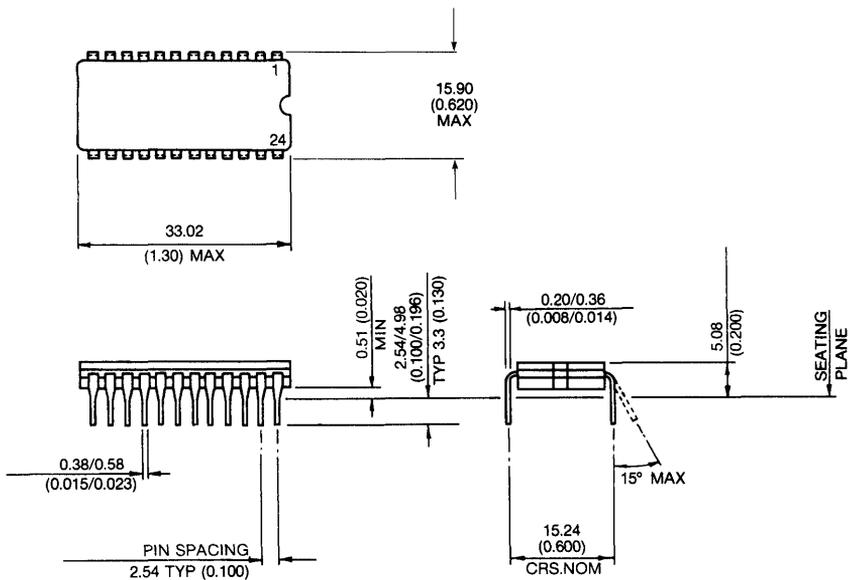
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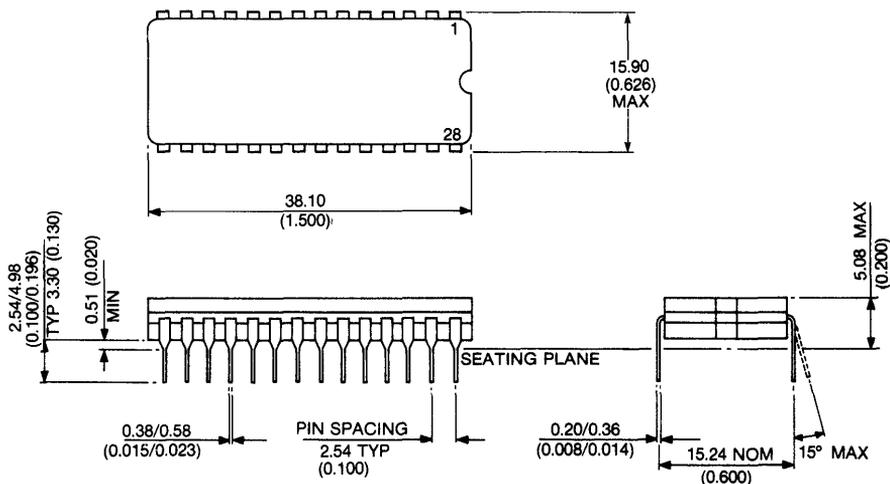
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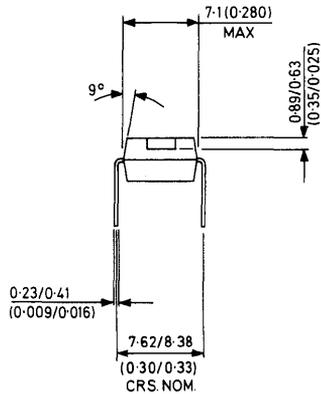
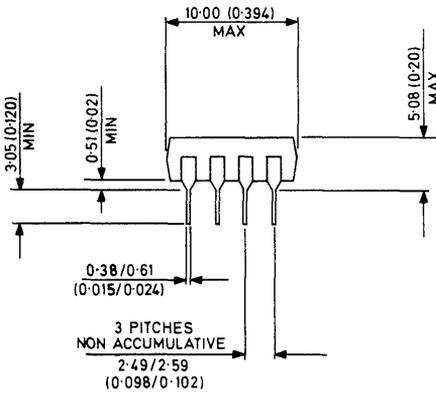
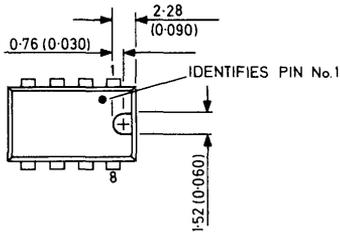
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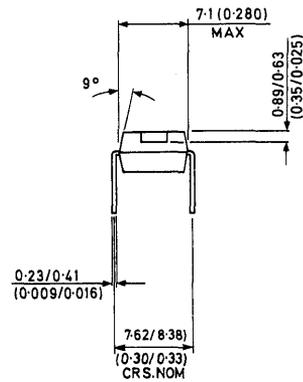
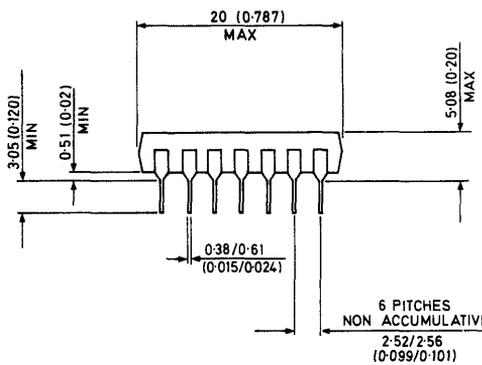
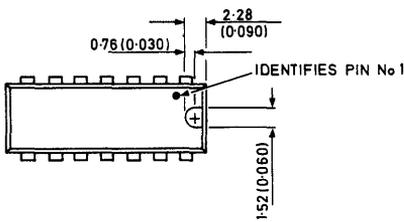
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CERDIP - DG24**



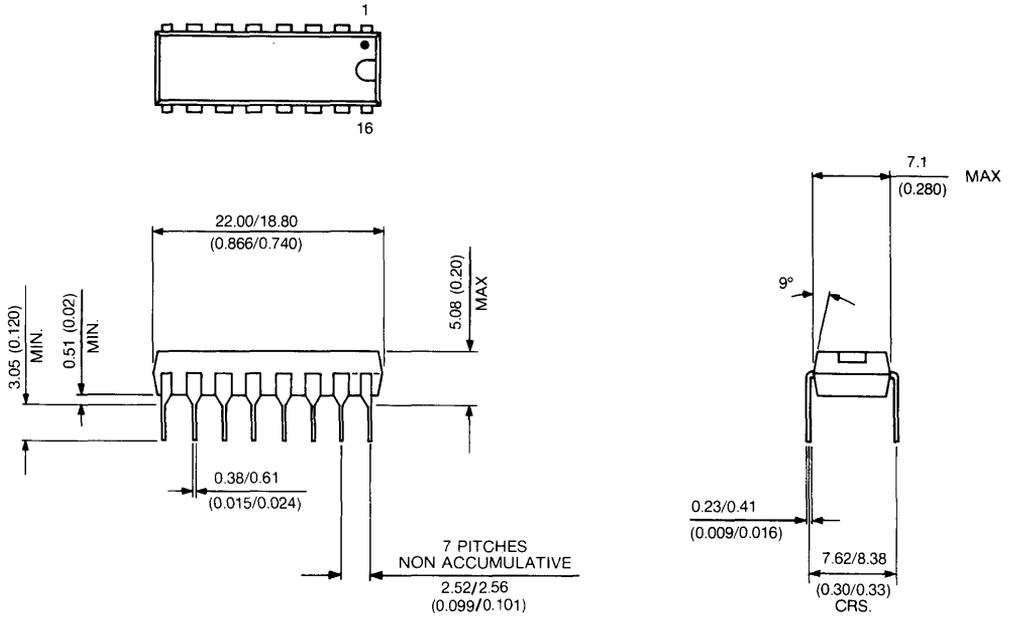
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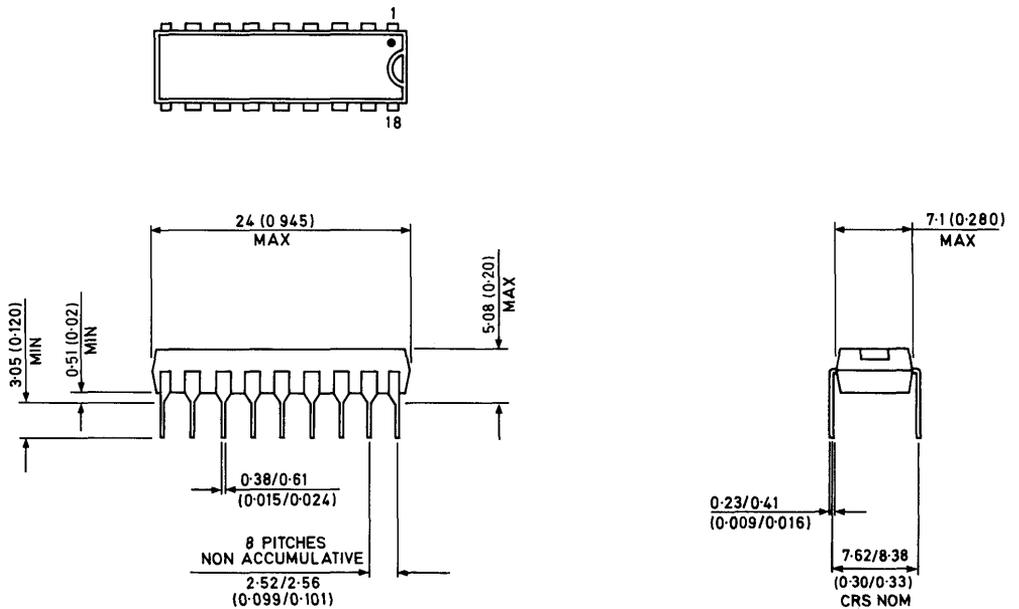
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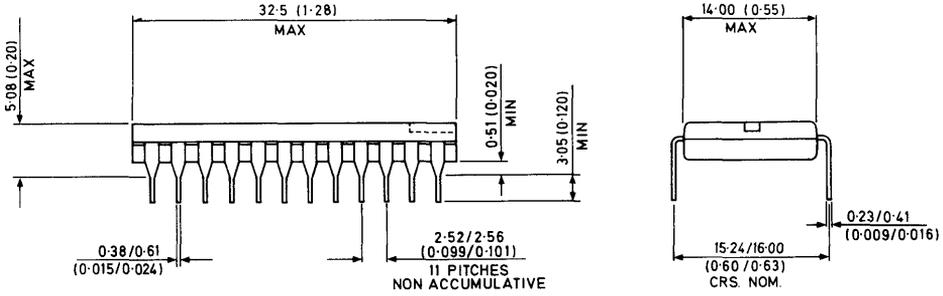
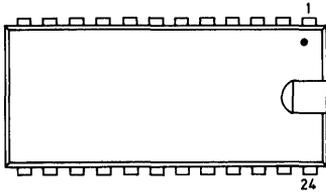
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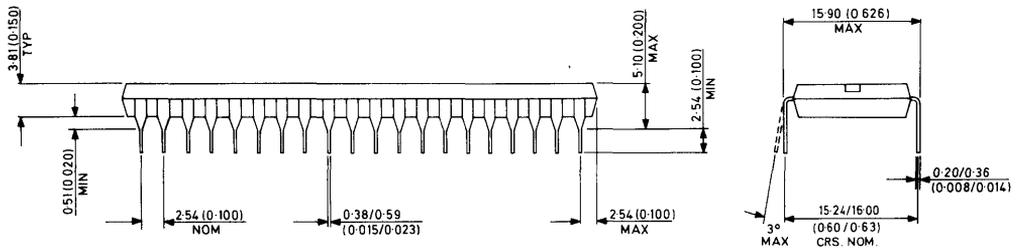
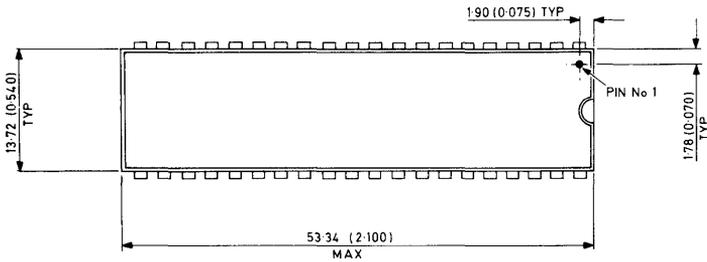
**16 LEAD PLASTIC DIL - DP16**



**18 LEAD PLASTIC DIL - DP18**



**24 LEAD PLASTIC DIL - DP24**



**40 LEAD PLASTIC DIL - DP40**

# Ordering information

Plessey Semiconductor integrated circuits are allocated type numbers which take the following general form

**WW XXXX Y/ZZ**

where **WW** is a two-letter code identifying the product group and/or technology, **XXXX** is a three or four numeral code uniquely specifying the particular device, **Y** is a single letter which denotes the precise electrical or thermal specification for certain devices and **ZZ** is a two-letter code defining the package style. Digits **WW**, **XXXX** and **Y** must always be used when ordering; digits **ZZ** need only be used where a device is offered in more than one package style. For example, the **MV8863** is offered in **DG** (Ceramic dual-in-line) and **DP** (Plastic dual-in line) packages so the full ordering number for this device in ceramic DIL would be **MV8863/DG** and **MV8863/DP** for the plastic DIL version.

The Pro-Electron standard is used for package codes wherever possible. The two letters of this code have the following meanings:

FIRST LETTER (indicates general shape)

- A** Pin-Grid Array
- C** Cylindrical
- D** Dual-in-Line (DIL)
- F** Flat Pack (leads on two sides)
- G** Flat Pack (leads on four sides)
- Q** Quad-in-Line

**M** Miniature (for Small Outline)

**L** Leadless Chip Carrier

Not yet designated by Pro-Electron

**H** Leaded Chip Carrier

SECOND LETTER (indicates material)

**C** Metal-Ceramic (Metal Sealed)

**G** Glass-Ceramic (Glass Sealed)

**M** Metal

**P** Plastic

**E** Epoxy

Please Note:

## **Leadless Chip Carriers**

**LC** Metal-Ceramic 3 Layer (Metal Sealed)

**LG** Glass-Sealed Ceramic

**LE** Epoxy-Sealed 1 Layer

**LP** Plastic

*Note: The above information refers generally to Plessey Semiconductors integrated circuit products and does not necessarily apply to all the devices contained in this handbook.*

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Astronic GmbH, Winzererstrasse 47D, 8000 Munchen 40. Tel: 089/309031 Tx: 5216187  
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